AFE7950 12GSPS DAC と 3GSPS ADC 搭載、4T6R RF サンプリング AFE

1 特長

- データシート全体のご請求
- クワッド RF サンプリング 12GSPS 送信 DAC
- クワッド RF サンプリング 3GSPS 受信 ADC
- デュアル RF サンプリング 3GSPS フィードバック (補助 RX) ADC
- 最大 RF 信号帯域幅:
  - 4TX または 2FB:1200MHz または 2TX:2400MHz
  - RX):1200MHz (FB なし)、600MHz (FB 付き)
- RF 周波数範囲:
  - TX:600MHz～12GHz
  - RX/FB:600MHz～12GHz
- デジタル・ステップ・アッテネータ (DSA):
  - TX:40dB レンジ、0.125dB ステップ
  - RX または FB:25dB レンジ、0.5dB ステップ
- TX と RX 向けにシングルバンドまたはデュアルバンド DUC または DDC を搭載
- TX または RX と FB に対応する 16 個の NCO
- DAC もしくは ADC クロック用の内部 PLL もしくは VCO、または DAC もしくは ADC サンプル・レートでの外部クロックを選択可能
- SerDes データ・インターフェイス:
  - JESD204B、JESD204C 適合
  - 8 つの SerDes トランシーバ (最高 29.5Gbps)
  - サブクラス 1 のマルチデバイス同期
- パッケージ:17mm × 17mm FCBGA、0.8mm ピッチ

2 アプリケーション

- レーダー
- 追尾フロント・エンド
- 防衛無線
- 戦術通信網
- ワイヤレス通信テスト

3 説明

AFE7950 は、高性能で広帯域幅のマルチチャネル・トランシーバで、4 つの RF サンプリング・トランスミッタ・チェーン、4 つの RF サンプリング・レシーバ・チェーン、2 つの RF サンプリング・フィードバック・チェーン (合計 6 つの RF サンプリング ADC) を統合しています。このデバイスは、最大 12GHz で動作するため、追加の周波数変換段を必要とせず、L、S、C、X バンドの周波数範囲について直接 RF サンプリングが可能です。密度と柔軟性の向上により、多くのチャネル数を持つマルチミッション・システムが可能になります。

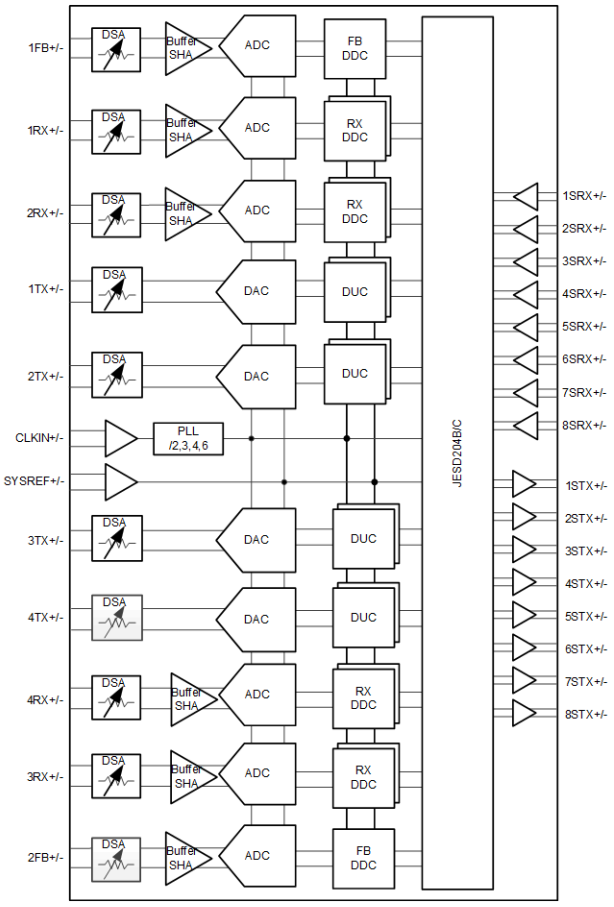
TX 信号パスは、4 個の TX で最大 1200MHz の信号帯域幅、または 2 個の TX で 2400MHz を実現する、補間およびデジタル・アップコンバージョン・オプションをサポートしています。DUC の出力は、2 次ナイキスト動作を拡張する混在モード出力方式で 12GSPS の DAC (D/A コンバータ) を駆動します。DAC 出力は、40dB レンジ、1dB アナログ・ステップ、0.125dB デジタル・ステップの可変ゲイン・アンプ (TX DSA) を内蔵しています。

パッケージ情報

部品番号	パッケージ(1)	パッケージ・サイズ (2)
AFE7950	FC-BGA	17mm × 17mm

(1) 詳細については、「メカニカル、パッケージ、および注文情報」を参照してください。

(2) パッケージ・サイズ (長さ × 幅) は公称値であり、該当する場合はピンも含まれます。



機能ブロック図

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4 概要 (続き)

各レシーバ・チェーンは、3GSPS の ADC (A/D コンバータ) に接続された 25dB レンジの DSA (デジタル・ステップ・アッテネータ) を備えています。各レシーバ・チャネルは、外部または内部の自律的な AGC (自動ゲイン制御) を補助するためのアナログ・ピーク電力検出器とさまざまなデジタル電力検出器、およびデバイスの信頼性を確保するための RF 過負荷検出器を備えています。柔軟なデシメーション・オプションによりデータ帯域幅を最適化でき、FB パスなしの 4 つの RX では最高 1200MHz 、2 つの FB パス付き (それぞれ 1200MHz の帯域幅) では最高 600MHz が得られます。

5 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

Changes from July 12, 2022 to June 12, 2023 (from Revision C (July 2022) to Revision D (June 2023)) **Page**

- 「パッケージ情報」表を変更して、注 2 を追加 ... 1
- Changed I_{IH} and I_{IL} units to µA ... 19
- Removed dither from conditions ... 28
- Changed captions to read 1.8 GHz in 1.8 GHz section and removed dither from conditions ... 36
- Removed dither from conditions ... 43
- Changed 0TX to 1TX in plot notes and removed dither from conditions and dither plot ... 51
- Removed dither from conditions ... 57
- Changed 0TX - 3TX to 1TX - 4TX in plot legends ... 64
- Removed TX dither plot and TX dither in conditions ... 64
- Removed dither from conditions ... 74
- Changed 0RX - 3RX to 1RX - 4RX in plot captions and notes ... 102

Changes from March 9, 2022 to July 12, 2022 (from Revision B (March 2022) to Revision C (July 2022)) **Page**

- Removed dither from conditions ... 28
- Changed captions to read 1.8 GHz in 1.8 GHz section and removed dither from conditions ... 36
- Removed dither from conditions ... 43
- Changed 0TX to 1TX in plot notes and removed dither from conditions and dither plot ... 51
- Removed dither from conditions ... 57
- Changed 0TX - 3TX to 1TX - 4TX in plot legends ... 64
- Removed TX dither plot and TX dither in conditions ... 64
- Removed dither from conditions ... 74
- Changed 0RX - 3RX to 1RX - 4RX in plot captions and notes ... 102

Changes from Revision A (August 2021) to Revision B (March 2022) **Page**

- 「*特長*」に「データシート全体のご請求」を追加 ... 1
- Added the Specification tables to the data sheet ... 4

Changes from Revision * (February 2021) to Revision A (August 2021) **Page**

- データシートのステータスを次のように変更 : *事前情報*から*量産データ*に変更 ... 1

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
Supply Voltage Range	DVDD0P9, VDDT0P9	–0.3	1.2	V
	VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2PLL, VDD1P2PLLCLKREF, VDD1P2FB, VDD1P2FBCML, VDD1P2RXCML	–0.3	1.4	V
	VDD1P8RX, VDD1P8RXCLK, VDD1P8TX, VDD1P8TXDAC, VDD1P8TXENC, VDD1P8PLL, VDD1P8PLLVCO, VDD1P8FB, VDD1P8FBCLK, VDD1P8GPIO, VDDA1P8	–0.5	2.1	V
Pin Volatge Range	{1/2/3/4}RXIN+/-	–0.5	VDDRX1P8+0.3	V
	1FBIN+/-, 2FB+/-	–0.5	VDDFB1P8+0.3	V
	{1/2/3/4}TXOUT+/-	–0.5	VDDTX1P8+0.3	V
	REFCLK+/-, SYSREF+/-	–0.3	1.4	V
	{1:8}SRX+/-	–0.3	1.4	V
	{1:8}STX+/-	–0.3	1.4	V
	GPIO{B/C/D/E}x, SPICLK, SPISDIO, SPISDO, SPISEN, RESETZ, BISTB0, BISTB1	–0.5	VDD1P8GPIO + 0.3	V
	IFORCE, VSENSE	–0.3	VDDCLK1P8 + 0.3	V
	SRDAMUX1, SRDAMUX2	–0.3	VDDA1P8+0.3	V
Peak Input Current	any input		20	mA
T_J	Junction temperature		150	°C
T_{stg}	Storage temperature	–65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Rating* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Condition*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins(1)	1000	V
		Charged device model (CDM), per ANSI/ESDA/JEDEC JS-002, all pins	150	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
DVDD0P9, VDDT0P9	Supply voltage 0.9V	0.9	0.925	0.95	V
VDD1P2{RX/TXCLK/TXENC/FB/PLL/PLLCLKREF/FBCML/RXCML}	Supply voltage 1.2V	1.15	1.2	1.25	V
VDD1P8{RX/RXCLK/TX/TXDAC/TXENC/PLL/PLLVCO/FB/FBCLK/GPIO}, VDDA1P8	Supply voltage 1.8V	1.75	1.8	1.85	V
T_A	Ambient temperature	–40		85	°C
T_J	Operating Junction Temperature			110(1)	°C
	Maximum Operating Junction Temperature	125			°C

(1) Prolonged use at or above this junction temperature can increase the device failure-in-time (FIT) rate. Refer to SBAA403 application note for additional details

6.4 Thermal Information

THERMAL METRIC(1)		AFE7950 ABJ or ALK (FC-BGA) 400 PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	16.2	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	0.42	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	4.85	°C/W
Ψ_{JT}	Junction-to-top characterization parameter	0.12	°C/W
Ψ_{JB}	Junction-to-board characterization parameter	4.6	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

6.5 Transmitter Electrical Characteristics

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, f_{DAC} = 11796.48MSPS; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps; TX clock dither enabled, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
DAC_{RES}	DAC resolution			14		bits
f_{RFout}	RF output frequency range	f_{DAC} = 12 GSPS, 1st Nyquist	600		6000	MHz
		f_{DAC} = 12 GSPS, 2nd Nyquist	6000		12000	
		f_{DAC} = 9 GSPS, 1st Nyquist	600		4500	
		f_{DAC} = 9 GSPS, 2nd Nyquist	4500		9000	
		f_{DAC} = 6 GSPS, 1st Nyquist	600		3000	
		f_{DAC} =6 GSPS, 2nd Nyquist	3000		6000	
P_{max_FS}	Max Full Scale Output Power, max gain 1 tone, at device pins	f_{out} = 850 MHz, f_{DAC} = 5898.24 MSPS, -0.5dBFS		4.2		dBm
		f_{out} = 1800 MHz, f_{DAC} = 5898.24 MSPS, -0.5dBFS		4.6		dBm
		f_{out} = 2600 MHz, f_{DAC} = 8847.36 MSPS, -0.5dBFS		4.0		dBm
		f_{out} = 3500 MHz, -0.5dBFS		3.9		dBm
		f_{out} = 4900 MHz, -0.5dBFS		3.1		dBm
		f_{out} = 3500 MHz, f_{DAC} = 5898.24 MSPS, -0.5dBFS, straight mode		1.0		dBm
		f_{out} = 4900 MHz, f_{DAC} = 5898.24 MSPS, -0.5dBFS, straight mode		0.1		dBm
		f_{out} = 4900 MHz, f_{DAC} = 8847.36 MSPS, -0.5dBFS, straight mode		-0.7		dBm
		f_{out} = 8100 MHz, -0.1dBFS, mixed mode		-2.8		dBm
		f_{out} = 9600 MHz, -0.1dBFS, mixed mode		-4.3		dBm
R_{TERM}	Output termination resistor	Default setting		50		Ω
ATT_{range}	DSA Attenuation range			40		dB
ATT_{step}	DSA Analog Attenuation step			1.0		dB
	DSA Attenuation step accuracy (DNL)	0 < Atten < 40dB, before calibration		±0.2		dB
	DSA Attenuation step accuracy (DNL)	0 < Atten < 40dB, after calibration		±0.1		dB
$ATT_{phase-err}$	DSA Gain Steps Phase accuracy, any 8dB range	f_{out} = 850MHz(2)		±1		deg
		f_{out} = 1800MHz(2)		±1		deg
		f_{out} =2600MHz(2)		±1		deg
		f_{out} = 3500MHz(2)		±1		
		f_{out} = 4900MHz(2)		±1		deg
		f_{out} = 8100MHz(2)		±2		deg
		f_{out} = 9600MHz(2)		±2		deg
G_{flat}	Gain flatness	any 20MHz		0.1		dB
		600MHz BW, F_{out} < 4.9G		1.2		

6.5 Transmitter Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, f_{DAC} = 11796.48MSPS; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps; TX clock dither enabled, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
IMD3	3rd Order Intermodulation distortion, 2 tones at f_{IF}±10 MHz	f_{out} = 850MHz, -7dBFS each tone		-66		dBc
		f_{out} = 1800MHz, -7dBFS each tone		-63		dBc
		f_{out} = 2600MHz, -7dBFS each tone		-62		dBc
		f_{out} = 3500MHz, -7dBFS each tone		-61		dBc
		f_{out} = 4900MHz, -7dBFS each tone		-57		dBc
		f_{out} = 8100MHz, -7dBFS each tone		-55		dBc
		f_{out} = 9600MHz, -7dBFS each tone		-52		dBc
		f_{out} = 850MHz, -13dBFS each tone		-74.4		dBc
		f_{out} = 1800MHz, -13dBFS each tone		-71.1		dBc
		f_{out} = 2600MHz, -13dBFS each tone		-73		dBc
		f_{out} = 3500MHz, -13dBFS each tone		-72		dBc
		f_{out} = 4900MHz, -13dBFS each tone		-67.8		dBc
		f_{out} = 8100MHz, -13dBFS each tone		-64		dBc
		f_{out} = 9600MHz, -13dBFS each tone		-68		dBc
SFDR	Spurious Free Dynamic Range (within Nyquist zone)	f_{out} = 850 MHz		50.8		dBc
		f_{out} = 1800 MHz		51.9		dBc
		f_{out} = 2600 MHz		42		dBc
		f_{out} = 3500 MHz		44		dBc
		f_{out}= 4900 MHz		46.1		dBc
$f_S/2 - f_{OUT}$	Interleaving Image	f_{DAC} = 5898.24MSPS, interleave mode		-51.9		dBc
		f_{DAC} = 8847.36 MSPS, interleave mode		-46.0		dBc
		f_{DAC} = 11796.48MSPS, interleave mode		-41		dBc
HD2	2nd Harmonic Distortion (within Nyquist zone)	f_{out} = 850 MHz		-49		dBc
		f_{out} = 1800 MHz		-53		dBc
		f_{out} = 2600 MHz		-50		dBc
		f_{out} = 3500 MHz		-48		dBc
		f_{out}= 4900 MHz		-47		dBc
		f_{out}= 8100 MHz		-50		dBc
		f_{out}= 9600 MHz		-53		dBc
		f_{out} = 850 MHz, A_{OUT}=-12dBFS		-60		dBc
		f_{out} = 1800 MHz, A_{OUT}=-12dBFS		-64		dBc
		f_{out} = 2600 MHz, A_{OUT}=-12dBFS		-45		dBc
		f_{out} = 3500 MHz, A_{OUT}=-12dBFS		-57		dBc
		f_{out}= 4900 MHz, A_{OUT}=-12dBFS		-58		dBc
		f_{out}= 8100 MHz, A_{OUT}=-12dBFS		-60		dBc
		f_{out}= 9600 MHz, A_{OUT}=-12dBFS		-62		dBc

6.5 Transmitter Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, f_{DAC} = 11796.48MSPS; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps; TX clock dither enabled, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
HD3	3rd Harmonic Distortion (within Nyquist zone)	f_{out} = 850 MHz		-62		dBc
		f_{out} = 1800 MHz		-55		dBc
		f_{out} = 2600 MHz		-57		dBc
		f_{out} = 3500 MHz		-60		dBc
		f_{out}= 4900 MHz		-54		dBc
		f_{out}= 8100 MHz		-54		dBc
		f_{out}= 9600 MHz		-56		dBc
		f_{out} = 850 MHz, A_{OUT}=-12dBFS		-80		dBc
		f_{out} = 1800 MHz, A_{OUT}=-12dBFS		-79		dBc
		f_{out} = 2600 MHz, A_{OUT}=-12dBFS		-77		dBc
		f_{out} = 3500 MHz, A_{OUT}=-12dBFS		-77		dBc
		f_{out}= 4900 MHz, A_{OUT}=-12dBFS		-78		dBc
		f_{out}= 8100 MHz, A_{OUT}=-12dBFS		-82		dBc
		f_{out}= 9600 MHz, A_{OUT}=-12dBFS		-80		dBc
HDn, n >= 4	Harmonic Distortion n >= 4 (within Nyquist zone)	f_{out} = 850 MHz		-81		dBc
		f_{out} = 1800 MHz		-88		dBc
		f_{out} = 2600 MHz		-86		dBc
		f_{out} = 3500 MHz		-79		dBc
		f_{out}= 4900 MHz		-86		dBc
		f_{out}= 8100 MHz		-87		dBc
		f_{out}= 9600 MHz		-85		dBc
		f_{out} = 850 MHz, A_{OUT}=-12dBFS		-93		dBc
		f_{out} = 1800 MHz, A_{OUT}=-12dBFS		-98		dBc
		f_{out} = 2600 MHz, A_{OUT}=-12dBFS		-84		dBc
		f_{out} = 3500 MHz, A_{OUT}=-12dBFS		-87		dBc
		f_{out}= 4900 MHz, A_{OUT}=-12dBFS		-87		dBc
		f_{out}= 8100 MHz, A_{OUT}=-12dBFS		-87		dBc
		f_{out}= 9600 MHz, A_{OUT}=-12dBFS		-87		dBc
SFDR +/- 250 MHz	Spurious Free Dynamic Range within +/- 250 MHz	f_{out} = 850 MHz		68.5		dBc
		f_{out} = 1800 MHz		79.4		dBc
		f_{out} = 2600 MHz		77		dBc
		f_{out} = 3500 MHz		75		dBc
		f_{out}= 4900 MHz		76		dBc
		f_{out}= 8100 MHz		61		dBc
		f_{out}= 9600 MHz		64		dBc
f_S/4	Fixed Spur	f_{DAC} = 5898.24MSPS		-64		dBFS
		f_{DAC} = 8847.36MSPS		-75		dBFS
		f_{DAC} = 11796.48MSPS		-67		dBFS
f_S/2	Fixed Spur	f_{DAC} = 5898.24MSPS		-49		dBFS
		f_{DAC} = 8847.36MSPS		-48		dBFS
		f_{DAC} = 11796.48 MSPS		-48		dBFS

6.5 Transmitter Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, f_{DAC} = 11796.48MSPS; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps; TX clock dither enabled, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
3*f_S/4	Fixed Spur	2nd Nyquist, f_{DAC} = 5898.24MSPS		-76		dBFS
		2nd Nyquist, f_{DAC} = 8847.36MSPS		-89		dBFS
		2nd Nyquist, f_{DAC} = 11796.48MSPS		-63		dBFS
$ACPR_{1xcarr}$	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f_{out} = 0.85 GHz	Atten=0dB, Pout=-13dBFs		-68.5		dBc
		Atten=20dB,Pout=-13dBFs		-67.2		dBc
		Atten=28dB,Pout=-13dBFs		-64.5		dBc
		Atten=39dB, Pout=-13dBFs		-53.9		dBc
$ACPR_{1xcarr}$	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f_{out} = 1.8425 GHz	Atten=0dB,Pout=-13dBFs		-70.7		dBc
		Atten=20dB, Pout=-13dBFs		-68.3		dBc
		Atten=28dB, Pout=-13dBFs		-62.9		dBc
		Atten=39dB, Pout=-13dBFs		-52.0		dBc
$ACPR_{1xcarr}$	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f_{out} = 2.6 GHz	Atten=0dB, Pout=-13dBFs		-71		dBc
		Atten=20dB, Pout=-13dBFs		-68		dBc
		Atten=28dB, Pout=-13dBFs		-62		dBc
		Atten=39dB, Pout=-13dBFs		-51.3		dBc
$ACPR_{1xcarr}$	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f_{out} = 3.5 GHz	Atten=0dB, Pout=-13dBFs		-70		dBc
		Atten=20dB, Pout=-13dBFs		-67		dBc
		Atten=28dB, Pout=-13dBFs		-60		dBc
		Atten=39dB, Pout=-13dBFs		-49.8		dBc
$ACPR_{1xcarr}$	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f_{out} = 4.9 GHz	Atten=0dB, Pout=-13dBFs		-68.8		dBc
		Atten=20dB, Pout=-13dBFs		-65.9		dBc
		Atten=28dB, Pout=-13dBFs		-60.6		dBc
		Atten=39dB, Pout=-13dBFs		-49.5		dBc
$ACPR_{1xcarr}$	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f_{out} = 2.6 GHz	Atten=0dB, Pout=-13dBFs		-65		dBc
		Atten=20dB, Pout=-13dBFs		-62		dBc
		Atten=20dB, Pout=-13dBFs		-55		dBc
		Atten=39dB,Pout=-13dBFs		-44.3		dBc
$ACPR_{1xcarr}$	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f_{out} = 3.5 GHz	Atten=0dB, Pout=-13dBFs		-64		dBc
		Atten=20dB, Pout=-13dBFs		-59		dBc
		Atten=28dB, Pout=-13dBFs		-52		dBc
		Atten=39dB, Pout=-13dBFs		-41.1		dBc
$ACPR_{1xcarr}$	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f_{out} = 4.9 GHz	Atten=0dB, Pout=-13dBFs		-64.1		dBc
		Atten=20dB, Pout=-13dBFs		-60.4		dBc
		Atten=28dB, Pout=-13dBFs		-53.5		dBc
		Atten=39dB, Pout=-13dBFs		-42.5		dBc
$ACPR_{1xcarr}$	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f_{out} = 8.1 GHz	Atten=0dB, Pout=-13dBFs		-58		dBc
		Atten=20dB, Pout=-13dBFs		-53		dBc
		Atten=28dB, Pout=-13dBFs		-46		dBc
		Atten=39dB, Pout=-13dBFs		-36		dBc

6.5 Transmitter Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, f_{DAC} = 11796.48MSPS; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps; TX clock dither enabled, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$ACPR_{1xcarr}$	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f_{out} = 9.6 GHz	Atten=0dB, Pout=-13dBFs		-57		dBc
		Atten=20dB, Pout=-13dBFs		-50		dBc
		Atten=28dB, Pout=-13dBFs		-42		dBc
		Atten=39dB, Pout=-13dBFs		-31		dBc
EVM	Error Vector Magnitude, 1x 20MHz E-TM3.1/3.1a, no ref. clock noise	F_{out} =0.85 GHz, P_{OUT}=-13dBFs		0.2		%
		F_{out} =1.8425 GHz, P_{OUT}=-13dBFs		0.3		%
		F_{out} =2.6 GHz, P_{OUT}=-13dBFs		0.28		%
		F_{out} =3.5 GHz, P_{OUT}=-13dBFs		0.38		%
		F_{out} =4.9 GHz, P_{OUT}=-13dBFs		0.4		%
NSD_{dBFS}	Noise Spectral Density 20MHz offset f_{OUT} = 0.85 GHz	Atten=0dB, f_{DAC} = 5898.24MSPS, Pout=-13dBFs		-157.6		dBFS/Hz
		Atten=20dB, f_{DAC} = 5898.24MSPS, Pout=-13dBFs		-153.3		dBFS/Hz
		Atten=28dB, f_{DAC} = 5898.24MSPS, Pout=-13dBFs		-147.9		dBFS/Hz
		Atten=39dB, f_{DAC} = 5898.24MSPS, Pout=-13dBFs		-136.9		dBFS/Hz
NSD_{dBFS}	Noise Spectral Density 20MHz offset f_{OUT} = 1.8 GHz	Atten=0dB, f_{DAC} = 5898.24MSPS, Pout=-13dBFs		-158.4		dBFS/Hz
		Atten=20dB, f_{DAC} = 5898.24MSPS, Pout=-13dBFs		-152.2		dBFS/Hz
		Atten=28dB, f_{DAC} = 5898.24MSPS, Pout=-13dBFs		-145.6		dBFS/Hz
		Atten=39dB, f_{DAC} = 5898.24MSPS, Pout=-13dBFs		-134.6		dBFS/Hz
NSD_{dBFS}	Noise Spectral Density 20MHz offset f_{OUT} = 2.6 GHz	Atten=0dB, f_{DAC} = 8847.36MSPS, Pout=-13dBFs		-157		dBFS/Hz
		Atten=20dB, f_{DAC} = 8847.36MSPS, Pout=-13dBFs		-151		dBFS/Hz
		Atten=28dB, f_{DAC} = 8847.36MSPS, Pout=-13dBFs		-144		dBFS/Hz
		Atten=39dB, f_{DAC} = 8847.36MSPS, Pout=-13dBFs		-133.0		dBFS/Hz
NSD_{dBFS}	Noise Spectral Density 20MHz offset F_{out} =3.5 GHz	Atten=0dB, Pout=-13dBFs		-158		dBFS/Hz
		Atten=20dB, Pout=-13dBFs		-150		dBFS/Hz
		Atten=28dB, Pout=-13dBFs		-143		dBFS/Hz
		Atten=39dB, Pout=-13dBFs		-131.8		dBFS/Hz

6.5 Transmitter Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, f_{DAC} = 11796.48MSPS; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps; TX clock dither enabled, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
NSD_{dBFS}	Noise Spectral Density 20MHz offset F_{out} =4.9 GHz	Atten=0dB, Pout=-13dBFs		-155.5		dBFS/Hz
		Atten=20dB, Pout=-13dBFs		-147.8		dBFS/Hz
		Atten=28dB, Pout=-13dBFs		-140.8		dBFS/Hz
		Atten=39dB, Pout=-13dBFs		-129.6		dBFS/Hz
NSD_{dBFS}	Noise Spectral Density 50MHz offset F_{out} =8.1 GHz	Atten=0dB, Pout=-13dBFs		-153		dBFS/Hz
		Atten=20dB, Pout=-13dBFs		-147		dBFS/Hz
		Atten=28dB, Pout=-13dBFs		-140		dBFS/Hz
		Atten=39dB, Pout=-13dBFs		-129		dBFS/Hz
NSD_{dBFS}	Noise Spectral Density 50MHz offset F_{out} =9.6 GHz	Atten=0dB, Pout=-13dBFs		-152		dBFS/Hz
		Atten=20dB, Pout=-13dBFs		-147		dBFS/Hz
		Atten=28dB, Pout=-13dBFs		-140		dBFS/Hz
		Atten=39dB, Pout=-13dBFs		-129		dBFS/Hz
S22	Output Return Loss, <6GHz, +/- fc * 10%	with matching		-17		dB
	Output Return Loss, >8GHz, +/- fc * 10%	with matching		-10		dB
Isolation	Near Channel: 1TXOUT to 2TXOUT or 3TXOUT to 4TXOUT(1)	f_{out} = 900 MHz, f_{DAC} = 8847.36MSPS, straight mode		-49		dB
		f_{out} = 1850 MHz, f_{DAC} = 8847.36MSPS, straight mode		-59		dB
		f_{out} = 2600 MHz, f_{DAC} = 8847.36MSPS, straight mode		-65		dB
		f_{out} = 3500 MHz, f_{DAC} = 8847.36MSPS, straight mode		-66		dB
		f_{out}= 4900 MHz, f_{DAC} = 8847.36MSPS, straight mode		-60		dB
		f_{out} = 900 MHz, f_{DAC} = 8847.36MSPS, straight mode		-90		dB
		f_{out} = 1850 MHz, f_{DAC} = 8847.36MSPS, straight mode		-91		dB
		f_{out} = 2600 MHz, f_{DAC} = 8847.36MSPS, straight mode		-93		dB
		f_{out} = 3500 MHz, f_{DAC} = 8847.36MSPS, straight mode		-94		dB
		f_{out}= 4900 MHz, f_{DAC} = 8847.36MSPS, straight mode		-83		dB

6.5 Transmitter Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS below 6GHz and 1474.56MSPS above 6GHz, f_{DAC} = 11796.48MSPS; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps; TX clock dither enabled, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
PN_{TXADD}	Additive Phase Noise External Clock Mode(3)	f_{out} = 9.6GHz, f_{OFFSET} = 100Hz		-88		dBc/Hz
		f_{out} = 9.6GHz, f_{OFFSET} = 1kHz		-102		dBc/Hz
		f_{out} = 9.6GHz, f_{OFFSET} = 10kHz		-110		dBc/Hz
		f_{out} = 9.6GHz, f_{OFFSET} = 100kHz		-123		dBc/Hz
		f_{out} = 9.6GHz, f_{OFFSET} = 1MHz		-136		dBc/Hz
		f_{out} = 9.6GHz, f_{OFFSET} = 10MHz		-143		dBc/Hz
		f_{out} = 9.6GHz, f_{OFFSET} = 100MHz		-146		dBc/Hz

(1) Measured with differential 50 ohm across TxP/M. The DC bias to 1.8V to each TxP/M at each pin remains and is not removed. Other external components on the TX paths are disconnected.
(2) After DSA calibration procedure
(3) Single side band, input clock phase noise subtracted.

6.6 RF ADC Electrical Characteristics

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, f_{ADC} = 2949.12MSPS; PLL clock mode with f_{REF} = 491.52MHz below 6GHz input frequency and External clock mode with f_{CLK} = 11796.48MHz above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate =24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ADC_{RES}	ADC resolution			14		bits
F_{RFin}	RF input frequency range		600		12000	MHz
$P_{FS\_CW,min}$	Min Full scale input power, at device pins (1)	f_{IN} = 830 MHz, DSA=0dB		-2.9		dBm
		f_{IN} = 1760 MHz, DSA=0dB		-2.8		dBm
		f_{IN} = 2610 MHz, DSA=0dB		-1.8		dBm
		f_{IN} = 3610 MHz, DSA=0dB		-0.4		dBm
		f_{IN} = 4910 MHz, DSA=0dB		0.1		dBm
		f_{IN} = 8150 MHz, DSA=0dB		2.1		dBm
		f_{IN} = 9610 MHz, DSA=0dB		4.3		dBm
$P_{FS\_CW,MAX}$	MAX Full scale input power - reliability limited, at device pins	f_{IN} = 830 MHz, DSA = 20dB		16.7		dBm
		f_{IN} = 1760 MHz, DSA = 20dB		17.0		dBm
		f_{IN} = 2610 MHz, DSA = 20dB		18		dBm
		f_{IN} = 3610 MHz, DSA = 20dB		18.5		dBm
		f_{IN} = 4910 MHz, DSA = 20dB		19.3		dBm
		f_{IN} = 8150 MHz, DSA = 20dB		21.3		dBm
		f_{IN} = 9610 MHz, DSA = 20dB		23.5		dBm
S11	Input Return Loss	with matching network		-12.0		dB
ATT_{range}	DSA Attenuation range			25.0		dB
ATT_{step}	DSA Attenuation step			0.5		dB
	DSA Attenuation step accuracy	Delta=Gatt(X)-Gatt(X-1), F_{in}=3610MHz, after calibration		±0.1		dB
	DSA Gain Steps Phase accuracy any 8dB range	F_{in}=3610MHz, after calibration		±0.9		deg
	DSA Gain Steps Phase accuracy any 8dB range	F_{in}=4910MHz, after calibration		±1.8		deg
NSD	Noise Density (small signal)	f_{IN} = 830 MHz, DSA = 3dB(3)		-155.2		dBFS/Hz
		f_{IN} = 1760 MHz, DSA = 3dB(3)		-155.0		dBFS/Hz
		f_{IN} = 2610 MHz, DSA = 3dB(3)		-154.4		dBFS/Hz
		f_{IN} = 3610 MHz, DSA = 3dB(3)		-154.1		dBFS/Hz
		f_{IN} = 4910 MHz, DSA = 3dB(3)		-155.1		dBFS/Hz
		f_{IN} = 8150 MHz, DSA = 3dB(3)		-150		dBFS/Hz
		f_{IN} = 9610 MHz, DSA = 3dB(3)		-151		dBFS/Hz
		f_{IN} = 830 MHz, 3<=Atten<=22		-156.0		dBFS/Hz
		f_{IN} = 1760 MHz, 3<=Atten<=25		-155.8		dBFS/Hz
		f_{IN} = 2610 MHz, 3<=Atten<=25		-155.7		dBFS/Hz
		f_{IN} = 3610 MHz, 3<=Atten<=25		-155.4		dBFS/Hz
		f_{IN} = 4910 MHz, 3<=Atten<=25		-155.8		dBFS/Hz
		f_{IN} = 8150 MHz, 3<=Atten<=25		-152.5		dBFS/Hz
		f_{IN} = 9610 MHz, 3<=Atten<=25		-152.5		dBFS/Hz

6.6 RF ADC Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, f_{ADC} = 2949.12MSPS; PLL clock mode with f_{REF} = 491.52MHz below 6GHz input frequency and External clock mode with f_{CLK} = 11796.48MHz above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate =24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
NF_{min}	Noise Figure min DSA Atten=0 - 3dB	f_{IN} = 830 MHz		19.1		dB
		f_{IN} = 1760 MHz		19.0		dB
		f_{IN} = 2610 MHz		20.9		dB
		f_{IN} = 3610 MHz		22.8		dB
		f_{IN} = 4910 MHz		22.4		dB
		f_{IN} = 8150 MHz		27.3		dB
		f_{IN} = 9610 MHz		30		dB
NF	Noise Figure DSA Atten=4dB	f_{IN} = 830 MHz(4)		20.0		dB
		f_{IN} = 1760 MHz(4)		20.6		dB
		f_{IN} = 2610 MHz(4)		21.9		dB
		f_{IN} = 3610 MHz(4)		23.5		dB
		f_{IN} = 4910 MHz(4)		22.3		dB
		f_{IN} = 8150 MHz(4)		27.9		dB
		f_{IN} = 9610 MHz(4)		30.7		dB
NF_{max}	Noise Figure DSA Atten=20dB	f_{IN} = 830 MHz		34.7		dB
		f_{IN} = 1760 MHz		35.2		dB
		f_{IN} = 2610 MHz		36.0		dB
		f_{IN} = 3610 MHz		37.3		dB
		f_{IN} = 4910 MHz		37.6		dB
		f_{IN} = 8150 MHz		42.8		dB
		f_{IN} = 9610 MHz		45		dB
IMD3	3rd order intermodulation 2 tones at at f_{IN} ± 10MHz -7dBFS each tone	f_{IN} = 840 MHz, 3<=Atten<=12		-82.4		dBc
		f_{IN} = 1770 MHz, 3<=Atten<=12		-84.1		dBc
		f_{IN} = 2610 MHz, 3<=Atten<=12		-74		dBc
		f_{IN} = 3610 MHz, 3<=Atten<=12		-77		dBc
		f_{IN} = 4920 MHz, 3<=Atten<=12		-75.9		dBc
		f_{IN} = 8150 MHz, 3<=Atten<=12, 25MHz tone spacing		-55		dBc
		f_{IN} = 9610 MHz, 3<=Atten<=12, 25MHz tone spacing		-60		dBc
SFDR	Spurious Free Dynamic Range within output bandwidth, A_{IN} = -3 dBFS	f_{IN} = 830 MHz		88.2		dBFS
		f_{IN} = 1760 MHz		80.6		dBFS
		f_{IN} = 2610 MHz		88		dBFS
		f_{IN} = 3610 MHz		84		dBFS
		f_{IN} = 4910 MHz		78.9		dBFS
		f_{IN} = 8150 MHz		78		dBFS
		f_{IN} = 9610 MHz		71		dBFS

6.6 RF ADC Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, f_{ADC} = 2949.12MSPS; PLL clock mode with f_{REF} = 491.52MHz below 6GHz input frequency and External clock mode with f_{CLK} = 11796.48MHz above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate =24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
HD2	2nd Harmonic Distortion A_{IN} = -3 dBFS(2)	f_{IN} = 830 MHz		-85.5		dBFS
		f_{IN} = 1760 MHz		-90.5		dBFS
		f_{IN} = 2610 MHz		-88		dBFS
		f_{IN} = 3610 MHz		-87		dBFS
		f_{IN} = 4910 MHz		-84.2		dBFS
		f_{IN} = 8150 MHz		-70		dBFS
		f_{IN} = 9610 MHz		-70		dBFS
HD3	3rd Harmonic Distortion A_{IN} = -3 dBFS	f_{IN} = 830 MHz		-80.2		dBFS
		f_{IN} = 1760 MHz		-85.3		dBFS
		f_{IN} = 2610 MHz		-86		dBFS
		f_{IN} = 3610 MHz		-78		dBFS
		f_{IN} = 4910 MHz		-75.4		dBFS
		f_{IN} = 8150 MHz		-70		dBFS
		f_{IN} = 9610 MHz		-70		dBFS
HDn, n>3	SFDR excl. HD2 and HD3 A_{IN} = -3 dBFS	f_{IN} = 830 MHz		-88.2		dBFS
		f_{IN} = 1760 MHz		-80.6		dBFS
		f_{IN} = 2610 MHz		-88		dBFS
		f_{IN} = 3610 MHz		-84		dBFS
		f_{IN} = 4910 MHz		-81.7		dBFS
		f_{IN} = 8150 MHz		-78		dBFS
		f_{IN} = 9610 MHz		-78		dBFS
SFDR	Spurious Free Dynamic Range A_{IN} = -13 dBFS 0<=Atten<=16	f_{IN} = 830 MHz		89.2		dBFS
		f_{IN} = 1760 MHz		88.8		dBFS
		f_{IN} = 2610 MHz		95		dBFS
		f_{IN} = 3610 MHz		90		dBFS
		f_{IN} = 4910 MHz		89.8		dBFS
		f_{IN} = 8150 MHz		83		dBFS
		f_{IN} = 9610 MHz		80		dBFS
HD2	2nd Harmonic Distortion A_{IN} = -13 dBFS 0<=Atten<=16	f_{IN} = 830 MHz, with board trim		-79.0		dBFS
		f_{IN} = 1760 MHz, with board trim		-101.6		dBFS
		f_{IN} = 2610 MHz, with board trim		-100		dBFS
		f_{IN} = 3610 MHz, with board trim		-101		dBFS
		f_{IN} = 4910 MHz, with board trim		-99.1		dBFS
		f_{IN} = 8150 MHz, with board trim		-107		dBFS
		f_{IN} = 9610 MHz, with board trim		-107		dBFS

6.6 RF ADC Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; RX Output Rate = 491.52MSPS below 6GHz input frequency and 1474.56MSPS above 6GHz input frequency, f_{ADC} = 2949.12MSPS; PLL clock mode with f_{REF} = 491.52MHz below 6GHz input frequency and External clock mode with f_{CLK} = 11796.48MHz above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate =24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
HD3	3rd Harmonic Distortion A_{IN} = -13 dBFS 0<=Atten<=16	f_{IN} = 830 MHz		-95.4		dBFS
		f_{IN} = 1760 MHz		-95.2		dBFS
		f_{IN} = 2610 MHz		-98		dBFS
		f_{IN} = 3610 MHz		-97		dBFS
		f_{IN} = 4910 MHz		-94		dBFS
		f_{IN} = 8150 MHz		-100		dBFS
		f_{IN} = 9610 MHz		-102		dBFS
HDn, n>3	SFDR excl. HD2 and HD3 A_{IN} = -13 dBFS 0<=Atten<=16	f_{IN} = 830 MHz		-89.2		dBFS
		f_{IN} = 1760 MHz		-88.8		dBFS
		f_{IN} = 2610 MHz		-95		dBFS
		f_{IN} = 3610 MHz		-90		dBFS
		f_{IN} = 4910 MHz		-90		dBFS
		f_{IN} = 8150 MHz		-83		dBFS
		f_{IN} = 9610 MHz		-80		dBFS
RX-RX Isolation	Near Channel: 1RXIN to 2RXIN 3RXIN to 4RXIN	f_{IN} = 830 MHz		-76.6		dBc
		f_{IN} = 1760 MHz		-70.9		dBc
		f_{IN} = 2610 MHz		-73.5		dBc
		f_{IN} = 3610 MHz		-76.9		dBc
		f_{IN} = 4910 MHz		-65.3		dBc
		f_{IN} = 8150 MHz		-64		dBc
		f_{IN} = 9610 MHz		-60		dBc
TX-FB Isolation	Near Channel: 2TXOUT to 1FBIN 4TXOUT to 2FBIN	f_{IN} = 830 MHz		-84.3		dBc
		f_{IN} = 1760 MHz		-87.7		dBc
		f_{IN} = 2610 MHz		-85		dBc
		f_{IN} = 3610 MHz		-75		dBc
		f_{IN} = 4910 MHz		-81.5		dBc
		f_{IN} = 8150 MHz		-71		dBc
		f_{IN} = 9610 MHz		-69		dBc
TX-RX Isolation	Far Channel: 2TXOUT to 1RXIN 4TXOUT to 3RXIN	f_{IN} = 830 MHz		-85.9		dBc
		f_{IN} = 1760 MHz		-86.9		dBc
		f_{IN} = 2610 MHz		-91		dBc
		f_{IN} = 3610 MHz		-83		dBc
		f_{IN} = 4910 MHz		-81.9		dBc
		f_{IN} = 8150 MHz		-68		dBc
		f_{IN} = 9610 MHz		-68		dBc

(1) The input fullscale at minimum attenuation can be reduce by adding a digital gain range to the DSA, extending the useful range of the DSA. The noise figure remains constant over the digital gain range.
(2) NLE correction of HD2
(3) From DSA = 3dB down to 0dB, NSD increases 1dB per DSA dB
(4) NF increase 1dB per DSA 1dB above DSA = 3dB

6.7 PLL/VCO/Clock Electrical Characteristics

Typical values at TA = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; Reference clock input frequency 491.52MHz (unless otherwise noted), $f_{DAC} = f_{VCO}$, $f_{OUT} = f_{DAC}/4$, normalized to f_{VCO}.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{VCO1}	VCO1 min frequency				7.2	GHz
	VCO1 max frequency		7.68			GHz
f_{VCO2}	VCO2 min frequency				8.8	GHz
	VCO2 max frequency		9.1			GHz
f_{VCO3}	VCO3 min frequency				9.7	GHz
	VCO3 max frequency		10.24			GHz
f_{VCO4}	VCO4 min frequency				11.6	GHz
	VCO4 max frequency		12.08			GHz
DIV_{DAC}	DAC sample rate divider			1, 2 or 3		
DIV_{FBADC}	ADC sample rate divider from DAC sample rate			1, 2, 3, 4, 6 or 8		
DIV_{RXADC}	ADC sample rate divider			1, 2, 3, 4, 6 or 8		
PN_{VCO}	Closed Loop Phase Noise F_{PLL} = 11.79848 GHz F_{REF}=491.52MHz	600kHz		-113		dBc/Hz
		800kHz		-116		dBc/Hz
		1MHz		-119		dBc/Hz
		1.8MHz		-125		dBc/Hz
		5MHz		-133		dBc/Hz
		50MHz		–141		dBc/Hz
	Closed Loop Phase Noise F_{PLL}=8.84736 GHz F_{REF}=491.52MHz	600kHz		-114		dBc/Hz
		800kHz		–118		dBc/Hz
		1MHz		–120		dBc/Hz
		1.8MHz		–127		dBc/Hz
		5MHz		–135		dBc/Hz
		50MHz		–142		dBc/Hz
	Closed Loop Phase Noise F_{PLL}= 9.8403 GHz F_{REF}=491.52MHz	600kHz		–113		dBc/Hz
		800kHz		–116		dBc/Hz
		1MHz		–119		dBc/Hz
		1.8MHz		–125		dBc/Hz
		5MHz		–134		dBc/Hz
		50MHz		–140		dBc/Hz
	Closed Loop Phase Noise F_{PLL}= 7.86432GHz F_{REF}=491.52MHz	600kHz		–116		dBc/Hz
		800kHz		–119		dBc/Hz
		1MHz		–122		dBc/Hz
		1.8MHz		–127		dBc/Hz
		5MHz		–136		dBc/Hz
		50MHz		–143		dBc/Hz
F_{rms}	Clock PLL integrated phase error(1)	f_{PLL}=11.79848 GHz, [1KHz, 100MHz]		-43.4		dBc/Hz
		f_{PLL}=8.8536 GHz, [1KHz, 100MHz]		-47.6		dBc/Hz
		f_{PLL}=9.8304 GHz, [1KHz, 100MHz]		-46.2		dBc/Hz
f_{PFD}	PFD frequency		100		500	MHz
PN_{pll_flat}	Normalized PLL flat Noise	f_{VCO} = 11796.48MHz		–226.5		dBc/Hz
F_{REF}	Input Clock frequency		0.1		12	GHz

6.7 PLL/VCO/Clock Electrical Characteristics (continued)

Typical values at TA = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; Reference clock input frequency 491.52MHz (unless otherwise noted), $f_{DAC} = f_{VCO}$, $f_{OUT} = f_{DAC}/4$, normalized to f_{VCO}.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{SS}	Input Clock level		0.6		1.8	Vppdiff
Coupling				AC Coupling Only		
	REFCLK input impedance(2)	Parallel resistance		100		Ω
		Parallel capacitance		0.5		pF

(1) Single Sideband, not including the reference clock contribution
(2) Refer to S11 data available from TI for impedance vs frequency

6.8 Digital Electrical Characteristics

Typical values at TA = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
CML SerDes Inputs [8:1]SRX+/-						
V_{SRDIFF}	SerDes Receiver Input Amplitude	differential	100		1200	mVpp
V_{SRCOM}	SerDes Input Common Mode		0.4	0.5	0.6	V
Z_{SRdiff}	SerDes Internal Differential Termination(1)			100		Ω
F_{SerDes}	SerDes Bit Rate	Full rate mode	19		29.5	Gbps
		Half rate mode	9.5		16.25	Gbps
		Quarter rate mode	4.75		8.125	Gbps
	Insertion Loss Tolerance(2)	Serdes supply = 1.8V		25		dB
TJ	Total Jitter Tolerance				0.42	UI
CML SerDes Outputs [8:1]STX+/-						
V_{STDIFF}	SerDes Transmitter Output Amplitude	differential	500		1000	mVpp
V_{STCOM}	SerDes Output Common Mode		0.4	0.45	0.55	V
Z_{STdiff}	SerDes Output Impedance			100		Ω
TRF	Output rise and fall time	20-80%	8			ps
TEQS	Equalization range				7	dB
TTJ	Output total jitter				0.21	UI
CMOS I/O: GPIO{B/C/D/E}x, SPICLK, SPISDIO, SPISDO, SPISEN, RESETZ, BISTB0, BISTB1						
V_{IH}	High-Level Input Voltage		0.6×VDD1 P8GPIO			V
V_{IL}	Low-Level Input Voltage				0.4×VDD1 P8GPIO	V
I_{IH}	High-Level Input Current		–250		250	µA
I_{IL}	Low-Level Input Current		–250		250	µA
C_L	CMOS input capacitance			2		pF
V_{OH}	High-Level Ouput Voltage		VDD1P8G PIO–0.2			V
V_{OL}	Low-Level Output Voltage				0.2	V
Differential Inputs: SYSREF+/- Mode A						
$Clock_{MODE}$				PLL Clock Mode Only		
$F_{SYSREFMAX}$	SYSREF Input Frequency Maximum			40		MHz
$V_{SWINGSRMAX}$	SYSREF Input Swing Maximum			1.8		Vppdiff(3)
$V_{SWINGSRMIN}$	SYSREF Input Swing Minimum	f_{REF} < 500MHz		0.3		Vppdiff(3)
$V_{SWINGSRMIN}$	SYSREF Input Swing Minimum	f_{REF} > 500MHz		0.6		Vppdiff(3)
$V_{COMSRMAX}$	SYSREF Input Common Mode Voltage Maximum			0.8		V
$V_{COMSRMIN}$	SYSREF Input Common Mode Voltage Minimum			0.6		V
Z_T	Input termination	differential		100 (1)		Ω
C_L	Input capacitance	Each pin to GND		0.5		pF
LVDS Inputs: 0SYNCIN+/- and 1SYNCIN+/-						
V_{ICOM}	Input Common Voltage			1.2		V
V_{ID}	Differential Input Voltage swing			450		Vppdiff(3)

6.8 Digital Electrical Characteristics (continued)

Typical values at TA = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Z_T	Input termination	differential		100		Ω
LVDS Outputs: 0SYNCOUT+/- and 1SYNCOUT+/-						
V_{OCOM}	Output Common Voltage			1.2		V
V_{OD}	Differential Output Voltage swing			500		Vppdiff(3)
Z_T	Internal Termination			100		Ω

(1) SYSREF termination is programmable between 100Ω, 150Ω and 300Ω
(2) Loss tolerance is bump to bump from STX to SRX
(3) Vppdiff is the difference between the maximum differential voltage (positive value) and minimum differential voltage (negative value).

6.9 Power Supply Electrical Characteristics

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS, f_{DAC} = 8847.36MSPS interleave mode; f_{ADC} = 2949.12MSPS; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 1: 4T2F - FDD FB 100% on, no RX TX/FB Rate: 491.52 Msps Single Band: 12x Int, FB 6x Dec f_{DAC} = 5898.24 SPS f_{ADC} = 2949.12MSPS f_{TX} = 1.85 GHz 64/66 coding, 16.22Gbps TX: 4-8-4-1, FB: 2-4-4-1		948.2		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			533.7		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			77.3		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			299.4		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			804.5		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			49.1		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2041.3		mA
P_{diss}	Power Dissipation			6027.1		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 2: 4T4R - TDD 1F shared with RX TX 75%, RX 25%, FB 75% Dual Band: 12x Int, FB 6x Dec, RX 24x Dec TX/FB Rate 491.52 Msps RX Rate 122.88 Msps f_{DAC} = 8847.36MSPS f_{ADC} = 2949.12MSPS f_{OUT}=f_{IN}= 1.9, 2.6 GHz 64/66 coding, 16.22Gbps TX: 8-16-4-1, FB: 2-4-4-1, RX: 2-16-16-1		820.4		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			735.2		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			74.4		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			289.0		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			822.0		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			45.6		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2263.8		mA
P_{diss}	Power Dissipation			6359.2		mW

6.9 Power Supply Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS, f_{DAC} = 8847.36MSPS interleave mode; f_{ADC} = 2949.12MSPS; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 3: 4T4R2F - FDD FB 100% on TX Dual Band: 12x Int, FB 6x Dec RX Dual Band: RX 24x TX/FB Rate 491.52 Msps RX Rate 122.88 Msps f_{DAC} = 11796.48 MSPS f_{ADC} = 2949.12 MSPS f_{TX} = 1.85 + 2.15 GHz f_{RX} = 1.75 + 1.88 GHz 64/66 coding, 16.22Gbps TX: 8-16-4-1, FB: 2-4-4-1, RX: 2-16-16-1		1668.6		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			965.1		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			77.6		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			893.4		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			879.5		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			50.7		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			3826.9		mA
P_{diss}	Power Dissipation			10513.0		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 4: 4T4R2F - FDD FB 100% on 7.5 GSPS DAC, 2.5 GSPS ADC Single Band: 15x Int, FB 5x Dec Dual Band: RX 20x TX/FB Rate 491.52 Msps RX Rate 122.88 Msps f_{DAC} = 7372.8 MSPS f_{ADC} = 2457.6 MSPS f_{TX} = 1.85 + 2.15 GHz f_{RX} = 1.75 + 1.88 GHz 64/66 coding, 16.22Gbps TX: 4-8-4-1, FB: 2-4-4-1, RX: 2-16-16-1		1611.5		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			694.5		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			72.8		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			768.5		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			940.5		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			45.5		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			3000.5		mA
P_{diss}	Power Dissipation			9087.4		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 5: 4T4R - TDD 1F shared with RX TX 75%, RX 25%, FB 75% Single Band: 12x Int, FB 3x Dec, RX 6x Dec TX/FB Rate = 983.04 Msps RX Rate 491.52 Msps f_{DAC} = 11796.48 MSPS f_{ADC} = 2949.12 MSPS f_{TX} = 3.5 GHz f_{RX} =3.5 GHz 64/66 coding, 16.22Gbps TX: 8-8-2-1, FB: 4-4-4-2, RX: 4-8-4-1		821.8		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			808.5		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			77.4		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			289.5		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			682.0		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			49.0		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2123.3		mA
P_{diss}	Power Dissipation			6209.3		mW

6.9 Power Supply Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS, f_{DAC} = 8847.36MSPS interleave mode; f_{ADC} = 2949.12MSPS; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7a: TDD 4T1FB (RX iin Standby) TX 9G and FB 3G -16bit: 368.64M; DSA = 6dB, non-interleave mode RX 3G : 368.64M. 16 bit, Standby Serdes: 25gbps) -> 2 lanes for Rx/FB (lane shared) and 2lanes for Tx		658.1		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			431.1		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			75.3		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			189.2		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1041.1		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			39.0		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2208.7		mA
P_{diss}	Power Dissipation			5607.0		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7b: TDD 4R (TX in Standby) TX 9G and FB 3G -16bit: 368.64M; DSA = 6dB, , non-interleave mode, Standby RX 3G : 368.64M. 16 bit Serdes: 25gbps) -> 2 lanes for Rx/FB (lane shared) and 2lanes for Tx		789.5		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			471.3		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			73.4		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			599.3		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			169.6		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			39.1		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			1645.3		mA
P_{diss}	Power Dissipation			4851.9		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7c: TDD 4T4R1FB TX 9G and FB 3G -16bit: 368.64M; DSA = 6dB, , non-interleave mode, 75% on RX 3G : 368.64M. 16 bit 25% on Serdes: 25gbps) -> 2 lanes for Rx/FB (lane shared) and 2lanes for Tx		691.0		mA
I_{VDD1P8}	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			441.2		mA
I_{VDD1P8}	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			74.8		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			291.7		mA
I_{VDD1P2}	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			823.2		mA
I_{VDD1P2}	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			39.0		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2067.9		mA
P_{diss}	Power Dissipation			5418.2		mW

6.9 Power Supply Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS, f_{DAC} = 8847.36MSPS interleave mode; f_{ADC} = 2949.12MSPS; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7d: FDD 4T4R1FB TX 9G and FB 3G -16bit: 368.64M; DSA = 6dB, , non-interleave mode, RX 3G : 368.64M. 16 bit Serdes: 25gbps) -> 2 lanes for Rx/FB (lane shared) and 2lanes for Tx		1283.8		mA
I_{VDD1P8}	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			752.0		mA
I_{VDD1P8}	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			74.6		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			750.5		mA
I_{VDD1P2}	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1077.6		mA
I_{VDD1P2}	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			47.7		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2695.5		mA
P_{diss}	Power Dissipation			8475.5		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 8: same configuration as mode 7, Sleep Mode. SLEEP pin is pull high.		20.3		mA
I_{VDD1P8}	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			292.8		mA
I_{VDD1P8}	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			12.6		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			4.6		mA
I_{VDD1P2}	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			54.3		mA
I_{VDD1P2}	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			15.3		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			313.1		mA
P_{diss}	Power Dissipation			956.8		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 9: 4T4R2F - FDD FB 100% on TX Single Band: 24x Int, FB 12x Dec RX Single Band: RX 24x TX/FB Rate 245.76 Msps RX Rate 122.88 Msps f_{DAC} = 5898.24 MSPS f_{ADC} = 2949.12 MSPS f_{TX} = 0.85 GHz f_{RX} = 0.8 GHz 8/10 coding, 9.8304Gbps TX: 4-8-4-1, FB: 2-4-4-1, RX: 2-8-8-1		1593.2		mA
I_{VDD1P8}	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			840.6		mA
I_{VDD1P8}	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			77.3		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			905.0		mA
I_{VDD1P2}	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			817.7		mA
I_{VDD1P2}	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			52.1		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2405.2		mA
P_{diss}	Power Dissipation			8814.3		mW

6.9 Power Supply Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS, f_{DAC} = 8847.36MSPS interleave mode; f_{ADC} = 2949.12MSPS; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 10: 4T4R2F - FDD FB 100% on TX Single Band: 18x Int, FB 6x Dec RX Single Band: RX 12x TX/FB Rate 491.52 Msps RX Rate 245.76 Msps f_{DAC} = 8847.36 MSPS f_{ADC} = 2949.12 MSPS f_{TX} = 1.85 GHz f_{RX} = 1.75 GHz 8/10 coding, 9.8304Gbps TX: 8-8-2-1, FB: 4-4-2-1, RX: 4-8-4-1		1626.2		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			976.4		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			74.6		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			902.7		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1111.9		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			48.0		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			3578.9		mA
P_{diss}	Power Dissipation			10515.0		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 11a: TDD 4T1FB (RX in Standby) Single Band: 8x Int, FB 2x Dec, RX uses FB TX/FB/RX Rate = 1474.56 Msps f_{DAC} = 11796.48 MSPS f_{ADC} = 2949.12 MSPS f_{TX} = f_{RX} = 8 GHz 64/66 coding, 24.33 Gbps TX: 8-8-2-1, FB/RX: 4-4-4-2		800		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			840		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			73		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			190		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1440		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			75		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			3070		mA
P_{diss}	Power Dissipation			8010		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 11b: TDD 4R (TX in Standby) Single Band: 8x Int, FB 2x Dec, RX uses FB TX/FB/RX Rate = 1474.56 Msps f_{DAC} = 11796.48 MSPS f_{ADC} = 2949.12 MSPS f_{TX} = f_{RX} = 8 GHz 64/66 coding, 24.33 Gbps TX: 8-8-2-1, FB/RX: 4-4-4-2		750		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			890		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			72		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			610		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			280		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			72		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2360		mA
P_{diss}	Power Dissipation			6460		mW

6.9 Power Supply Electrical Characteristics (continued)

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS, f_{DAC} = 8847.36MSPS interleave mode; f_{ADC} = 2949.12MSPS; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 11c: TDD 4T4R1FB average TX/FB: 75%, RX 25% Single Band: 8x Int, FB 2x Dec, RX uses FB TX/FB/RX Rate = 1474.56 Msps f_{DAC} = 11796.48 MSPS f_{ADC} = 2949.12 MSPS f_{TX} = f_{RX} = 8 GHz 64/66 coding, 24.33 Gbps TX: 8-8-2-1, FB/RX: 4-4-4-2		790		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			850		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			73		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			300		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1150		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			75		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			2890		mA
P_{diss}	Power Dissipation			7620		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 11d: FDD 4T4R Single Band: 8x Int, RX uses FB TX/FB/RX Rate = 1474.56 Msps f_{DAC} = 11796.48 MSPS f_{ADC} = 2949.12 MSPS f_{TX} = f_{RX} = 8 GHz 64/66 coding, 24.33 Gbps TX: 8-8-2-1, FB/RX: 4-4-4-2		1260		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			940		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			73		mA
I_{VDD1P2}	Group 2A: VDD1P2FB + VDD1P2RX			630		mA
	Group 2B: VDD1P2TXCLK + VDD1P2TXENC			1480		mA
	Group 2C: VDD1P2FBCML + VDD1P2RXCML + VDD1P2PLLCLKREF			78		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			4200		mA
P_{diss}	Power Dissipation			10640		mW

6.10 Timing Requirements

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS, f_{DAC} = 8847.36MSPS; f_{ADC} = 2949.12MSPS; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

		MIN	NOM	MAX	UNIT
Timing: SYSREF+/-					
$t_{s(SYSREF)}$	Setup Time, SYSREF+/- Valid to Rising Edge of CLK+/-		50		ps
$t_{h(SYSREF)}$	Hold Time, SYSREF+/- Valid after Rising Edge of CLK+/-		50		ps
Timing: Serial ports					
$t_{s(SENB)}$	Setup Time, SENB to Rising Edge of SCLK		15		ns
$t_{h(SENB)}$	Hold Time, SENB after last Rising Edge of SCLK (1)		5 + t_{SCLK}		ns
$t_{s(SDIO)}$	Setup Time, SDIO valid to Rising Edge of SCLK		15		ns
$t_{h(SDIO)}$	Hold Time, SDIO valid after Rising Edge of SCLK		5		ns
$t_{(SCLK)\_W}$	Minimum SCLK period: registers write		25		ns
$t_{(SCLK)\_R}$	Minimum SCLK period: registers read		50		ns
$t_{d(data\_out)}$	Minimum Data Output delay after Falling Edge of SCLK		0		ns
	Maximum Data Output delay after Falling Edge of SCLK		15		ns
t_{RESET}	Minimum RESETZ Pulse Width		1		ms

(1) SDEN\\ need to be held one more extra clock cycle with the last SCLK edge

6.11 Switching Characteristics

Typical values at T_A = +25°C, full temperature range is $T_{A,MIN}$ = -40°C to $T_{J,MAX}$ = +110°C; TX Input Rate = 491.52MSPS, f_{DAC} = 8847.36MSPS; f_{ADC} = 2949.12MSPS; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

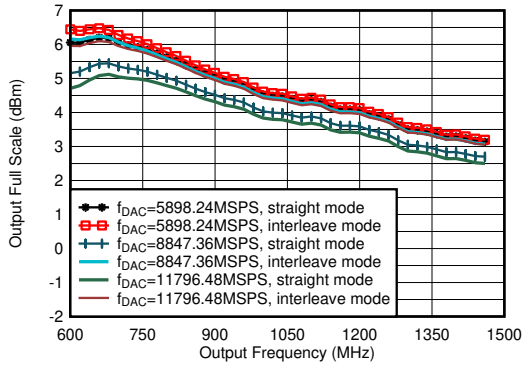
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
TX Channel Latency						
	SerDes Receiver Analog Delay	Full rate		2.8		ns
t_{JESDTX}	JESD to TX output Latency	LMFSHd=2-8-8-1, 368.64 MSPS input rate, 24x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		152		interface clock cycles(1)
		LMFSHd=8-16-4-1, 491.52 MSPS 24x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		176		
		LMFSHd=4-16-8-1, 245.76 MSPS 48x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		124		
		LMFSHd=2-16-16-1, 122.88 MSPS 96x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		97		
RX Channel Latency						
	SerDes Transmitter Analog Delay			3.6		ns
t_{JESDRX}	RX input to JESD output Latency	LMFS=2-16-16-1, 122.88 MSPS, 24x Decimation, Serdes rate = 16.22Gbps (JESD204C)		92		interface clock cycles(1)
		LMFS=4-16-8-1, 245.76 MSPS, 12x Decimation, Serdes rate = 16.22Gbps (JESD204C)		108		
		LMFS=4-8-4-1, 491.52 MSPS, 6x Decimation, Serdes rate = 16.22Gbps (JESD204C)		153		
FB Channel Latency						
	SerDes Transmitter Analog Delay			3.6		ns
t_{JESDFB}	FB input to JESD output Latency	LMFS=1-2-8-1, 368.64 MSPS, 8x Decimation		151		interface clock cycles(1)
		LMFS=2-4-4-1, 491.52 MSPS, 6x Decimation		177		

(1) Interface clock cycles is the period of the digital interface sample rate, e.g. 1GSPS = 1ns.

6.12 Typical Characteristics

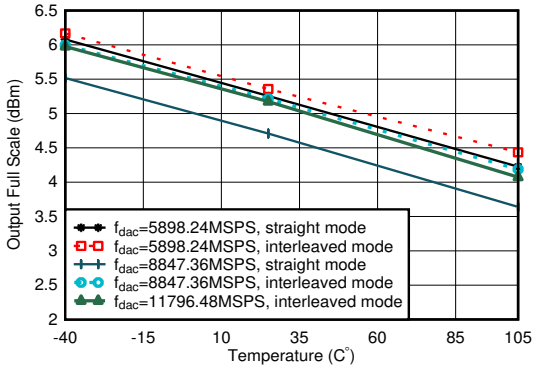
6.12.1 TX Typical Characteristics 800 MHz

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



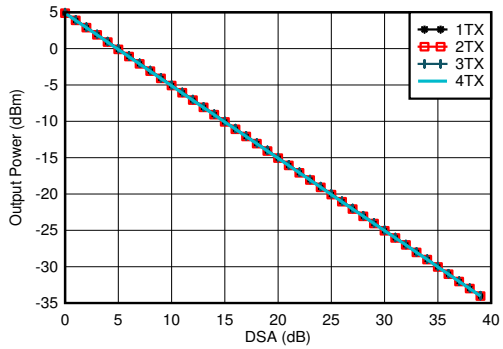
including PCB and cable losses, A_{out} = -0.5dFBS, DSA = 0, 0.8 GHz matching

図 6-1. TX Output Fullscale vs Output Frequency



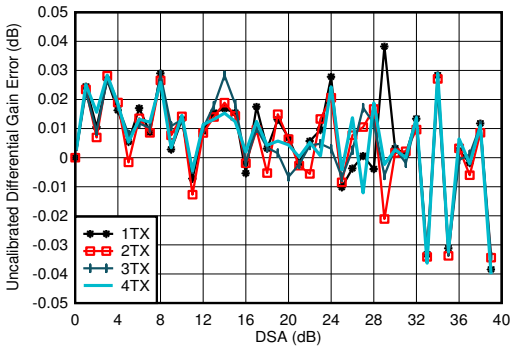
including PCB and cable losses, A_{out} = -0.5dFBS, DSA = 0, 0.8 GHz matching

図 6-2. TX Output Fullscale vs Temperature



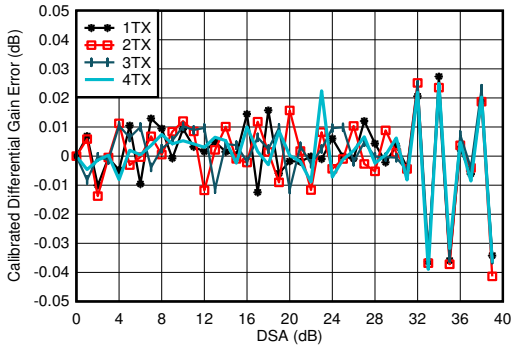
f_{DAC} = 11796.48 MSPS, interleave mode, A_{out} = -0.5dFBS, matching 0.8 GHz

図 6-3. TX Output Power vs DSA Setting and Channel at 0.85 GHz



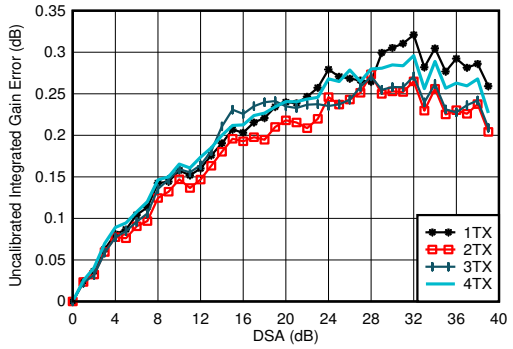
f_{DAC}=5898.24MSPS, interleave mode, matching at 0.8 GHz Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-4. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 0.85 GHz



f_{DAC}=5898.24MSPS, interleave mode, matching at 0.8 GHz Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-5. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 0.85 GHz

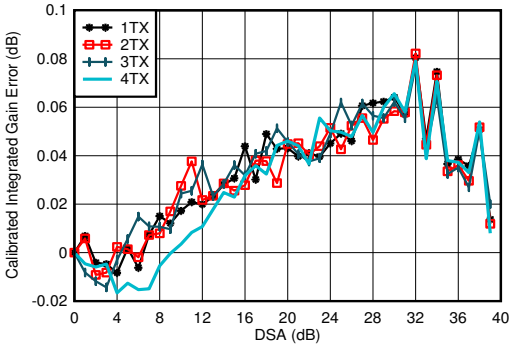


f_{DAC}=5898.24MSPS, interleave mode, matching at 0.8 GHz Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + DSA Settings

図 6-6. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 0.85 GHz

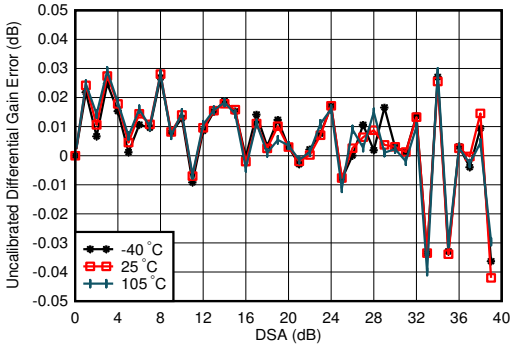
6.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



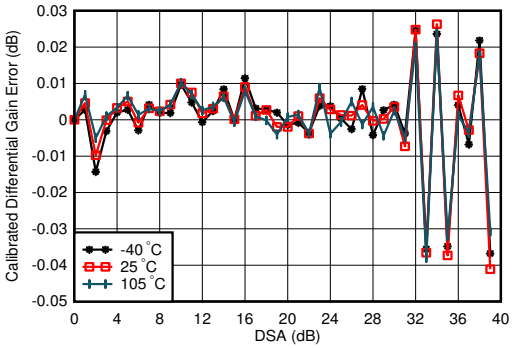
f_{DAC}=5898.24MSPS, interleave mode, matching at 0.8 GHz Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + DSA Setting

図 6-7. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 0.85 GHz



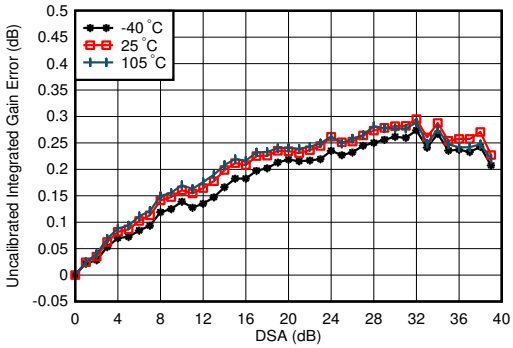
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-8. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 0.85 GHz



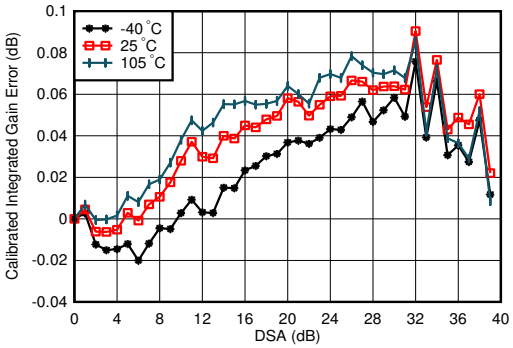
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-9. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 0.85 GHz



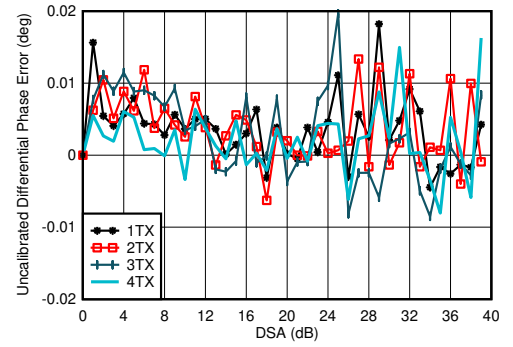
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + DSA Setting

図 6-10. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 0.85 GHz



f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + DSA Setting

図 6-11. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 0.85 GHz

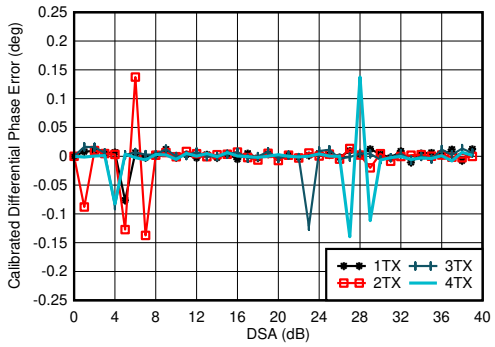


f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-12. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 0.85 GHz

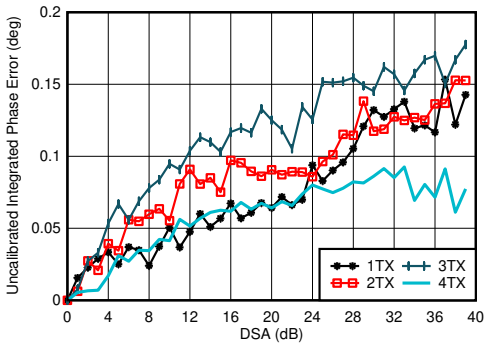
6.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



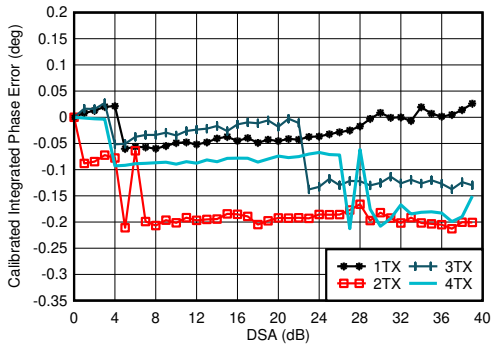
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)
Phase DNL spike may occur at any DSA setting.

図 6-13. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 0.85 GHz



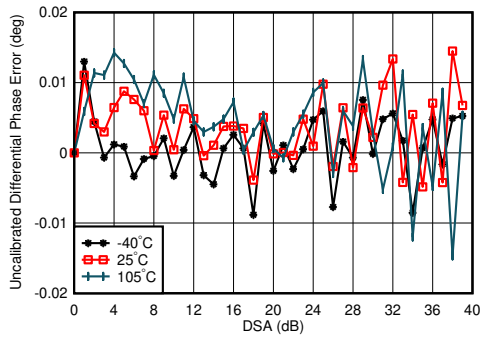
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz
Integrated Phase Error = $Phase_{OUT}$(DSA Setting) – $Phase_{OUT}$(DSA Setting = 0)

図 6-14. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 0.85 GHz



f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz
Integrated Phase Error = $Phase_{OUT}$(DSA Setting) – $Phase_{OUT}$(DSA Setting = 0)

図 6-15. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 0.85 GHz

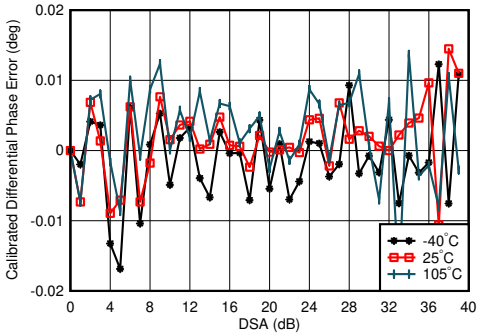


f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting) + 1

図 6-16. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 0.85 GHz

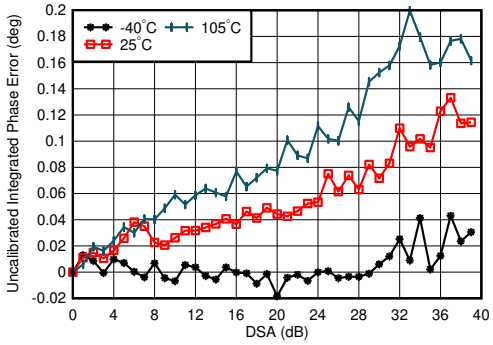
6.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



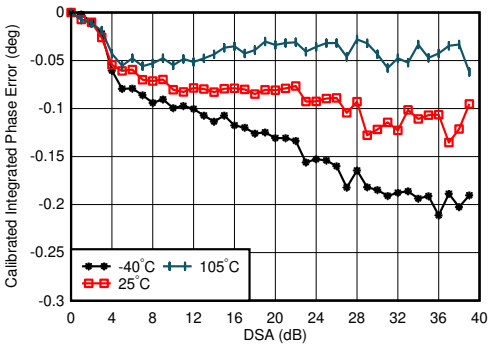
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz, channel with the median variation over DSA setting at 25°C
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting) + 1

図 6-17. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 0.85 GHz



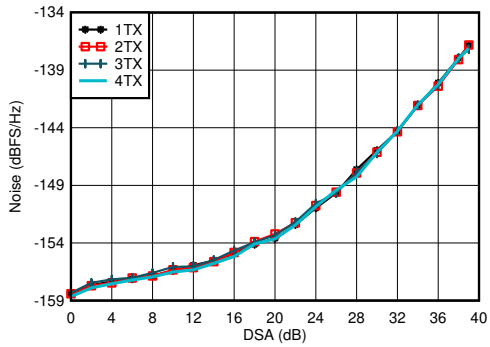
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz
Integrated Phase Error = $Phase_{OUT}$(DSA Setting) – $Phase_{OUT}$(DSA Setting = 0)

図 6-18. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 0.85 GHz



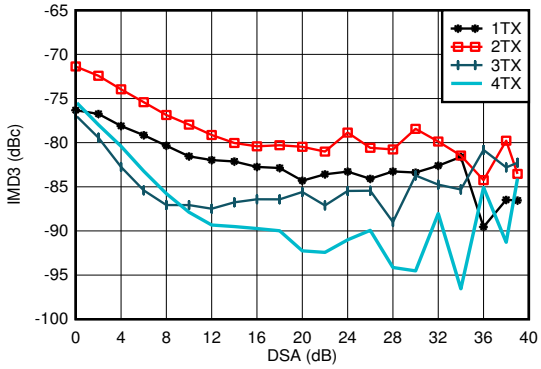
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz
Integrated Phase Error = $Phase_{OUT}$(DSA Setting) – $Phase_{OUT}$(DSA Setting = 0)

図 6-19. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 0.85 GHz



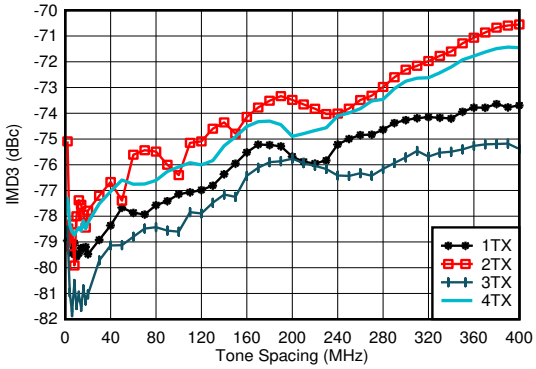
f_{DAC} = 5898.24MSPS, interleave mode, matching at 0.8 GHz, P_{OUT} = –13 dBFS

図 6-20. TX Output Noise vs Channel and Attenuation at 0.85 GHz



f_{DAC} = 11796.48MSPS, interleave mode, f_{CENTER} = 0.85 GHz, matching at 0.8 GHz, –13 dBFS each tone

図 6-21. TX IMD3 vs DSA Setting at 0.85 GHz

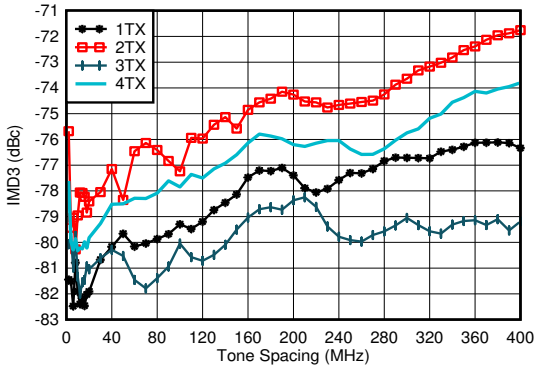


f_{DAC} = 5898.24MSPS, straight mode, f_{CENTER} = 0.85 GHz, matching at 0.8 GHz, –13 dBFS each tone

図 6-22. TX IMD3 vs Tone Spacing and Channel at 0.85 GHz

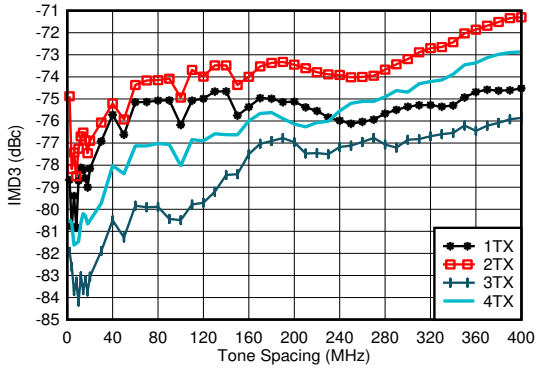
6.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



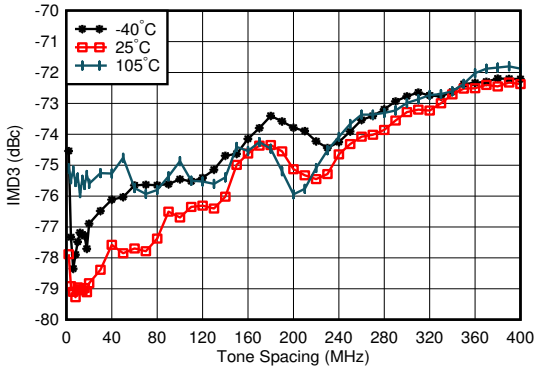
f_{DAC} = 8847.36MSPS, straight mode, f_{CENTER} = 0.85 GHz, matching at 0.8 GHz, –13 dBFS each tone

図 6-23. TX IMD3 vs Tone Spacing and Channel at 0.85 GHz



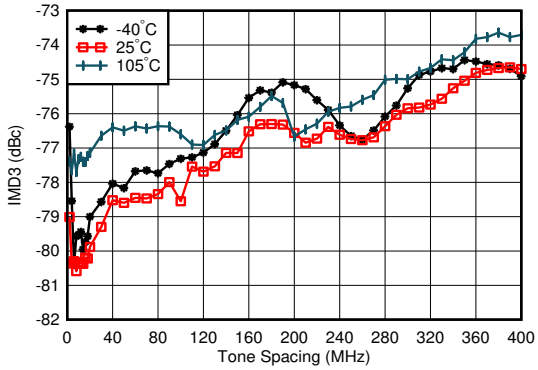
f_{DAC} = 11796.48MSPS, interleave mode, f_{CENTER} = 0.85 GHz, matching at 0.8 GHz, –13 dBFS each tone

図 6-24. TX IMD3 vs Tone Spacing and Channel at 0.85 GHz



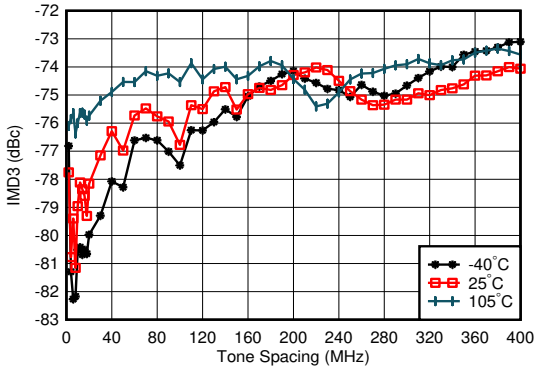
f_{DAC} = 5898.24MSPS, straight mode, f_{CENTER} =0.85 GHz, matching at 0.8 GHz, –13 dBFS each tone, worst channel

図 6-25. TX IMD3 vs Tone Spacing and Temperature at 0.85 GHz



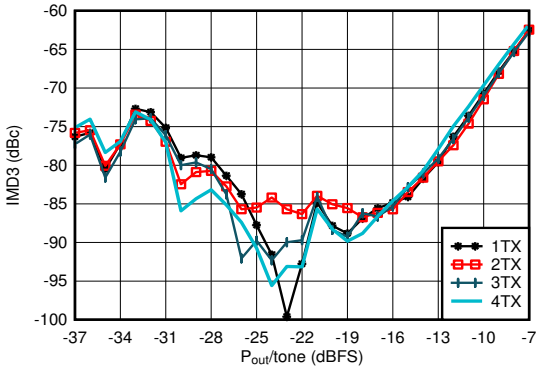
f_{DAC} = 8847.36MSPS, straight mode, f_{CENTER} =0.85 GHz, matching at 0.8 GHz, –13 dBFS each tone, worst channel

図 6-26. TX IMD3 vs Tone Spacing and Temperature at 0.85 GHz



f_{DAC} = 11796.48MSPS, straight mode, f_{CENTER} =0.85 GHz, matching at 0.8 GHz, –13 dBFS each tone, worst channel

図 6-27. TX IMD3 vs Tone Spacing and Temperature at 0.85 GHz

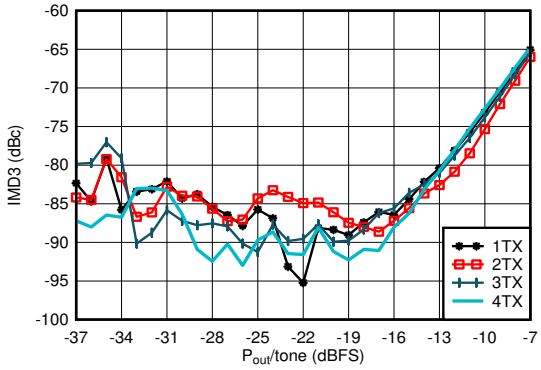


f_{DAC} = 5898.24MSPS, straight mode, f_{CENTER} = 0.85 GHz, $f_{SPACING}$ = 20 MHz, matching at 0.8 GHz

図 6-28. TX IMD3 vs Digital Level at 0.85 GHz

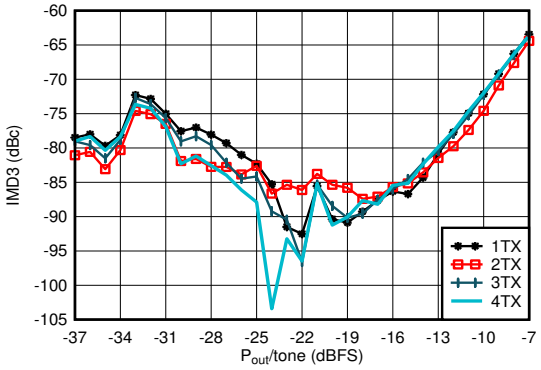
6.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



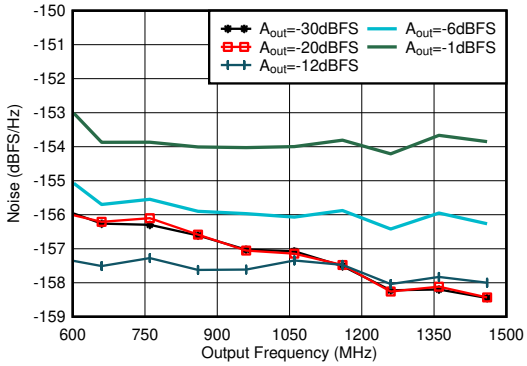
f_{DAC} = 8847.36MSPS, straight mode, f_{CENTER} = 0.85 GHz, $f_{SPACING}$ = 20 MHz, matching at 0.8 GHz

図 6-29. TX IMD3 vs Digital Level at 0.85 GHz



f_{DAC} = 11796.48MSPS, interleave mode, f_{CENTER} = 0.85 GHz, $f_{SPACING}$ = 20 MHz, matching at 0.8 GHz

図 6-30. TX IMD3 vs Digital Level at 0.85 GHz

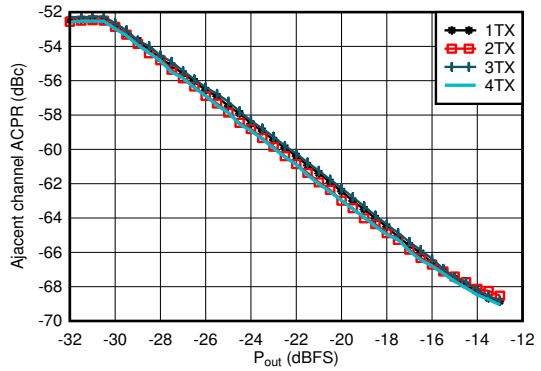


Matching at 2.6 GHz, Single tone, f_{DAC} = 11.79648GSPS, interleave mode, 40-MHz offset, DSA = 0dB

図 6-31. TX Single Tone Output Noise vs Frequency and Amplitude at 0.85 GHz

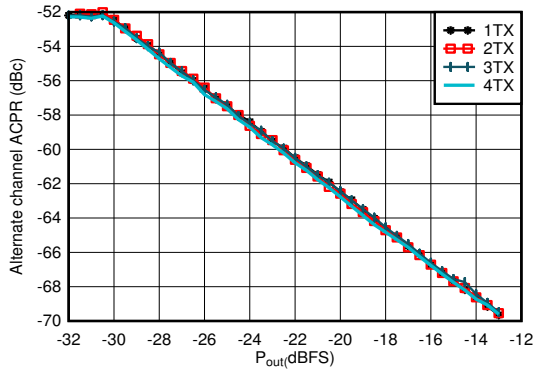
TM1.1, P_{OUT_RMS} = –13 dBFS

図 6-32. TX 20-MHz LTE Output Spectrum at 0.85 GHz



Matching at 0.8 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-33. TX 20-MHz LTE ACPR vs Digital Level at 0.85 GHz

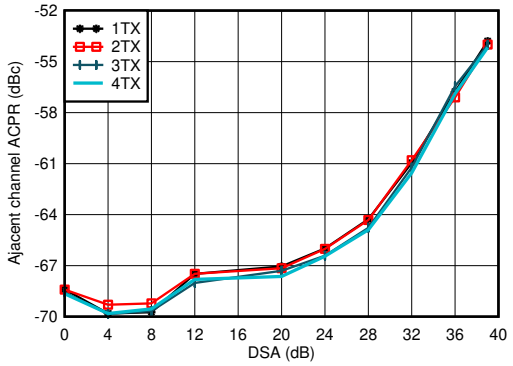


Matching at 0.8 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-34. TX 20-MHz LTE alt-ACPR vs Digital Level at 0.85 GHz

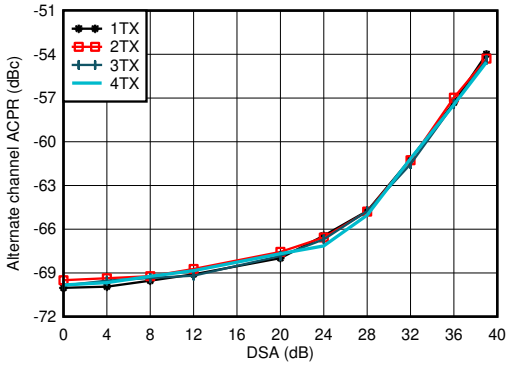
6.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



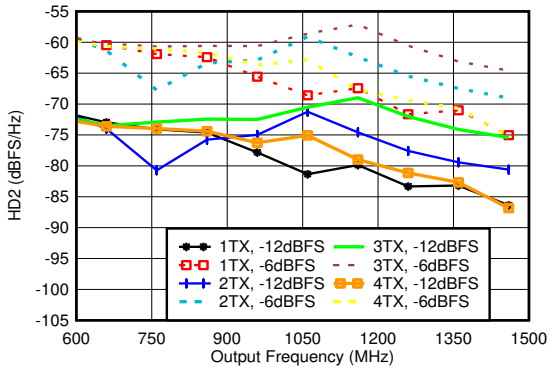
Matching at 0.8 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-35. TX 20-MHz LTE ACPR vs DSA at 0.85 GHz



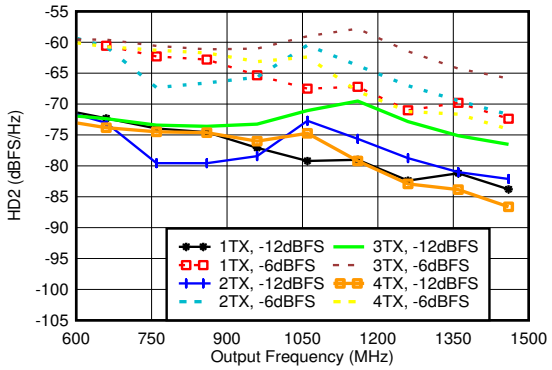
Matching at 0.8 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-36. TX 20-MHz LTE alt-ACPR vs DSA at 0.85 GHz



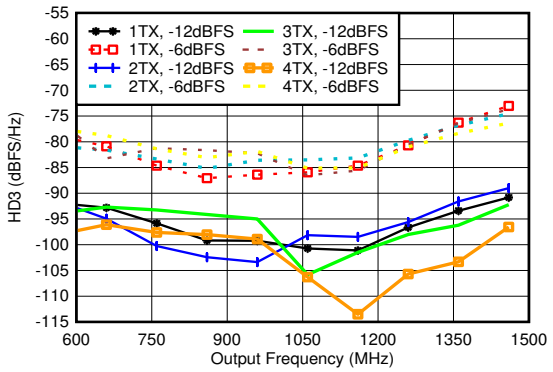
Matching at 0.8 GHz, f_{DAC} = 5898.24GSPS, straight mode

図 6-37. TX HD2 vs Digital Amplitude and Output Frequency at 0.85 GHz



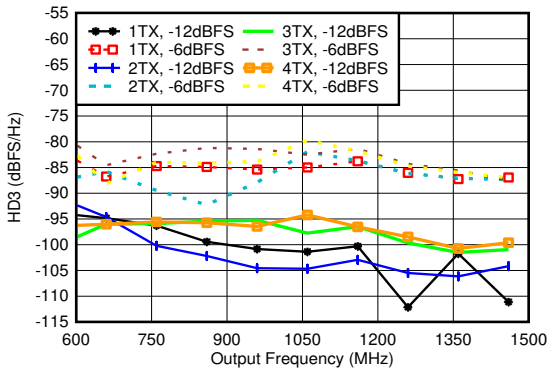
Matching at 0.8 GHz, f_{DAC} = 8847.36GSPS, straight mode

図 6-38. TX HD2 vs Digital Amplitude and Output Frequency at 0.85 GHz



Matching at 0.8 GHz, f_{DAC} = 5898.24MSPS, straight mode, normalized to output power at harmonic frequency

図 6-39. TX HD3 vs Digital Amplitude and Output Frequency at 0.85 GHz

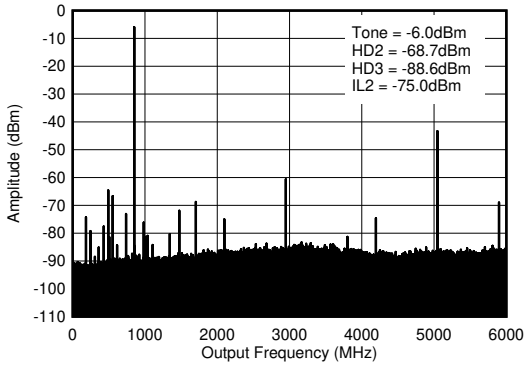


Matching at 0.8 GHz, f_{DAC} = 8847.36MSPS, straight mode, normalized to output power at harmonic frequency

図 6-40. TX HD3 vs Digital Amplitude and Output Frequency at 0.85 GHz

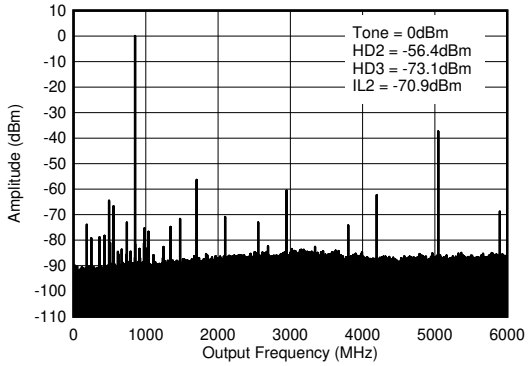
6.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



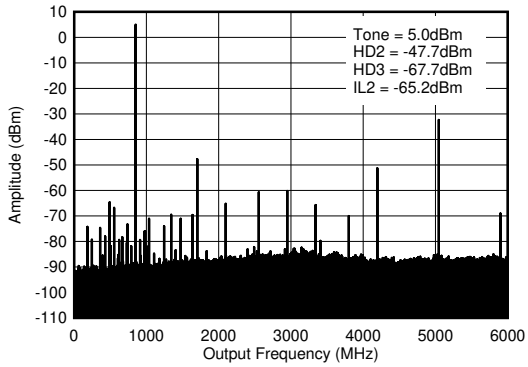
f_{DAC} = 5898.24MSPS, interleave mode, 0.8 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$.

図 6-41. TX Single Tone (–12 dBFS) Output Spectrum at 0.85 GHz (0-f_{DAC})



f_{DAC} = 5898.24MSPS, interleave mode, 0.8 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$.

図 6-42. TX Single Tone (–6 dBFS) Output Spectrum at 0.85 GHz (0-f_{DAC})

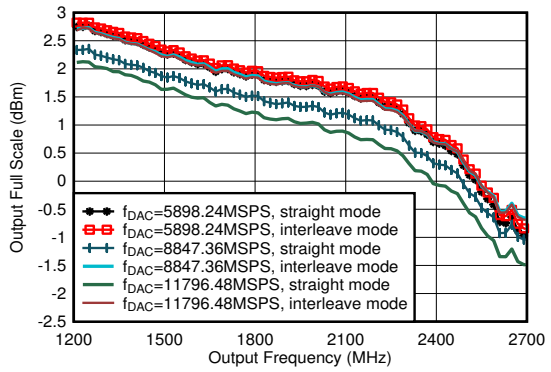


f_{DAC} = 5898.24MSPS, interleave mode, 0.8 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$.

図 6-43. TX Single Tone (–1 dBFS) Output Spectrum at 0.85 GHz (0-f_{DAC})

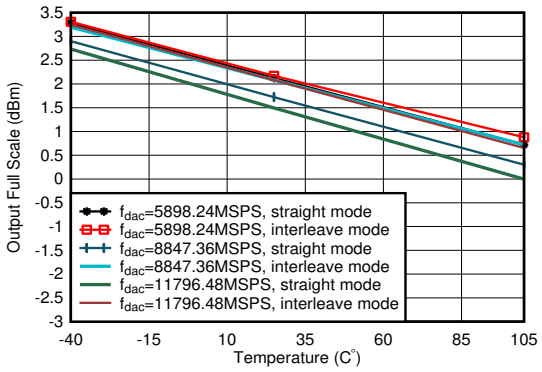
6.12.2 TX Typical Characteristics at 1.8 GHz

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



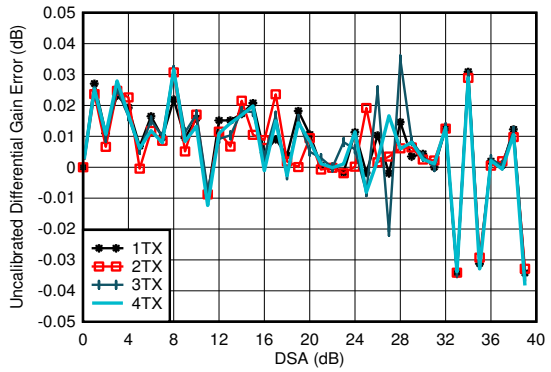
including PCB and cable losses, A_{out} = -0.5dFBS, DSA = 0, 1.8 GHz matching

図 6-44. TX Output Fullscale vs Output Frequency



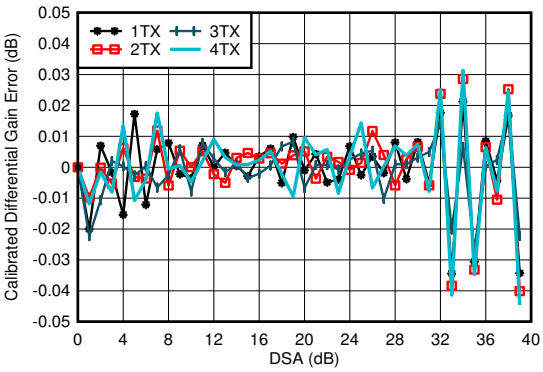
A_{out} = -0.5dFBS, matching 1.8 GHz

図 6-45. TX Output Power vs Temperature at 1.8 GHz



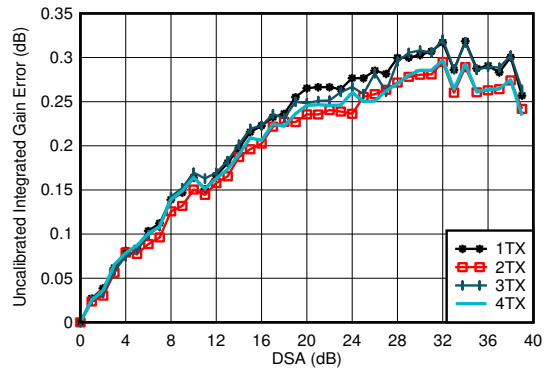
f_{DAC}=5898.24MSPS, interleave mode, matching at 1.8 GHz Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-46. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 1.8 GHz



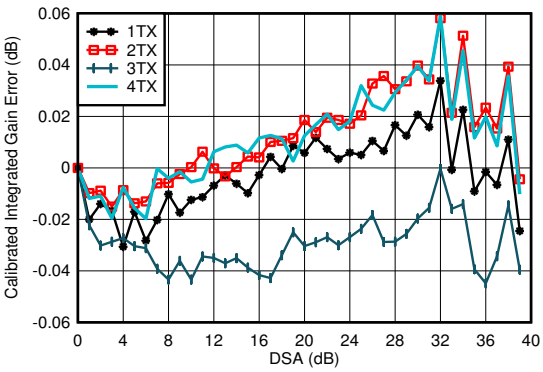
f_{DAC}=5898.24MSPS, interleave mode, matching at 1.8 GHz Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-47. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 1.8 GHz



f_{DAC}=5898.24MSPS, interleave mode, matching at 1.8 GHz Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-48. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 1.8 GHz

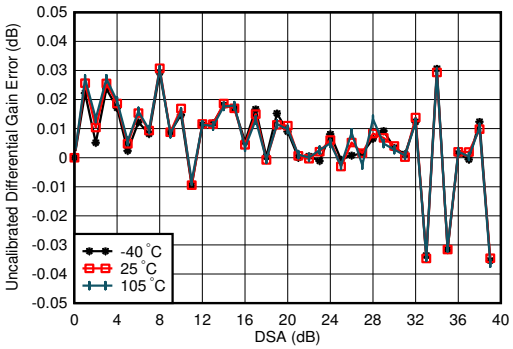


f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-49. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 1.8 GHz

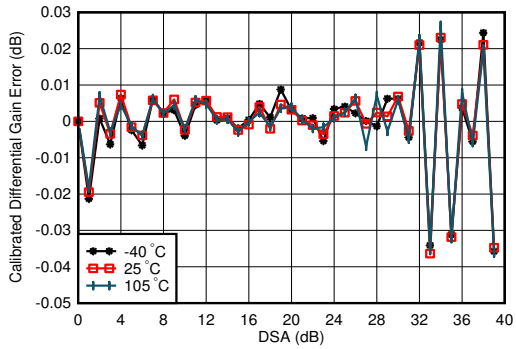
6.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



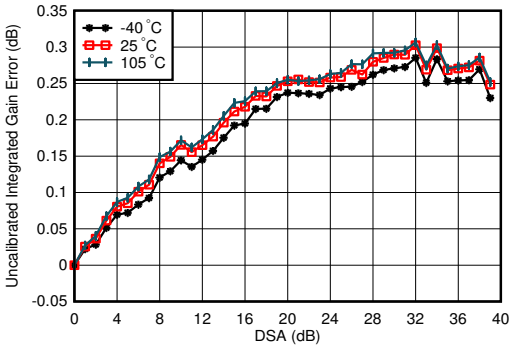
f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-50. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 1.8 GHz



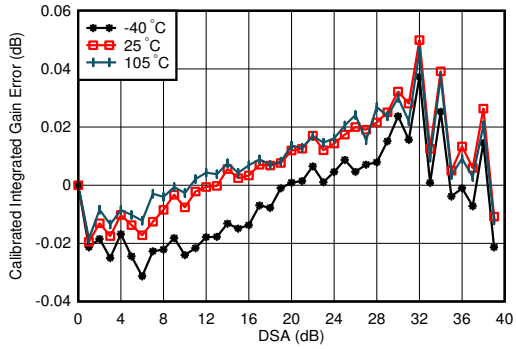
f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-51. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 1.8 GHz



f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-52. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 1.8 GHz

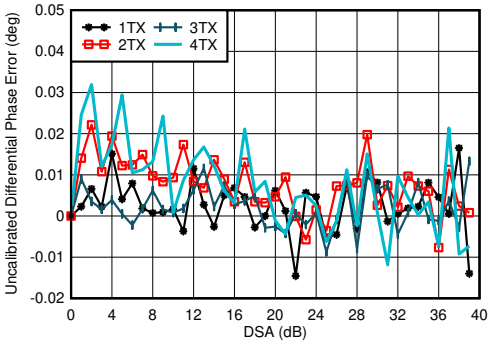


f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-53. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 1.8 GHz

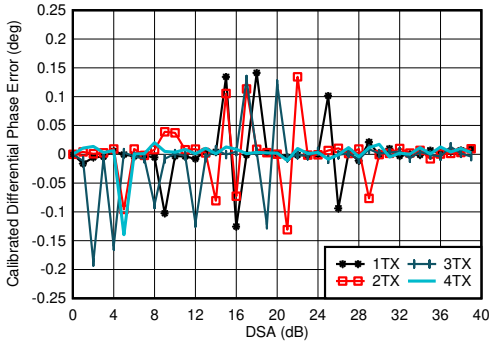
6.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



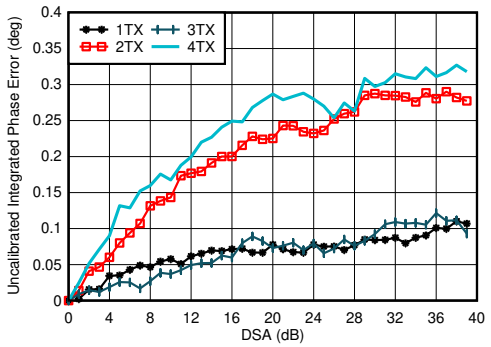
f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-54. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 1.8 GHz



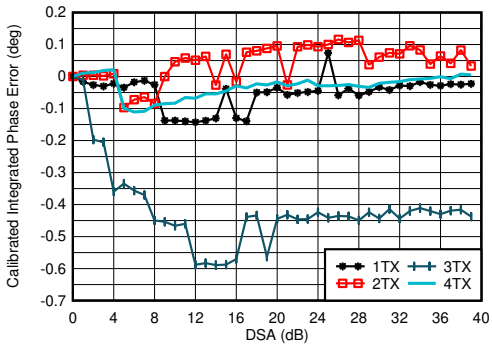
f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)
Phase DNL spike may occur at any DSA setting.

図 6-55. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 1.8 GHz



f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-56. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 1.8 GHz

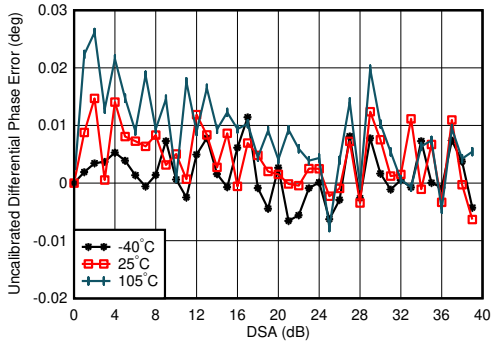


f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-57. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 1.8 GHz

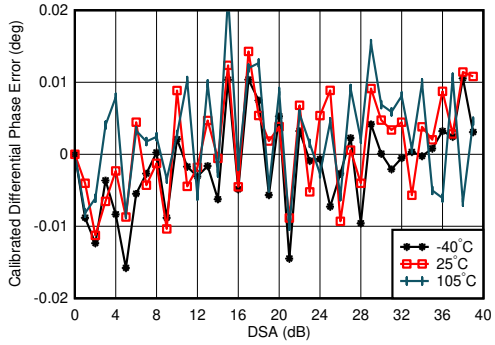
6.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



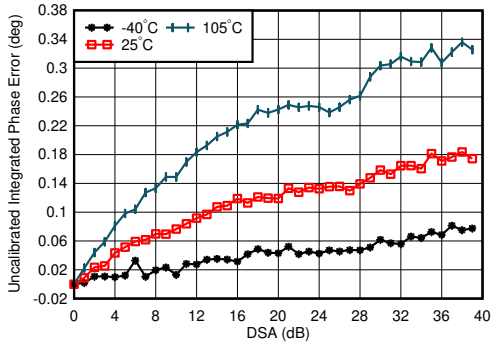
f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-58. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 1.8 GHz



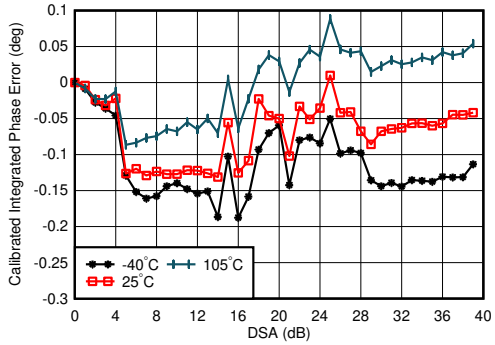
f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz, channel with the median variation over DSA setting at 25°C
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-59. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 1.8 GHz



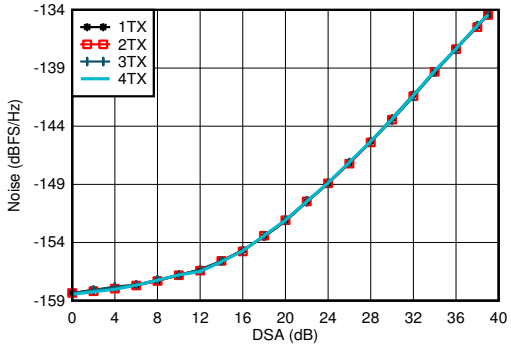
f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz, channel with the median variation over DSA setting at 25°C
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-60. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 1.8 GHz



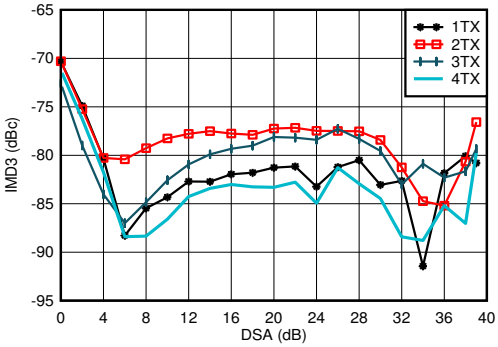
f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz, channel with the median variation over DSA setting at 25°C
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-61. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 1.8 GHz



f_{DAC} = 5898.24MSPS, interleave mode, matching at 1.8 GHz, P_{OUT} = –13 dBFS

図 6-62. TX Output Noise vs Channel and Attenuation at 1.8 GHz

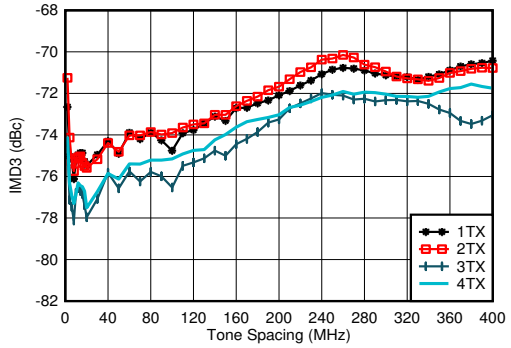


f_{DAC} = 11796.48MSPS, interleave mode, f_{CENTER} = 1.8 GHz, matching at 1.8 GHz, –13 dBFS each tone

図 6-63. TX IMD3 vs DSA Setting at 1.8 GHz

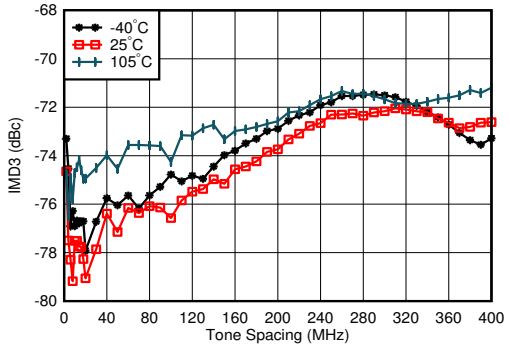
6.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



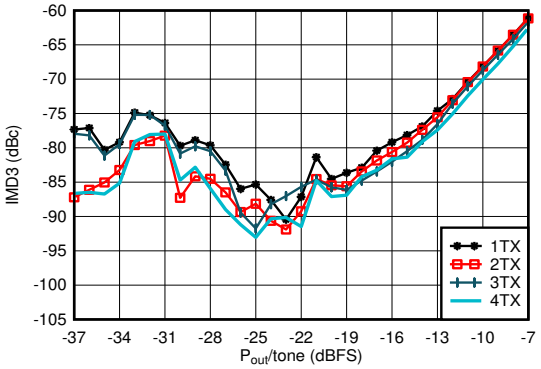
f_{DAC} = 11796.48MSPS, interleave mode, f_{CENTER} = 1.8 GHz, matching at 1.8 GHz, –13 dBFS each tone

図 6-64. TX IMD3 vs Tone Spacing and Channel at 1.8 GHz



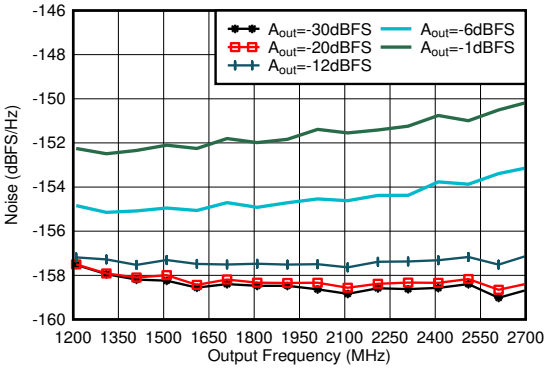
f_{DAC} = 11796.48MSPS, interleave mode, f_{CENTER} = 1.8 GHz, matching at 1.8 GHz, –13 dBFS each tone, worst channel

図 6-65. TX IMD3 vs Tone Spacing and Temperature at 1.8 GHz



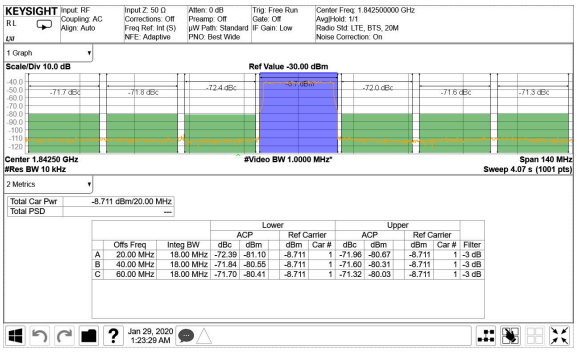
f_{DAC} = 11796.48MSPS, interleave mode, f_{CENTER} = 1.8 GHz, $f_{SPACING}$ = 20 MHz, matching at 1.8 GHz

図 6-66. TX IMD3 vs Digital Level at 1.8 GHz



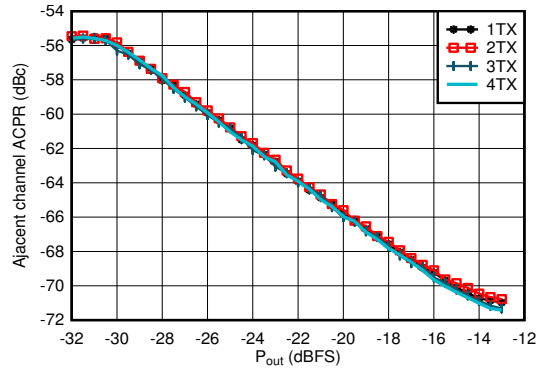
Matching at 2.6 GHz, Single tone, f_{DAC} = 11.79648GSPS, interleave mode, 40-MHz offset

図 6-67. TX Single Tone Output Noise vs Frequency and Amplitude at 1.8 GHz



TM1.1, P_{OUT_RMS} = –13 dBFS

図 6-68. TX 20-MHz LTE Output Spectrum at 1.8425 GHz

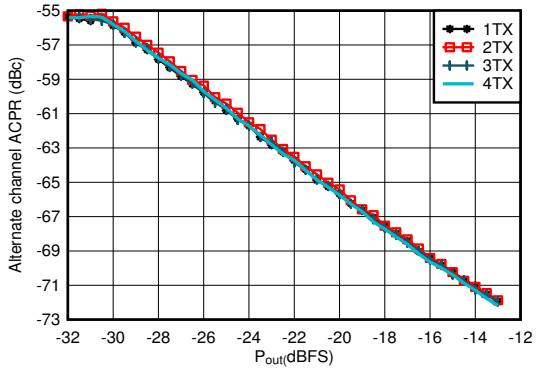


Matching at 1.8 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-69. TX 20-MHz LTE ACPR vs Digital Level at 1.8425 GHz

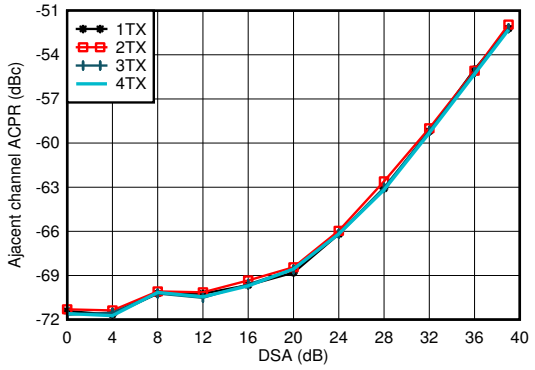
6.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



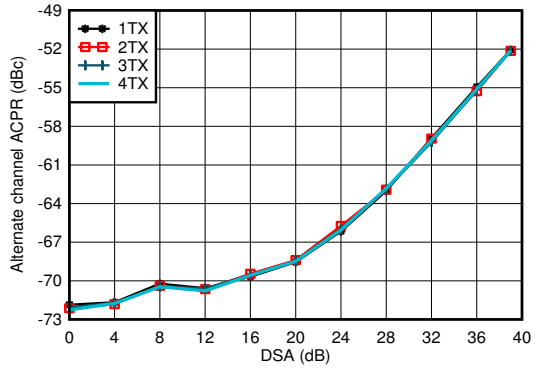
Matching at 1.8 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-70. TX 20-MHz LTE alt-ACPR vs Digital Level at 1.8425 GHz



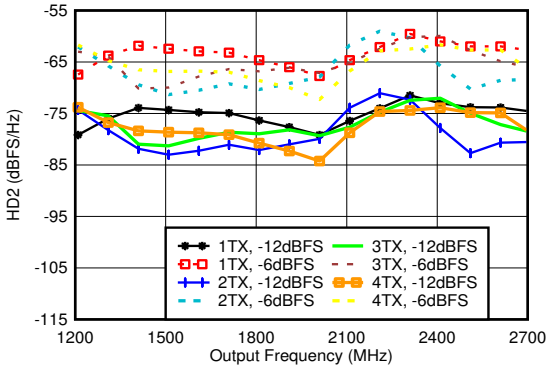
Matching at 1.8 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-71. TX 20-MHz LTE ACPR vs DSA at 1.8 GHz



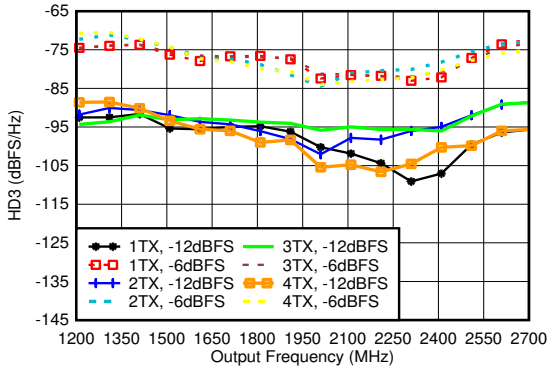
Matching at 1.8 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-72. TX 20-MHz LTE alt-ACPR vs DSA at 1.8 GHz



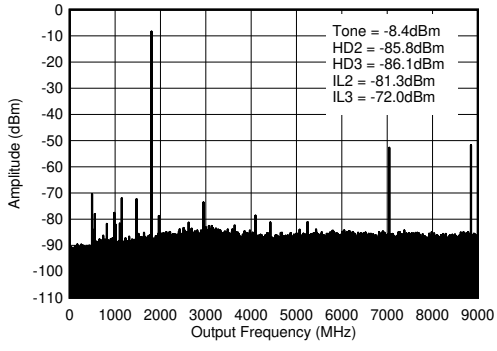
Matching at 1.8 GHz, f_{DAC} = 11.79648GSPS, interleave mode, normalized to output power at harmonic frequency

図 6-73. TX HD2 vs Digital Amplitude and Output Frequency at 1.8 GHz



Matching at 1.8 GHz, f_{DAC} = 11.79648GSPS, interleave mode, normalized to output power at harmonic frequency

図 6-74. TX HD3 vs Digital Amplitude and Output Frequency at 1.8 GHz

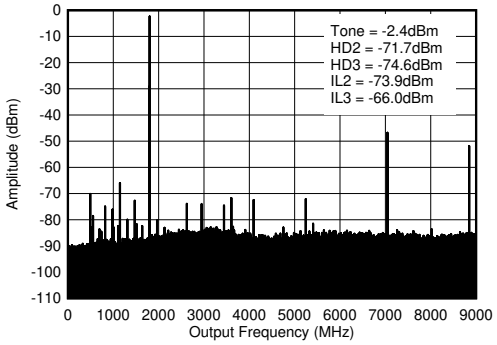


f_{DAC} = 8847.36MSPS, straight mode, 1.8 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

図 6-75. TX Single Tone (–12 dBFS) Output Spectrum at 1.8 GHz (0-f_{DAC})

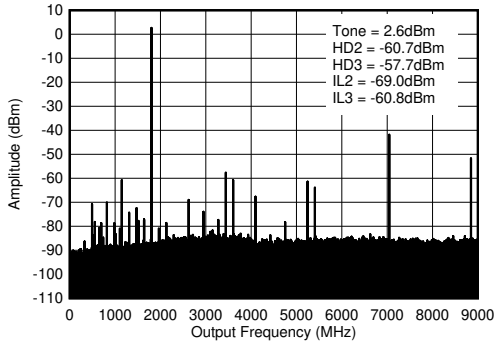
6.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



f_{DAC} = 8847.36MSPS, straight mode, 1.8 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

図 6-76. TX Single Tone (–6 dBFS) Output Spectrum at 1.8 GHz (0-f_{DAC})

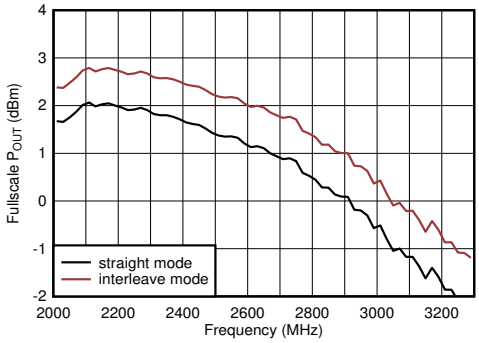


f_{DAC} = 8847.36MSPS, straight mode, 1.8 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

図 6-77. TX Single Tone (–1 dBFS) Output Spectrum at 1.8 GHz (0-f_{DAC})

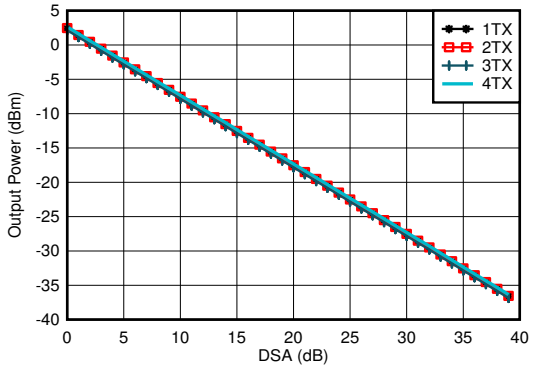
6.12.3 TX Typical Characteristics at 2.6 GHz

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



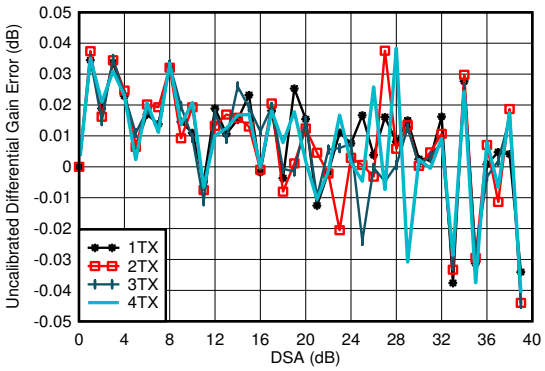
Including PCB and cable losses, A_{out} = -0.5dBFS, DSA = 0, 2.6 GHz matching

図 6-78. TX Full Scale vs RF Frequency at 11796.48MSPS



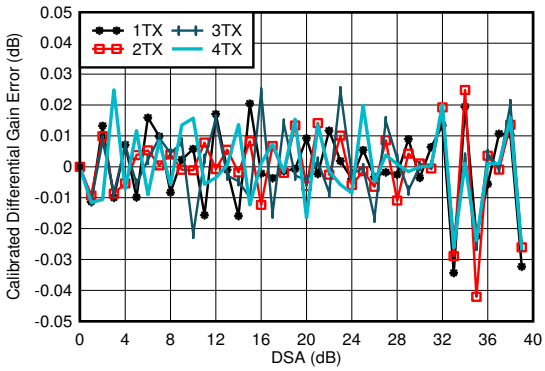
f_{DAC} = 8847.36 MSPS, A_{out} = -0.5dBFS, matching 2.6 GHz

図 6-79. TX Output Power vs DSA Setting and Channel at 2.6 GHz



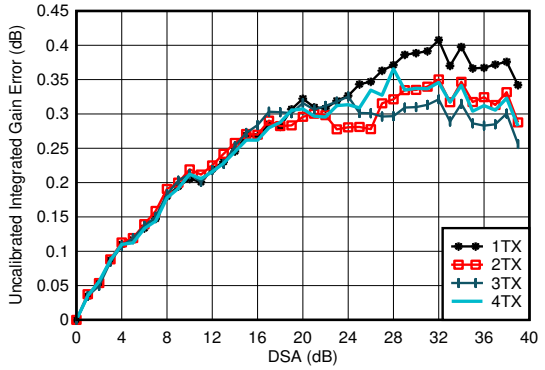
f_{DAC}=8847.36MSPS, straight mode, matching at 2.6 GHz
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-80. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 2.6 GHz



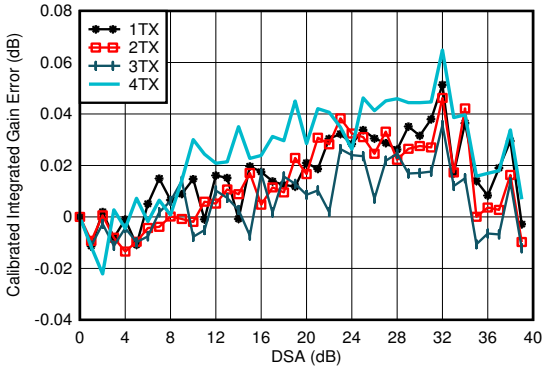
f_{DAC}=8847.36MSPS, straight mode, matching at 2.6 GHz
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-81. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 2.6 GHz



f_{DAC}=8847.36MSPS, straight mode, matching at 2.6 GHz
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-82. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 2.6 GHz

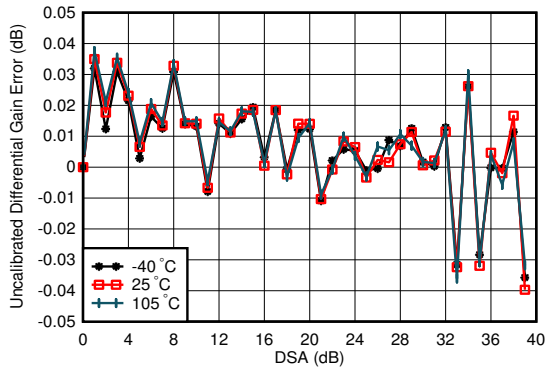


f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-83. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 2.6 GHz

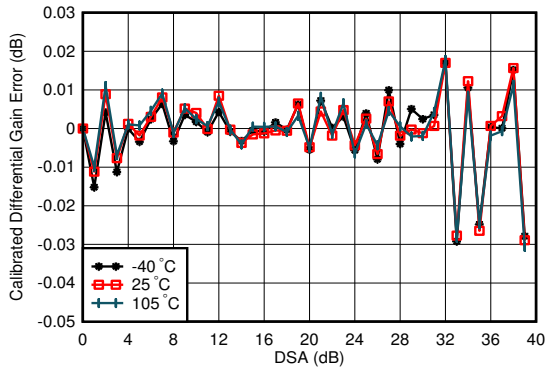
6.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



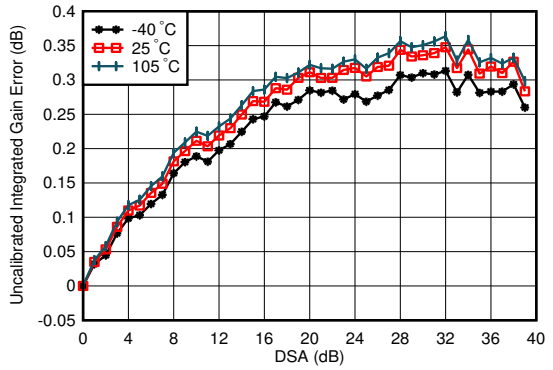
f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-84. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 2.6 GHz



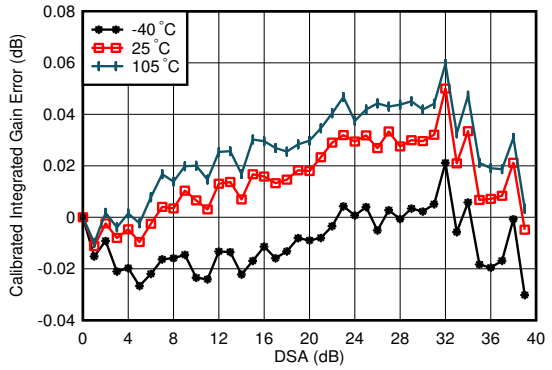
f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-85. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 2.6 GHz



f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-86. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 2.6 GHz

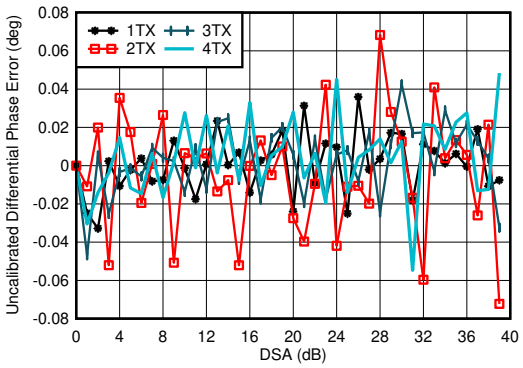


f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-87. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 2.6 GHz

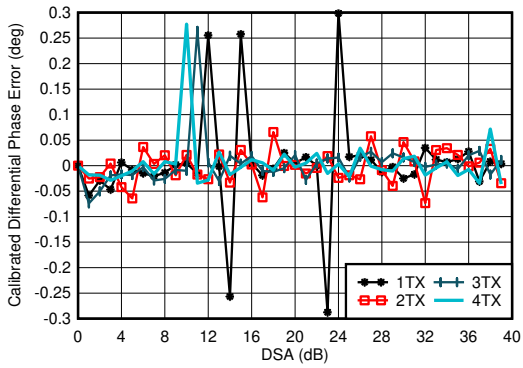
6.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



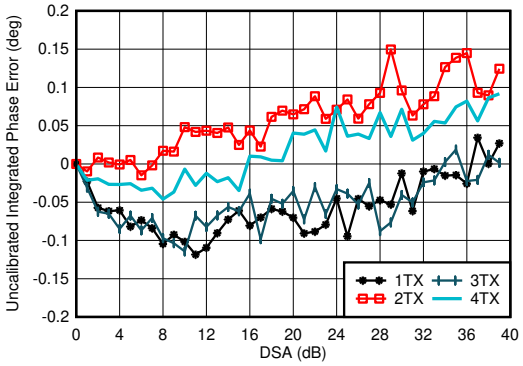
f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-88. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 2.6 GHz



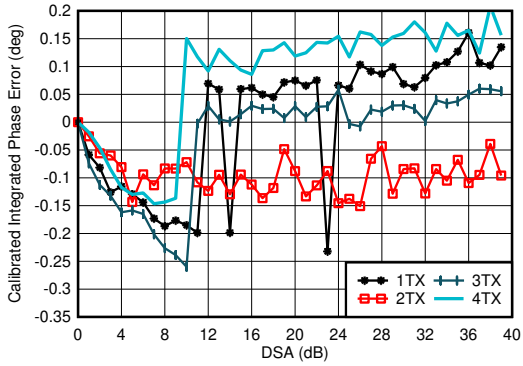
f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz
Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)
Phase DNL spike may occur at any DSA setting.

図 6-89. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 2.6 GHz



f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-90. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 2.6 GHz

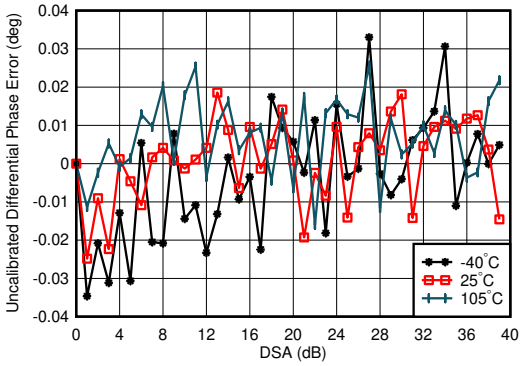


f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-91. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 2.6 GHz

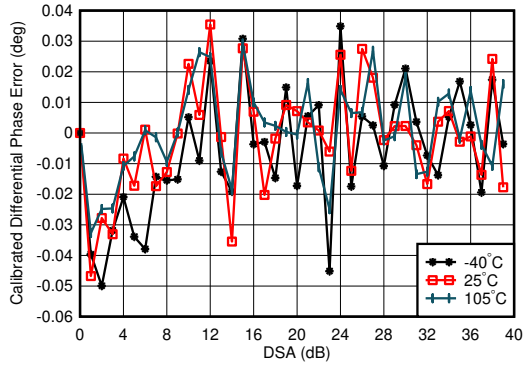
6.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



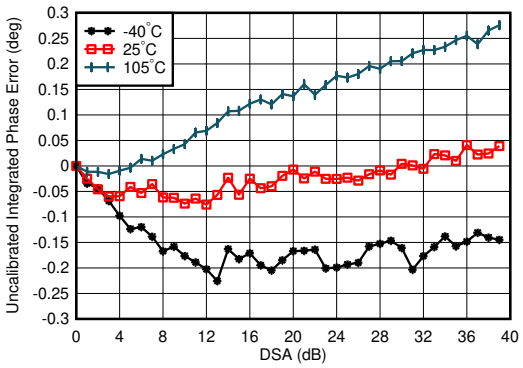
f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-92. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 2.6 GHz



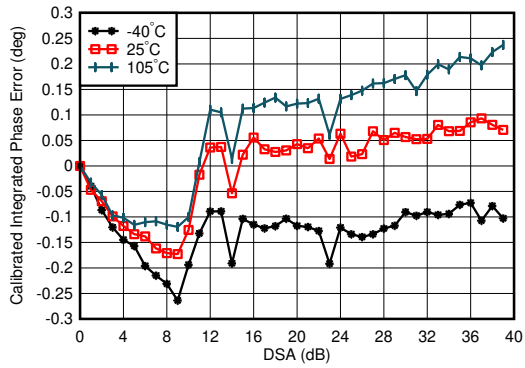
f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-93. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 2.6 GHz



f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, channel with the medium variation over DSA setting at 25°C Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-94. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 2.6 GHz

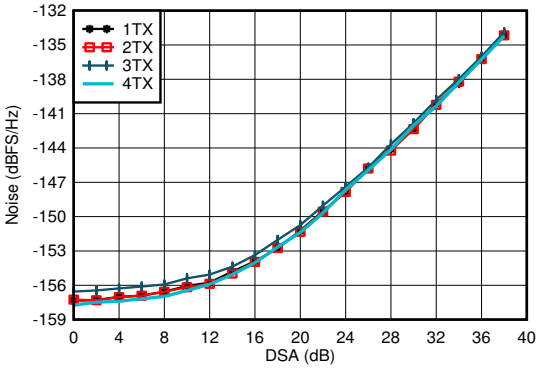


f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-95. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 2.6 GHz

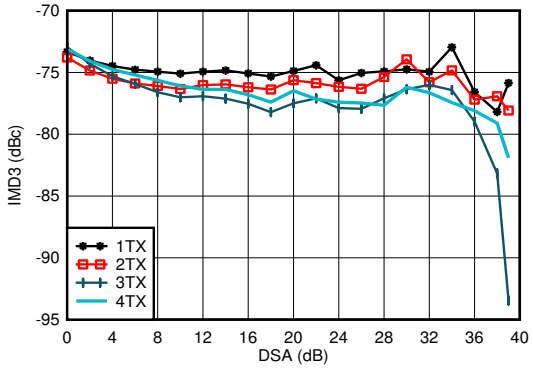
6.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



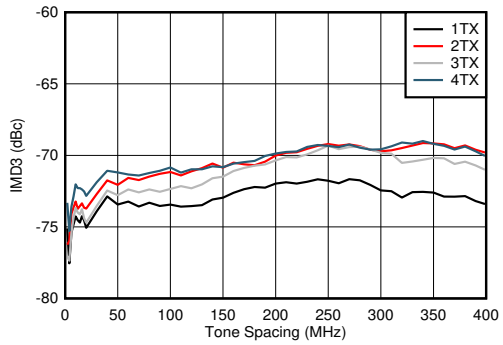
f_{DAC} = 8847.36MSPS, straight mode, matching at 2.6 GHz, P_{OUT} = –13 dBFS

図 6-96. TX Output Noise vs Channel and Attenuation at 2.6 GHz



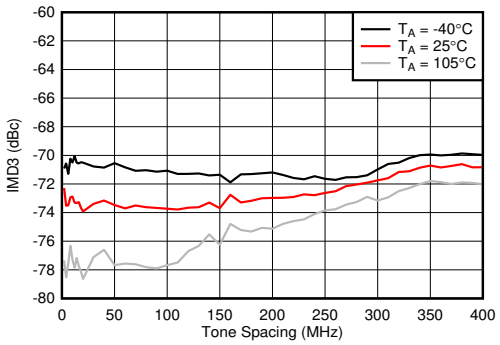
f_{DAC} = 8847.36MSPS, straight mode, f_{CENTER} = 2.6 GHz, matching at 2.6 GHz, –13 dBFS each tone

図 6-97. TX IMD3 vs DSA Setting at 2.6 GHz



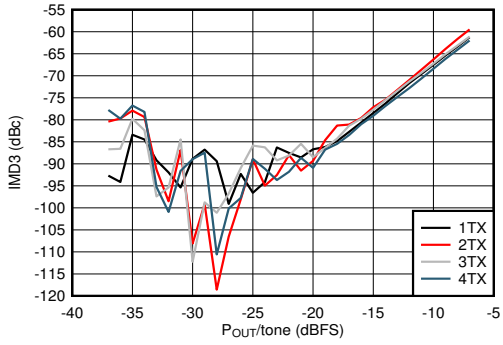
f_{DAC} = 8847.36MSPS, straight mode, f_{CENTER} = 2.6 GHz, matching at 2.6 GHz, –13 dBFS each tone

図 6-98. TX IMD3 vs Tone Spacing and Channel at 2.6 GHz



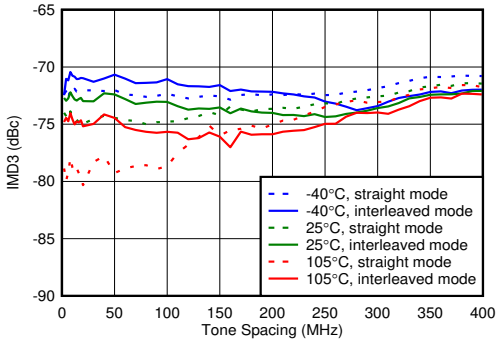
f_{DAC} = 8847.36MSPS, straight mode, f_{CENTER} = 2.6 GHz, matching at 2.6 GHz, –13 dBFS each tone, worst channel.

図 6-99. TX IMD3 vs Tone Spacing and Temperature at 2.6 GHz



f_{DAC} = 8847.36MSPS, straight mode, f_{CENTER} = 2.6 GHz, $f_{SPACING}$ = 20 MHz, matching at 2.6 GHz

図 6-100. TX IMD3 vs Digital Level at 2.6 GHz

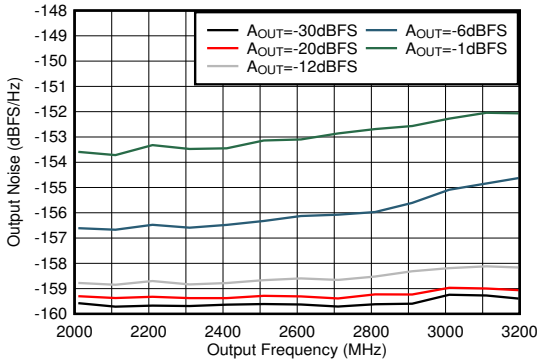


f_{DAC} = 8847.36MSPS, straight mode, f_{CENTER} = 2.6 GHz, matching at 2.6 GHz, –13 dBFS each tone

図 6-101. TX IMD3 vs Tone Spacing and Temperature

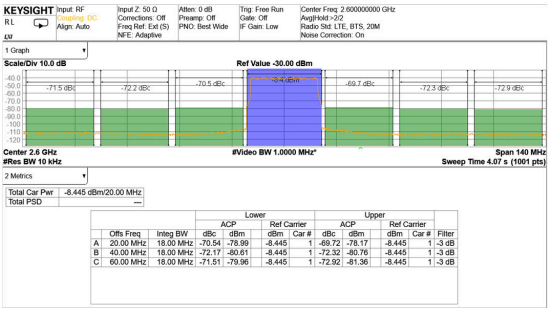
6.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



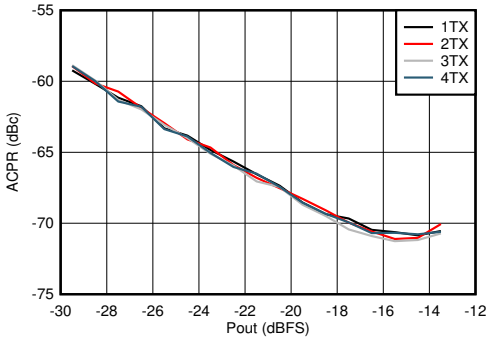
Matching at 2.6 GHz, Single tone, f_{DAC} = 11.79648GSPS, interleave mode, 40-MHz offset

図 6-102. TX Single Tone Output Noise vs Frequency and Amplitude at 2.6 GHz



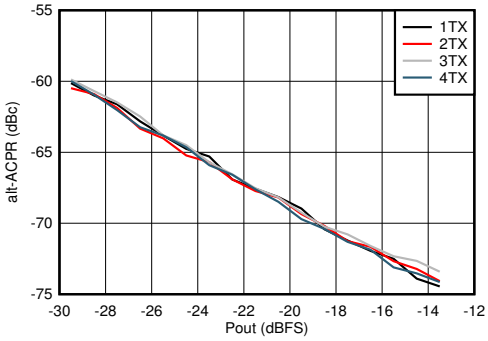
TM1.1, P_{OUT_RMS} = –13 dBFS

図 6-103. TX 20-MHz LTE Output Spectrum at 2.6 GHz (Band 41)



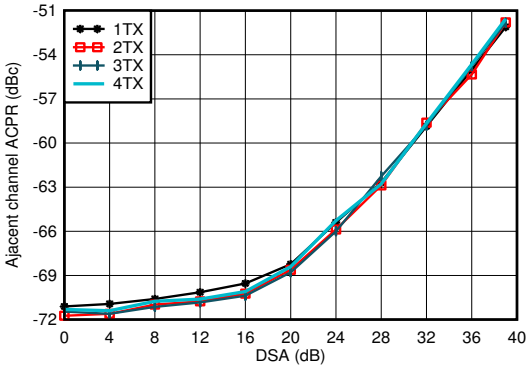
Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-104. TX 20-MHz LTE ACPR vs Digital Level at 2.6 GHz



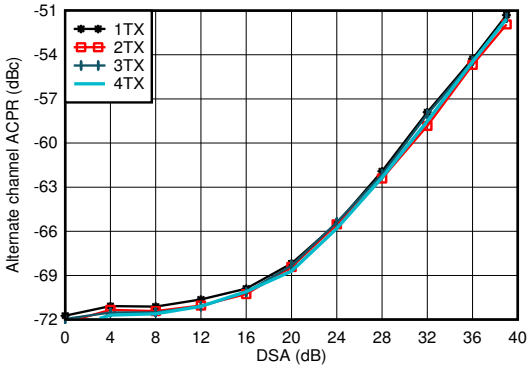
Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-105. TX 20-MHz LTE alt-ACPR vs Digital Level at 2.6 GHz



Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-106. TX 20-MHz LTE ACPR vs DSA at 2.6 GHz

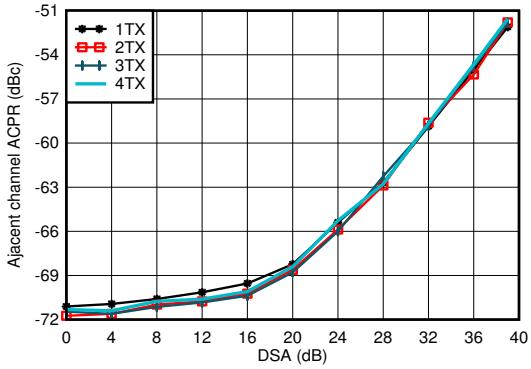


Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-107. TX 20-MHz LTE alt-ACPR vs DSA at 2.6 GHz

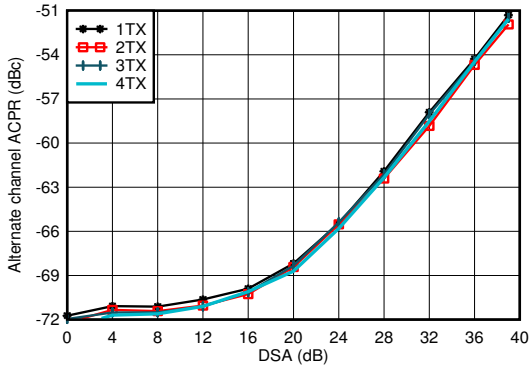
6.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



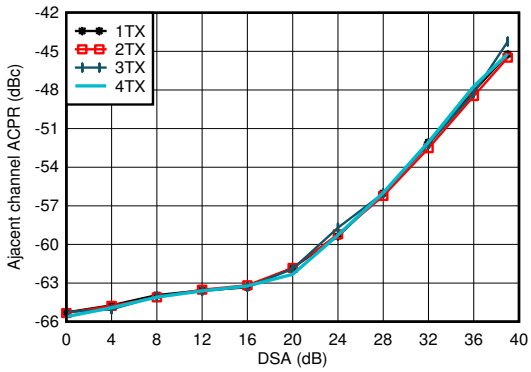
Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-108. TX 20-MHz LTE ACPR vs DSA at 2.6 GHz



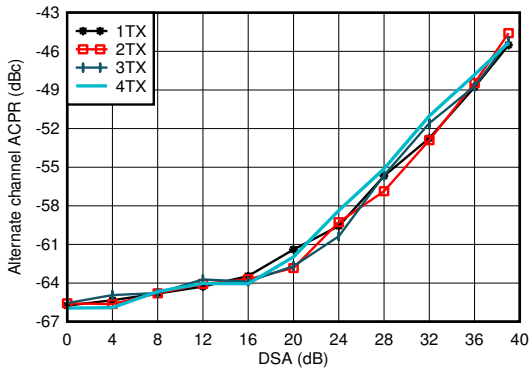
Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-109. TX 20-MHz LTE alt-ACPR vs DSA at 2.6 GHz



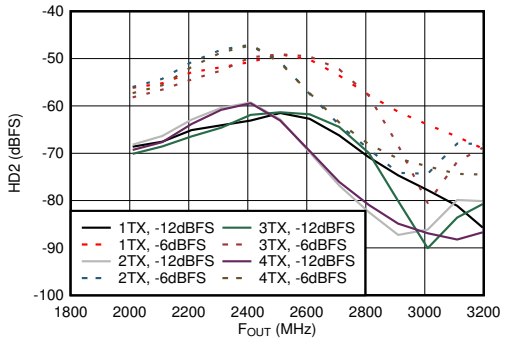
Matching at 2.6 GHz, single carrier 100-MHz BW TM1.1 NR

図 6-110. TX 100-MHz NR ACPR vs DSA at 2.6 GHz



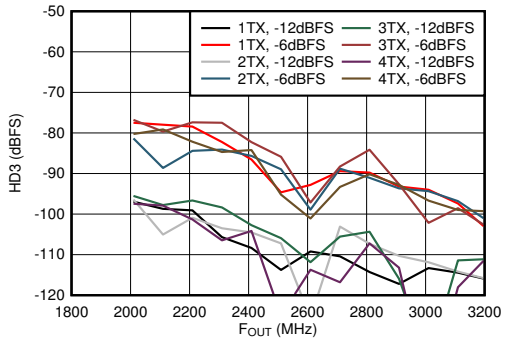
Matching at 2.6 GHz, single carrier 100-MHz BW TM1.1 NR

図 6-111. TX 100-MHz NR alt-ACPR vs DSA at 2.6 GHz



Matching at 2.6 GHz, f_{DAC} = 11.79648GSPS, interleave mode, normalized to output power at harmonic frequency

図 6-112. TX HD2 vs Digital Amplitude and Output Frequency at 2.6 GHz

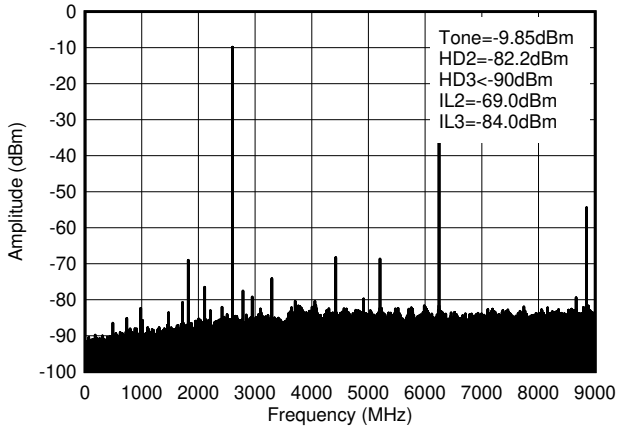


Matching at 2.6 GHz, f_{DAC} = 11.79648GSPS, interleave mode, normalized to output power at harmonic frequency

図 6-113. TX HD3 vs Digital Amplitude and Output Frequency at 2.6 GHz

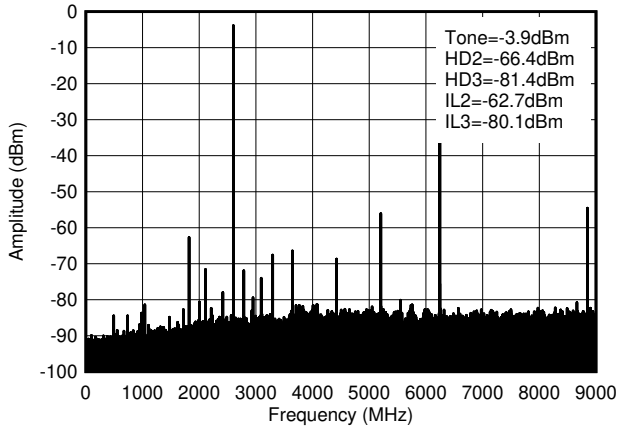
6.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



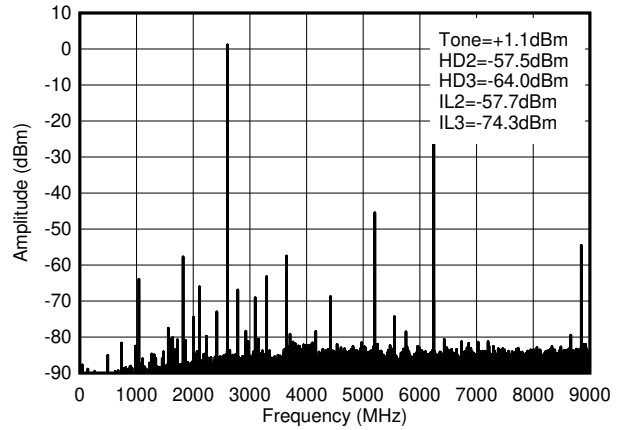
f_{DAC} = 8847.36MSPS, straight mode, 2.6 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

図 6-114. TX Single Tone (–12 dBFS) Output Spectrum at 2.6 GHz (0-f_{DAC})



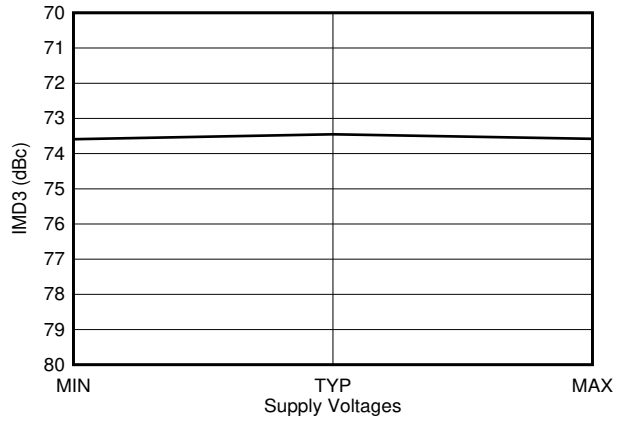
f_{DAC} = 8847.36MSPS, straight mode, 2.6 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

図 6-115. TX Single Tone (–6 dBFS) Output Spectrum at 2.6 GHz (0-f_{DAC})



f_{DAC} = 8847.36MSPS, straight mode, 2.6 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

図 6-116. TX Single Tone (–1 dBFS) Output Spectrum at 2.6 GHz (0-f_{DAC})

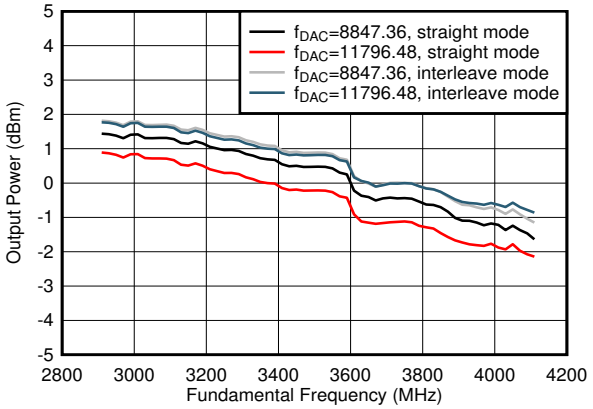


f_{DAC} = 11796.48MSPS, interleave mode, 2.6 GHz matching. 40-MHz offset from tone. Output Power = –13 dBFS. All supplies simultaneously at MIN, TYP, or MAX voltages.

図 6-117. TX IMD3 vs Supply Voltage at 2.6 GHz

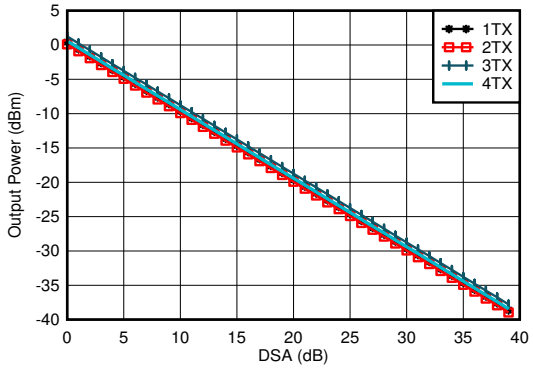
6.12.4 TX Typical Characteristics at 3.5 GHz

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



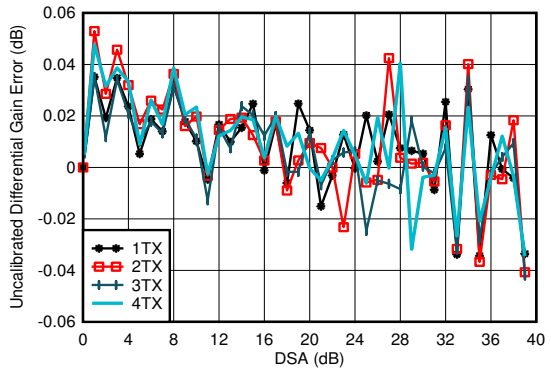
A_{out} = -0.5dFBS, 3.5 GHz Matching, included PCB and cable losses

図 6-118. TX Output Power vs Frequency



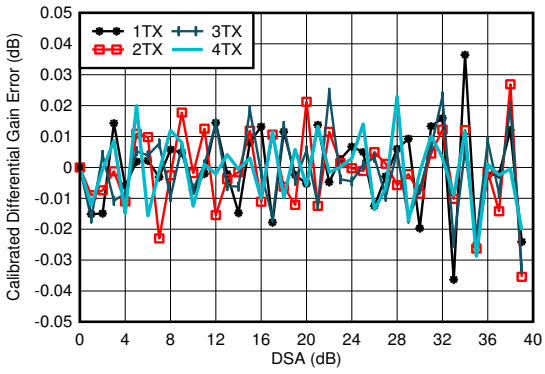
A_{out} = -0.5dFBS, 3.5 GHz Matching, included PCB and cable losses

図 6-119. TX Output Power vs DSA Setting at 3.5 GHz



3.5 GHz Matching, included PCB and cable losses
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-120. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 3.5 GHz

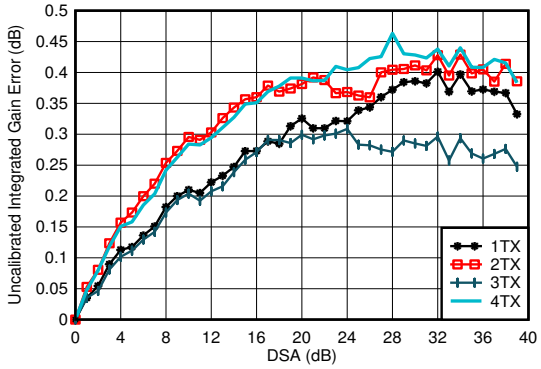


3.5 GHz Matching, included PCB and cable losses
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-121. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 3.5 GHz

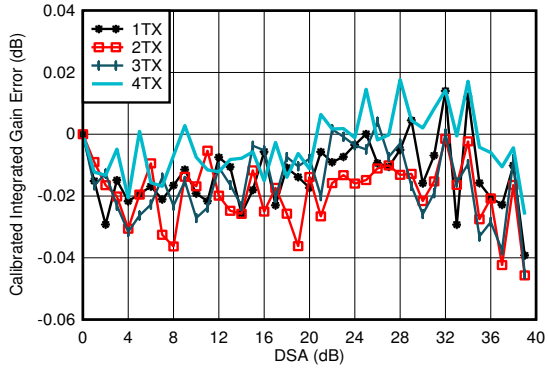
6.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



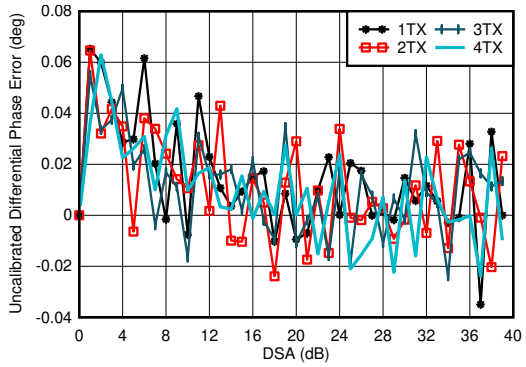
3.5 GHz Matching, included PCB and cable losses
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-122. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 3.5 GHz



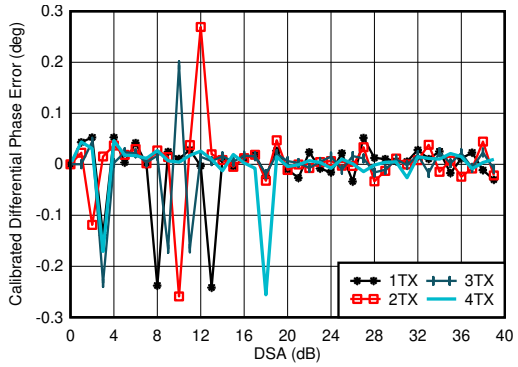
3.5 GHz Matching, included PCB and cable losses
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-123. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 3.5 GHz



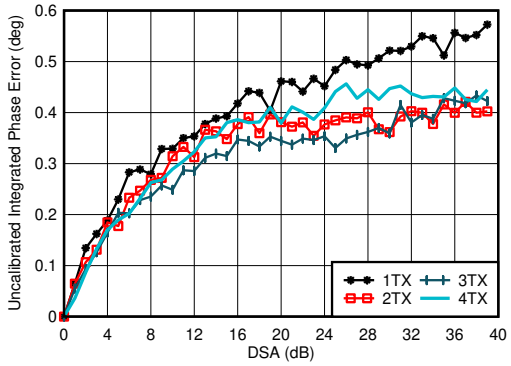
3.5 GHz Matching, included PCB and cable losses

図 6-124. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 3.5 GHz



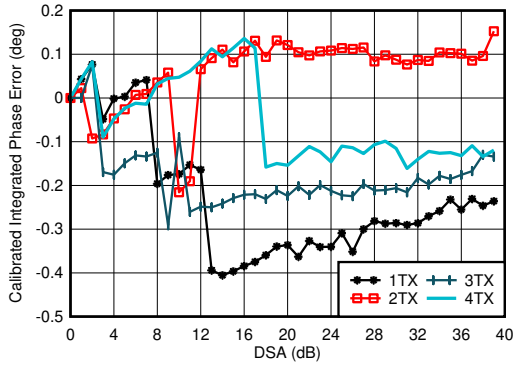
3.5 GHz Matching, included PCB and cable losses
Phase DNL spike may occur at any DSA setting.

図 6-125. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 3.5 GHz



3.5 GHz Matching, included PCB and cable losses

図 6-126. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 3.5 GHz

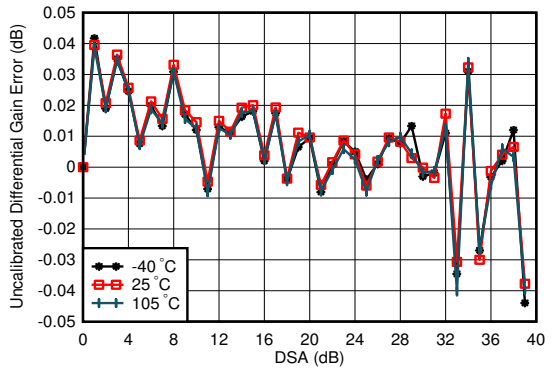


3.5 GHz Matching, included PCB and cable losses

図 6-127. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 3.5 GHz

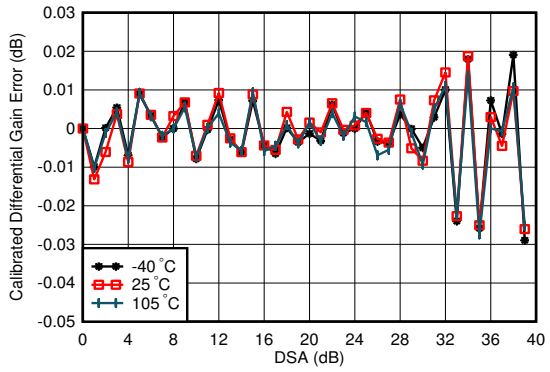
6.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



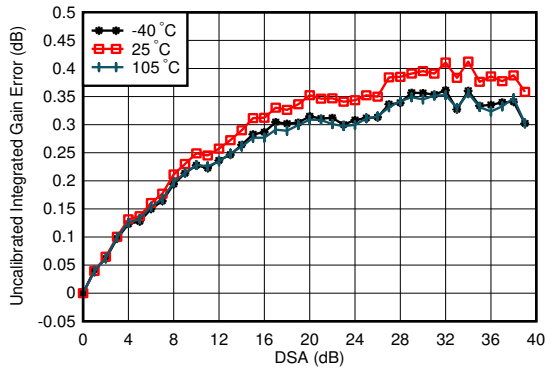
3.5 GHz Matching, 1TX

図 6-128. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 3.5 GHz



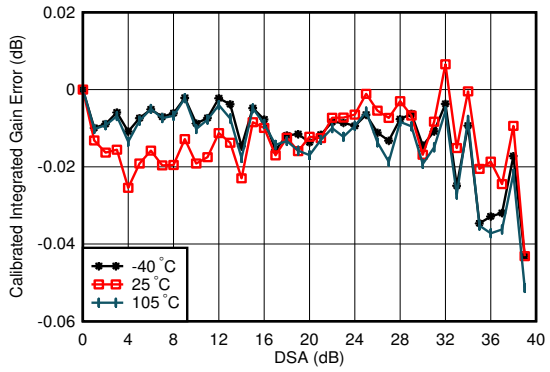
3.5 GHz Matching, 1TX, Calibrated at 25°C

図 6-129. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 3.5 GHz



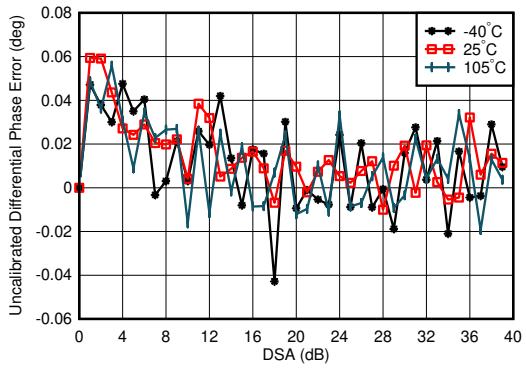
3.5 GHz Matching, 1TX

図 6-130. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 3.5 GHz



3.5 GHz Matching, 1TX, Calibrated at 25°C

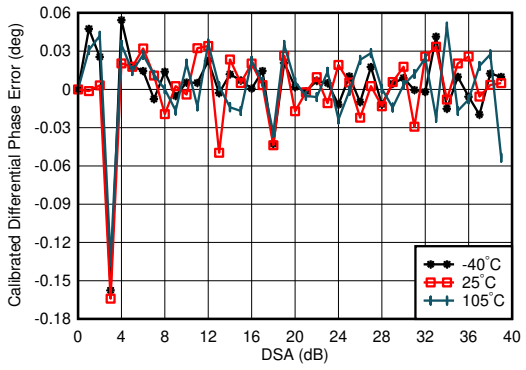
図 6-131. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 3.5 GHz



3.5 GHz Matching, 1TX

Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-132. TX Uncalibrated Differential Phase Error vs DSA setting and Temperature at 3.5 GHz



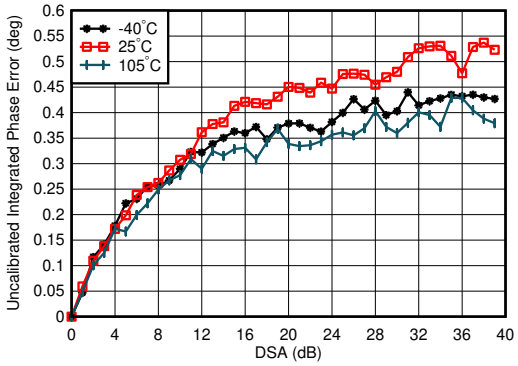
3.5 GHz Matching, 1TX, Calibrated at 25°C

Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-133. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 3.5 GHz

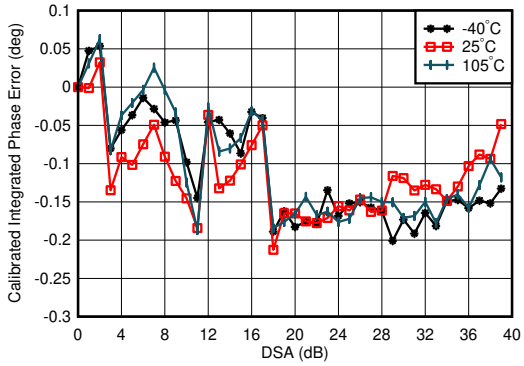
6.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



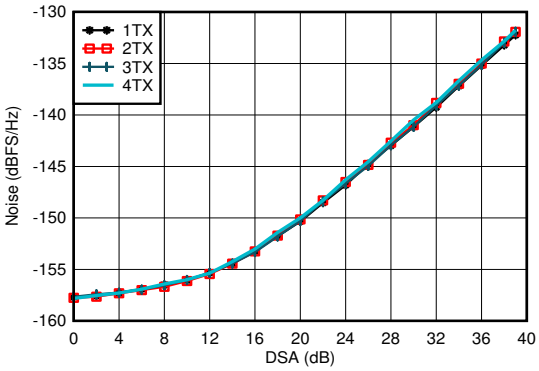
3.5 GHz Matching, 1TX
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting=0)

図 6-134. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 3.5 GHz



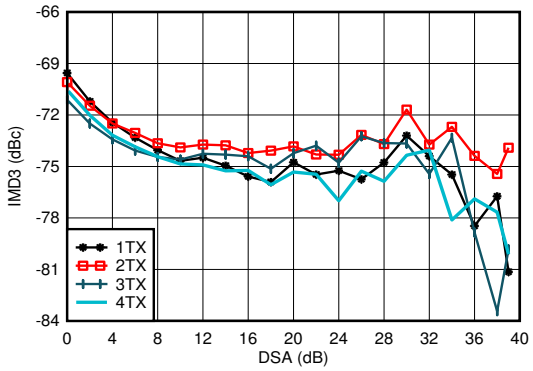
3.5 GHz Matching, 1TX, Calibrated at 25°C
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-135. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 3.5 GHz



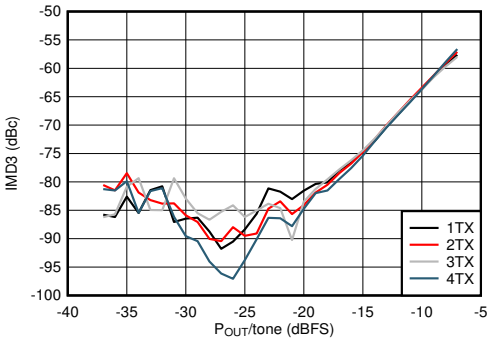
f_{DAC}=11796.48MSPS, interleave mode, matching at 3.5GHz, A_{out} = –13 dBFS.

図 6-136. TX NSD vs DSA Setting at 3.5 GHz



20-MHz tone spacing, 3.5 GHz Matching, –13 dBFS each tone, included PCB and cable losses

図 6-137. TX IMD3 vs DSA Setting at 3.5 GHz



20-MHz tone spacing, 3.5 GHz Matching

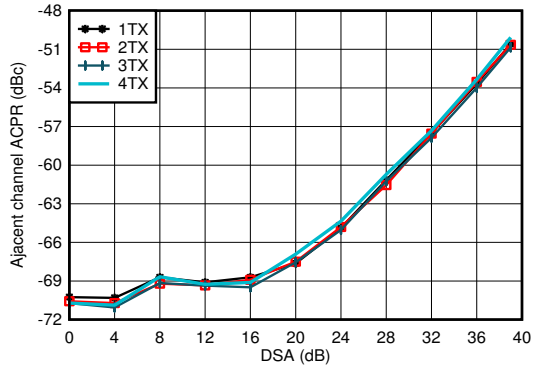
図 6-138. TX IMD3 vs Digital Amplitude and Channel at 3.5 GHz

3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

図 6-139. TX 20-MHz LTE Output Spectrum at 3.5 GHz (Band 42)

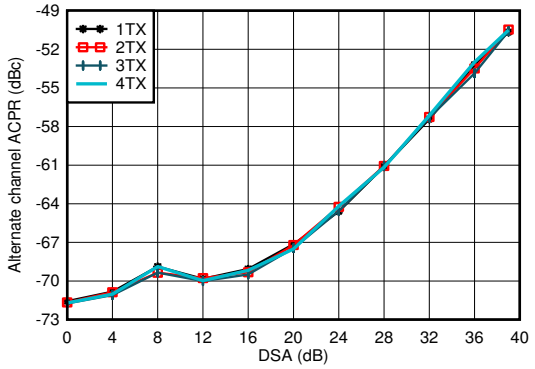
6.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



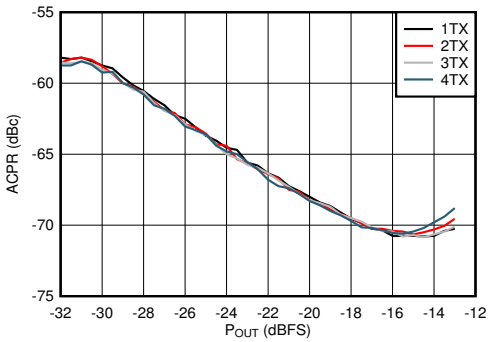
3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

図 6-140. TX 20-MHz LTE ACPR vs DSA Setting at 3.5 GHz



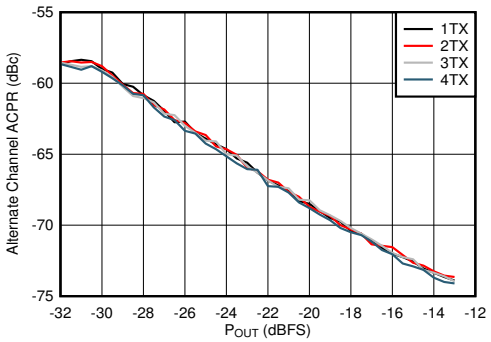
3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

図 6-141. TX 20-MHz LTE alt-ACPR vs DSA Setting at 3.5 GHz



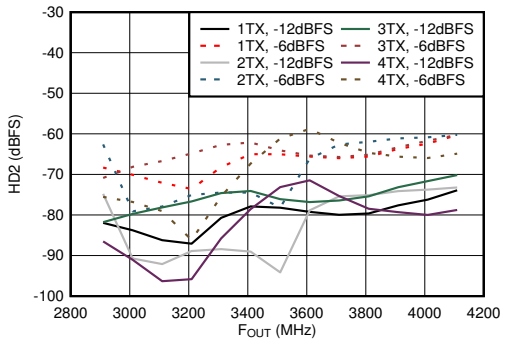
3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

図 6-142. TX 20-MHz LTE ACPR vs Digital Level at 3.5 GHz



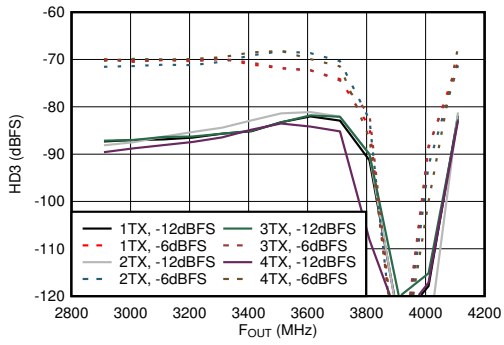
3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

図 6-143. TX 20-MHz LTE alt-ACPR vs Digital Level at 3.5 GHz



Matching at 3.5 GHz, f_{DAC} = 11.79648GSPS, interleave mode, normalized to output power at harmonic frequency

図 6-144. TX Single Tone HD2 vs Frequency and Digital Level at 3.5 GHz

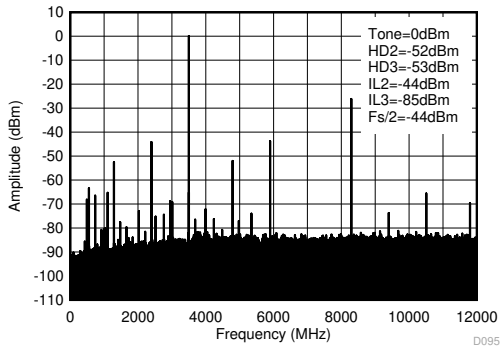


Matching at 3.5 GHz, f_{DAC} = 11.79648GSPS, interleave mode, normalized to output power at harmonic frequency. Dip is due to HD3 falling near DC.

図 6-145. TX Single Tone HD3 vs Frequency and Digital Level at 3.5 GHz

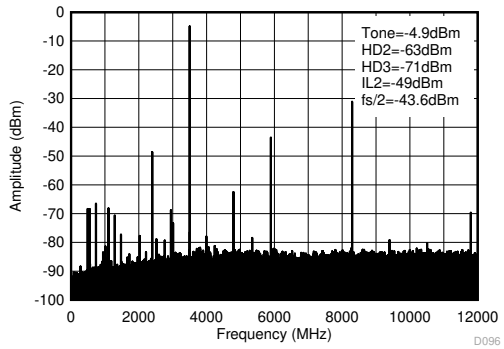
6.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



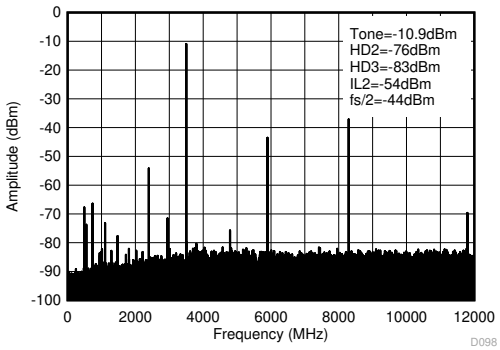
Matching at 3.5 GHz, f_{DAC} = 11.79648GSPS, interleave mode.

図 6-146. TX Single Tone (–1 dBFS) Output Spectrum at 3.5 GHz (0 - f_{DAC})



Matching at 3.5 GHz, f_{DAC} = 11.79648GSPS, interleave mode.

図 6-147. TX Single Tone (–6 dBFS) Output Spectrum at 3.5 GHz (0-f_{DAC})

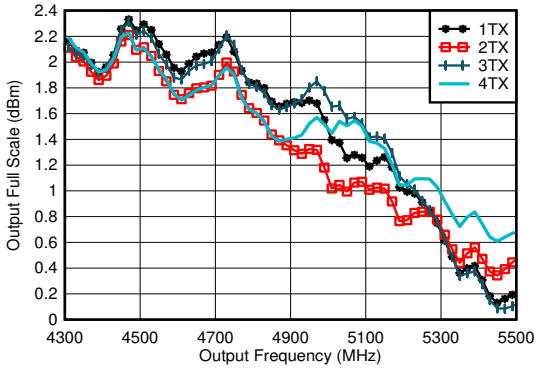


Matching at 3.5 GHz, f_{DAC} = 11.79648GSPS, interleave mode.

図 6-148. TX Single Tone (–12 dBFS) Output Spectrum at 3.5 GHz (0-f_{DAC})

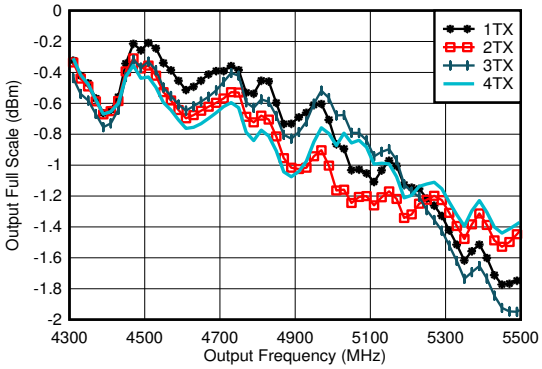
6.12.5 TX Typical Characteristics at 4.9 GHz

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



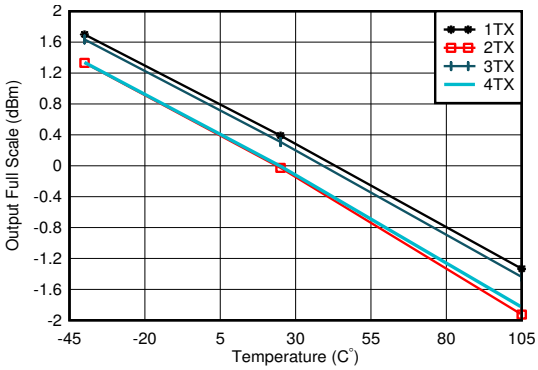
Excluding PCB and cable losses, A_{out} = -0.5dFBS, DSA = 0, 4.9 GHz matching

図 6-149. TX Full Scale vs RF Frequency and Channel at 11796.48MSPS



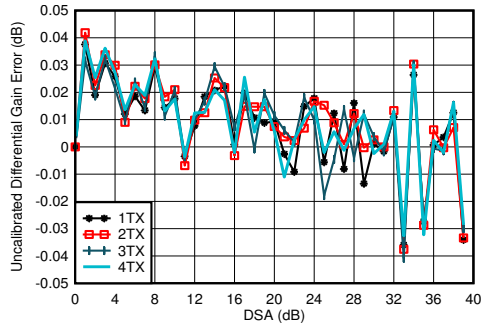
Excluding PCB and cable losses, A_{out} = -0.5dFBS, DSA = 0, 4.9 GHz matching

図 6-150. TX Full Scale vs RF Frequency and Channel at 5898.24MSPS, Straight Mode, 2nd Nyquist Zone



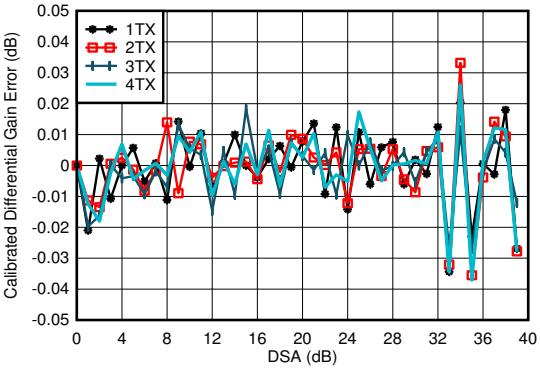
f_{DAC} = 11796.48 MSPS, A_{out} = -0.5dFBS, matching 4.9 GHz

図 6-151. TX Output Power vs DSA Setting and Channel at 4.9 GHz



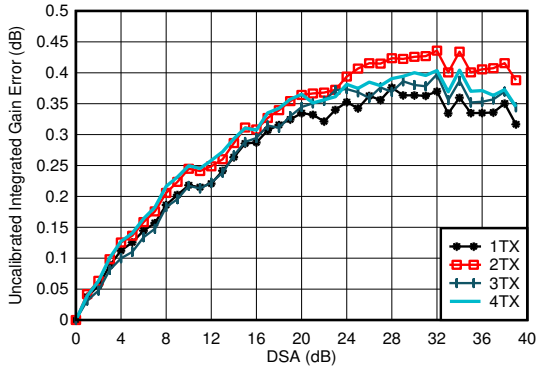
f_{DAC}=11796.48MSPS, interleave mode, matching at 4.9 GHz
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-152. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 4.9 GHz



f_{DAC}=11796.48MSPS, interleave mode, matching at 4.9 GHz
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-153. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 4.9 GHz

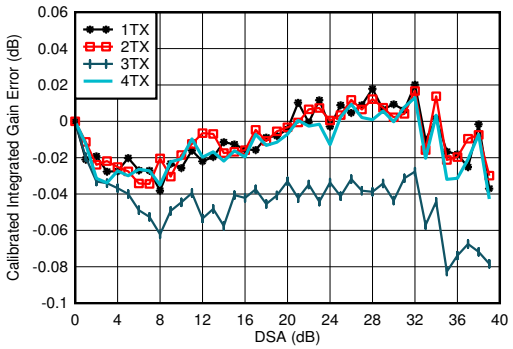


f_{DAC}=11796.48MSPS, interleave mode, matching at 4.9 GHz
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-154. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 4.9 GHz

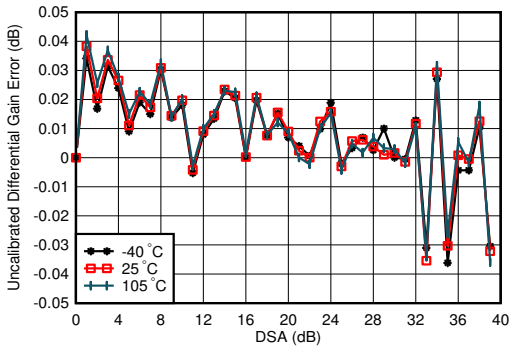
6.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



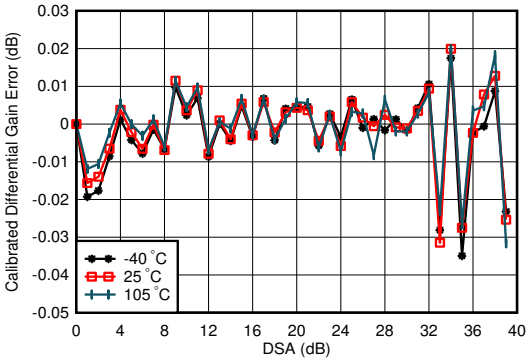
f_{DAC} = 11796.48MSPS, interleave mode, matching at 4.9 GHz
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-155. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 4.9 GHz



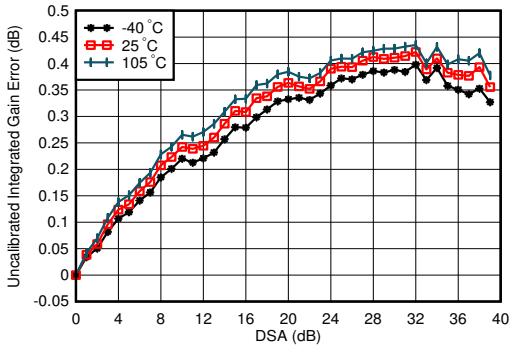
f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-156. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 4.9 GHz



f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz
Differential Gain Error = P_{OUT}(DSA Setting – 1) – P_{OUT}(DSA Setting) + 1

図 6-157. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 4.9 GHz

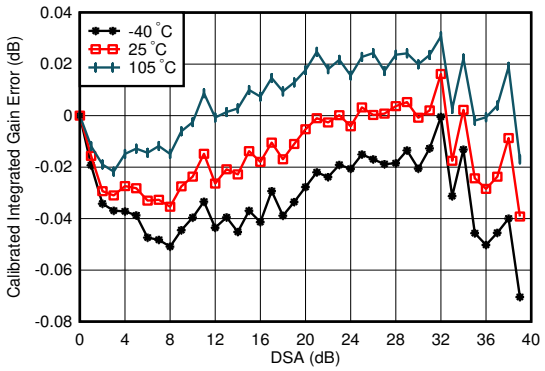


f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz
Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

図 6-158. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 4.9 GHz

6.12.5 TX Typical Characteristics at 4.9 GHz (continued)

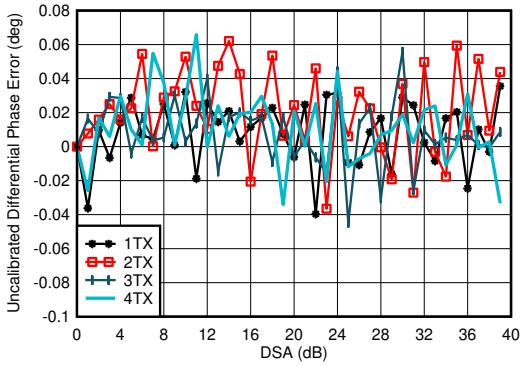
Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz

Integrated Gain Error = P_{OUT}(DSA Setting) – P_{OUT}(DSA Setting = 0) + (DSA Setting)

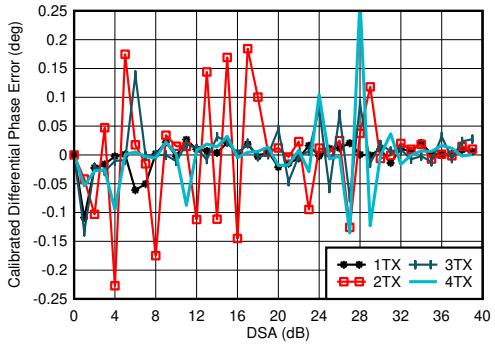
図 6-159. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 4.9 GHz



f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz

Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-160. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 4.9 GHz

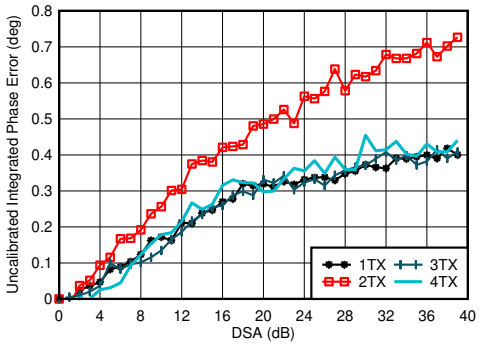


f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz

Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

Phase DNL spike may occur at any DSA setting.

図 6-161. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 4.9 GHz



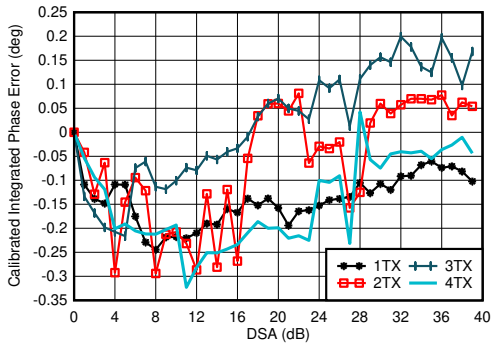
f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz

Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-162. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 4.9 GHz

6.12.5 TX Typical Characteristics at 4.9 GHz (continued)

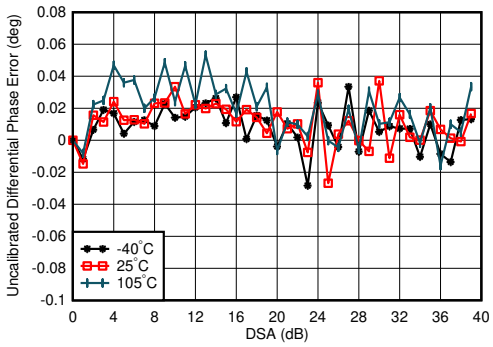
Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz

Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

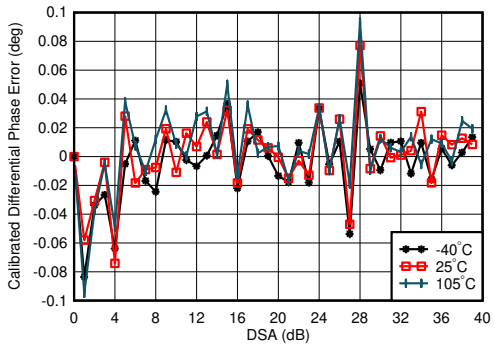
図 6-163. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 4.9 GHz



f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz

Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

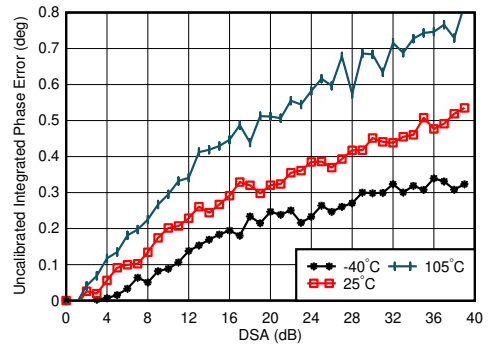
図 6-164. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 4.9 GHz



f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz

Differential Phase Error = $Phase_{OUT}$(DSA Setting – 1) – $Phase_{OUT}$(DSA Setting)

図 6-165. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 4.9 GHz



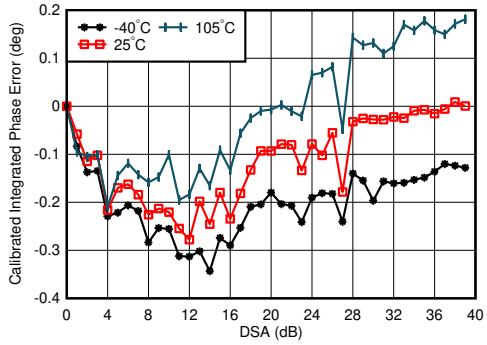
f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz

Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-166. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 4.9 GHz

6.12.5 TX Typical Characteristics at 4.9 GHz (continued)

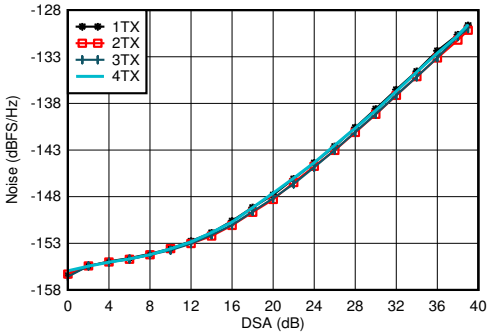
Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz, channel with the median variation over DSA setting at 25°C

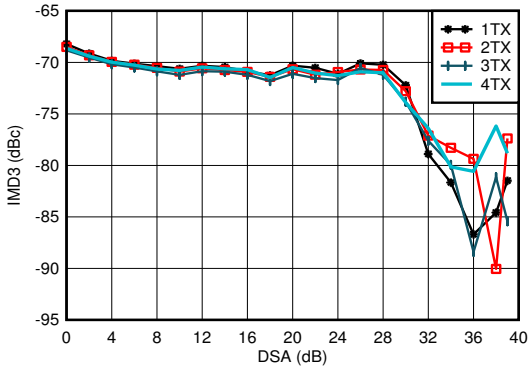
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-167. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 4.9 GHz



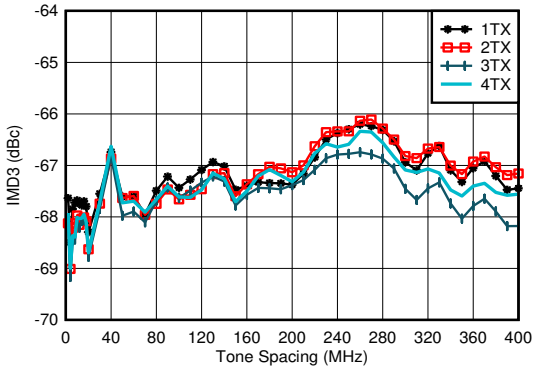
f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz, P_{OUT} = –13 dBFS

図 6-168. TX Output Noise vs Channel and Attenuation at 2.6 GHz



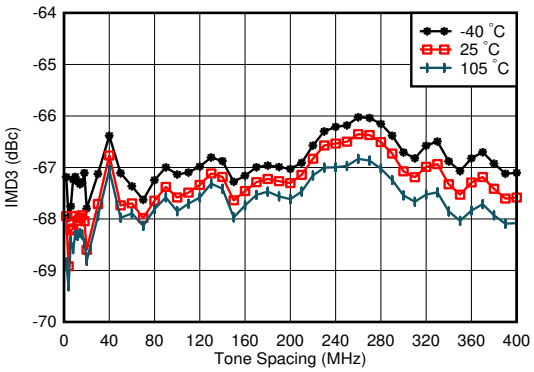
f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz, f_{CENTER} = 4.9GHz, -13 dBFS each tone

図 6-169. TX IMD3 vs DSA Setting at 4.9 GHz



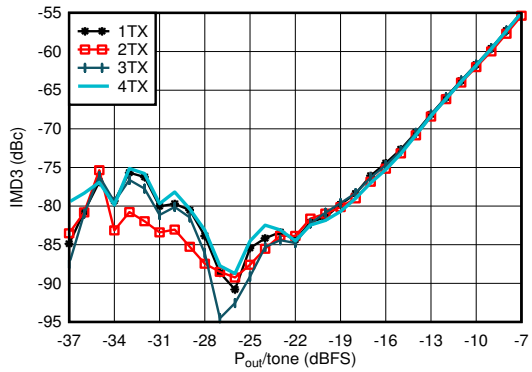
f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz, f_{CENTER} = 4.9GHz, –13 dBFS each tone

図 6-170. TX IMD3 vs Tone Spacing and Channel at 4.9 GHz



f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz, f_{CENTER} = 4.9GHz, –13 dBFS each tone, worst channel

図 6-171. TX IMD3 vs Tone Spacing and Temperature at 4.9 GHz

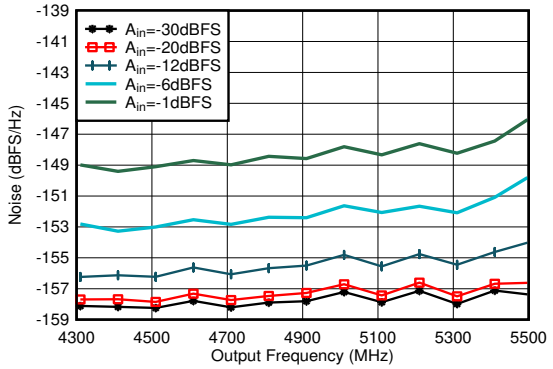


f_{DAC} = 11796.48MSPS, interleaved mode, matching at 4.9 GHz, f_{CENTER} = 4.9GHz, $f_{SPACING}$ = 20 MHz

図 6-172. TX IMD3 vs Digital Level at 4.9 GHz

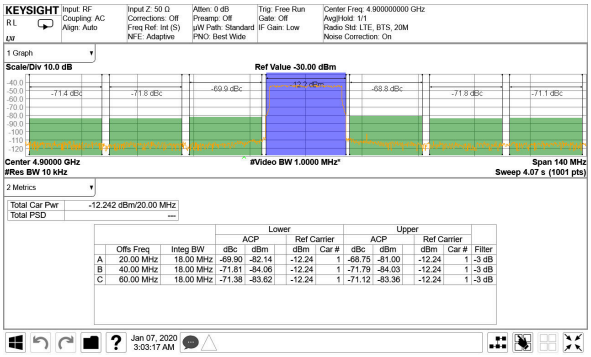
6.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



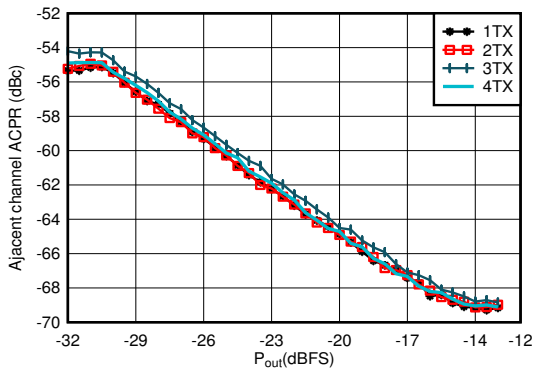
Matching at 4.9 GHz, Single tone, f_{DAC} = 11.79648GSPS, interleave mode, 40-MHz offset, DSA=0dB

図 6-173. TX Single Tone Output Noise vs Frequency and Amplitude at 4.9 GHz



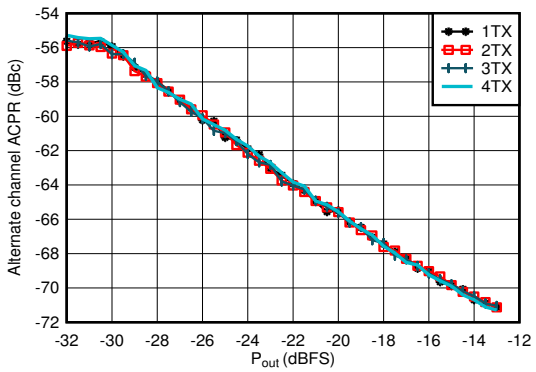
TM1.1, P_{OUT_RMS} = –13 dBFS

図 6-174. TX 20-MHz LTE Output Spectrum at 4.9 GHz



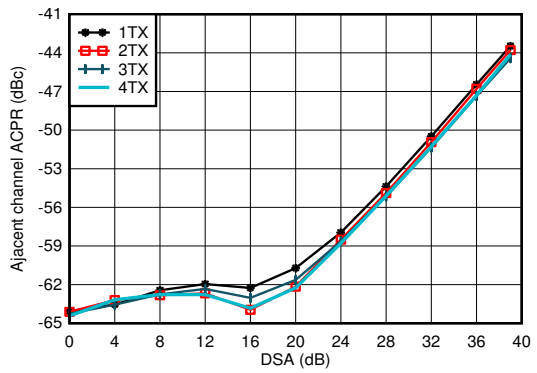
Matching at 4.9 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-175. TX 20-MHz LTE ACPR vs Digital Level at 4.9 GHz



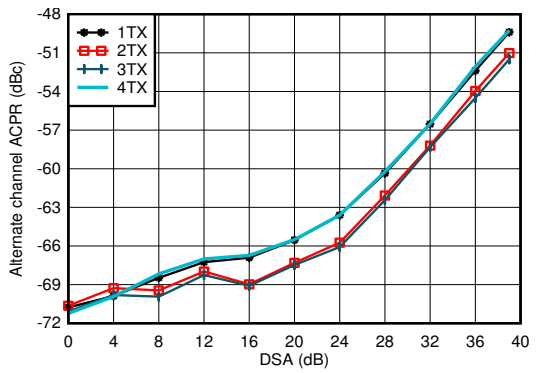
Matching at 4.9 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-176. TX 20-MHz LTE alt-ACPR vs Digital Level at 4.9 GHz



Matching at 4.9 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-177. TX 20-MHz LTE ACPR vs DSA at 4.9 GHz

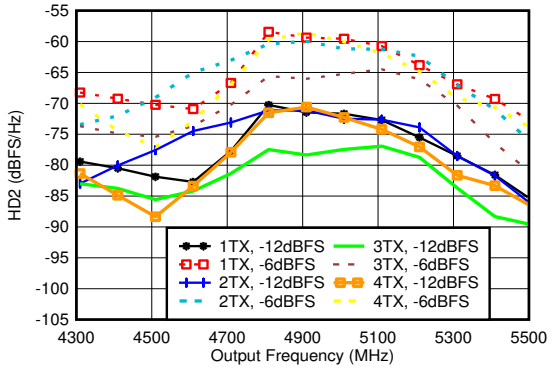


Matching at 4.9 GHz, single carrier 20-MHz BW TM1.1 LTE

図 6-178. TX 20-MHz LTE alt-ACPR vs DSA at 4.9 GHz

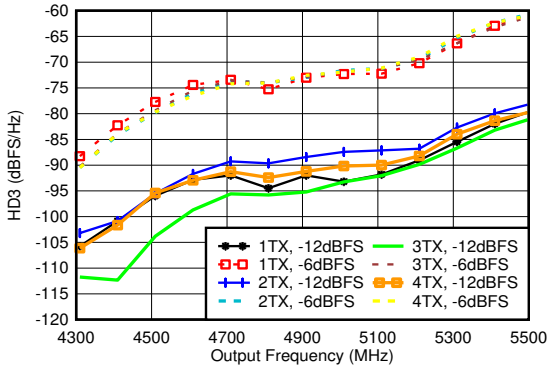
6.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



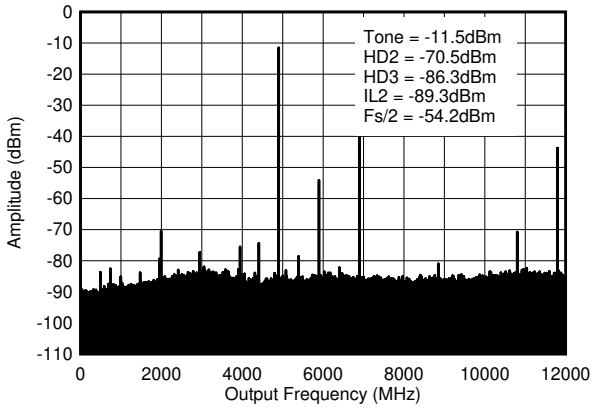
Matching at 4.9 GHz, f_{DAC} = 11.79648GSPS, interleave mode, normalized to output power at harmonic frequency

図 6-179. TX HD2 vs Digital Amplitude and Output Frequency at 4.9 GHz



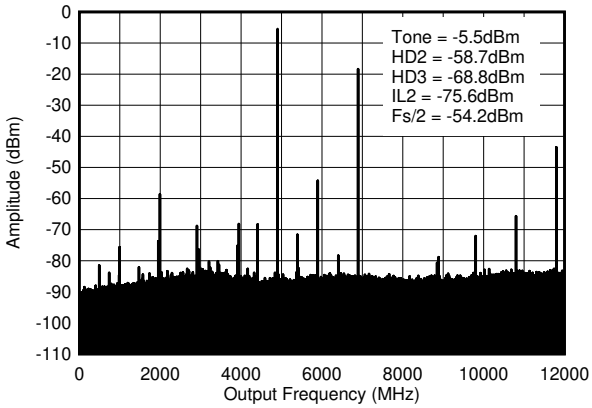
Matching at 4.9 GHz, f_{DAC} = 11.79648GSPS, interleave mode, normalized to output power at harmonic frequency

図 6-180. TX HD3 vs Digital Amplitude and Output Frequency at 4.9 GHz



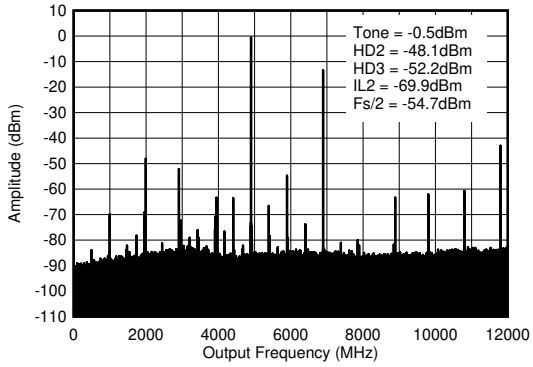
f_{DAC} = 11796.48MSPS, interleave mode, 4.9 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$.

図 6-181. TX Single Tone (–12 dBFS) Output Spectrum at 4.9 GHz (0-f_{DAC})



f_{DAC} = 11796.48MSPS, interleave mode, 4.9 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$.

図 6-182. TX Single Tone (–6 dBFS) Output Spectrum at 4.9 GHz (0-f_{DAC})

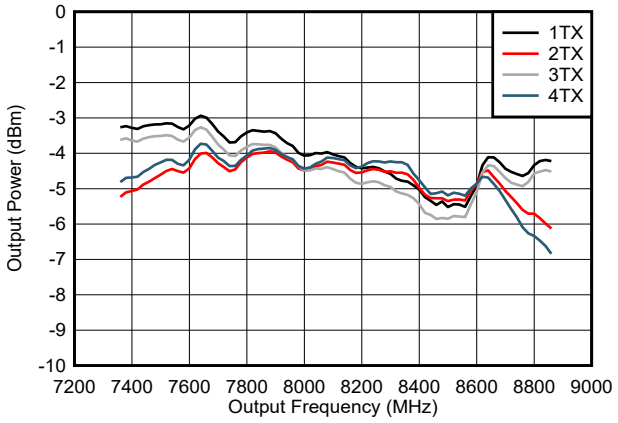


f_{DAC} = 11796.48MSPS, interleave mode, 4.9 GHz matching, includes PCB and cable losses. ILn = $f_S/n \pm f_{OUT}$.

図 6-183. TX Single Tone (–1 dBFS) Output Spectrum at 4.9 GHz (0-f_{DAC})

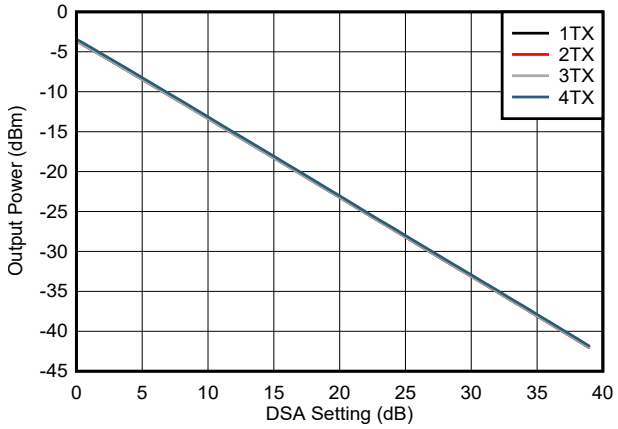
6.12.6 TX Typical Characteristics at 8.1 GHz

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching



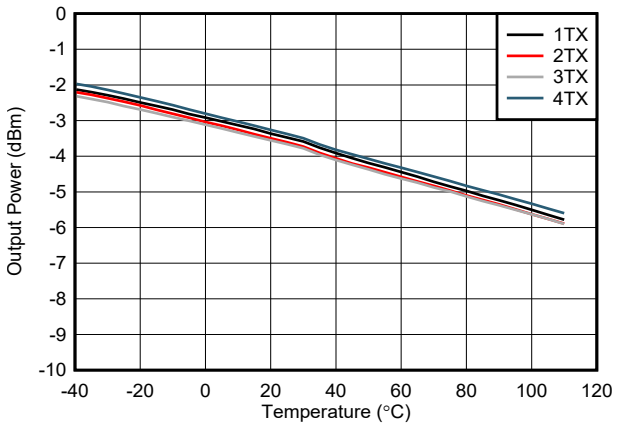
includes PCB and cable losses.

図 6-184. TX Output Power vs Frequency at 8.11 GHz



includes PCB and cable losses.

図 6-185. TX Output Power vs DSA Setting at 8.11 GHz



includes PCB and cable losses.

図 6-186. TX Output Power vs Temperature at 8.11 GHz

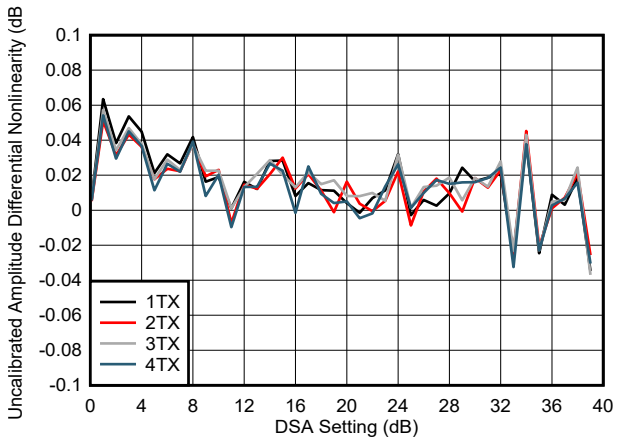


図 6-187. TX DSA Uncalibrated Amplitude Differential Nonlinearity at 8.11 GHz

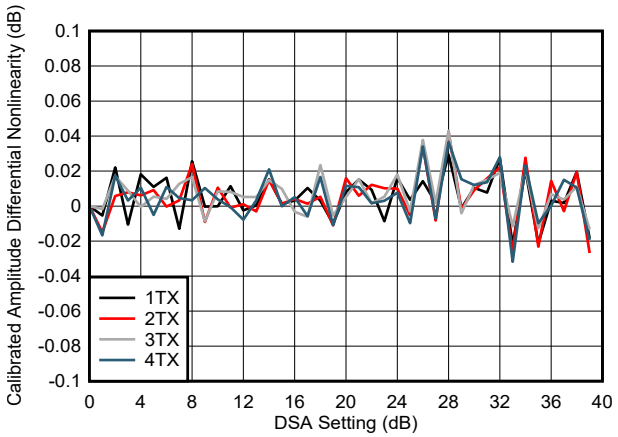


図 6-188. TX DSA Calibrated Amplitude Differential Nonlinearity at 8.11 GHz

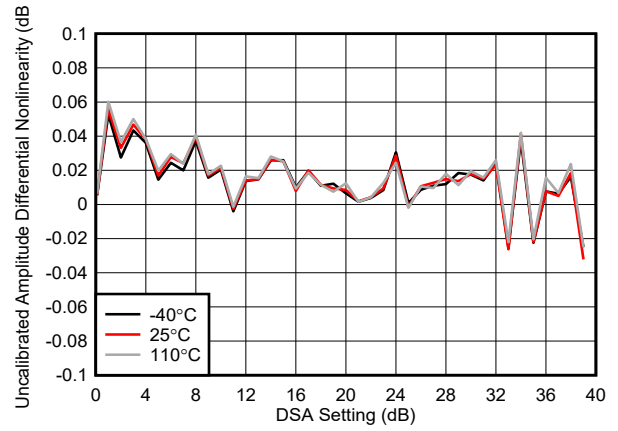


図 6-189. TX DSA Uncalibrated Amplitude Differential Nonlinearity at 8.11 GHz

6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

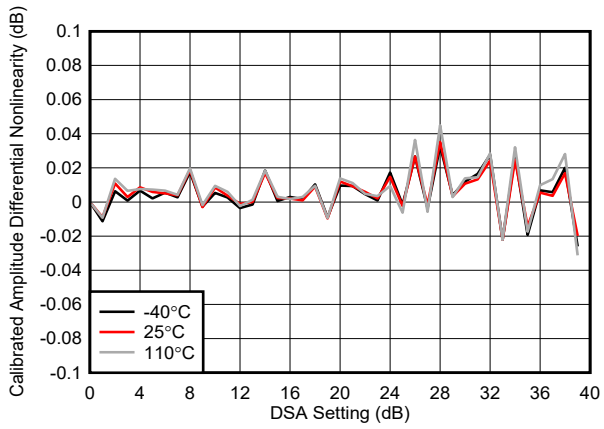


図 6-190. TX DSA Calibrated Amplitude Differential Nonlinearity at 8.11 GHz

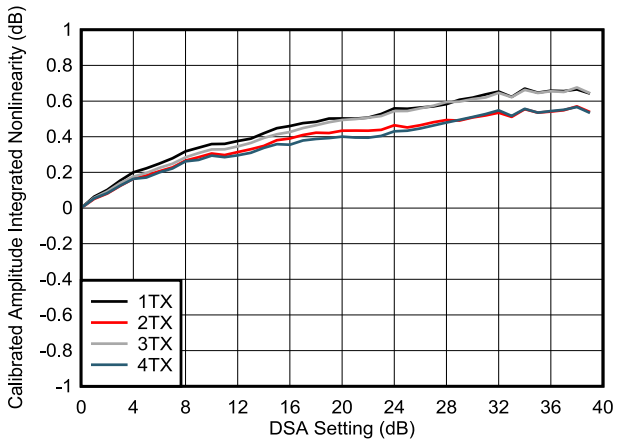


図 6-191. TX DSA Uncalibrated Amplitude Integrated Nonlinearity at 8.11 GHz

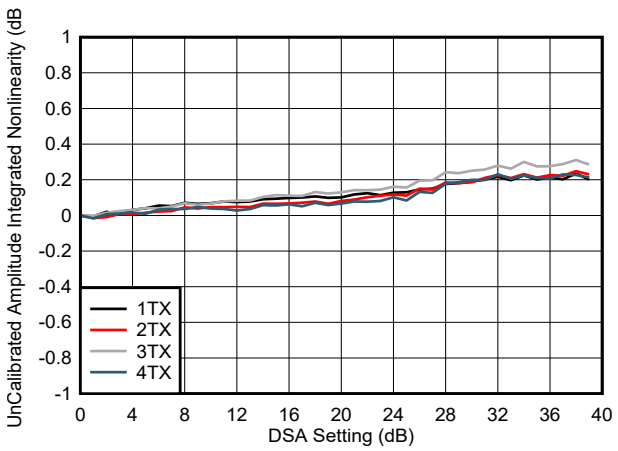


図 6-192. TX DSA Calibrated Amplitude Integrated Nonlinearity at 8.11 GHz

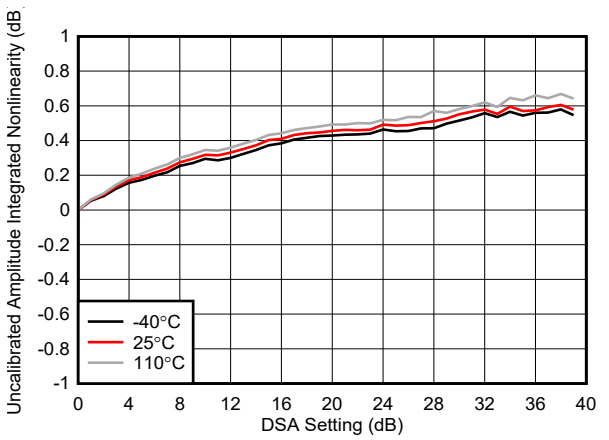


図 6-193. TX DSA Uncalibrated Amplitude Integrated Nonlinearity at 8.11 GHz

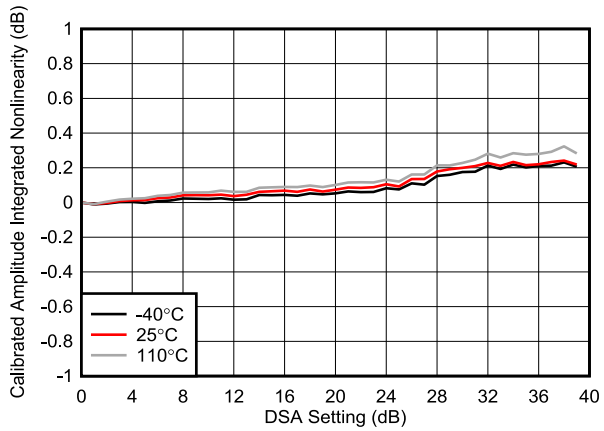


図 6-194. TX DSA Calibrated Amplitude Integrated Nonlinearity at 8.11 GHz

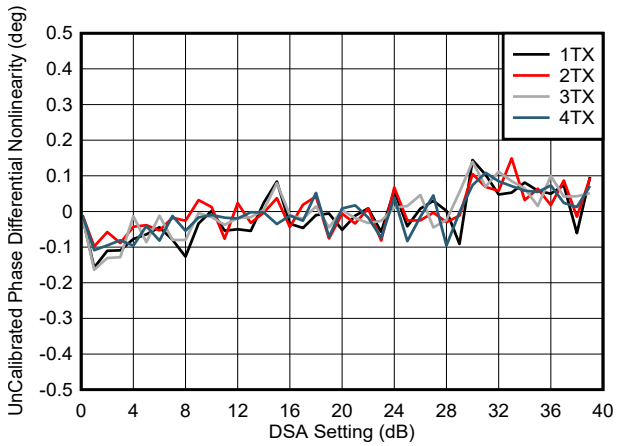


図 6-195. TX DSA Uncalibrated Phase Differential Nonlinearity at 8.11 GHz

6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

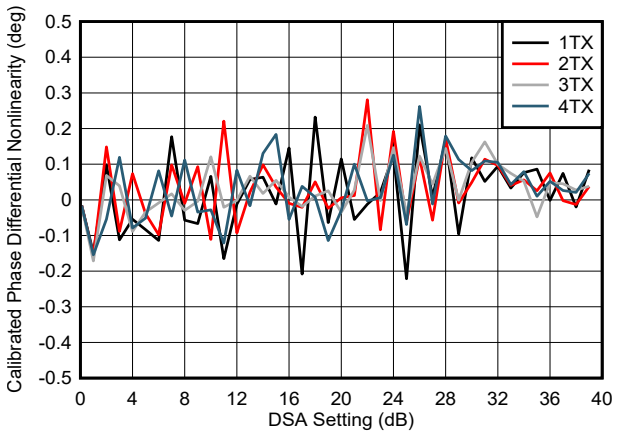


図 6-196. TX DSA Calibrated Phase Differential Nonlinearity at 8.11 GHz

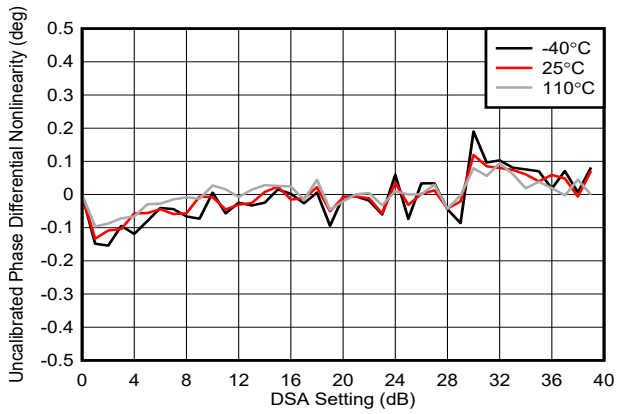


図 6-197. TX DSA Uncalibrated Phase Differntial Nonlinearity at 8.11 GHz

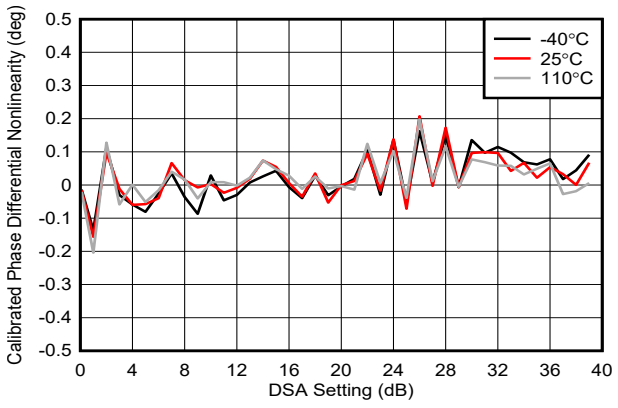


図 6-198. TX DSA Calibrated Phase Differential Nonlinearity at 8.11 GHz

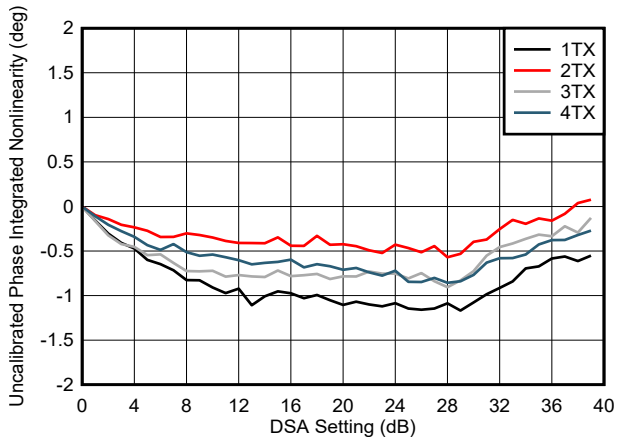


図 6-199. TX DSA Uncalibrated Phase Integrated Nonlinearity at 8.11 GHz

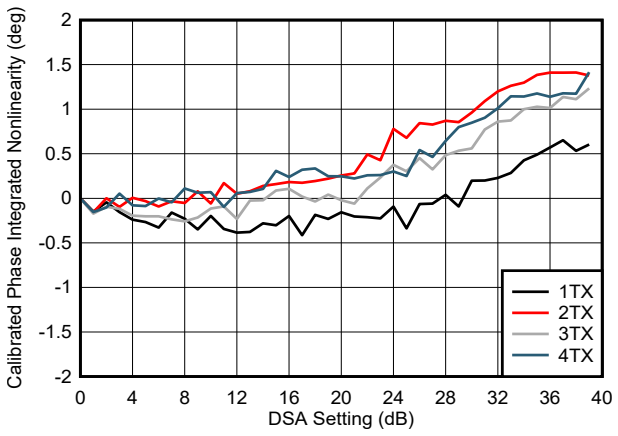


図 6-200. TX DSA Calibrated Phase Integrated Nonlinearity at 8.11 GHz

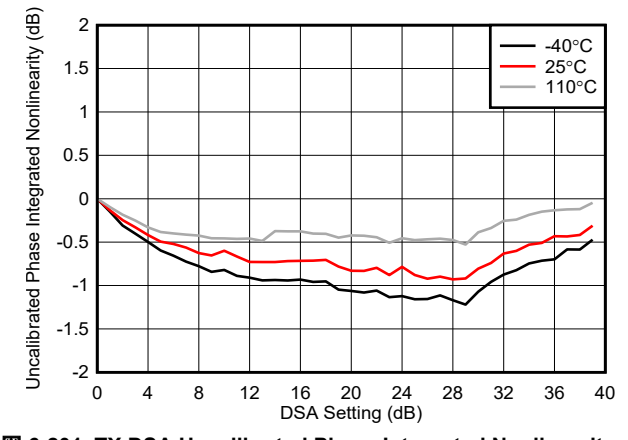


図 6-201. TX DSA Uncalibrated Phase Integrated Nonlinearity at 8.11 GHz

6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

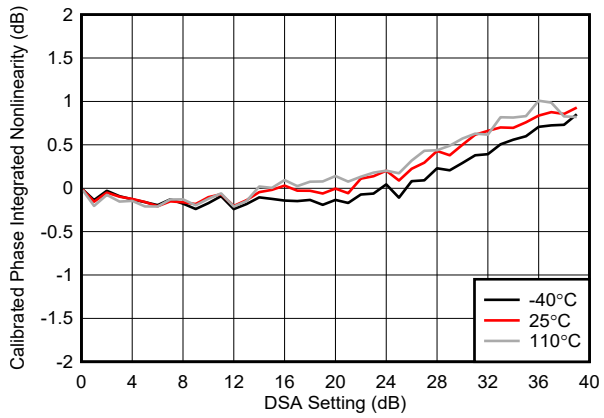
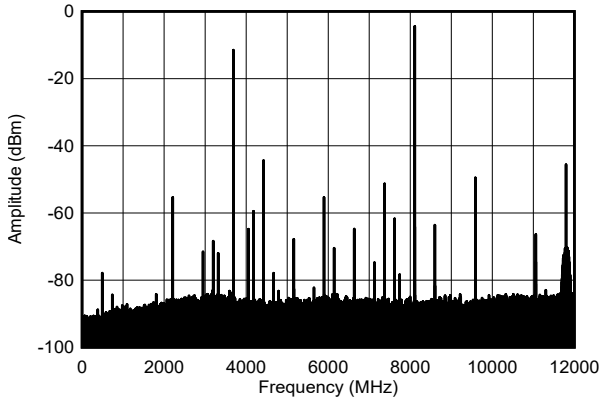
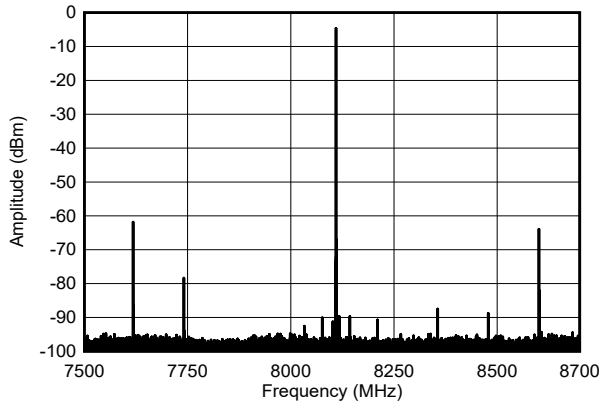


図 6-202. TX DSA Calibrated Phase Integrated Nonlinearity at 8.11 GHz



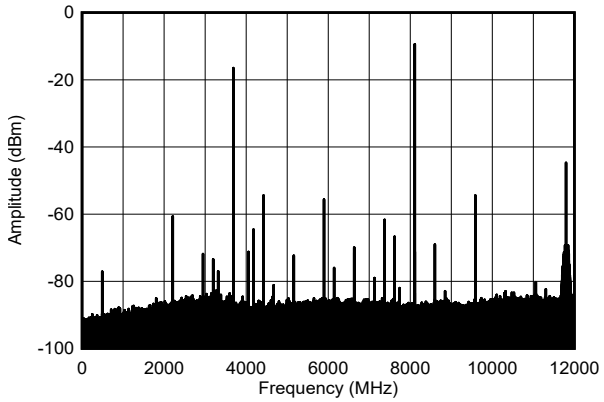
–1 dBFS

図 6-203. TX Single Tone Output Spectrum at 8.11 GHz



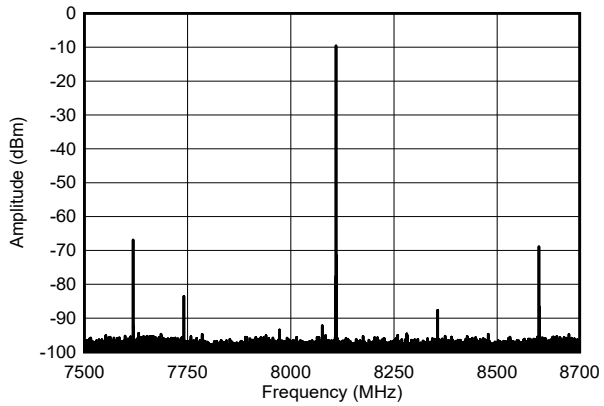
–1 dBFS

図 6-204. TX Single Tone Output Spectrum at 8.11 GHz



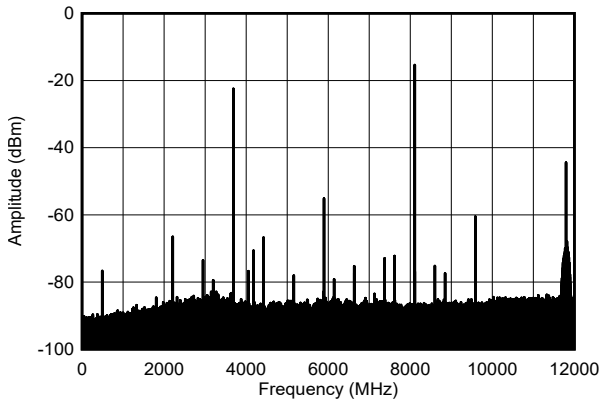
–6 dBFS

図 6-205. TX Single Tone Output Spectrum at 8.11 GHz



–6 dBFS

図 6-206. TX Single Tone Output Spectrum at 8.11 GHz

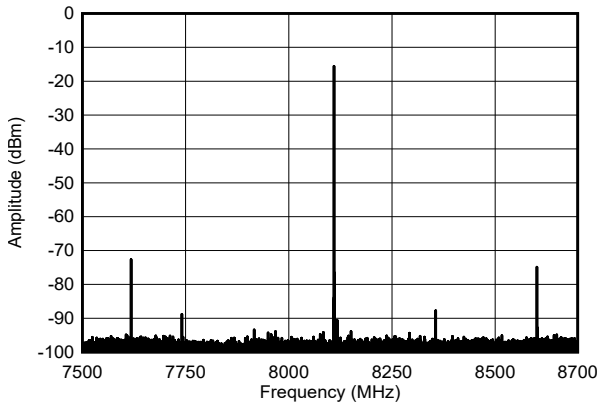


–12 dBFS

図 6-207. TX Single Tone Output Spectrum at 8.11 GHz

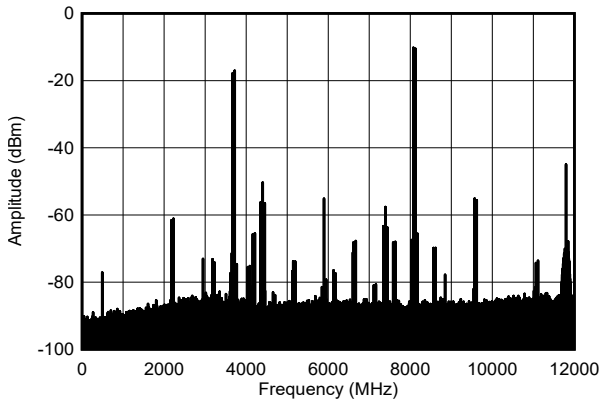
6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching



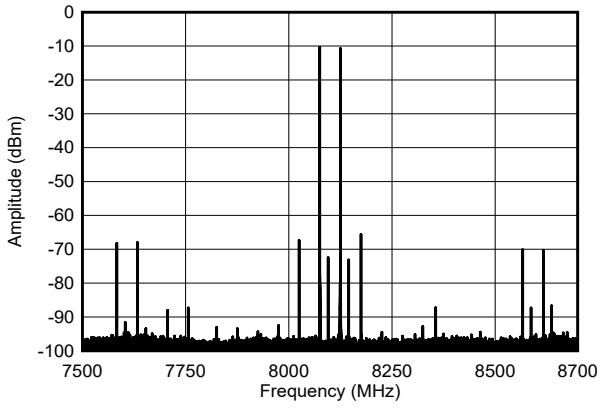
–12 dBFS

図 6-208. TX Single Tone Output Spectrum at 8.11 GHz



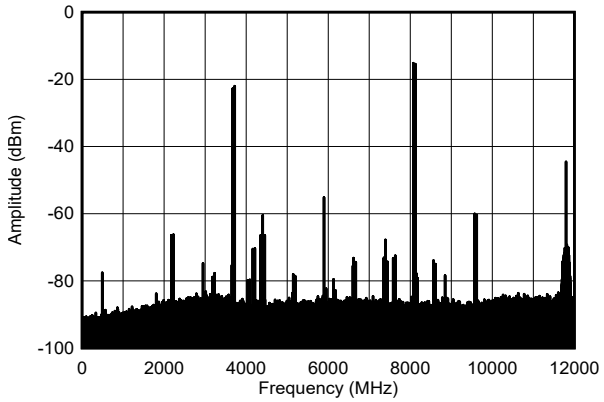
50-MHz tone spacing, –7 dBFS each tone

図 6-209. TX Dual Tone Output Spectrum at 8.11 GHz



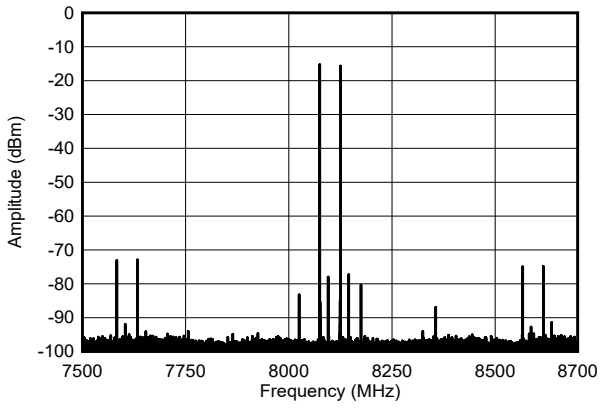
50-MHz tone spacing, –7 dBFS each tone

図 6-210. TX Dual Tone Output Spectrum at 8.11 GHz



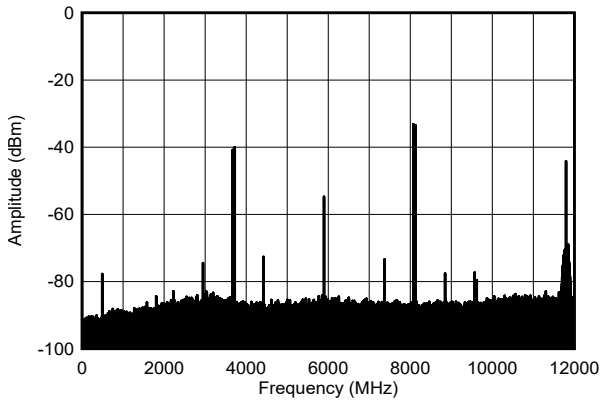
50-MHz tone spacing, –12 dBFS each tone

図 6-211. TX Dual Tone Output Spectrum at 8.11 GHz



50-MHz tone spacing, –12 dBFS each tone

図 6-212. TX Dual Tone Output Spectrum at 8.11 GHz

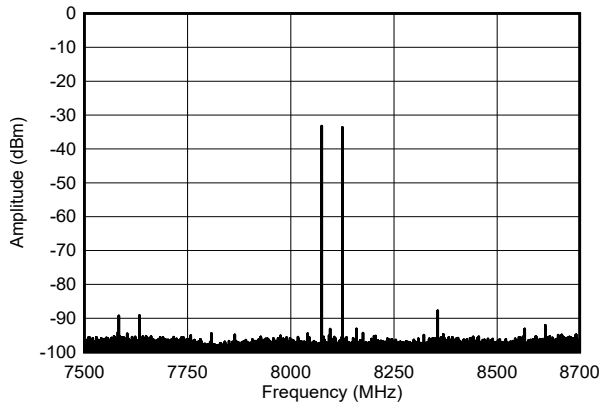


50-MHz tone spacing, –30 dBFS each tone

図 6-213. TX Dual Tone Output Spectrum at 8.11 GHz

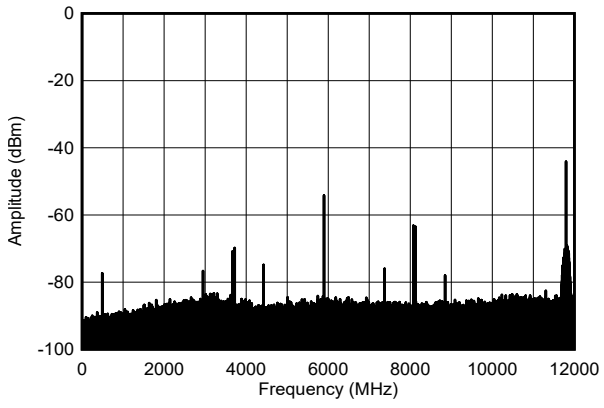
6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching



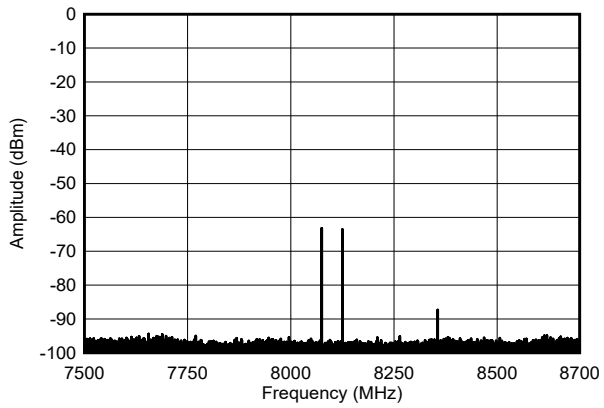
50-MHz tone spacing, –30 dBFS each tone

図 6-214. TX Dual Tone Output Spectrum at 8.11 GHz



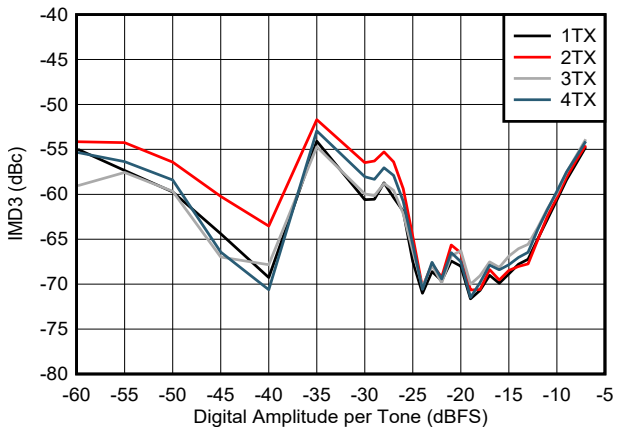
50-MHz tone spacing, –60 dBFS each tone

図 6-215. TX Dual Tone Output Spectrum at 8.11 GHz



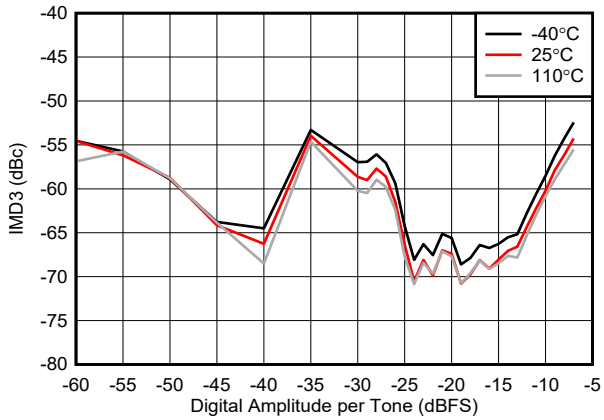
50-MHz tone spacing, –60 dBFS each tone

図 6-216. TX Dual Tone Output Spectrum at 8.11 GHz



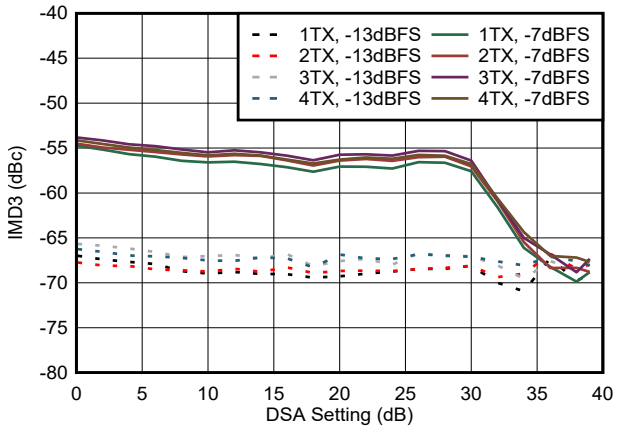
50-MHz tone spacing

図 6-217. TX IMD3 vs Digital Amplitude at 8.11 GHz



50-MHz tone spacing

図 6-218. TX IMD3 vs Digital Amplitude at 8.11 GHz

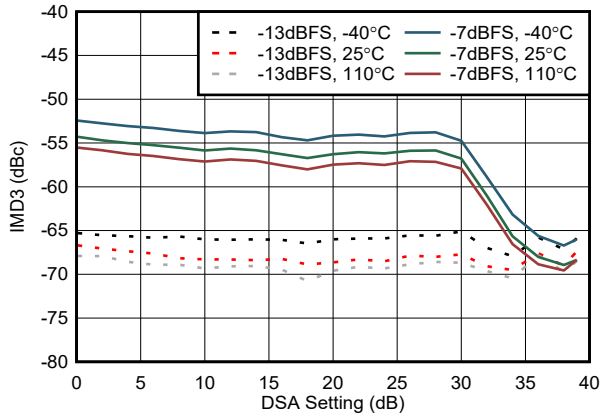


50-MHz tone spacing

図 6-219. TX IMD3 vs DSA Setting at 8.11 GHz

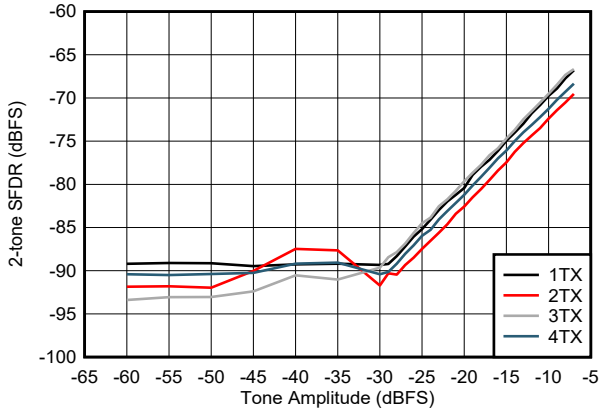
6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching



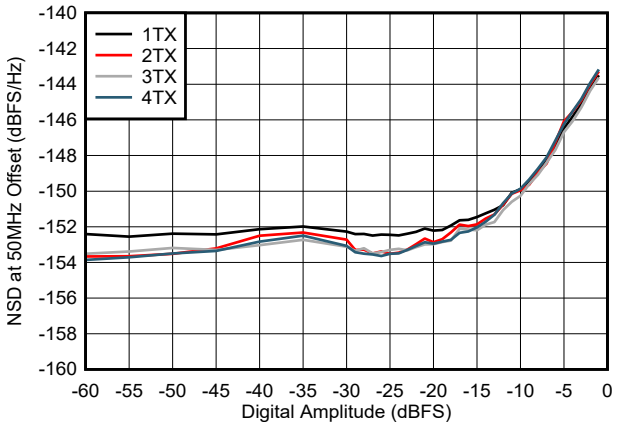
50-MHz tone spacing

図 6-220. TX IMD3 vs DSA Setting at 8.11 GHz



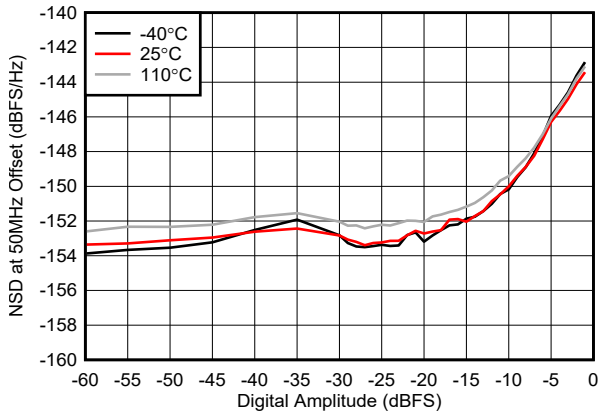
50-MHz tone spacing

図 6-221. TX 2-Tone SFDR vs Digital Amplitude at 8.11 GHz



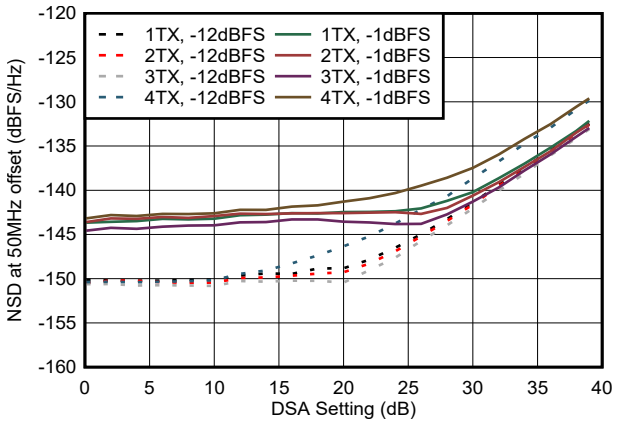
50-MHz offset

図 6-222. TX NSD vs Digital Amplitude at 8.11 GHz



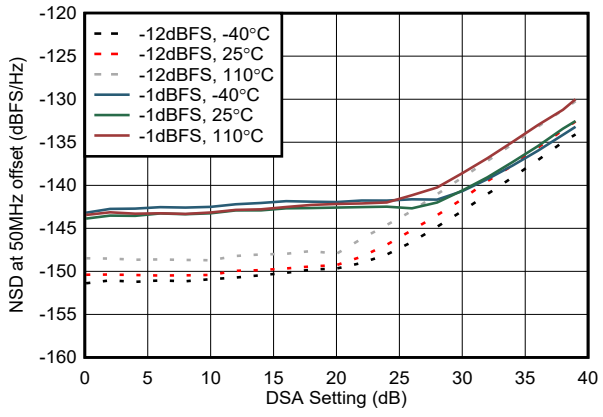
50-MHz offset

図 6-223. TX NSD vs Digital Amplitude at 8.11 GHz



50-MHz offset

図 6-224. TX NSD vs DSA Setting at 8.11 GHz



50-MHz offset

図 6-225. TX NSD vs DSA Setting at 8.11 GHz

6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

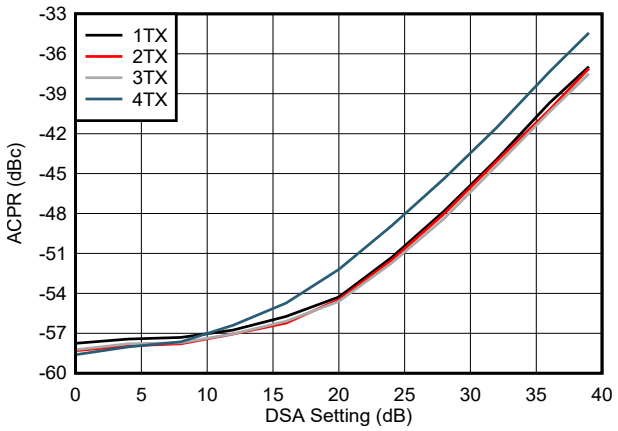


図 6-226. TX NR100MHz ACPR vs DSA Setting 8.11 GHz

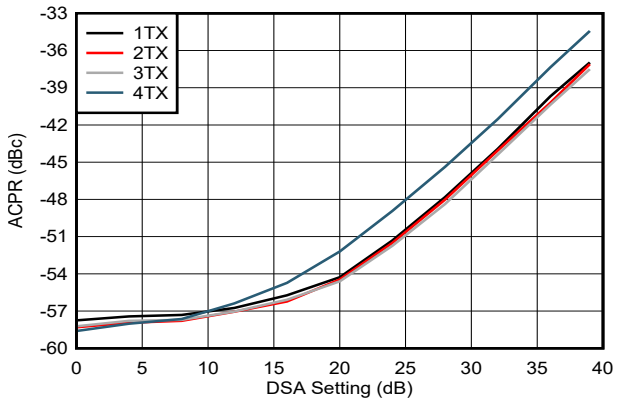


図 6-227. TX NR100MHz alt-ACPR vs DSA Setting 8.11 GHz

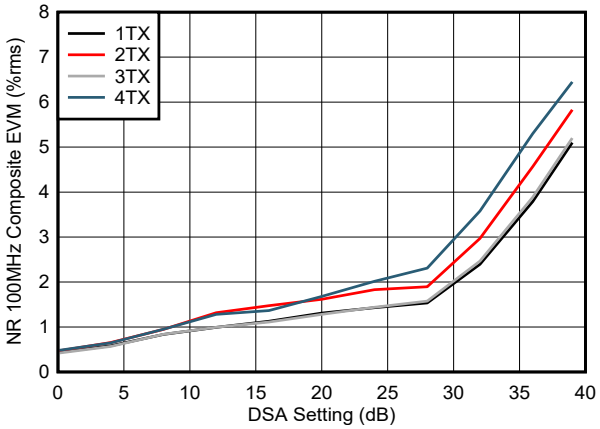


図 6-228. TX NR100MHz EVM vs DSA Setting 8.11 GHz

6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

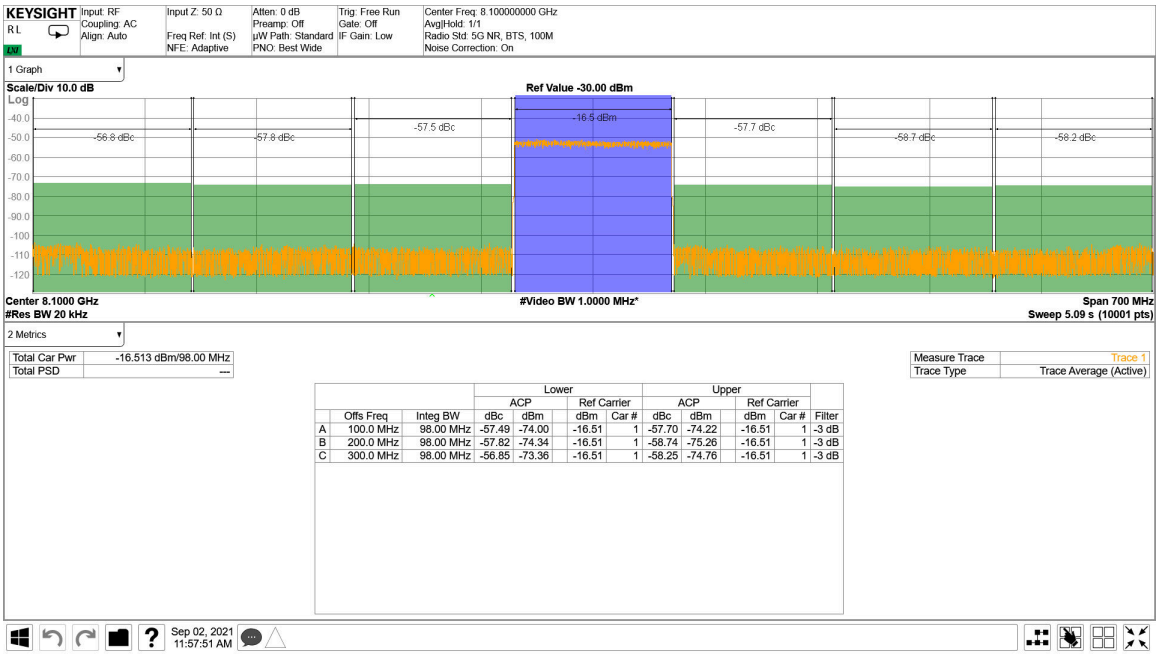


図 6-229. TX 100MHz NR Output Spectrum at 8.11 GHz

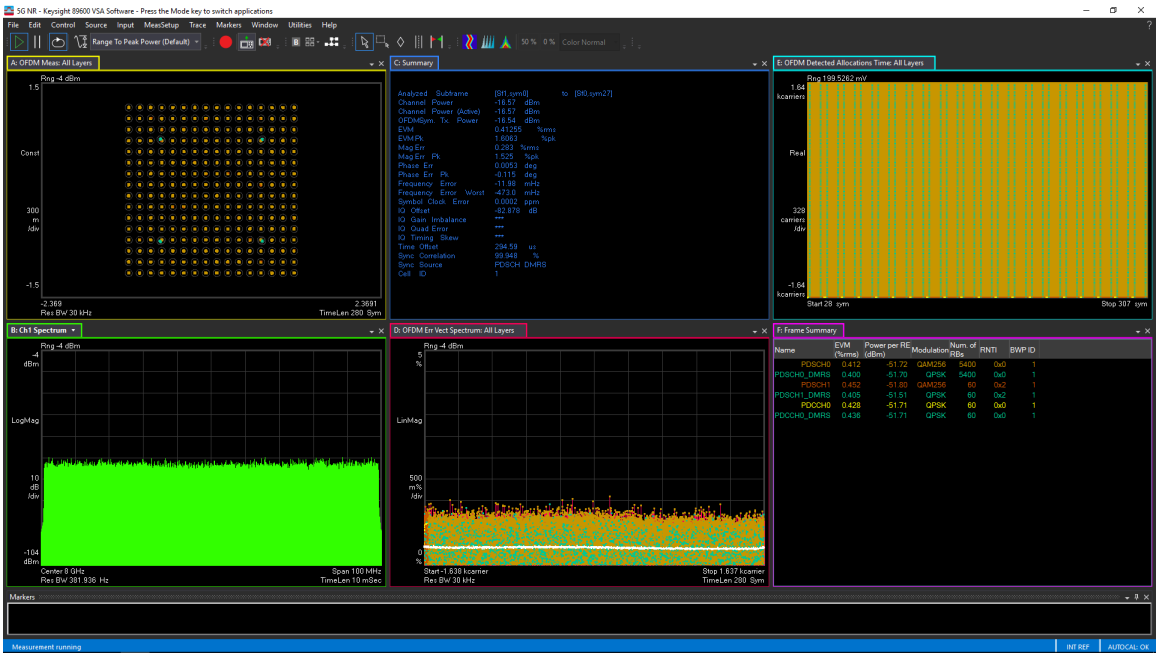


図 6-230. TX 100MHz NR EVM at 8.11 GHz

6.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 491.52 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

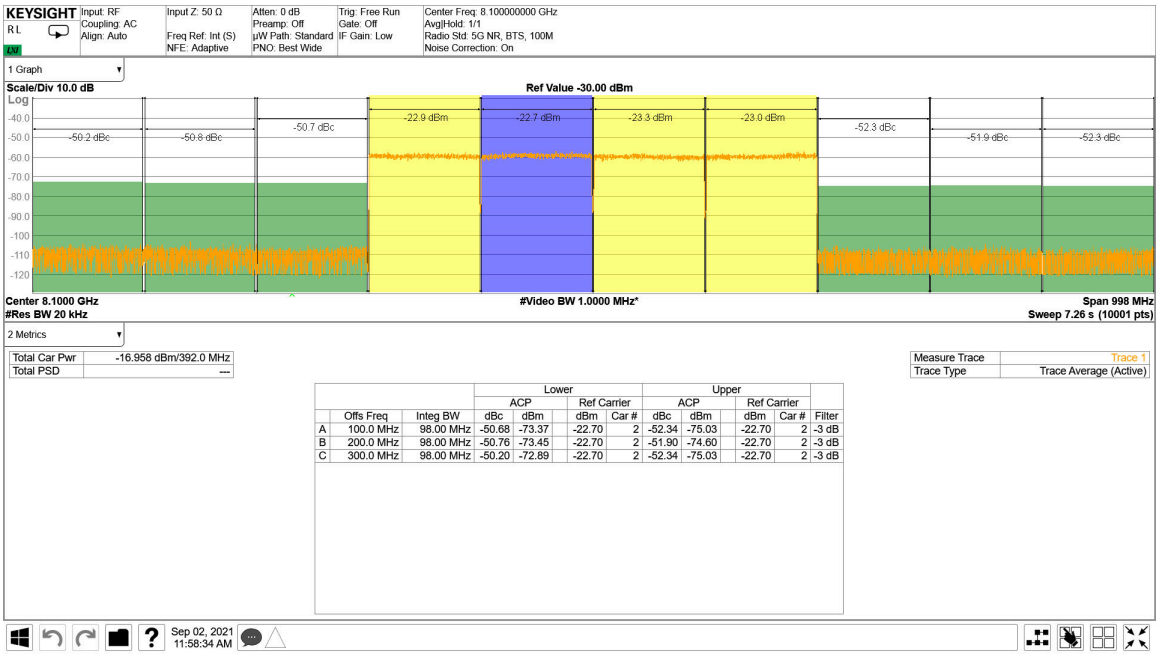


図 6-231. TX 4x100MHz NR Output Spectrum 8.11 GHz

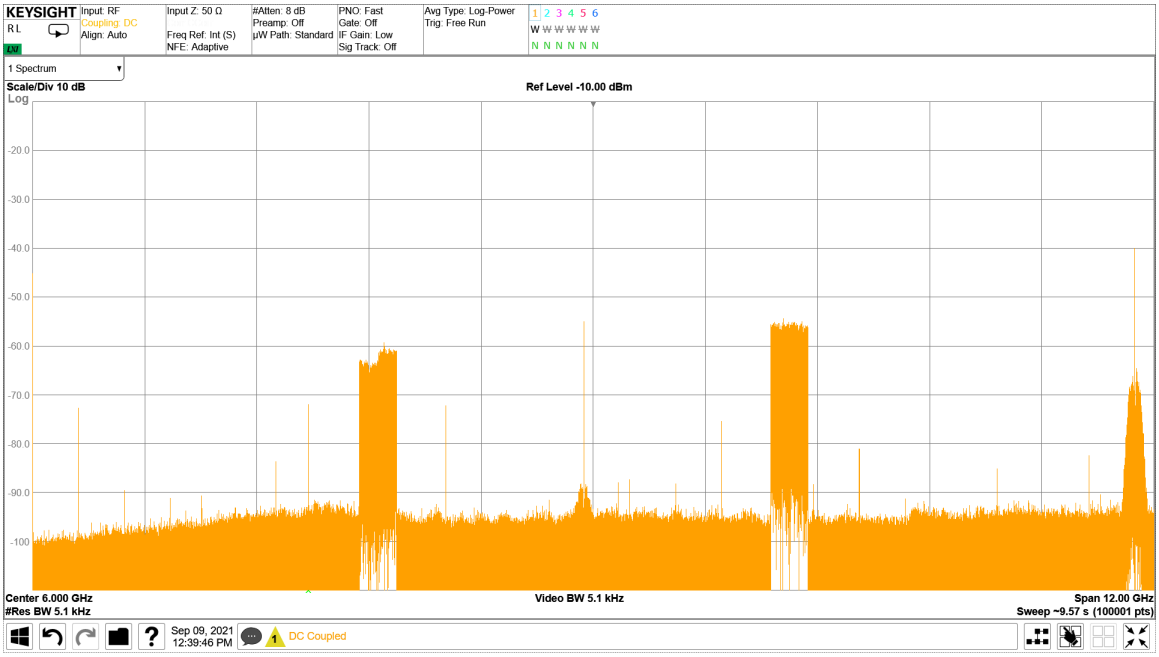
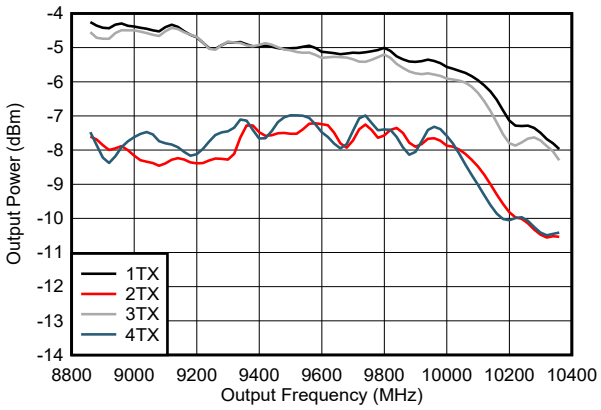


図 6-232. TX 4x100MHz NR Output Spectrum 8.11 GHz

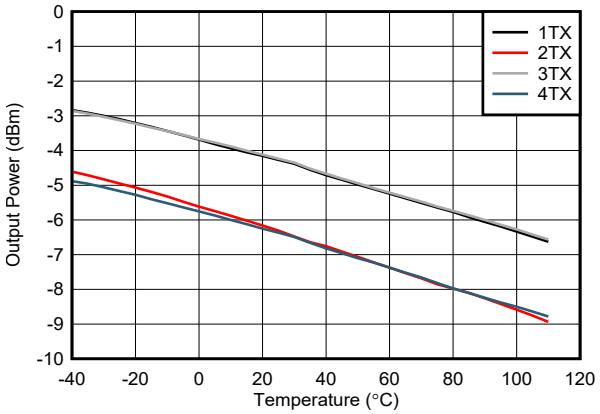
6.12.7 TX Typical Characteristics at 9.6 GHz

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching



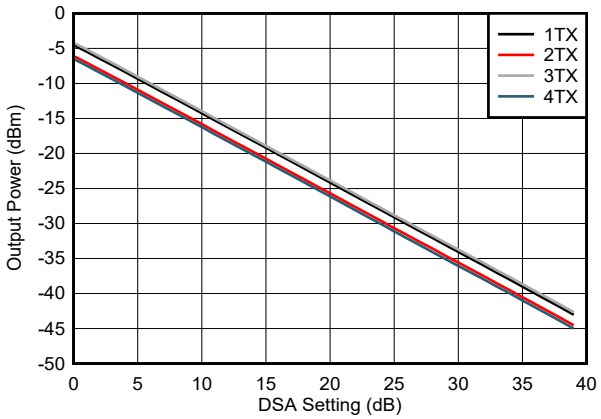
Includes PCB and cable losses.

図 6-233. TX Output Power vs Frequency at 9.61 GHz



Includes PCB and cable losses.

図 6-234. TX Output Power vs Frequency at 9.61 GHz



Includes PCB and cable losses.

図 6-235. TX Output Power vs DSA Setting at 9.61 GHz

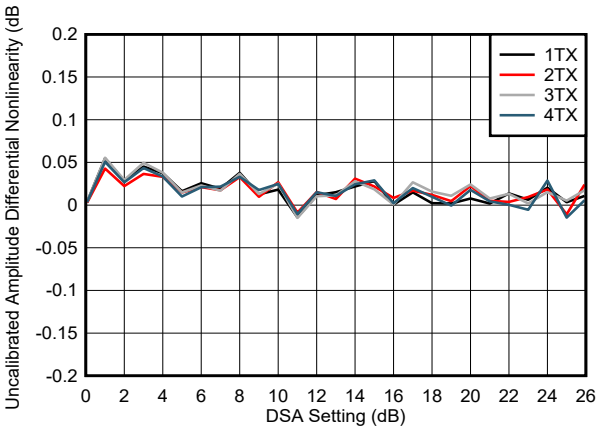


図 6-236. TX DSA Uncalibrated Amplitude Differential Nonlinearity

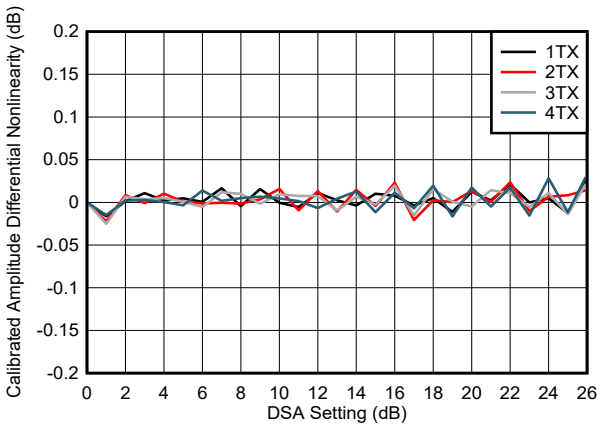


図 6-237. TX DSA Calibrated Amplitude Differential Nonlinearity

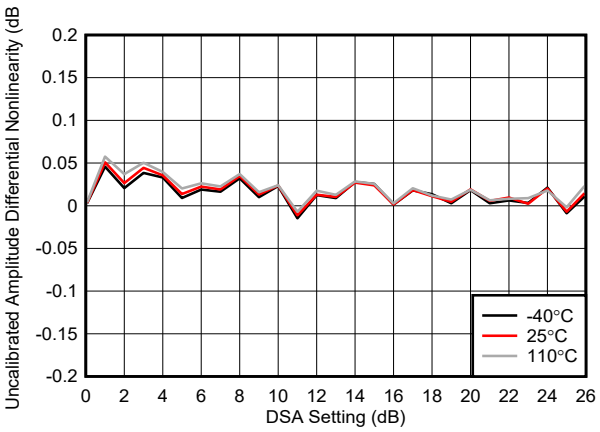


図 6-238. TX DSA Uncalibrated Amplitude Differential Nonlinearity

6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching

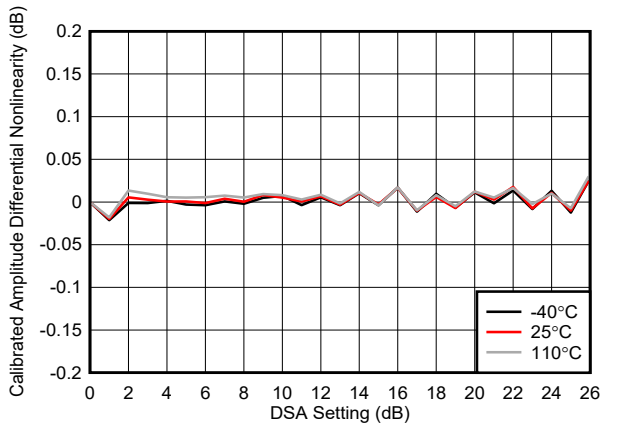


図 6-239. TX DSA Calibrated Amplitude Differential Nonlinearity

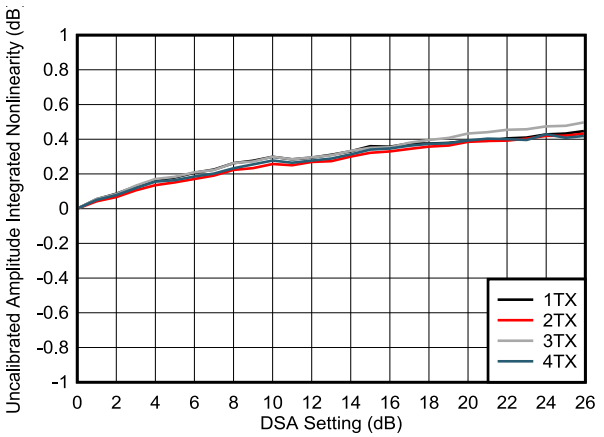


図 6-240. TX DSA Uncalibrated Amplitude Integrated Nonlinearity

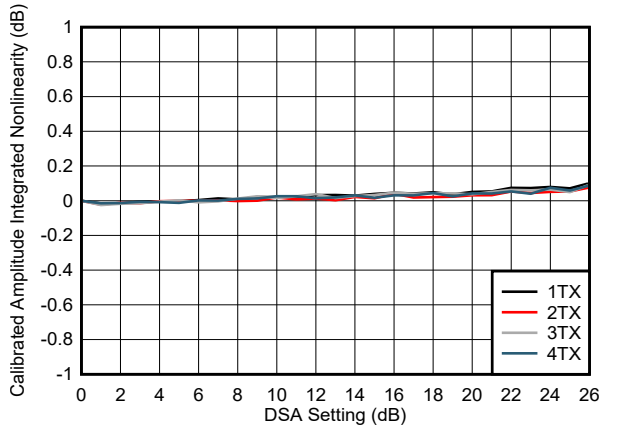


図 6-241. TX DSA Calibrated Amplitude Integrated Nonlinearity

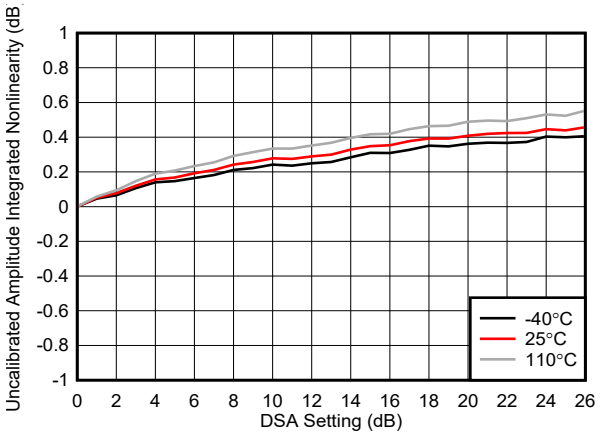


図 6-242. TX DSA Uncalibrated Amplitude Integrated Nonlinearity

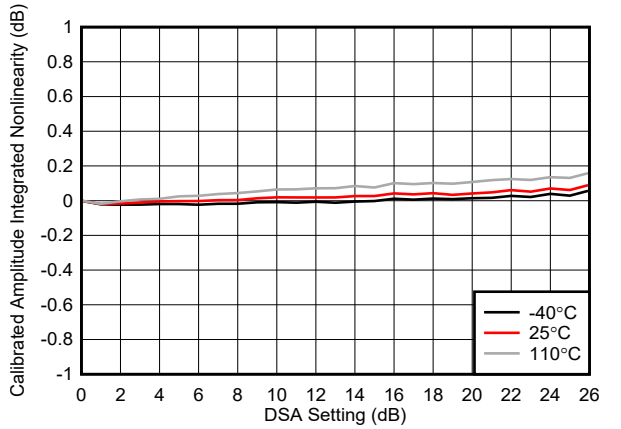


図 6-243. TX DSA Calibrated Amplitude Integrated Nonlinearity

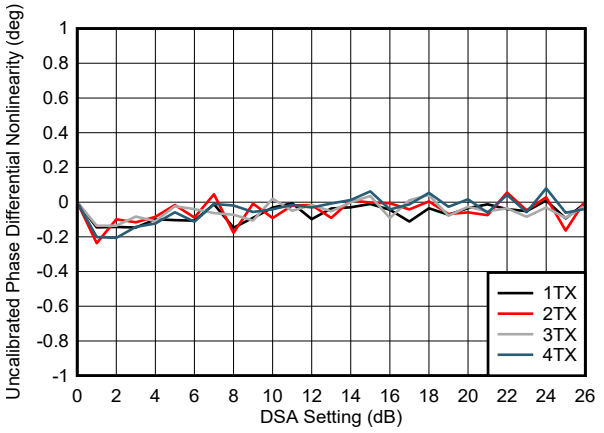


図 6-244. TX DSA Uncalibrated Phase Differential Nonlinearity

6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching

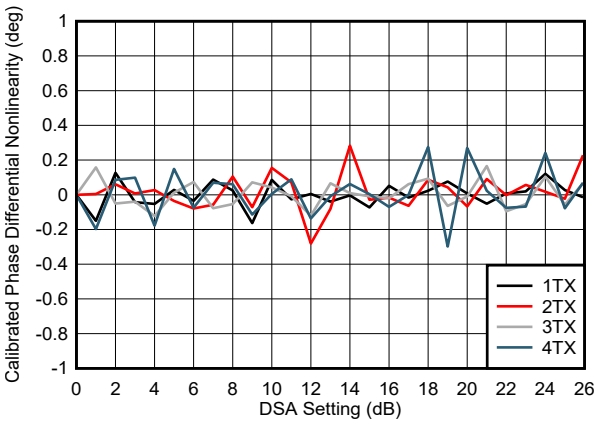


図 6-245. TX DSA Calibrated Phase Differential Nonlinearity

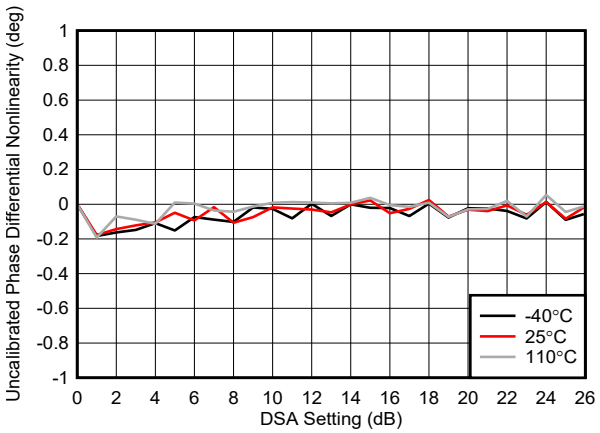


図 6-246. TX DSA Uncalibrated Phase Differential Nonlinearity

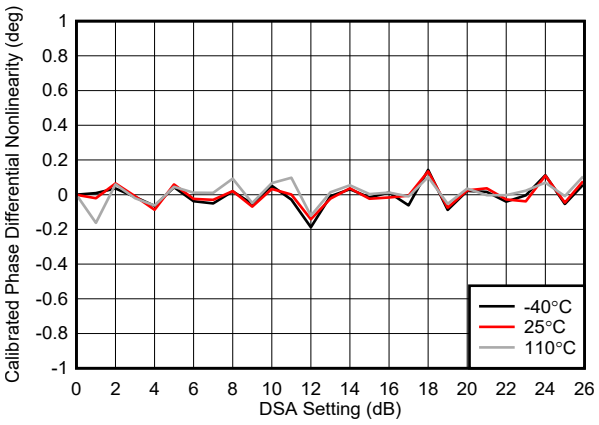


図 6-247. TX DSA Calibrated Phase Differential Nonlinearity

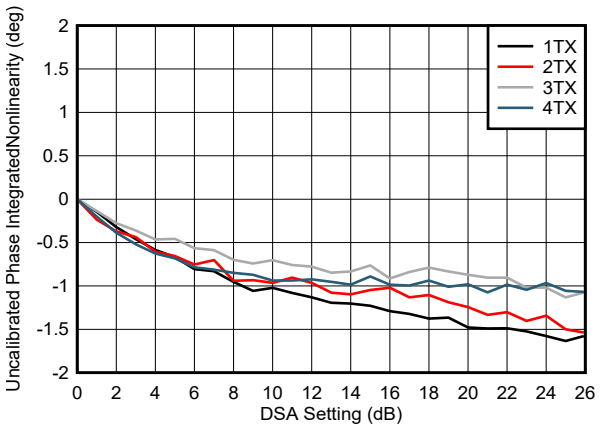


図 6-248. TX DSA Uncalibrated Phase Integrated Nonlinearity

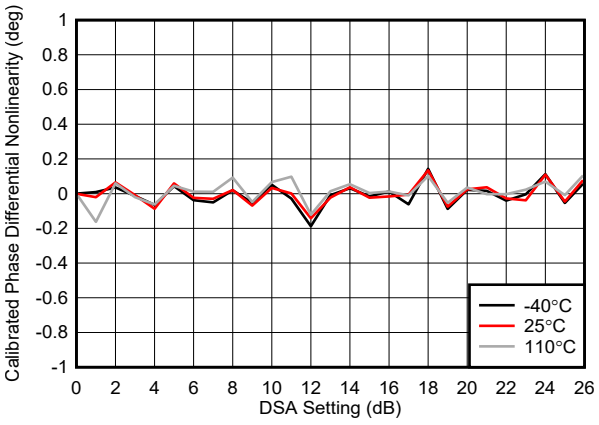


図 6-249. TX DSA Calibrated Phase Integrated Nonlinearity

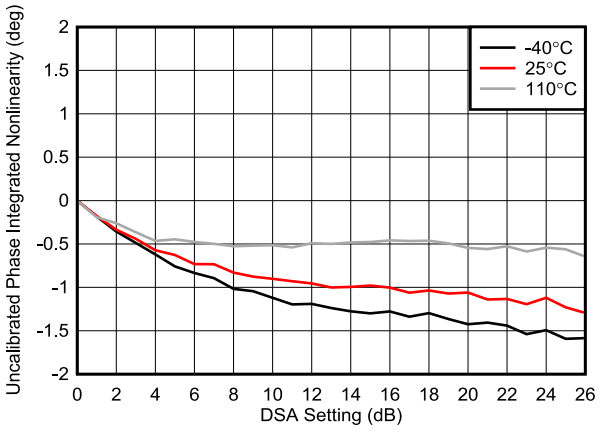


図 6-250. TX DSA Uncalibrated Phase Integrated Nonlinearity

6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching

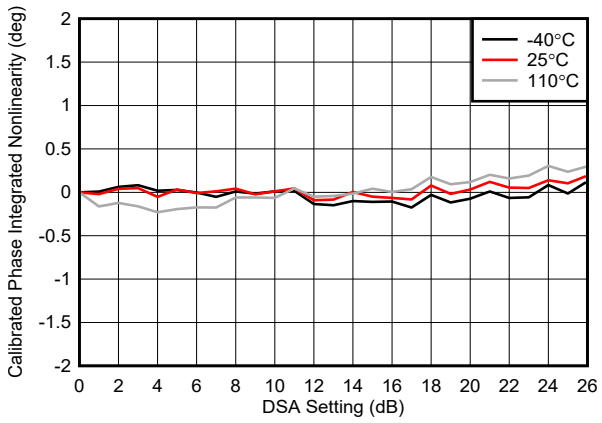
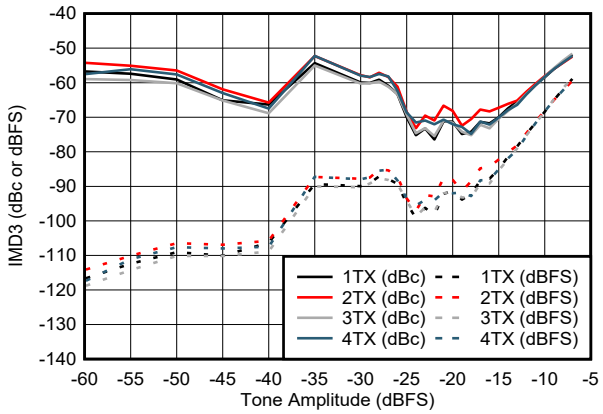
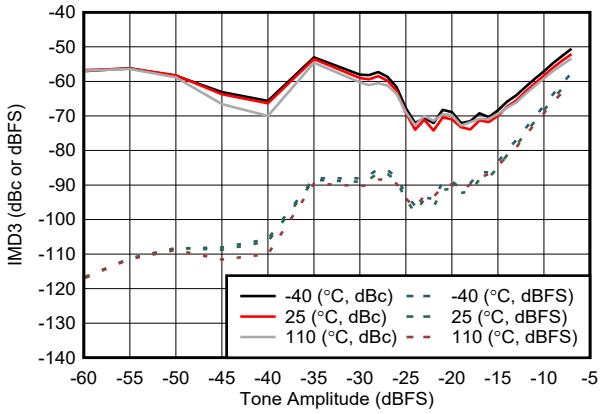


図 6-251. TX DSA Calibrated Amplitude Integrated Nonlinearity



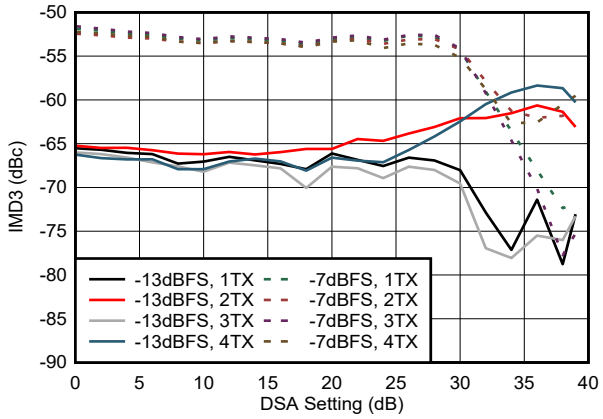
50-MHz tone spacing

図 6-252. TX IMD3 vs Digital Amplitude at 9.61 GHz



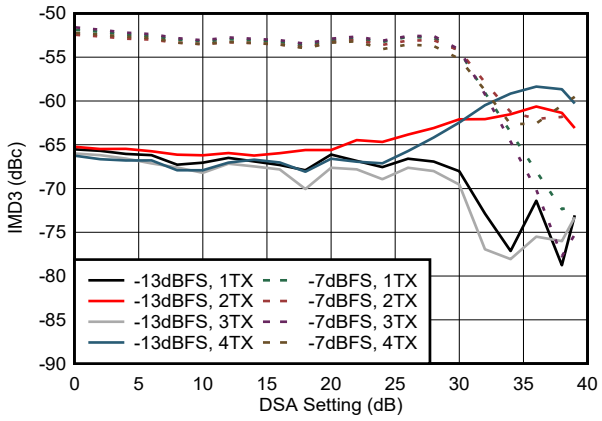
50-MHz tone spacing

図 6-253. TX IMD3 vs Digital Amplitude at 9.61 GHz



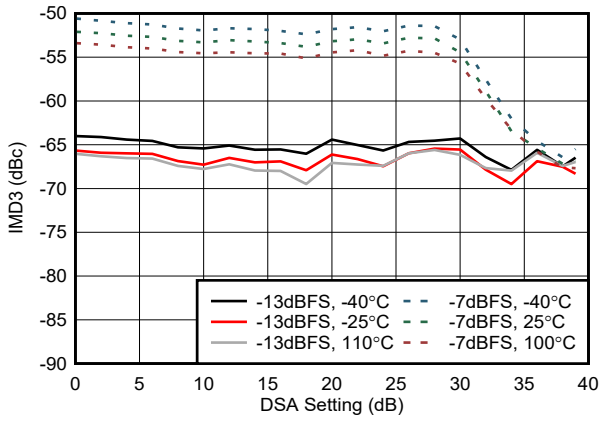
50-MHz tone spacing

図 6-254. TX IMD3 vs DSA Setting at 9.61 GHz



50-MHz tone spacing

図 6-255. TX IMD3 vs DSA Setting at 9.61 GHz



50-MHz tone spacing

図 6-256. TX IMD3 vs DSA Setting at 9.61 GHz

6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching

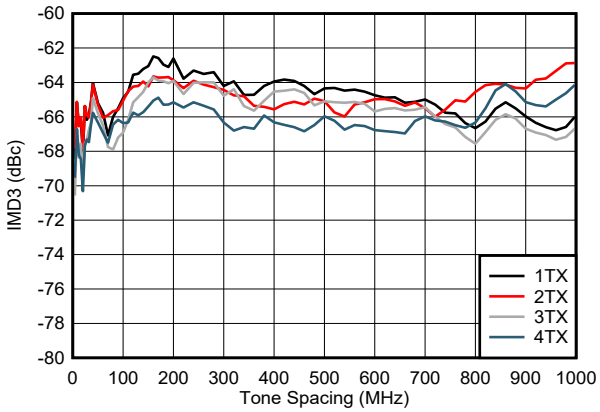


図 6-257. TX IMD3 vs Tone Spacing at 9.61 GHz

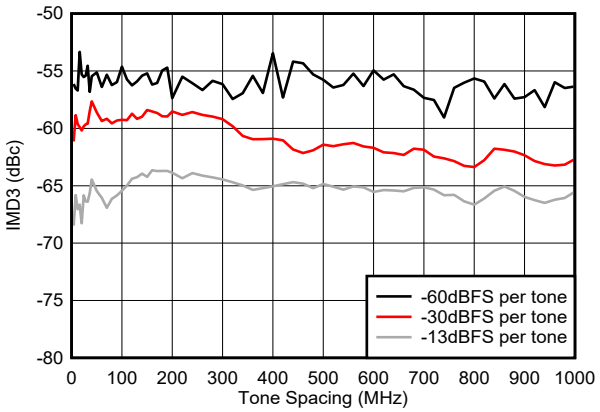


図 6-258. TX IMD3 vs Tone Spacing at 9.61 GHz

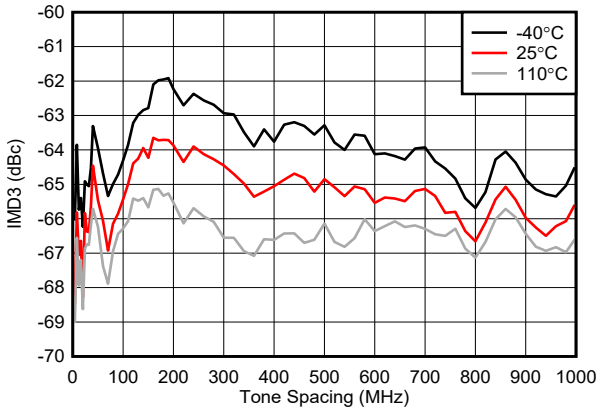


図 6-259. TX IMD3 vs Tone Spacing at 9.61 GHz

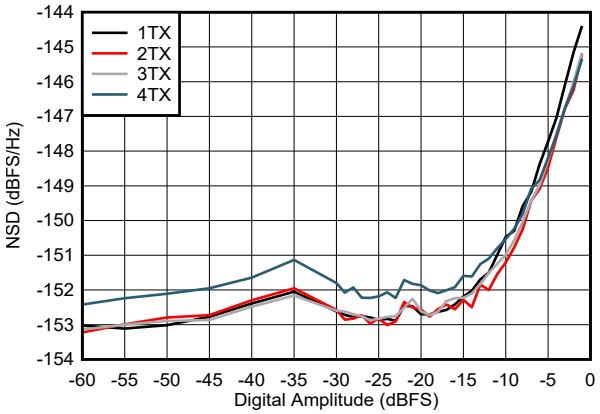


図 6-260. TX NSD vs Digital Amplitude at 9.61 GHz

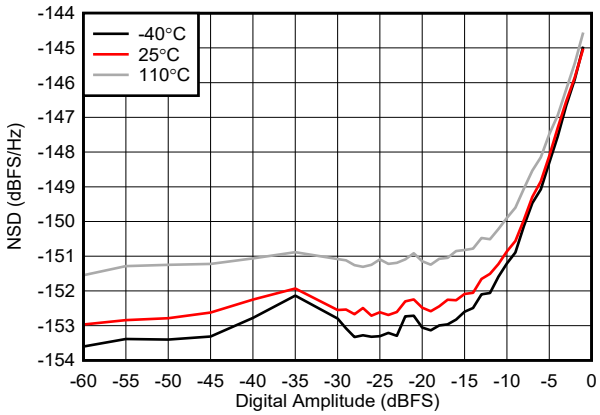


図 6-261. TX NSD vs Digital Amplitude at 9.61 GHz

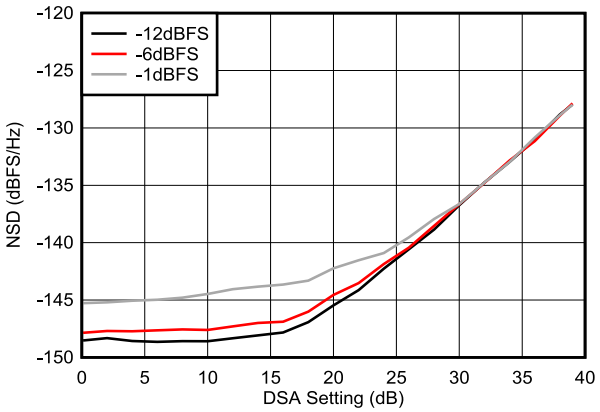


図 6-262. TX NSD vs DSA Setting at 9.61 GHz

6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching

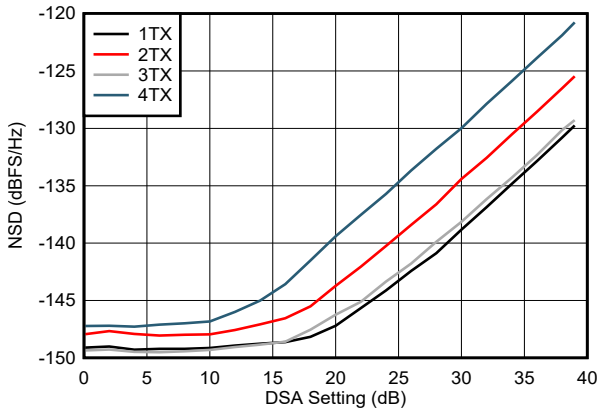


図 6-263. TX NSD vs DSA Setting at 9.61 GHz

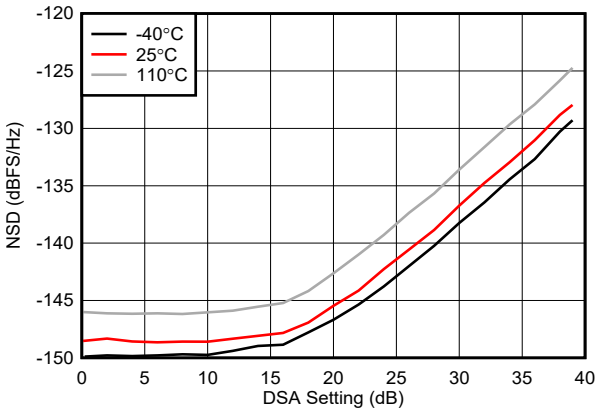
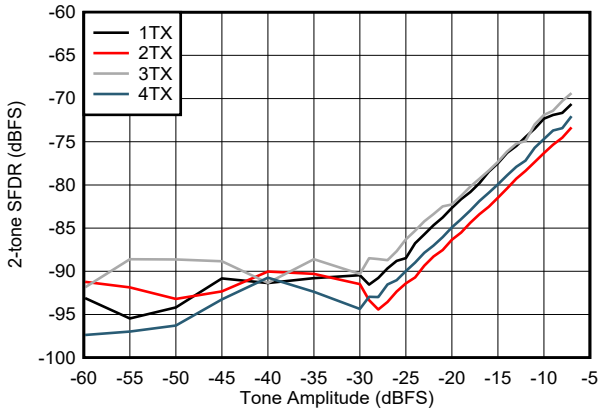
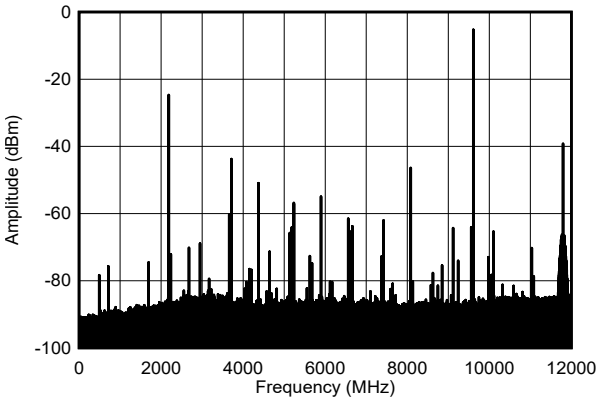


図 6-264. TX NSD vs DSA Setting at 9.61 GHz



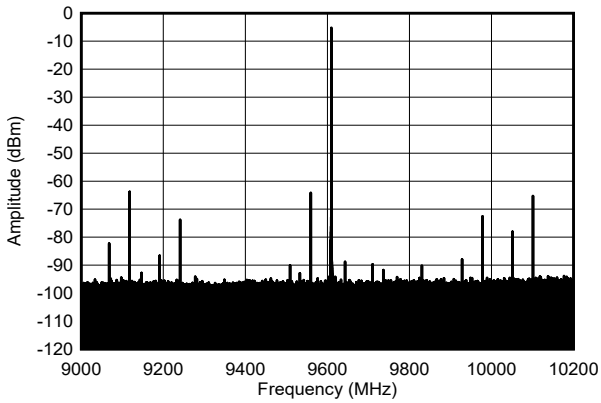
50-MHz tone spacing

図 6-265. TX 2-tone SFDR vs Digital Amplitude at 9.61 GHz



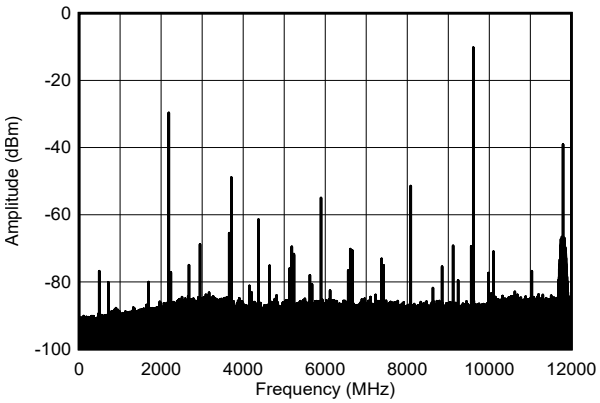
Includes PCB and cable losses.

図 6-266. TX Single Tone Spectrum at 9.61 GHz and -1dBFS (wideband)



Includes PCB and cable losses.

図 6-267. TX Single Tone Spectrum at 9.61 GHz and -1dBFS (1.2GHz BW)

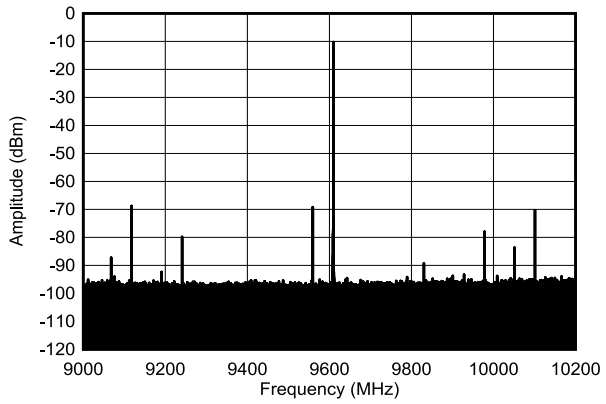


Includes PCB and cable losses.

図 6-268. TX Single Tone Spectrum at 9.61 GHz and -6dBFS (wideband)

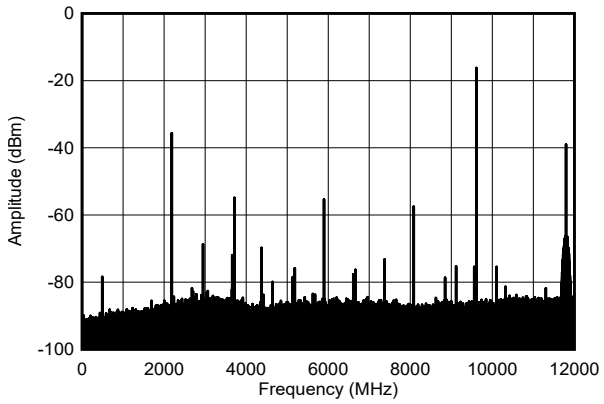
6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching



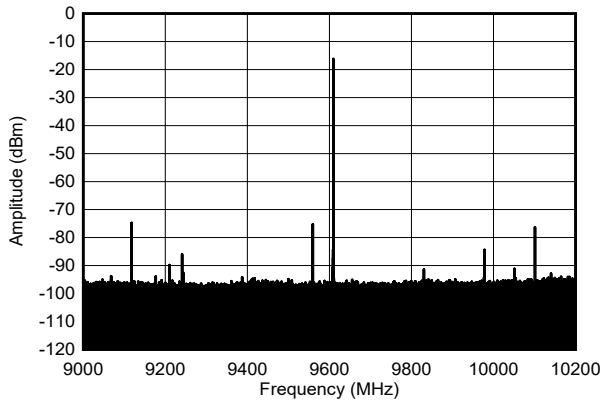
Includes PCB and cable losses.

図 6-269. TX Single Tone Spectrum at 9.61 GHz and -6dBFS (1.2GHz BW)



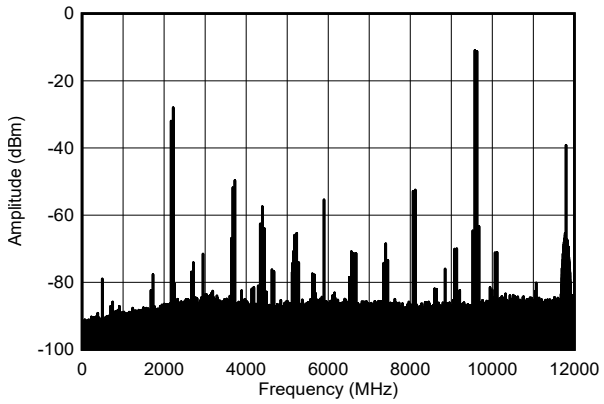
Includes PCB and cable losses.

図 6-270. TX Single Tone Spectrum at 9.61 GHz and -12dBFS (wideband)



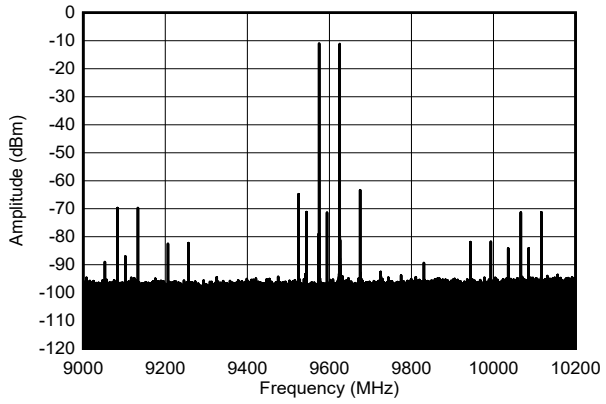
Includes PCB and cable losses.

図 6-271. TX Single Tone Spectrum at 9.61 GHz and -12dBFS (1.2GHz BW)



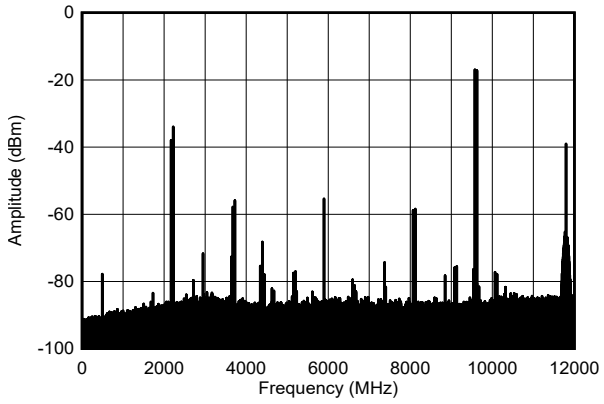
Includes PCB and cable losses, 50-MHz tone spacing.

図 6-272. TX 2-Tone Spectrum at 9.61 GHz and -7dBFS (wideband)



Includes PCB and cable losses, 50-MHz tone spacing.

図 6-273. TX 2-Tone Spectrum at 9.61 GHz and -7dBFS (1.2GHz BW)

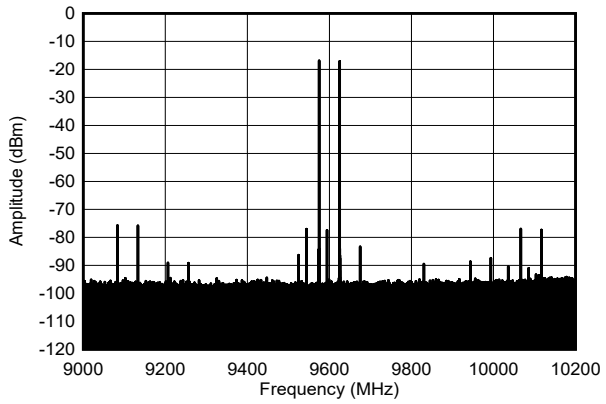


Includes PCB and cable losses, 50-MHz tone spacing.

図 6-274. TX 2-Tone Spectrum at 9.61 GHz and -13dBFS (wideband)

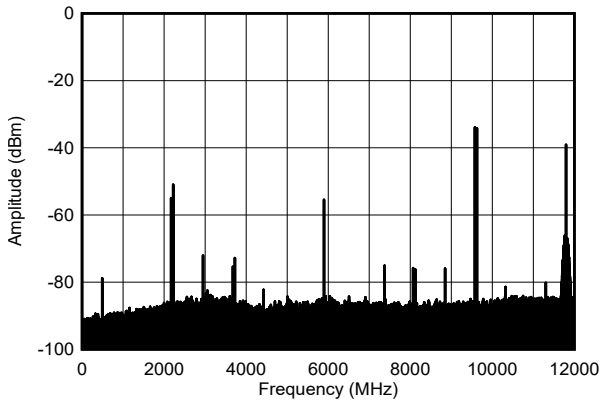
6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching



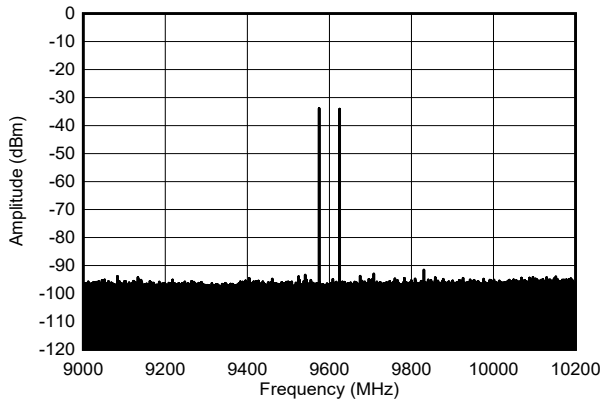
Includes PCB and cable losses, 50-MHz tone spacing.

図 6-275. TX 2-Tone Spectrum at 9.61 GHz and -13dBFS (1.2GHz BW)



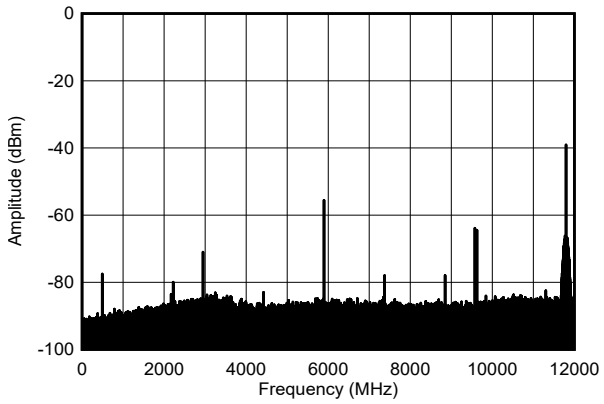
Includes PCB and cable losses, 50-MHz tone spacing.

図 6-276. TX 2-Tone Spectrum at 9.61 GHz and -30dBFS Each (wideband)



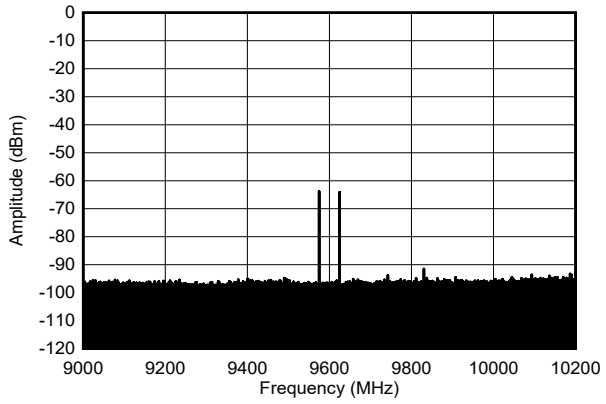
Includes PCB and cable losses, 50-MHz tone spacing.

図 6-277. TX 2-Tone Spectrum at 9.61 GHz and -30dBFS Each (1.2GHz BW)



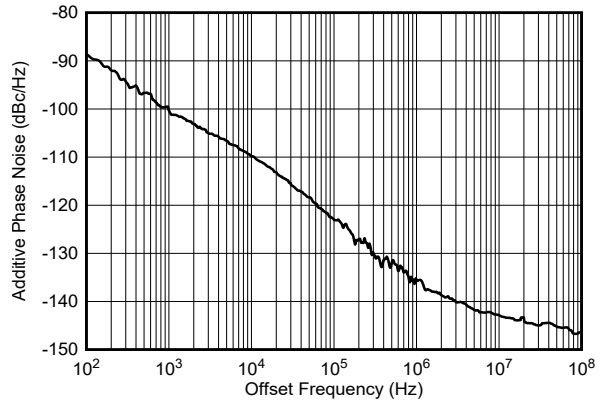
Includes PCB and cable losses, 50-MHz tone spacing.

図 6-278. TX 2-Tone Spectrum at 9.61 GHz and -60dBFS Each (wideband)



Includes PCB and cable losses, 50-MHz tone spacing.

図 6-279. TX 2-Tone Spectrum at 9.61 GHz and -60dBFS Each (1.2GHz BW)



Single sideband, external clock mode, input clock phase noise removed

図 6-280. TX Additive Phase Noise vs Offset Frequency at 9.61 GHz

6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching

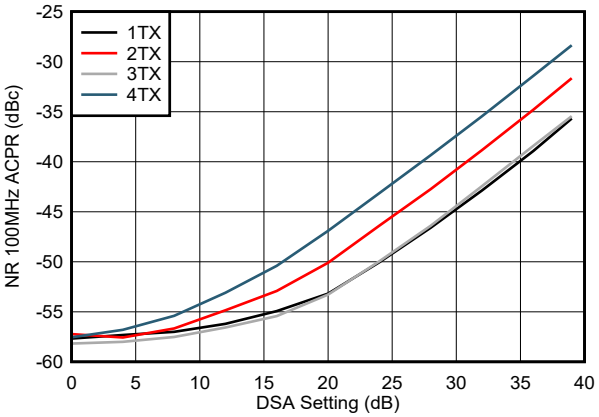


図 6-281. TX NR100MHz ACPR vs DSA Setting at 9.61 GHz

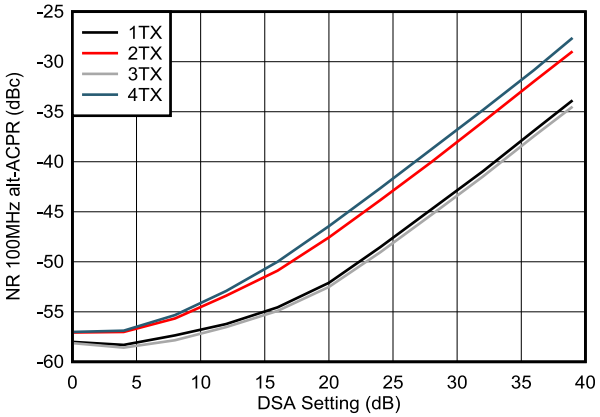


図 6-282. TX NR100MHz alt-ACPR vs DSA Setting at 9.61 GHz

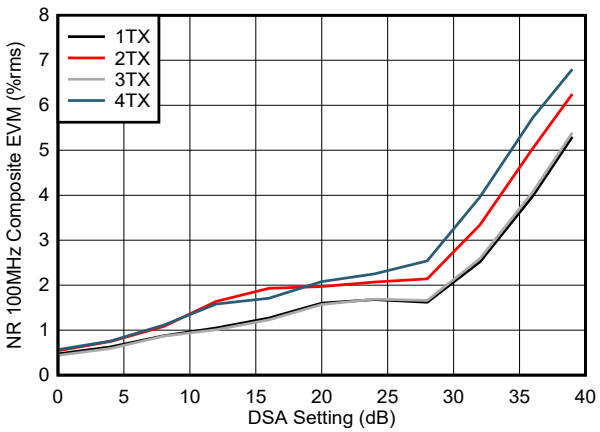
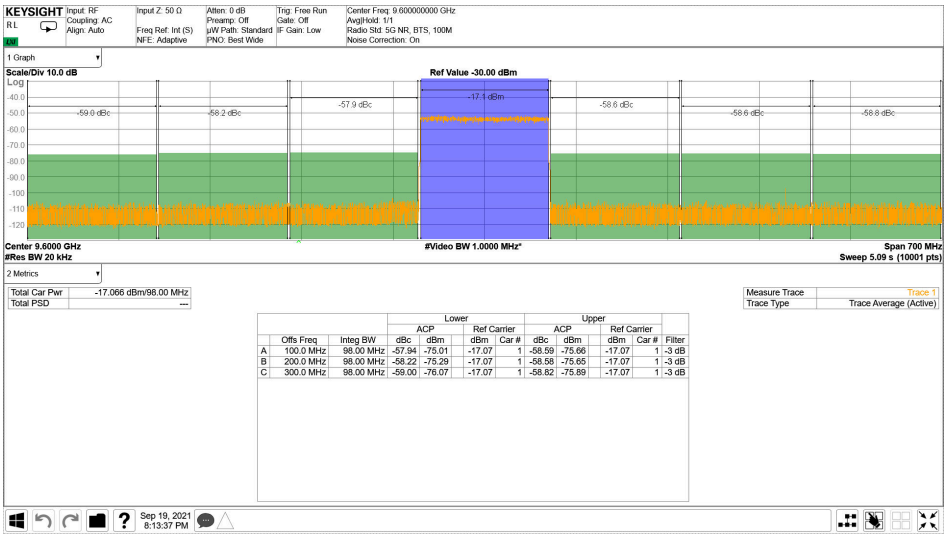


図 6-283. TX NR100MHz EVM vs DSA Setting at 9.61 GHz

6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

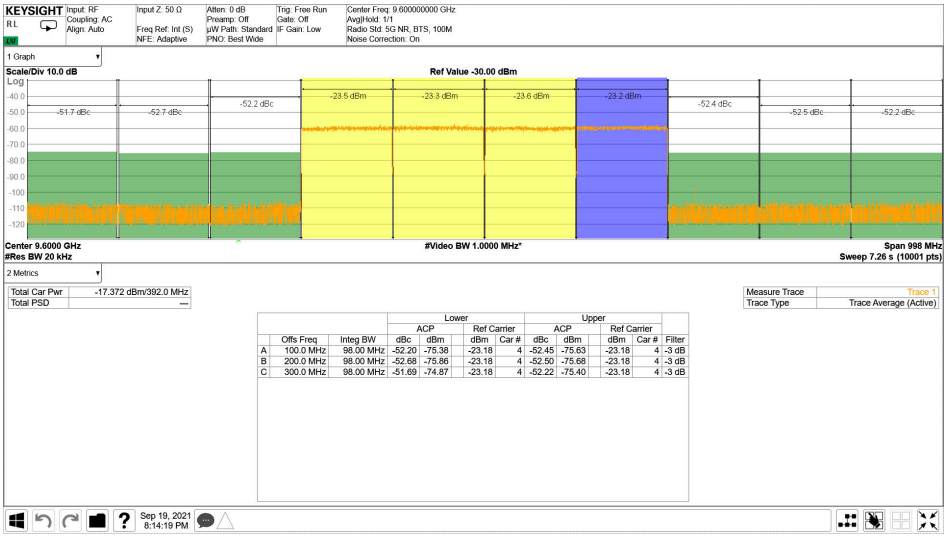
Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching



	Offs Freq	Integ BW	Lower ACP dBc	Lower ACP dBm	Lower Ref Carrier dBm	Lower Ref Carrier Car #	Upper ACP dBc	Upper ACP dBm	Upper Ref Carrier dBm	Upper Ref Carrier Car #	Filter
A	100.0 MHz	98.00 MHz	-57.94	-75.01	-17.07	1	-58.59	-75.66	-17.07	1	-3 dB
B	200.0 MHz	98.00 MHz	-58.22	-75.29	-17.07	1	-58.58	-75.65	-17.07	1	-3 dB
C	300.0 MHz	98.00 MHz	-59.00	-76.07	-17.07	1	-58.82	-75.89	-17.07	1	-3 dB

Includes PCB and cable losses.

図 6-284. TX NR100MHz Output Spectrum at 9.61 GHz



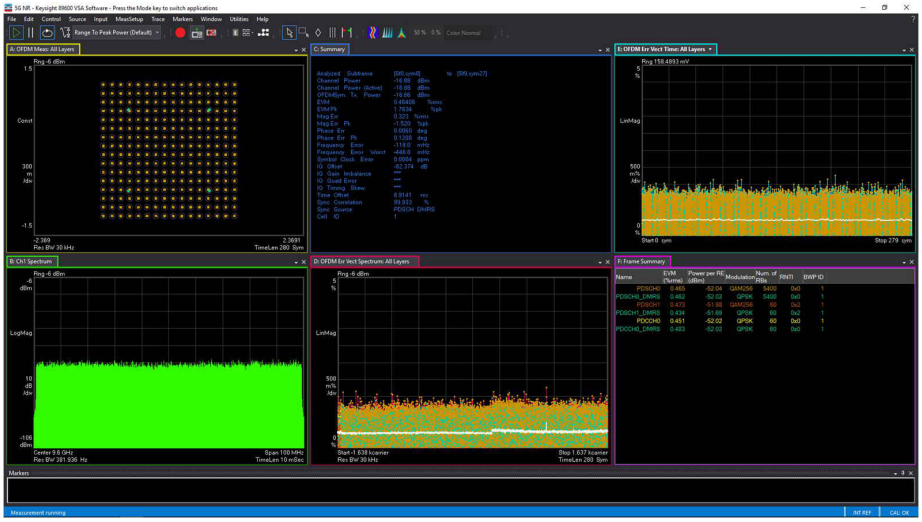
	Offs Freq	Integ BW	Lower ACP dBc	Lower ACP dBm	Lower Ref Carrier dBm	Lower Ref Carrier Car #	Upper ACP dBc	Upper ACP dBm	Upper Ref Carrier dBm	Upper Ref Carrier Car #	Filter
A	100.0 MHz	98.00 MHz	-52.20	-75.38	-23.18	4	-52.45	-75.63	-23.18	4	-3 dB
B	200.0 MHz	98.00 MHz	-52.68	-75.86	-23.18	4	-52.50	-75.68	-23.18	4	-3 dB
C	300.0 MHz	98.00 MHz	-51.69	-74.87	-23.18	4	-52.22	-75.40	-23.18	4	-3 dB

Includes PCB and cable losses.

図 6-285. TX 4xNR100MHz Output Spectrum at 9.61 GHz

6.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, f_{DAC} = 11796.48MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with f_{REF} = 1474.56 MHz, A_{OUT} = –1 dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6 GHz matching



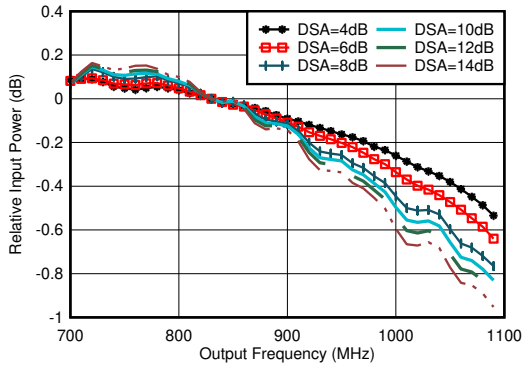
注

Includes PCB and cable losses.

図 6-286. TX 100MHz NR EVM at 9.61 GHz

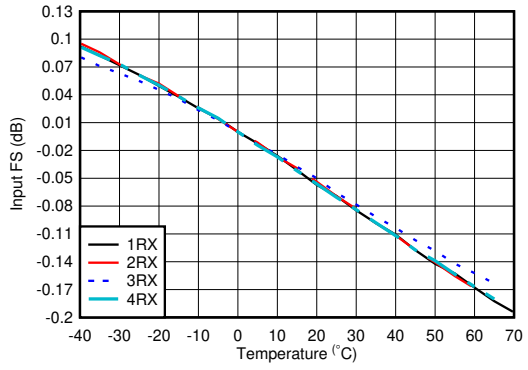
6.12.8 RX Typical Characteristics at 800 MHz

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 0.8 GHz matching, normalized to 830 MHz

図 6-287. RX In-Band Gain Flatness for Channel 1RX, f_{IN} = 830 MHz

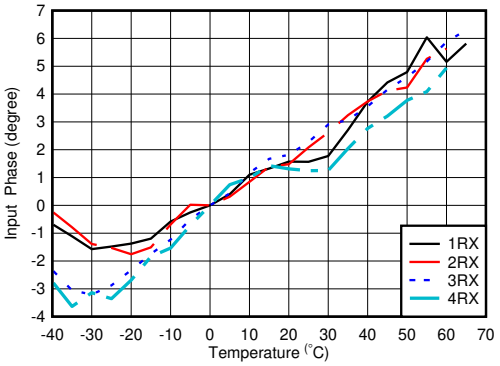


With 0.8 GHz matching, normalized to fullscale at 25°C for each channel

図 6-288. RX Input Fullscale vs Temperature and Channel at 800MHz

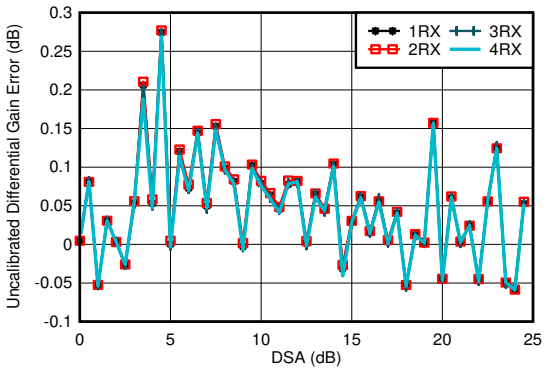
6.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 0.8 GHz matching, normalized to phase at 25°C

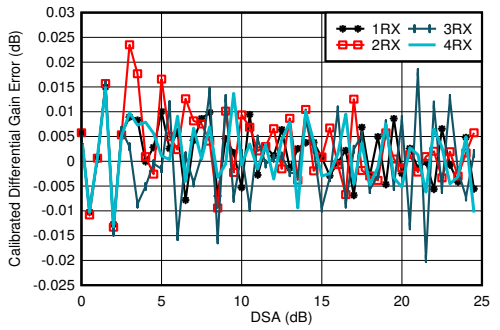
図 6-289. RX Input Phase vs Temperature and DSA at f_{OUT} = 0.8 GHz



With 0.8 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

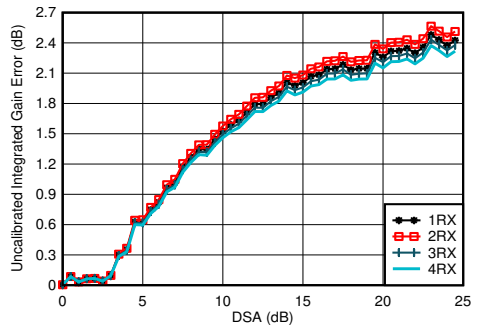
図 6-290. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 0.8 GHz



With 0.8 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

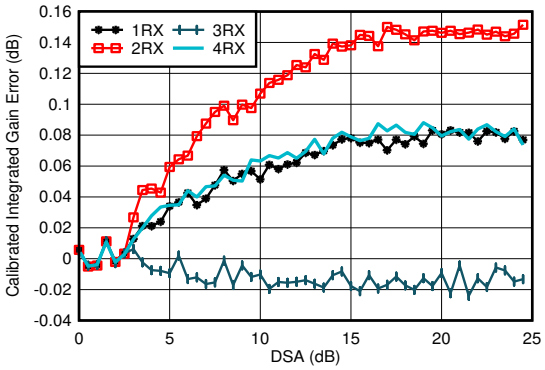
図 6-291. RX Calibrated Differential Amplitude Error vs DSA Setting at 0.8 GHz



With 0.8 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

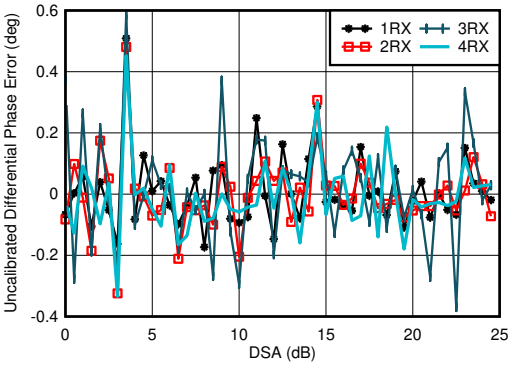
図 6-292. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 0.8 GHz



With 0.8 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

図 6-293. RX Calibrated Integrated Amplitude Error vs DSA Setting at 2.6 GHz



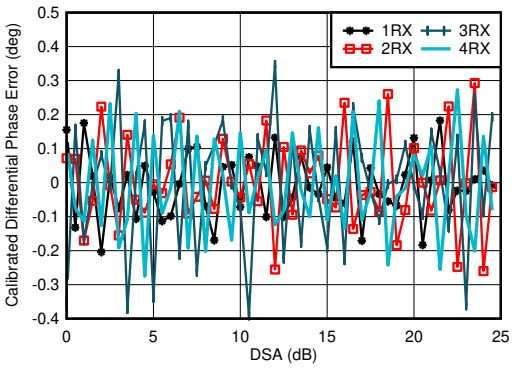
With 0.8 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

図 6-294. RX Uncalibrated Differential Phase Error vs DSA Setting at 0.8 GHz

6.12.8 RX Typical Characteristics at 800 MHz (continued)

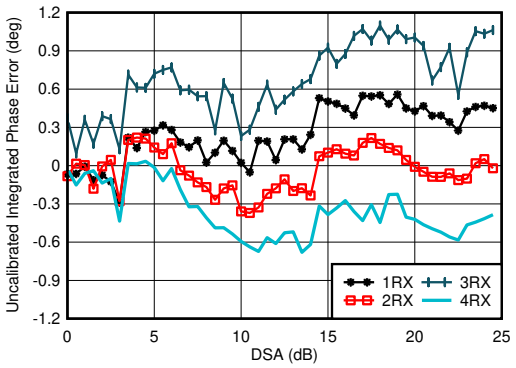
Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 0.8 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

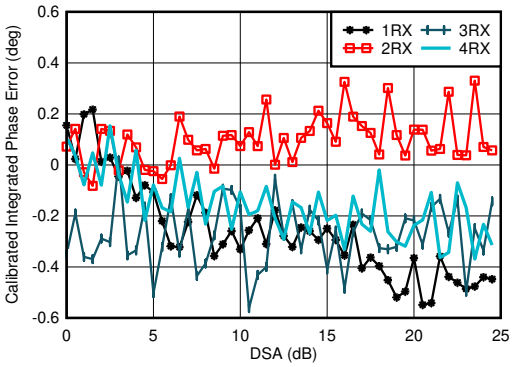
図 6-295. RX Calibrated Differential Phase Error vs DSA Setting at 0.8 GHz



With 0.8 GHz matching

Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

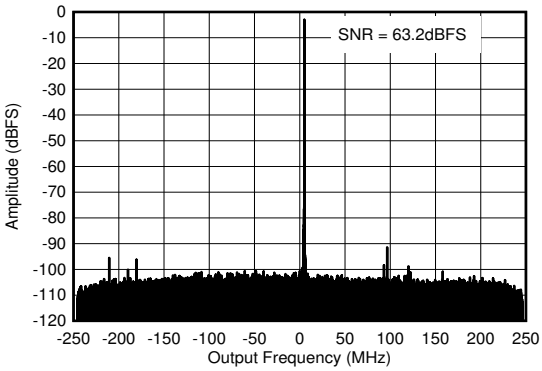
図 6-296. RX Uncalibrated Integrated Phase Error vs DSA Setting at 0.8 GHz



With 0.8 GHz matching

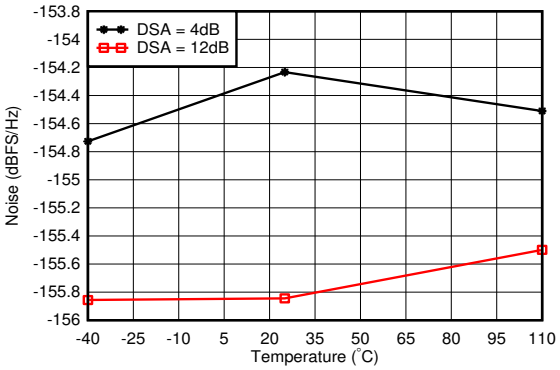
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-297. RX Calibrated Integrated Phase Error vs DSA Setting at 0.8 GHz



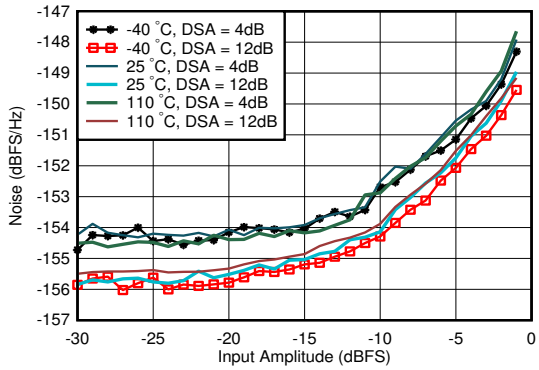
With 0.8 GHz matching, f_{IN} = 840 MHz, A_{IN}= –3 dBFS

図 6-298. RX Output FFT at 0.8 GHz



With 0.8 GHz matching, 12.5-MHz offset from tone

図 6-299. RX Noise Spectral Density vs Temperature at 0.8 GHz

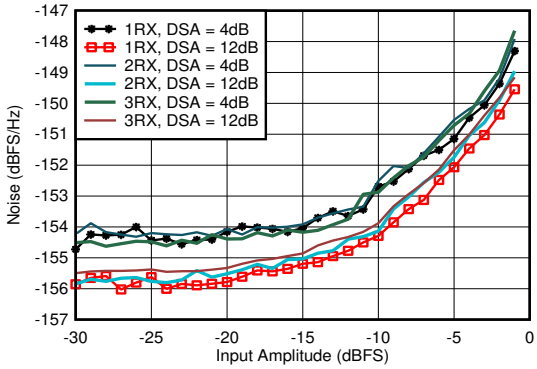


With 0.8 GHz matching, DSA Setting = 12 dB, 12.5-MHz offset from tone

図 6-300. RX Noise Spectral Density vs Input Amplitude and Temperature at 0.8 GHz

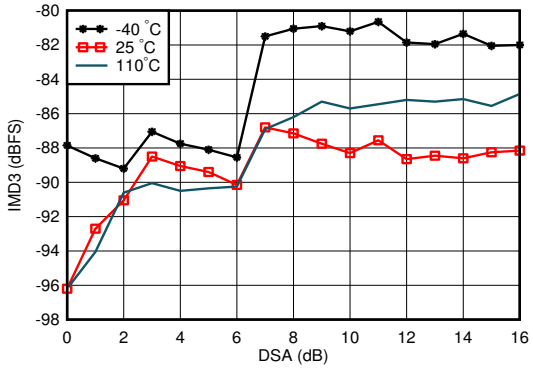
6.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



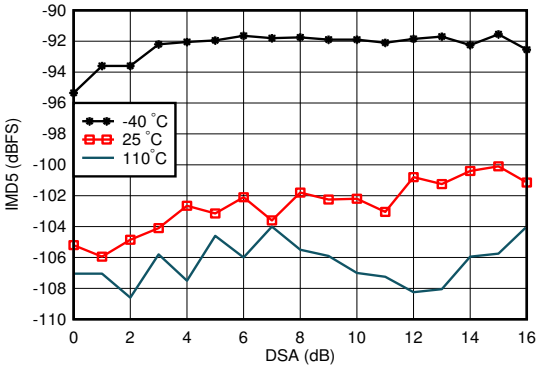
With 0.8 GHz matching, 12.5-MHz offset from tone

図 6-301. RX Noise Spectral Density vs Input Amplitude and Channel at 0.8 GHz



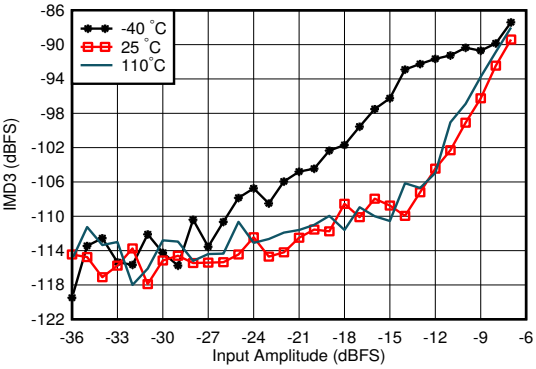
With 0.8 GHz matching, each tone –7 dBFS, tone spacing = 20 MHz

図 6-302. RX IMD3 vs DSA Setting and Temperature at 0.8 GHz



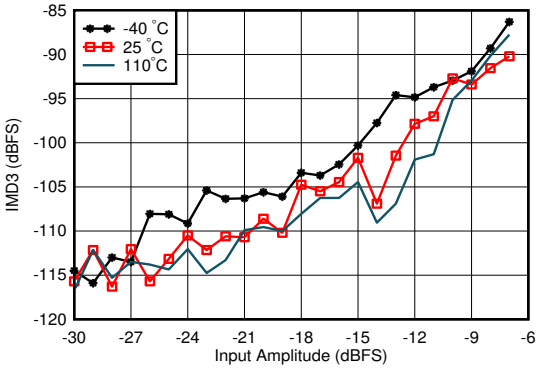
With 0.8 GHz matching, each tone –7 dBFS, tone spacing = 20 MHz

図 6-303. RX IMD5 vs DSA Setting and Temperature at 0.8 GHz



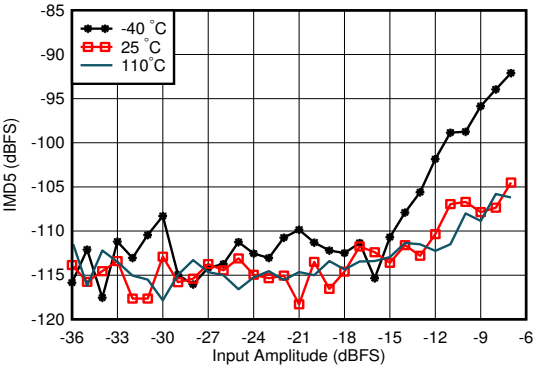
With 0.8 GHz matching, tone spacing = 20 MHz, DSA = 4 dB

図 6-304. RX IMD3 vs Input Level and Temperature at 0.8 GHz



With 0.8 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

図 6-305. RX IMD3 vs Input Level and Temperature at 0.8 GHz

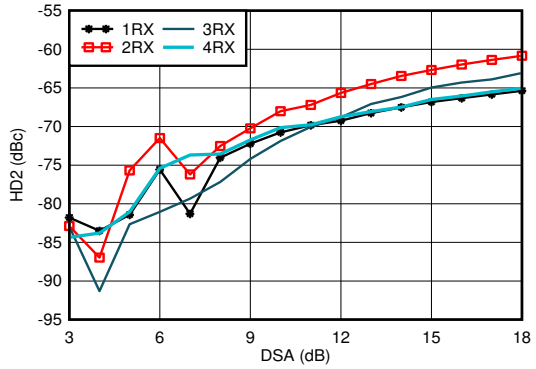


With 0.8 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

図 6-306. RX IMD5 vs Input Level and Temperature at 0.8 GHz

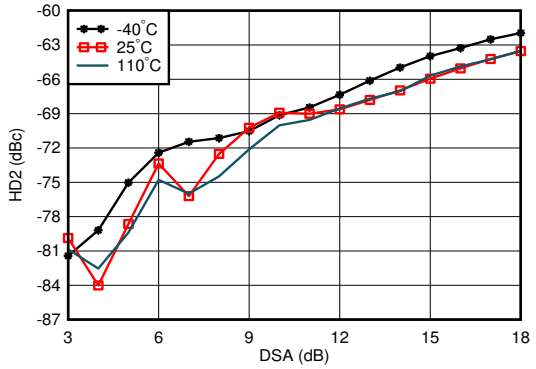
6.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



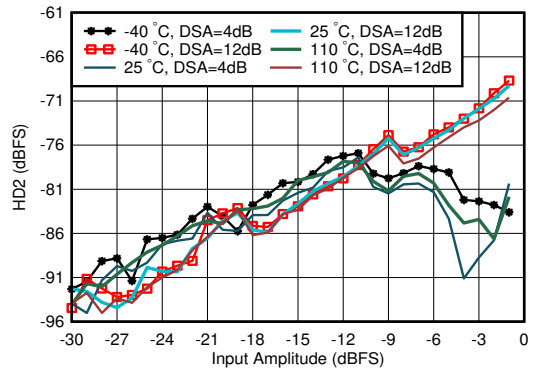
With 0.8 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-307. RX HD2 vs DSA Setting and Channel at 0.8 GHz



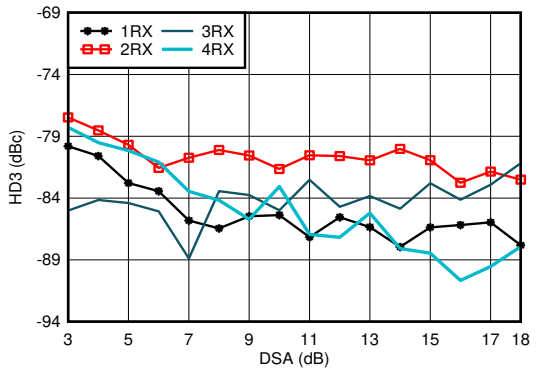
With 0.8 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-308. RX HD2 vs DSA Setting and Temperature at 0.8 GHz



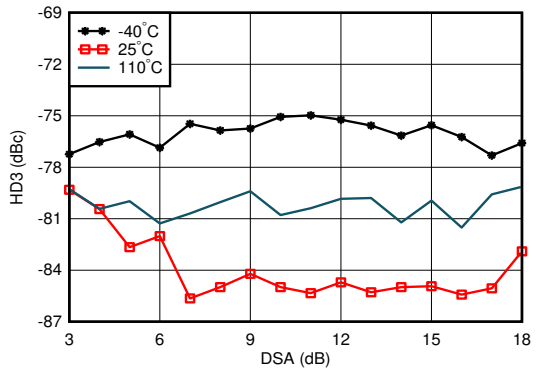
With 0.8 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-309. RX HD2 vs Input Level and Temperature at 0.8 GHz



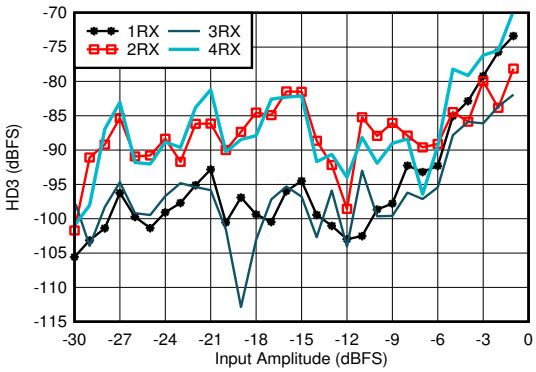
With 0.8 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-310. RX HD3 vs DSA Setting and Channel at 0.8 GHz



With 0.8 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-311. RX HD3 vs DSA Setting and Temperature at 0.8 GHz

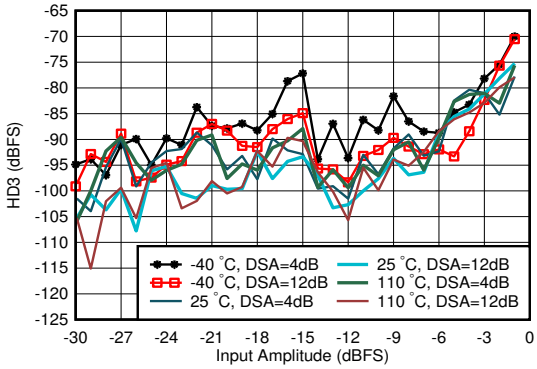


With 0.8 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-312. RX HD3 vs Input Level and Channel at 0.8 GHz

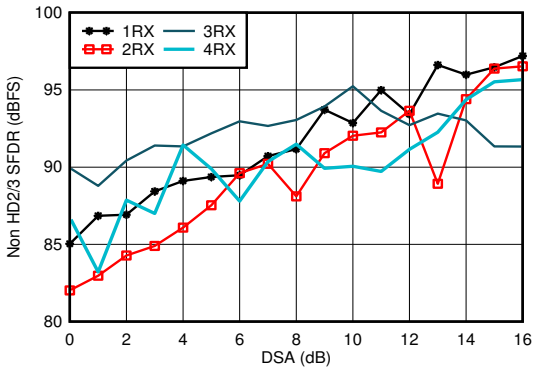
6.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



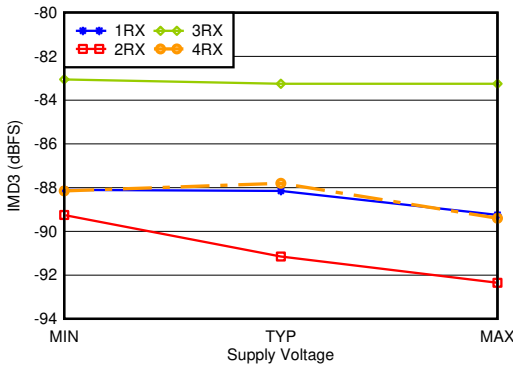
With 0.8 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-313. RX HD3 vs Input Level and Temperature at 0.8 GHz



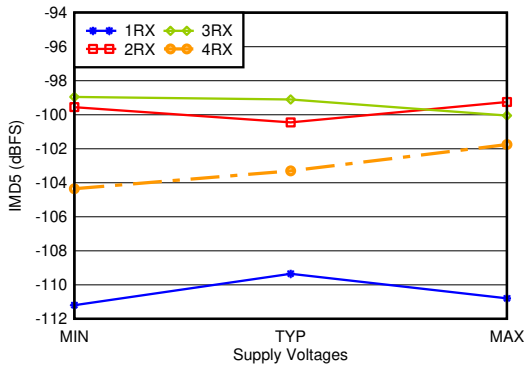
With 0.8 GHz matching

図 6-314. RX Non-HD2/3 vs DSA Setting at 0.8 GHz



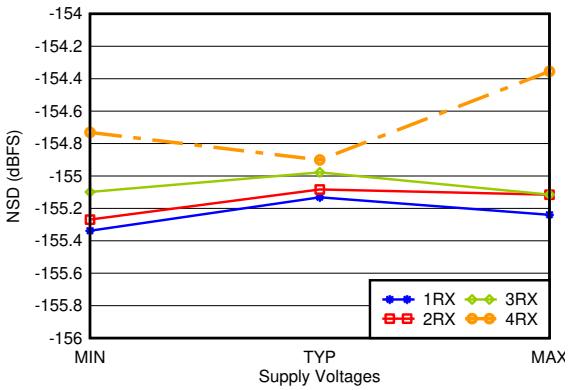
With 0.8 GHz matching, –7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-315. RX IMD3 vs Supply and Channel at 0.8 GHz



With 0.8 GHz matching, –7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-316. RX IMD5 vs Supply and Channel at 0.8 GHz

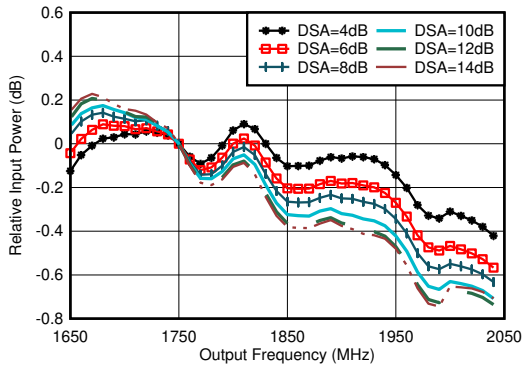


With 0.8 GHz matching, 12.5-MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-317. RX Noise Spectral Density vs Supply and Channel at 0.8 GHz

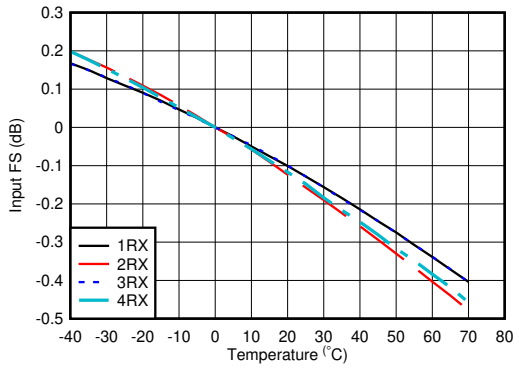
6.12.9 RX Typical Characteristics at 1.75 GHz – 1.9 GHz

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



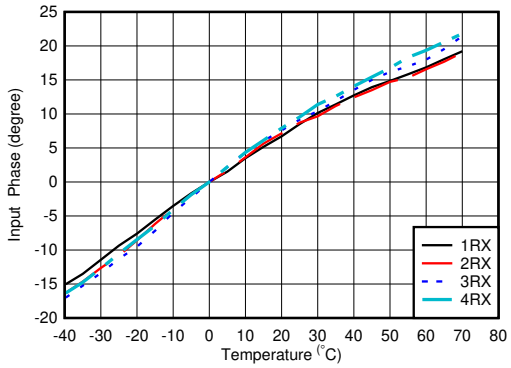
With 1.8 GHz matching, normalized to 1.75 GHz

図 6-318. RX In-Band Gain Flatness, f_{IN} = 1750 MHz



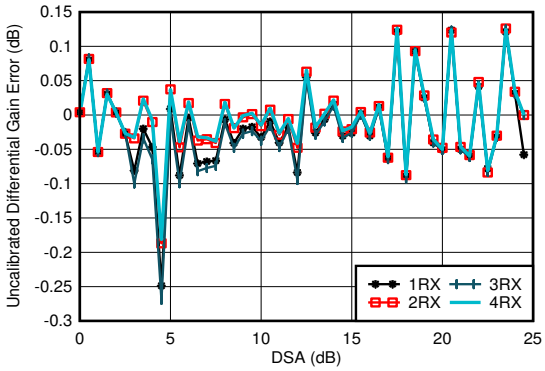
With 1.8 GHz matching, normalized to fullscale at 25°C for each channel

図 6-319. RX Input Fullscale vs Temperature and Channel at 1.75 GHz



With 2.6 GHz matching, normalized to phase at 25°C

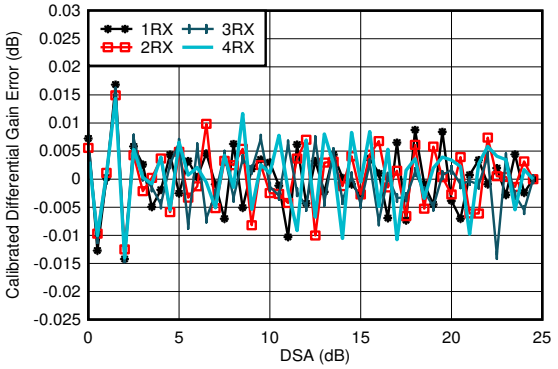
図 6-320. RX Input Phase vs Temperature and DSA at f_{IN} = 1.75 GHz



With 1.8 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

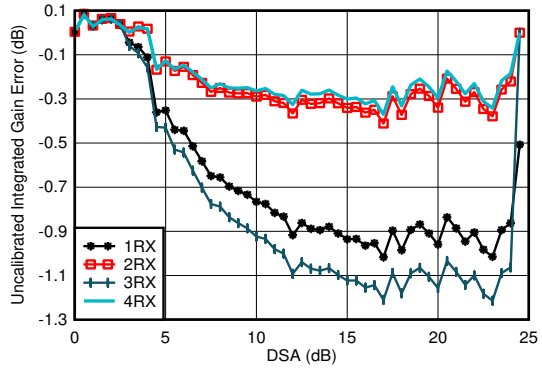
図 6-321. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 1.75 GHz



With 1.8 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

図 6-322. RX Calibrated Differential Amplitude Error vs DSA Setting at 1.75 GHz



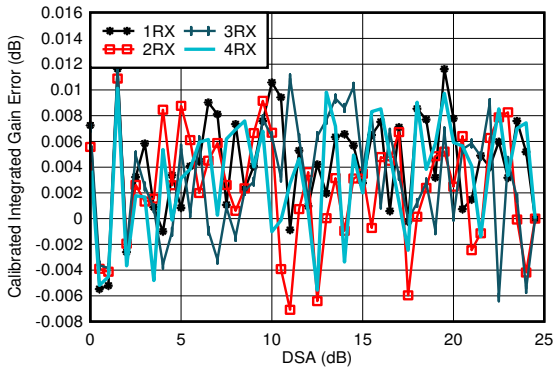
With 1.8 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

図 6-323. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 1.75 GHz

6.12.9 RX Typical Characteristics at 1.75 GHz – 1.9 GHz (continued)

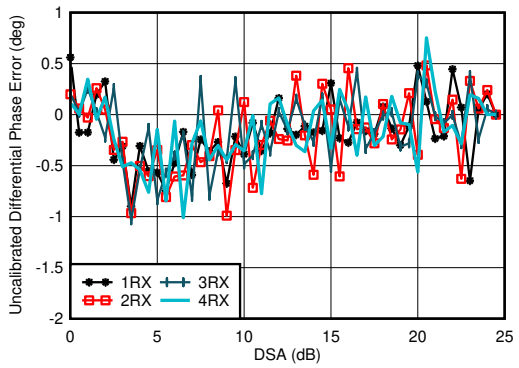
Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 1.8 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

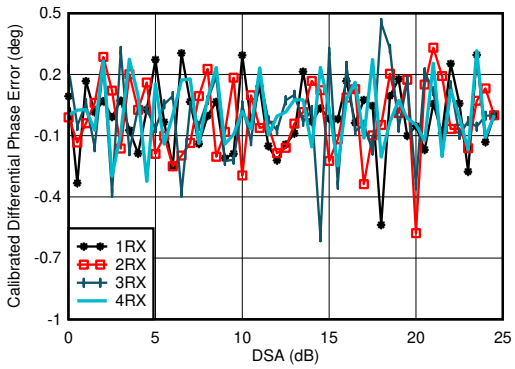
図 6-324. RX Calibrated Integrated Amplitude Error vs DSA Setting at 1.75 GHz



With 1.8 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

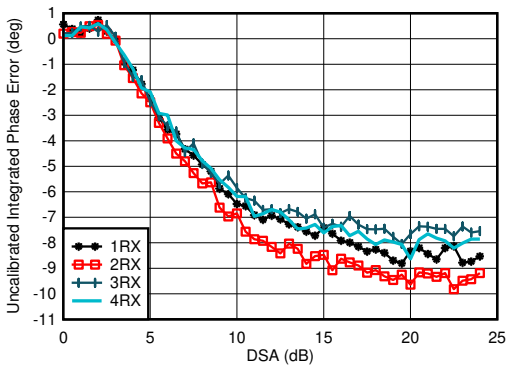
図 6-325. RX Uncalibrated Differential Phase Error vs DSA Setting at 1.75 GHz



With 1.8 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

図 6-326. RX Calibrated Differential Phase Error vs DSA Setting at 1.75 GHz



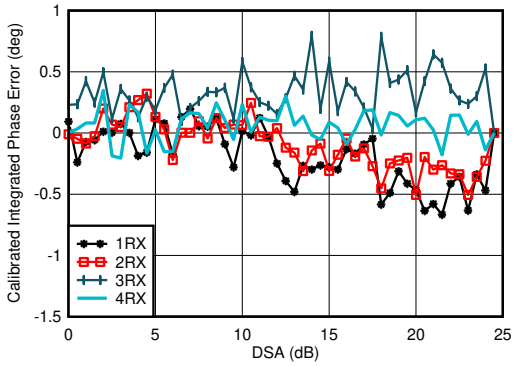
With 1.8 GHz matching

Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-327. RX Uncalibrated Integrated Phase Error vs DSA Setting at 1.75 GHz

6.12.9 RX Typical Characteristics at 1.75 GHz – 1.9 GHz (continued)

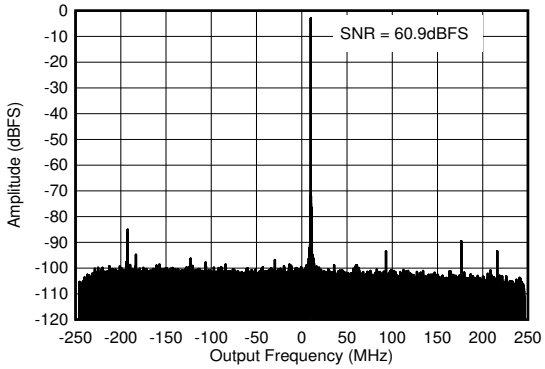
Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 1.8 GHz matching

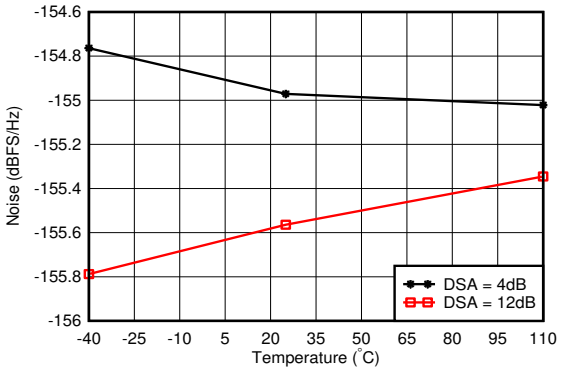
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-328. RX Calibrated Integrated Phase Error vs DSA Setting at 1.75 GHz



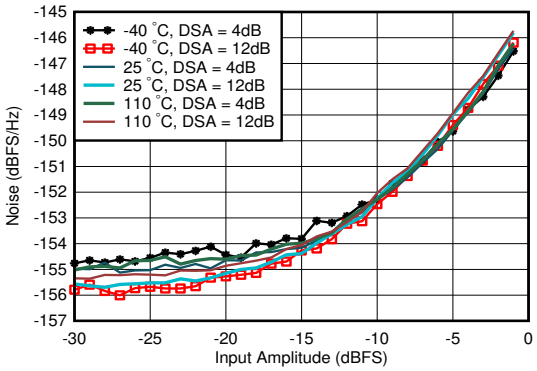
With 1.8 GHz matching, f_{IN} = 2610 MHz, A_{IN}= –3 dBFS

図 6-329. RX Output FFT at 1.75 GHz



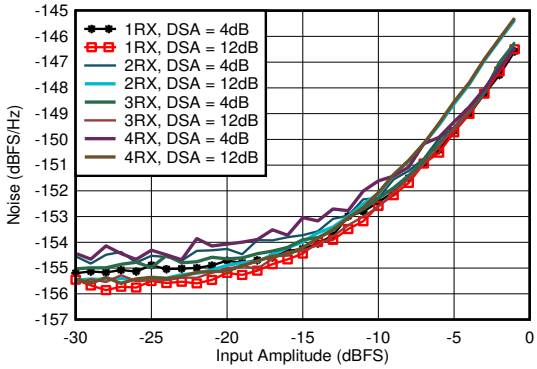
With 1.8 GHz matching, 12.5-MHz offset from tone

図 6-330. RX Noise Spectral Density vs Temperature at 1.75 GHz



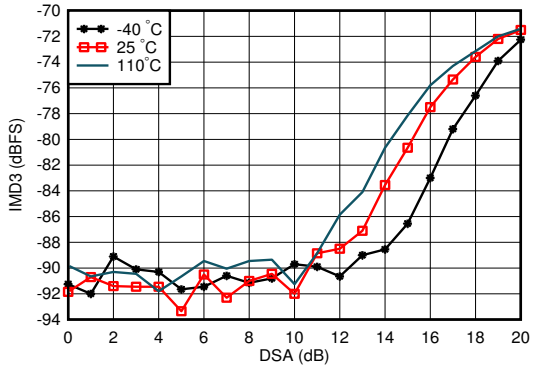
With 1.8 GHz matching, DSA Setting = 12 dB, 12.5-MHz offset from tone

図 6-331. RX Noise Spectral Density vs Input Amplitude and Temperature at 1.75 GHz



With 1.8 GHz matching, 12.5-MHz offset from tone

図 6-332. RX Noise Spectral Density vs Input Amplitude and Channel at 1.75 GHz

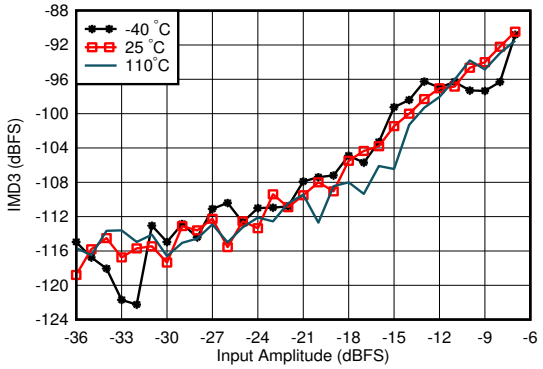


With 1.8 GHz matching, each tone –7 dBFS, tone spacing = 20 MHz

図 6-333. RX IMD3 vs DSA Setting and Temperature at 1.75 GHz

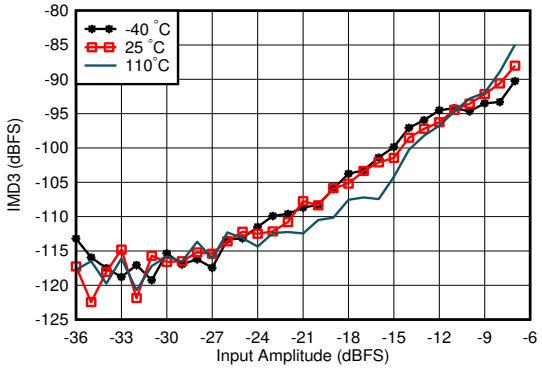
6.12.9 RX Typical Characteristics at 1.75 GHz – 1.9 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



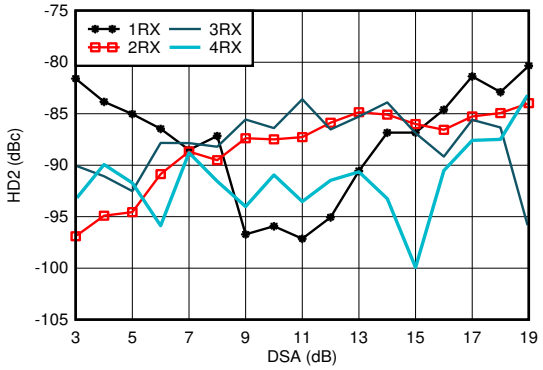
With 1.8 GHz matching, tone spacing = 20 MHz, DSA = 4 dB

図 6-334. RX IMD3 vs Input Level and Temperature at 1.75 GHz



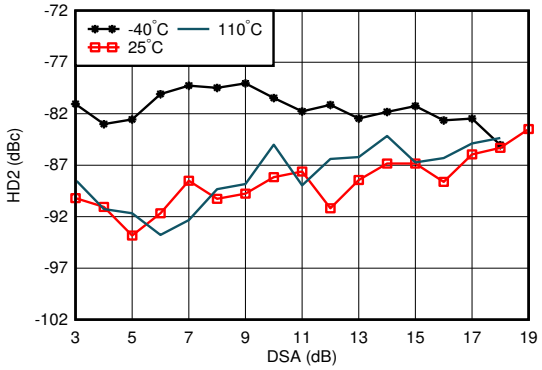
With 1.8 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

図 6-335. RX IMD3 vs Input Level and Temperature at 1.75 GHz



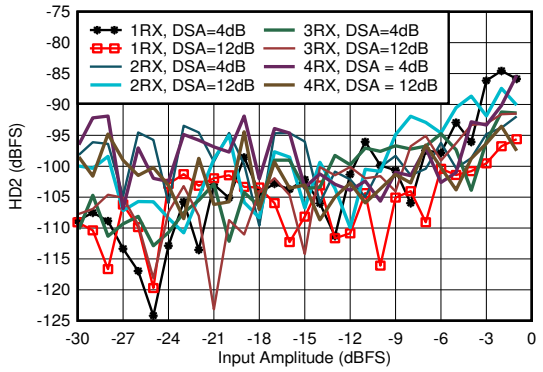
With 1.8 GHz matching, f_{in} = 1900MHz, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-336. RX HD2 vs DSA Setting and Channel at 1.9 GHz



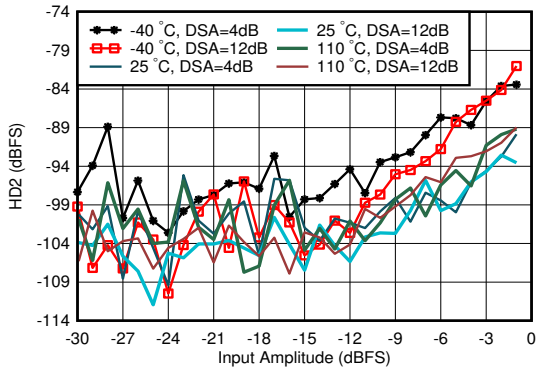
With 1.8 GHz matching, f_{in} = 1900MHz, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-337. RX HD2 vs DSA Setting and Temperature at 1.9 GHz



With 1.8 GHz matching, f_{in} = 1900MHz, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-338. RX HD2 vs Input Amplitude and Channel at 1.9 GHz

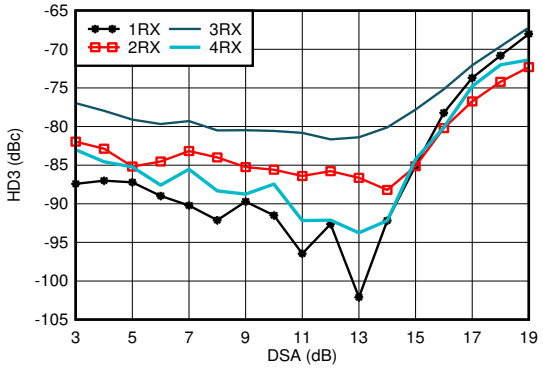


With 1.8 GHz matching, f_{in} = 1900MHz, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-339. RX HD2 vs Input Amplitude and Temperature at 1.9 GHz

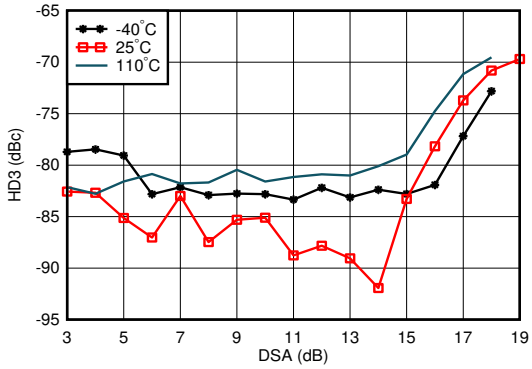
6.12.9 RX Typical Characteristics at 1.75 GHz – 1.9 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



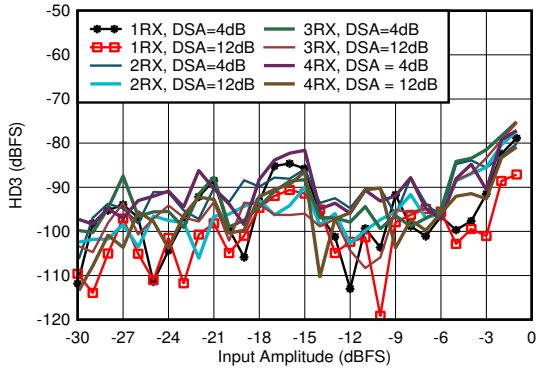
With 1.8 GHz matching, f_{in} = 1900MHz, DDC bypass mode (TI only mode for characterization)

図 6-340. RX HD3 vs DSA Setting and Channel at 1.9 GHz



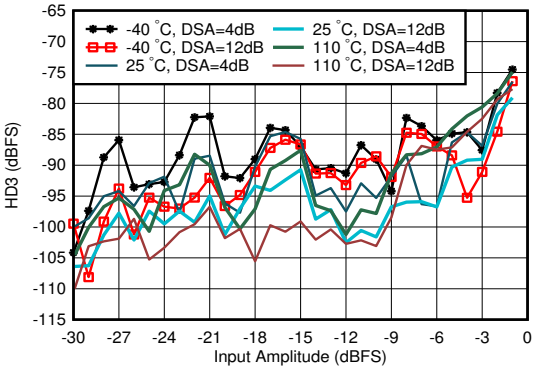
With 1.8 GHz matching, f_{in} = 1900MHz, DDC bypass mode (TI only mode for characterization)

図 6-341. RX HD3 vs DSA Setting and Temperature at 1.9 GHz



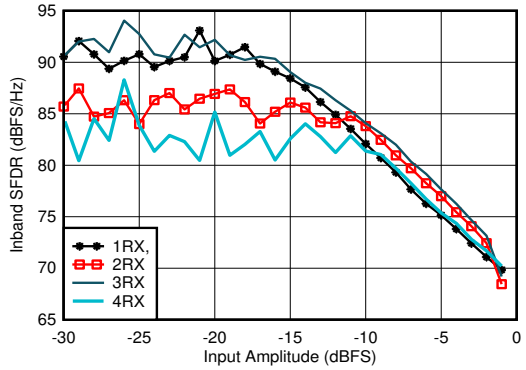
With 1.8 GHz matching, f_{in} = 1900MHz, DDC bypass mode (TI only mode for characterization)

図 6-342. RX HD3 vs Input Level and Channel at 1.9 GHz



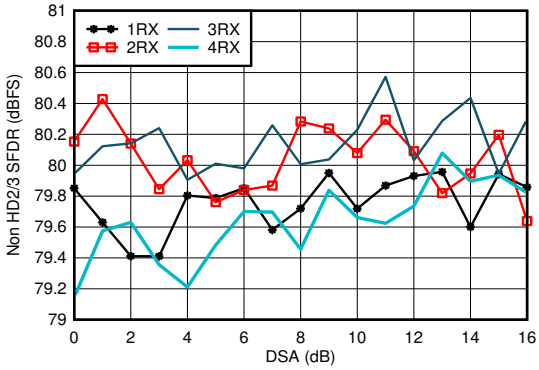
With 1.8 GHz matching, f_{in} = 1900MHz, DDC bypass mode (TI only mode for characterization)

図 6-343. RX HD3 vs Input Level and Temperature at 1.9 GHz



With 1.8 GHz matching, decimated by 3

図 6-344. RX In-Band SFDR (±400 MHz) vs Input Amplitude at 1.75 GHz

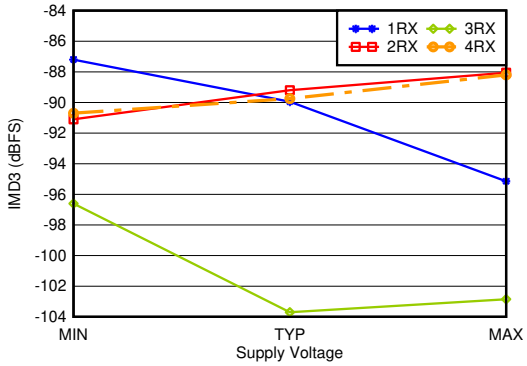


With 1.8 GHz matching

図 6-345. RX Non-HD2/3 vs DSA Setting at 1.75 GHz

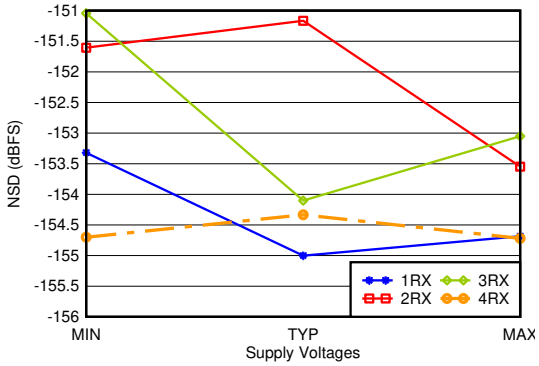
6.12.9 RX Typical Characteristics at 1.75 GHz – 1.9 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 1.8 GHz matching, –7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-346. RX IMD3 vs Supply and Channel at 1.75 GHz

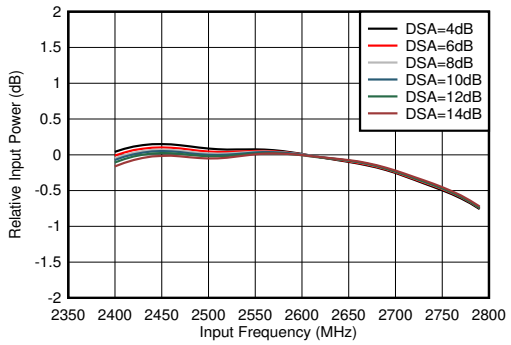


With 1.8 GHz matching, 12.5-MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-347. RX Noise Spectral Density vs Supply and Channel at 1.75 GHz

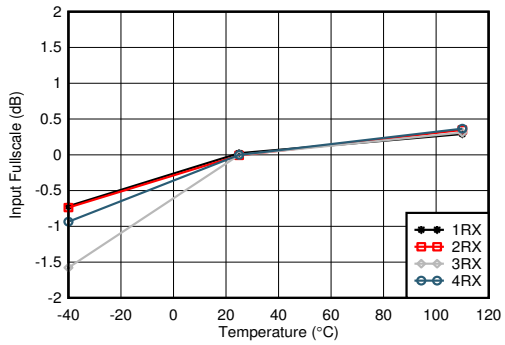
6.12.10 RX Typical Characteristics at 2.6 GHz

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With matching, normalized to power at 2.6 GHz for each DSA setting

図 6-348. RX Inband Gain Flatness, f_{IN} = 2600 MHz

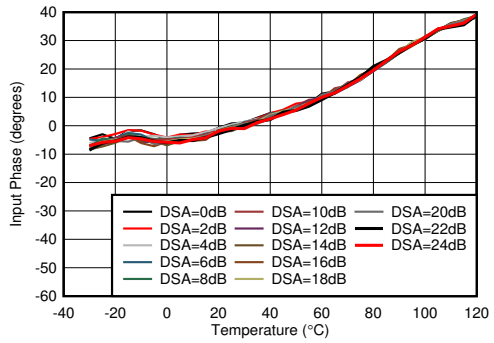


With 2.6 GHz matching, normalized to fullscale at 25°C for each channel

図 6-349. RX Input Fullscale vs Temperature and Channel at 2.6 GHz

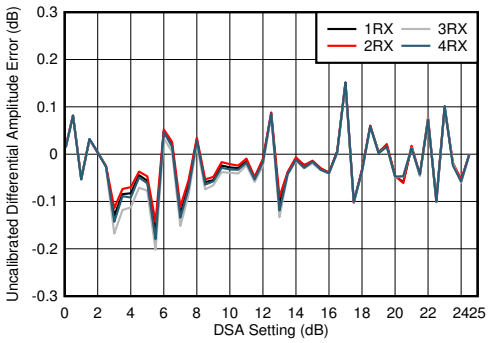
6.12.10 RX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 2.6 GHz matching, normalized to phase at 25°C

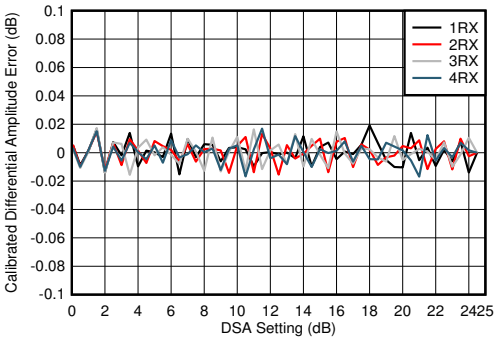
図 6-350. RX Input Phase vs Temperature and DSA at f_{OUT} = 2.6 GHz



With 2.6 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

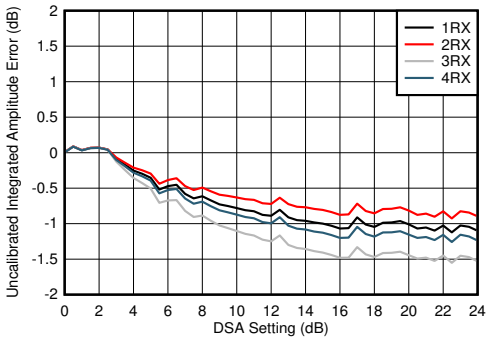
図 6-351. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 2.6 GHz



With 2.6 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

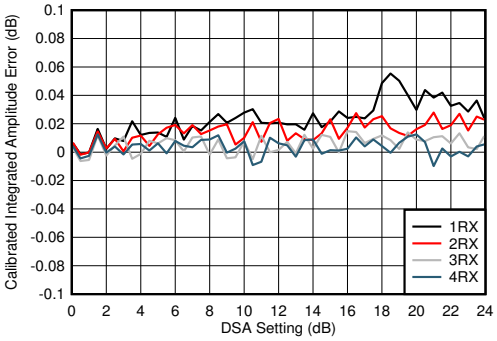
図 6-352. RX Calibrated Differential Amplitude Error vs DSA Setting at 2.6 GHz



With 2.6 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

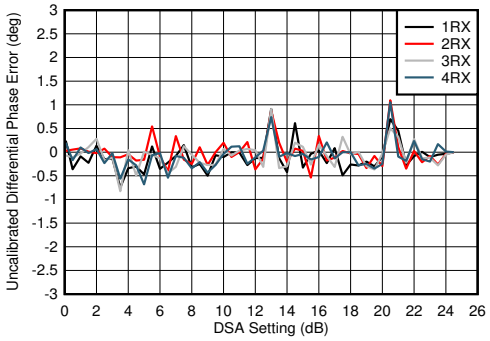
図 6-353. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 2.6 GHz



With 2.6 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

図 6-354. RX Calibrated Integrated Amplitude Error vs DSA Setting at 2.6 GHz



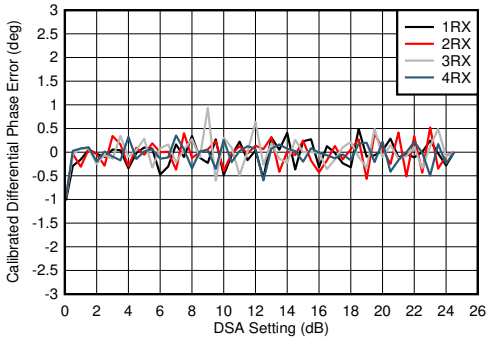
With 2.6 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

図 6-355. RX Uncalibrated Differential Phase Error vs DSA Setting at 2.6 GHz

6.12.10 RX Typical Characteristics at 2.6 GHz (continued)

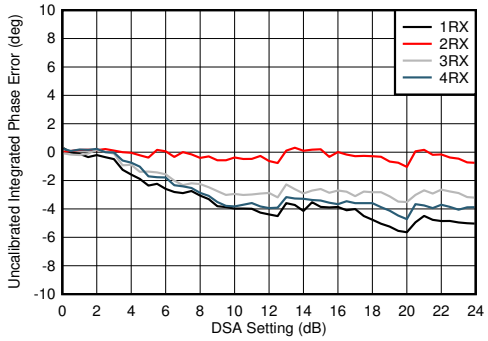
Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 2.6 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

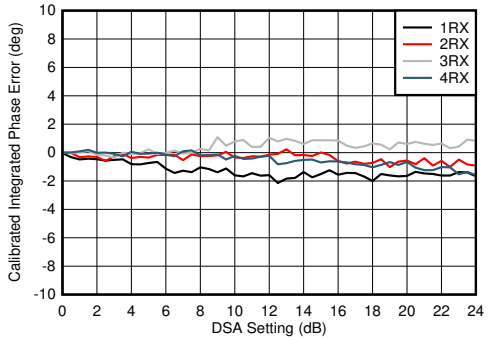
図 6-356. RX Calibrated Differential Phase Error vs DSA Setting at 2.6 GHz



With 2.6 GHz matching

Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

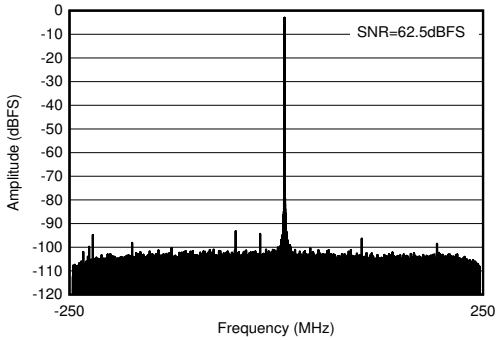
図 6-357. RX Uncalibrated Integrated Phase Error vs DSA Setting at 2.6 GHz



With 2.6 GHz matching

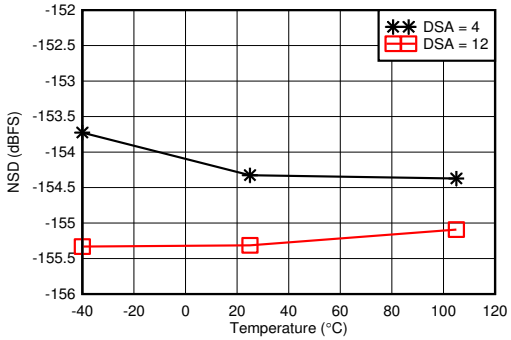
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-358. RX Calibrated Integrated Phase Error vs DSA Setting at 2.6 GHz



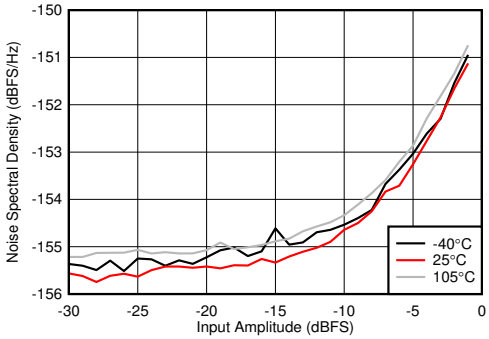
With 2.6 GHz matching, f_{IN} = 2610 MHz, A_{IN}= –3 dBFS

図 6-359. RX Output FFT at 2.6 GHz



With 2.6 GHz matching, 12.5-MHz offset from tone

図 6-360. RX Noise Spectral Density vs Temperature at 2.6 GHz

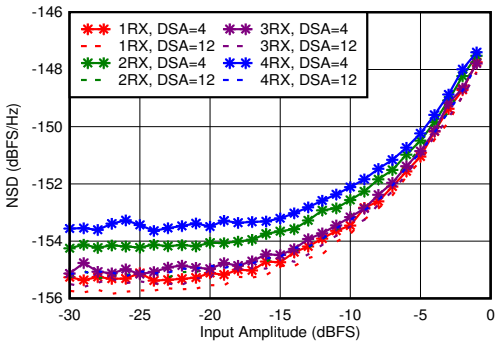


With 2.6 GHz matching, DSA Setting = 12 dB, 12.5-MHz offset from tone

図 6-361. RX Noise Spectral Density vs Input Amplitude and Temperature at 2.6 GHz

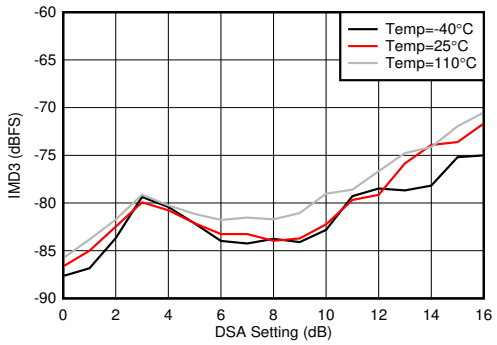
6.12.10 RX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



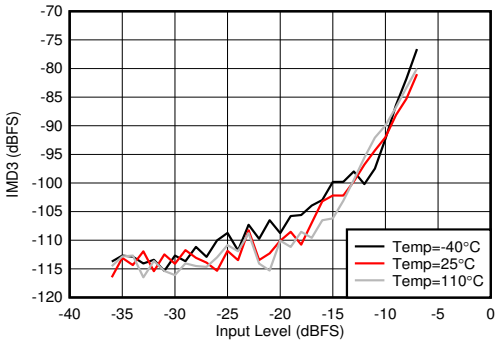
With 2.6 GHz matching, 12.5-MHz offset from tone

図 6-362. RX Noise Spectral Density vs Input Amplitude and Channel at 2.6 GHz



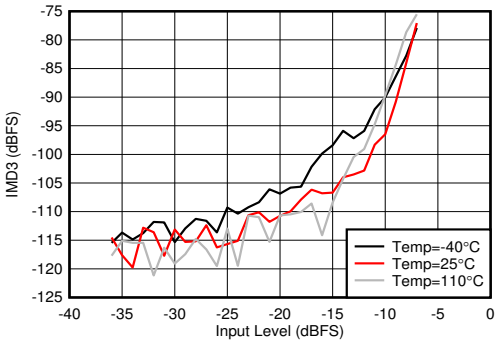
With 2.6 GHz matching, each tone –7 dBFS, tone spacing = 20 MHz

図 6-363. RX IMD3 vs DSA Setting and Temperature at 2.6 GHz



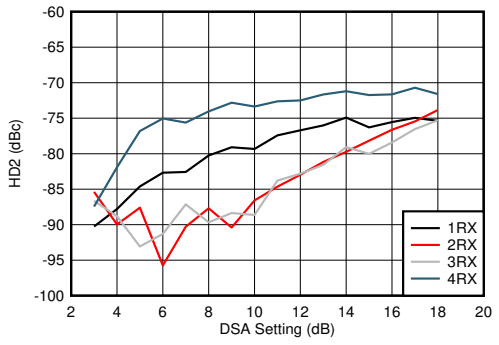
With 2.6 GHz matching, tone spacing = 20 MHz, DSA = 4 dB

図 6-364. RX IMD3 vs Input Level and Temperature at 2.6 GHz



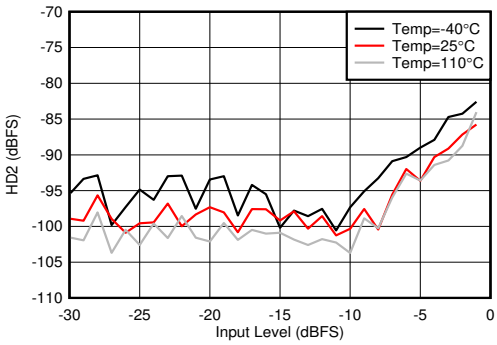
With 2.6 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

図 6-365. RX IMD3 vs Input Level and Temperature at 2.6 GHz



With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-366. RX HD2 vs DSA Setting and Channel at 2.6 GHz

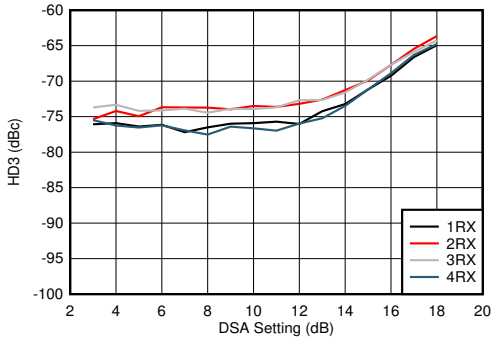


With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-367. RX HD2 vs Input Level and Temperature at 2.6 GHz

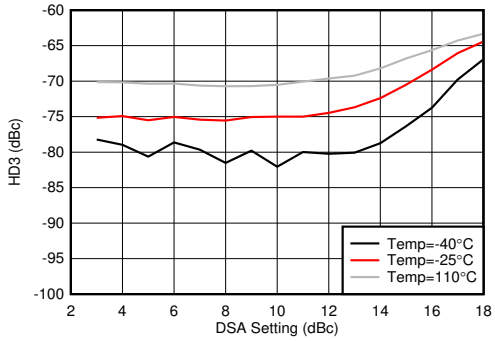
6.12.10 RX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



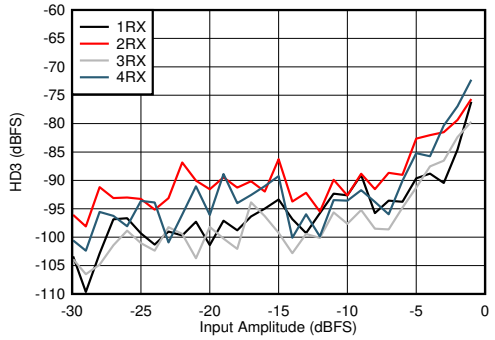
With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-368. RX HD3 vs DSA Setting and Channel at 2.6 GHz



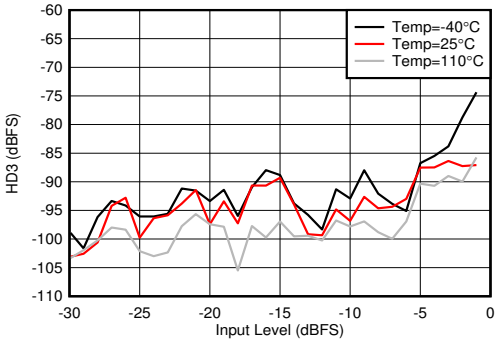
With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-369. RX HD3 vs DSA Setting and Temperature at 2.6 GHz



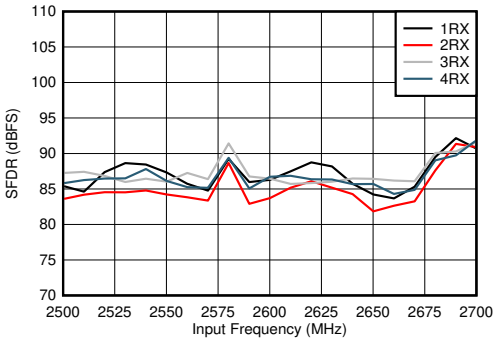
With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-370. RX HD3 vs Input Level and Channel at 2.6 GHz



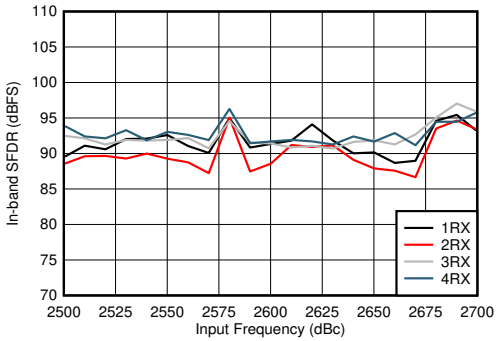
With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-371. RX HD3 vs Input Level and Temperature at 2.6 GHz



With 2.6 GHz matching

図 6-372. RX In-Band SFDR (±200 MHz) vs Frequency With A_{IN}= –1 dBFS at 2.6 GHz

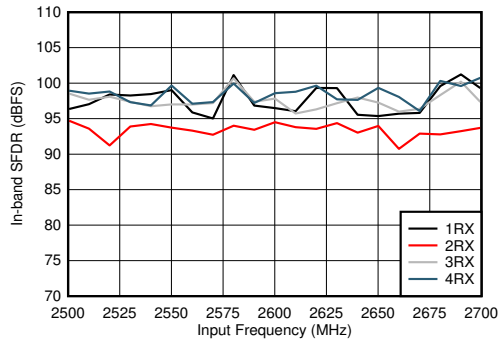


With 2.6 GHz matching

図 6-373. RX In-Band SFDR (±200 MHz) vs Frequency With A_{IN}= –6 dBFS at 2.6 GHz

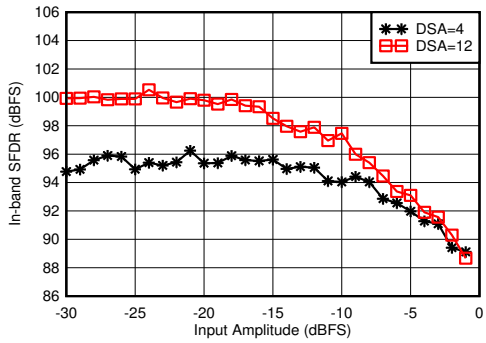
6.12.10 RX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



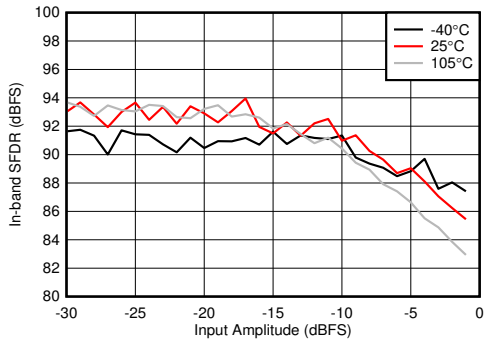
With 2.6 GHz matching

図 6-374. RX In-Band SFDR (±200 MHz) vs Frequency With A_{IN}= –12 dBFS at 2.6 GHz



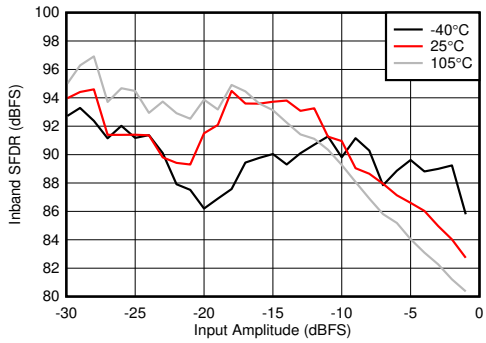
With 2.6 GHz matching

図 6-375. RX In-Band SFDR (±200 MHz) vs Input Amplitude at 2.6 GHz



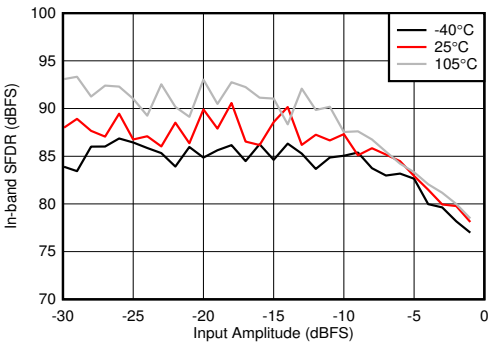
With 2.6 GHz matching

図 6-376. RX In-Band SFDR (±200 MHz) vs Input Amplitude and Temperature at 2.6 GHz



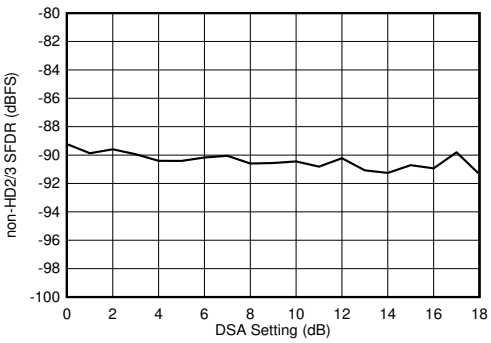
With 2.6 GHz matching, decimate by 8, DSA Setting = 12 dB

図 6-377. RX Inband SFDR (±150 MHz) vs Input Amplitude and Temperature at 2.6 GHz



With 2.6 GHz matching, decimate by 4

図 6-378. RX In-Band SFDR (±300 MHz) vs Input Amplitude and Temperature at 2.6 GHz

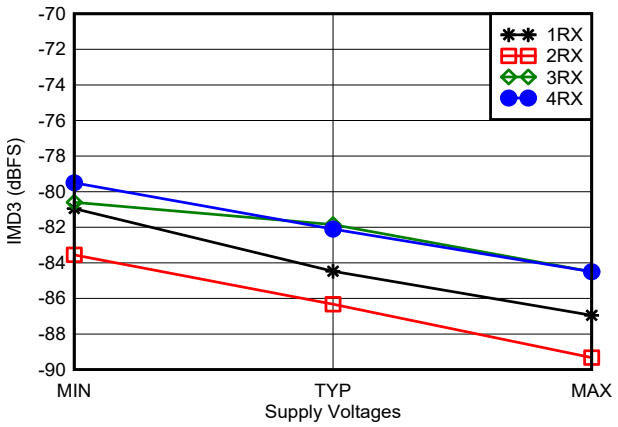


With 2.6 GHz matching

図 6-379. RX Non-HD2/3 vs DSA Setting at 2.6 GHz

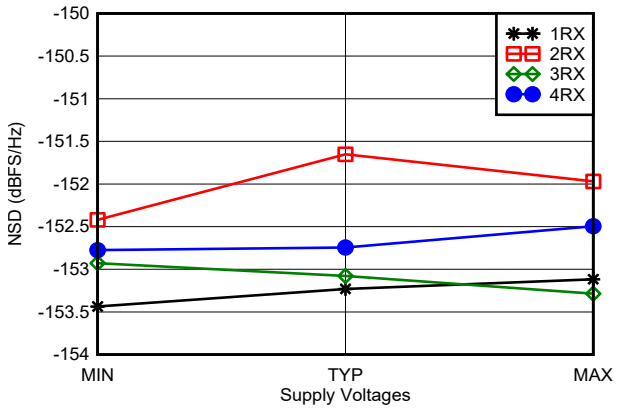
6.12.10 RX Typical Characteristics at 2.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 2.6 GHz matching, –7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-380. RX IMD3 vs Supply and Channel at 2.6 GHz

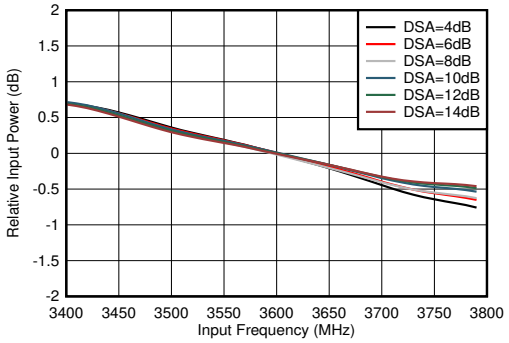


With 2.6 GHz matching, 12.5-MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-381. RX Noise Spectral Density vs Supply and Channel at 2.6 GHz

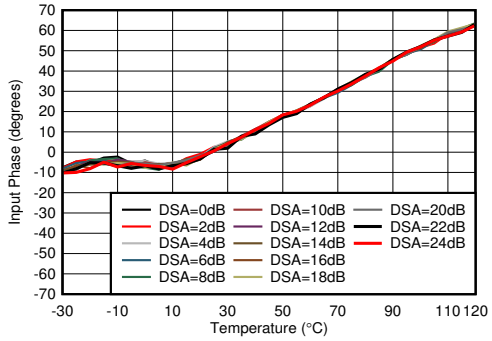
6.12.11 RX Typical Characteristics at 3.5 GHz

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



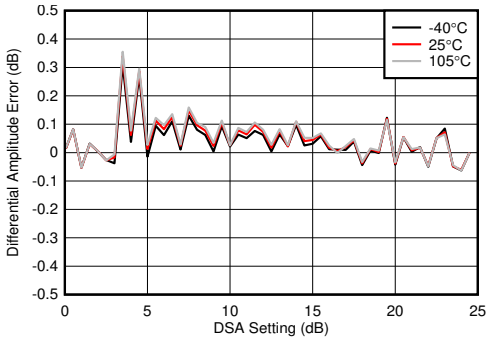
With 3.6 GHz matching, normalized to 3.6 GHz

図 6-382. RX In-Band Gain Flatness, f_{IN} = 3600 MHz



With 3.6 GHz matching, normalized to phase at 25°C

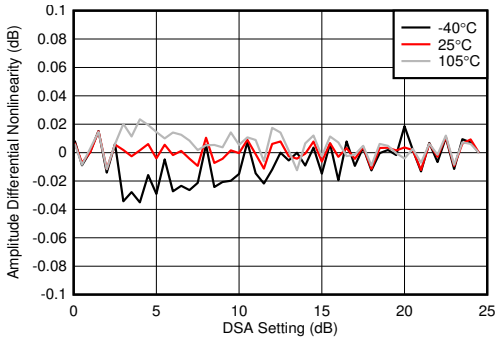
図 6-383. RX Input Phase vs Temperature at 3.6 GHz



With 3.6 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

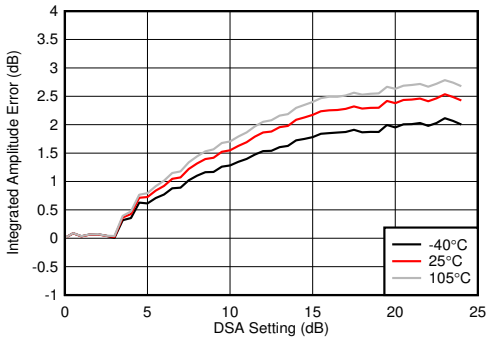
図 6-384. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

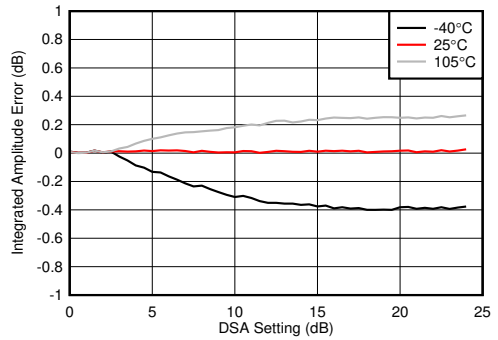
図 6-385. RX Calibrated Differential Amplitude Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

図 6-386. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 3.6 GHz



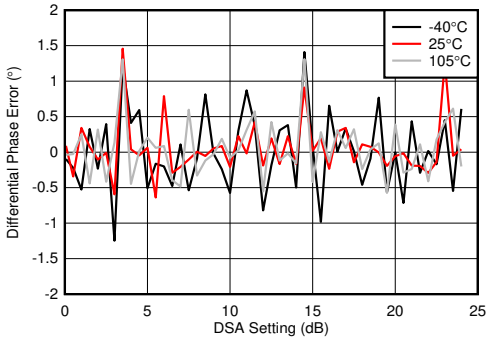
With 3.6 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

図 6-387. RX Calibrated Integrated Amplitude Error vs DSA Setting at 3.6 GHz

6.12.11 RX Typical Characteristics at 3.5 GHz (continued)

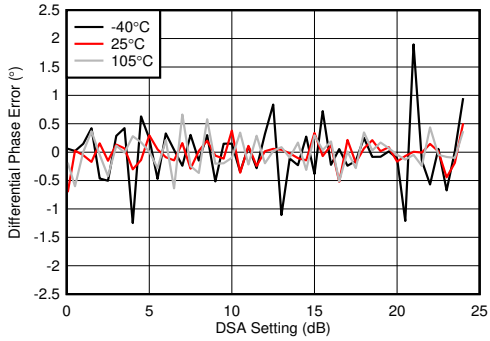
Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 3.6 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

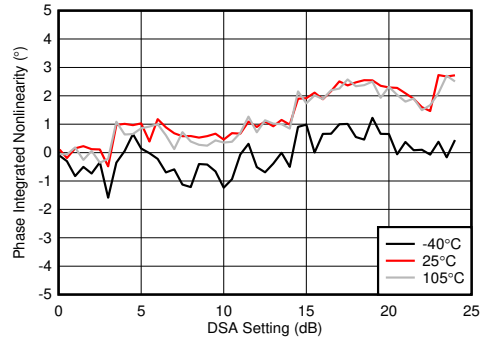
図 6-388. RX Uncalibrated Phase Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

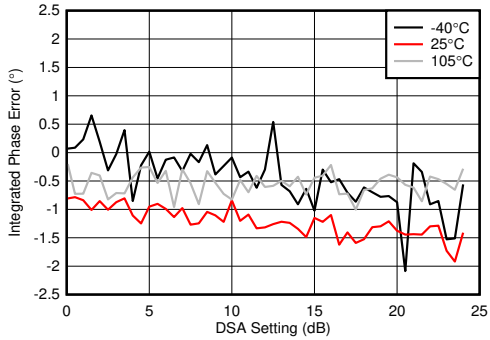
図 6-389. RX Calibrated Differential Phase Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching

Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

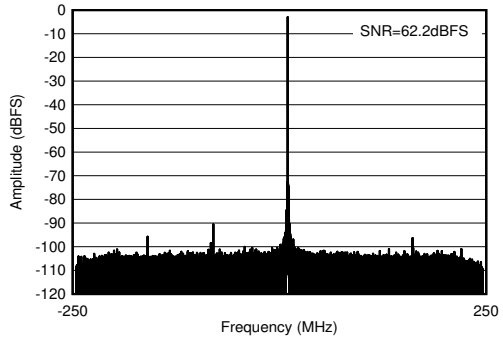
図 6-390. RX Uncalibrated Integrated Phase Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching

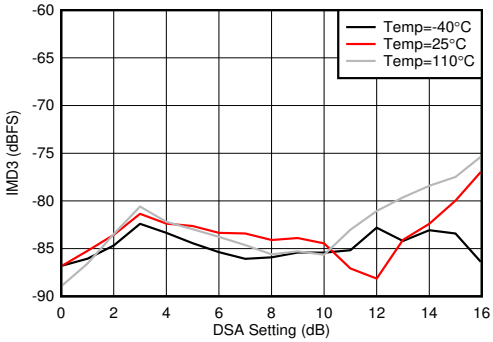
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-391. RX Calibrated Integrated Phase Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching , f_{IN} = 3610 MHz, A_{IN} = –3 dBFS

図 6-392. RX Output FFT at 3.6 GHz

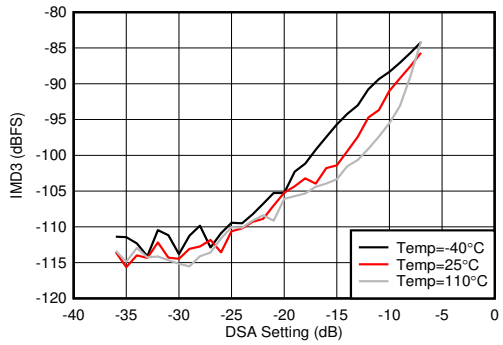


With 3.5 GHz matching, each tone at –7 dBFS, 20-MHz tone spacing

図 6-393. RX IMD3 vs DSA Setting and Temperature at 3.6 GHz

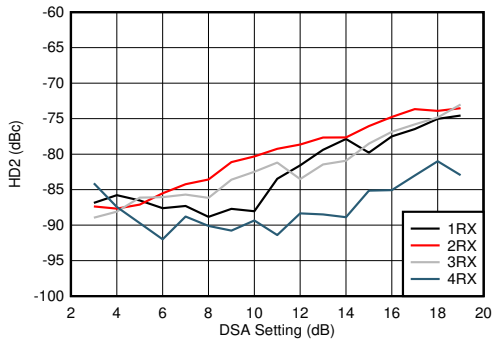
6.12.11 RX Typical Characteristics at 3.5 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



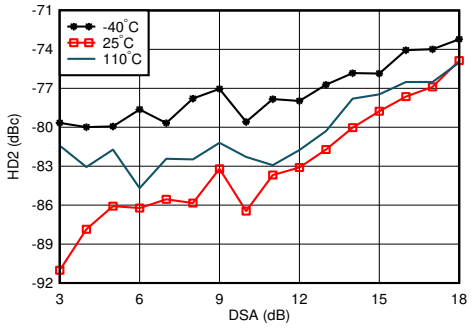
With 3.5 GHz matching, 20-MHz tone spacing

図 6-394. RX IMD3 vs Input Level and Temperature at 3.6 GHz



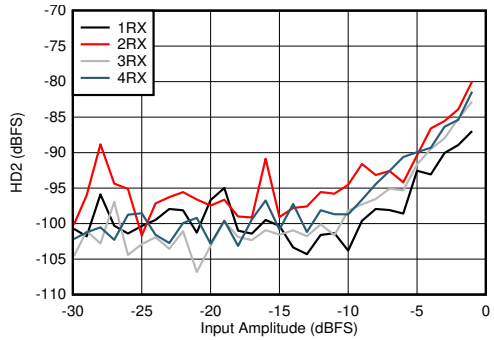
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-395. RX HD2 vs DSA Setting and Channel at 3.6 GHz



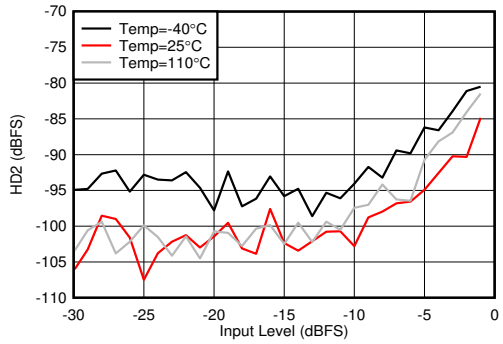
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-396. RX HD2 vs DSA Setting and Temperature at 3.6 GHz



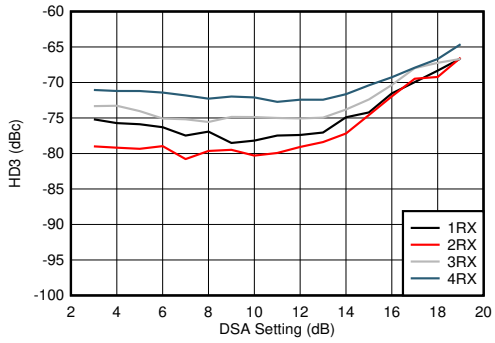
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-397. RX HD2 vs Input Level and Channel at 3.6 GHz



With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-398. RX HD2 vs Input Level and Temperature at 3.6 GHz

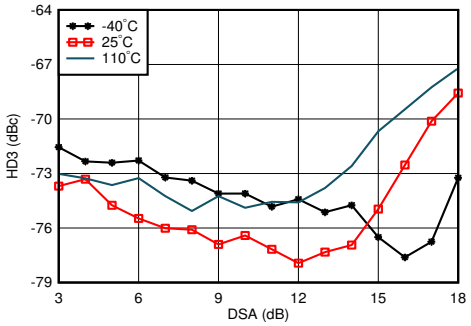


With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-399. RX HD3 vs DSA Setting and Channel at 3.6 GHz

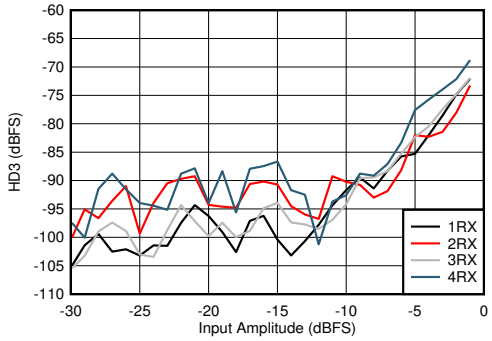
6.12.11 RX Typical Characteristics at 3.5 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



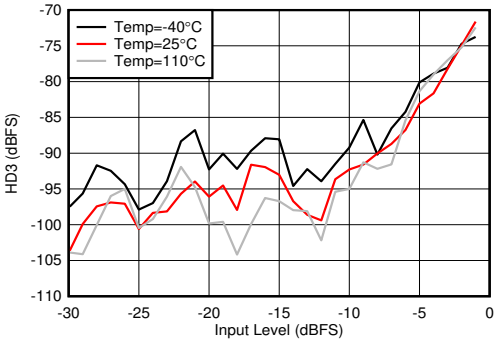
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-400. RX HD3 vs DSA Setting and Temperature at 3.6 GHz



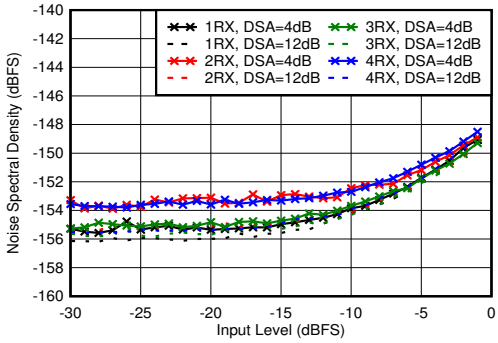
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-401. RX HD3 vs Input Level and Channel at 3.6 GHz



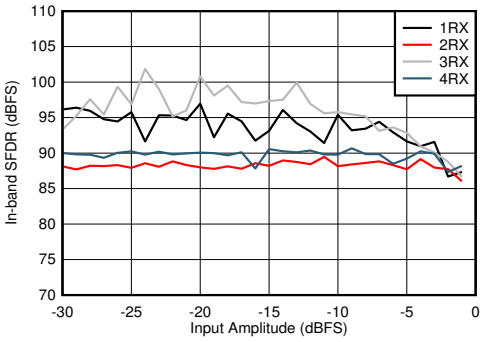
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-402. RX HD3 vs Input Level and Temperature at 3.6 GHz



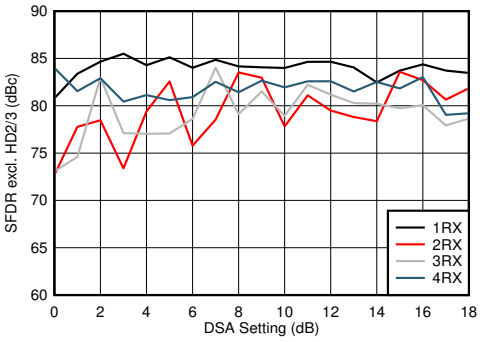
With 3.5 GHz matching, 12.5-MHz offset from tone

図 6-403. RX Noise Spectral Density vs Input Level and DSA Setting at 3.6 GHz



With 3.5 GHz matching

図 6-404. RX In-Band SFDR (±200 MHz) vs Input Level and Channel at 3.6 GHz

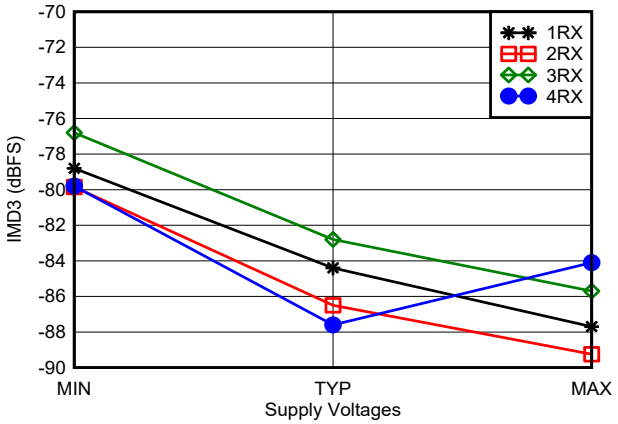


With 3.5 GHz matching

図 6-405. RX SFDR Excluding HD2/3 vs DSA Setting and Channel at 3.6 GHz

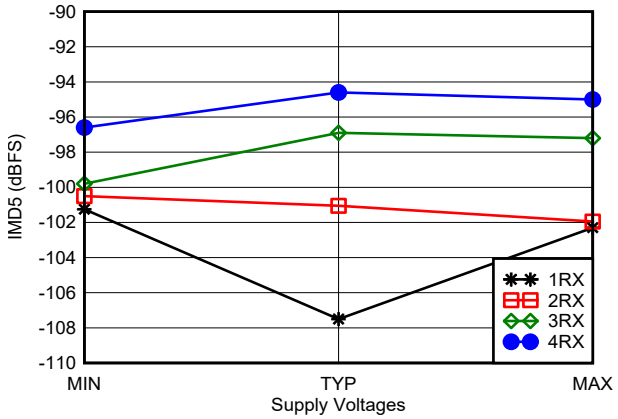
6.12.11 RX Typical Characteristics at 3.5 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



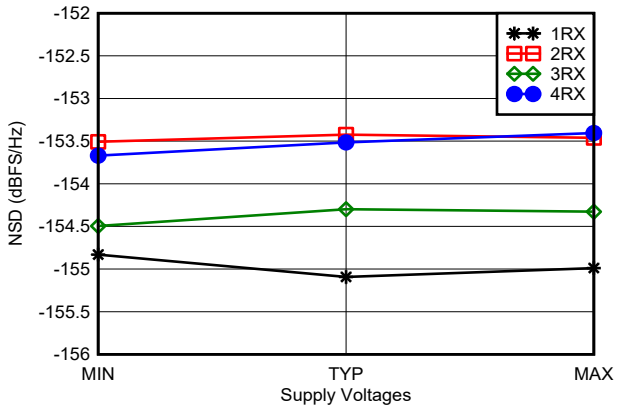
With 3.6 GHz matching, –7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-406. RX IMD3 vs Supply Voltage and Channel at 3.6 GHz



With 3.6 GHz matching, –7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-407. RX IMD5 vs Supply Voltage and Channel at 3.6 GHz

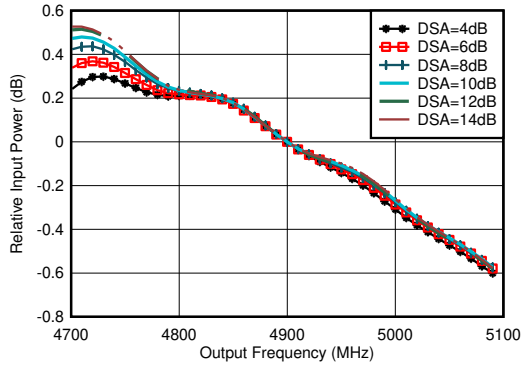


With 3.6 GHz matching, tone at –20 dBFS, 12.5-MHz offset frequency, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-408. RX Noise Spectral Density vs Supply Voltage and Channel at 3.6 GHz

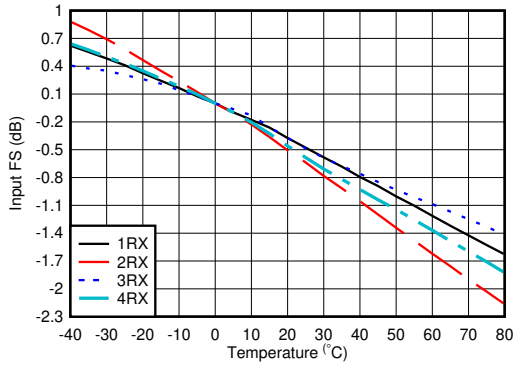
6.12.12 RX Typical Characteristics at 4.9 GHz

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



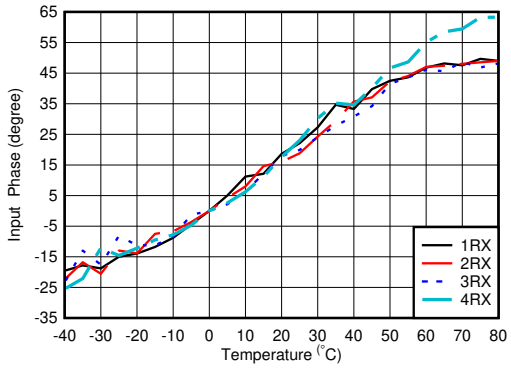
With matching, normalized to power at 4.9GHz for each DSA setting

図 6-409. RX Inband Gain Flatness, f_{IN} = 4900 MHz



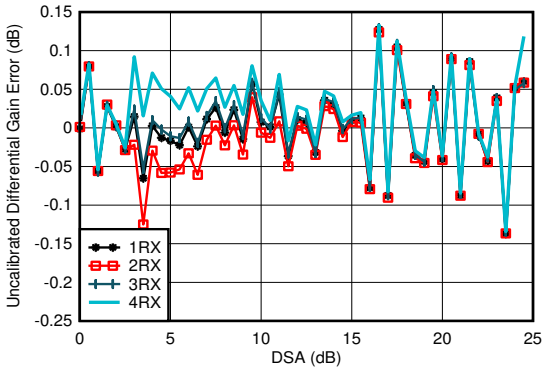
With 4.9 GHz matching, normalized to fullscale at 25°C for each channel

図 6-410. RX Input Fullscale vs Temperature and Channel at 4.9 GHz



With 4.9 GHz matching, normalized to phase at 25°C

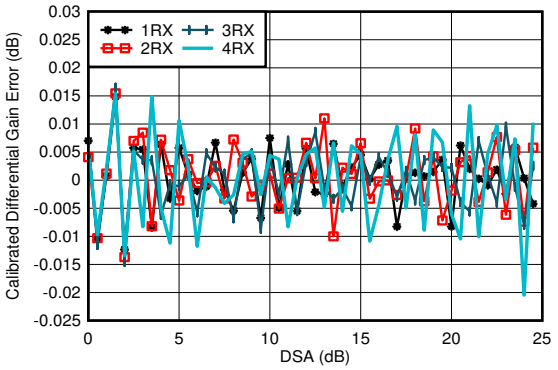
図 6-411. RX Input Phase vs Temperature and DSA at f_{OUT} = 4.9 GHz



With 4.9 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

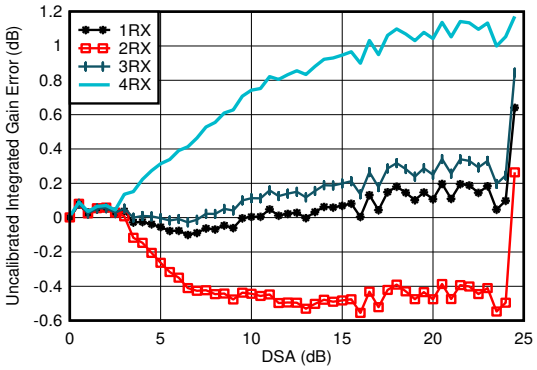
図 6-412. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 4.9 GHz



With 4.9 GHz matching

Differential Amplitude Error = P_{IN}(DSA Setting – 1) – P_{IN}(DSA Setting) + 1

図 6-413. RX Calibrated Differential Amplitude Error vs DSA Setting at 4.9 GHz



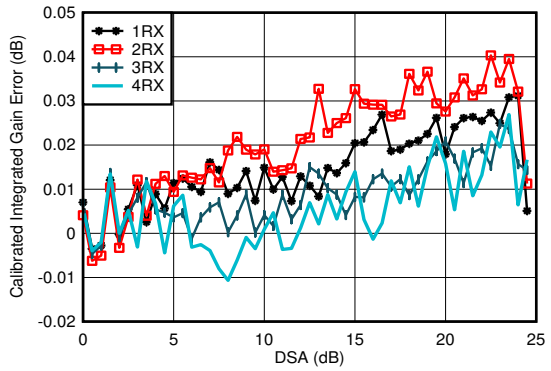
With 4.9 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

図 6-414. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 4.9 GHz

6.12.12 RX Typical Characteristics at 4.9 GHz (continued)

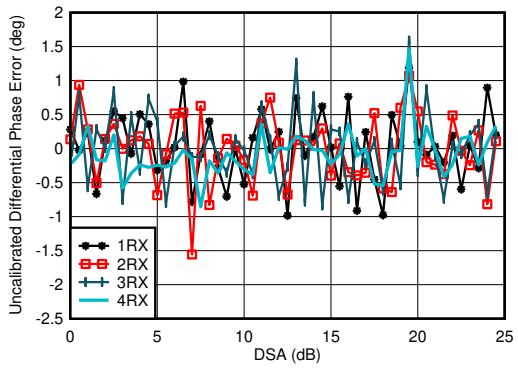
Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 4.9 GHz matching

Integrated Amplitude Error = P_{IN}(DSA Setting) – P_{IN}(DSA Setting = 0) + (DSA Setting)

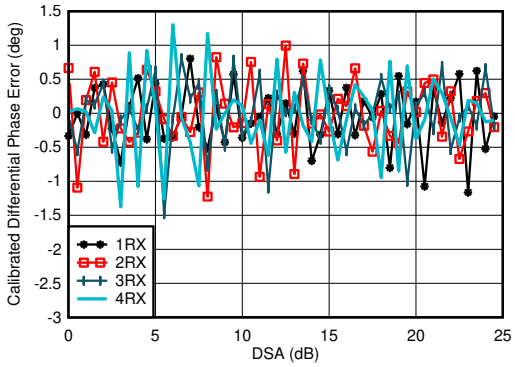
図 6-415. RX Calibrated Integrated Amplitude Error vs DSA Setting at 4.9 GHz



With 4.9 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

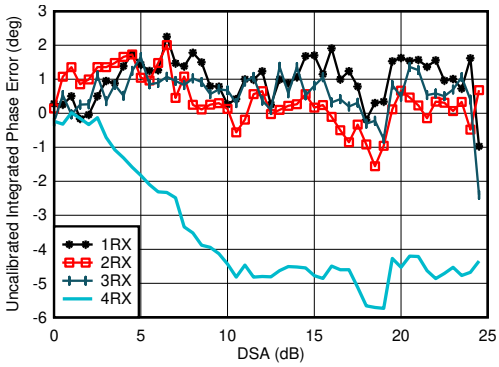
図 6-416. RX Uncalibrated Differential Phase Error vs DSA Setting at 4.9 GHz



With 4.9 GHz matching

Differential Phase Error = $Phase_{IN}$(DSA Setting – 1) – $Phase_{IN}$(DSA Setting)

図 6-417. RX Calibrated Differential Phase Error vs DSA Setting at 4.9 GHz



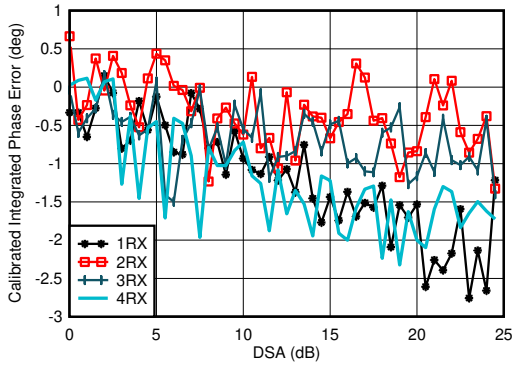
With 4.9 GHz matching

Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-418. RX Uncalibrated Integrated Phase Error vs DSA Setting at 4.9 GHz

6.12.12 RX Typical Characteristics at 4.9 GHz (continued)

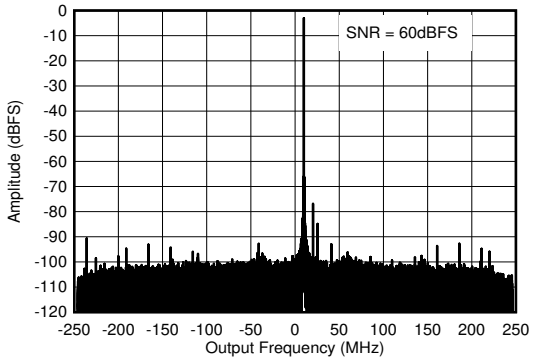
Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



With 4.9 GHz matching

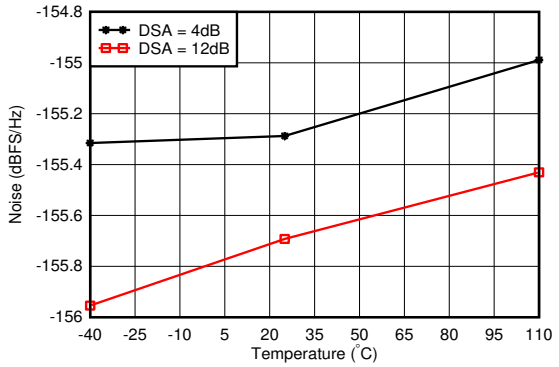
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

図 6-419. RX Calibrated Integrated Phase Error vs DSA Setting at 4.9 GHz



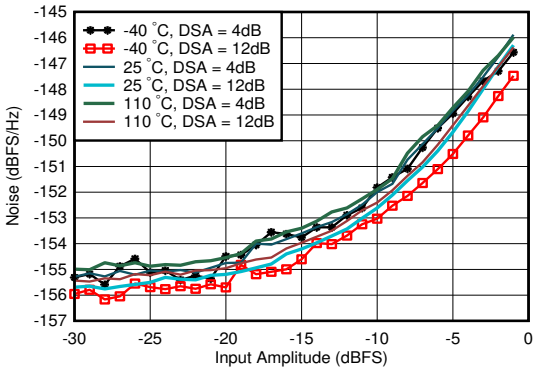
With 4.9 GHz matching, f_{IN} = 4910 MHz, A_{IN}= –3 dBFS

図 6-420. RX Output FFT at 4.9 GHz



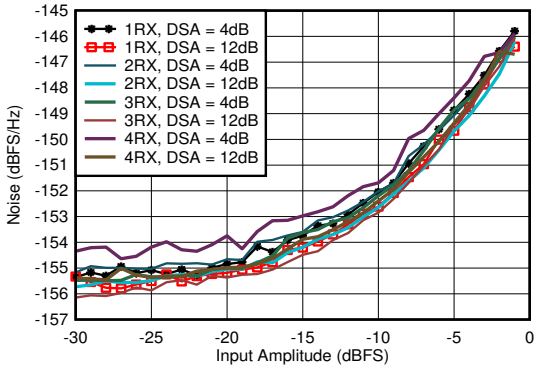
With 4.9 GHz matching, 12.5-MHz offset from tone

図 6-421. RX Noise Spectral Density vs Temperature at 4.9 GHz



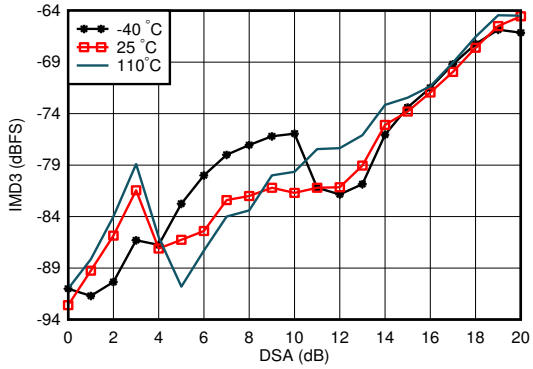
With 4.9 GHz matching, DSA Setting = 12 dB, 12.5-MHz offset from tone

図 6-422. RX Noise Spectral Density vs Input Amplitude and Temperature at 4.9 GHz



With 4.9 GHz matching, 12.5-MHz offset from tone

図 6-423. RX Noise Spectral Density vs Input Amplitude and Channel at 4.9 GHz

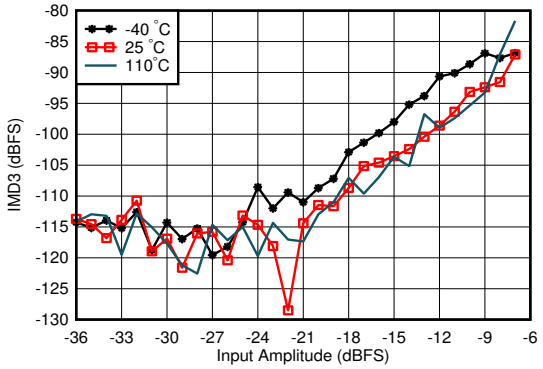


With 4.9 GHz matching, each tone –7 dBFS, tone spacing = 20 MHz

図 6-424. RX IMD3 vs DSA Setting and Temperature at 4.9 GHz

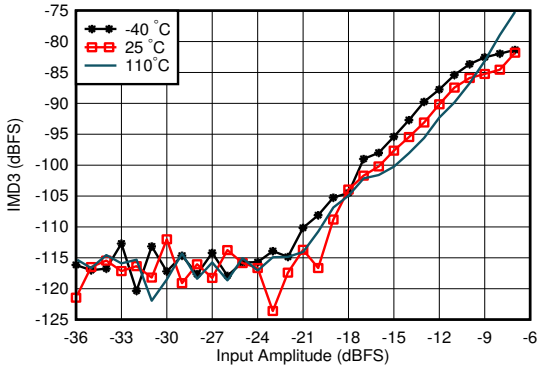
6.12.12 RX Typical Characteristics at 4.9 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



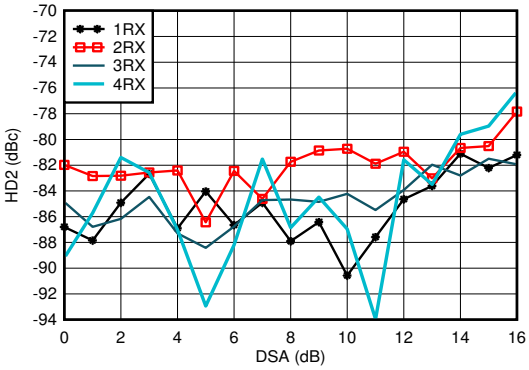
With 4.9 GHz matching, tone spacing = 20 MHz, DSA = 4 dB

図 6-425. RX IMD3 vs Input Level and Temperature at 4.9 GHz



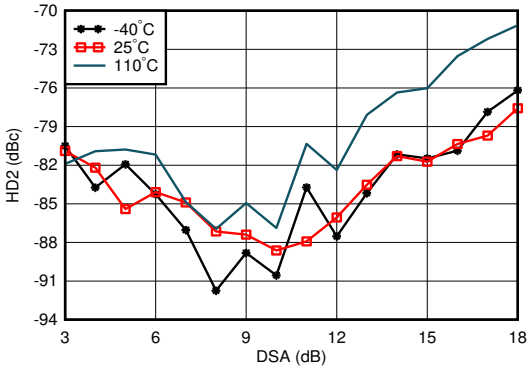
With 4.9 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

図 6-426. RX IMD3 vs Input Level and Temperature at 4.9 GHz



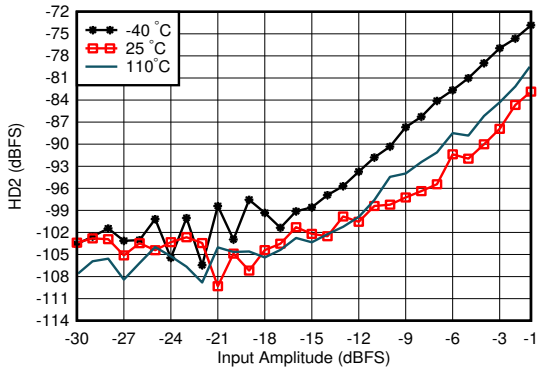
With 4.9 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-427. RX HD2 vs DSA Setting and Channel at 4.9 GHz



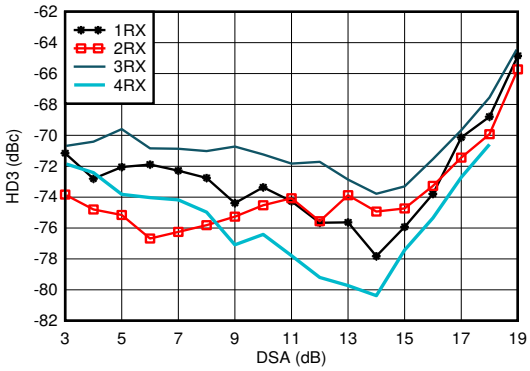
With 4.9 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-428. RX HD2 vs DSA and Temperature at 4.9 GHz



With 4.9 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

図 6-429. RX HD2 vs Input Level and Temperature at 4.9 GHz

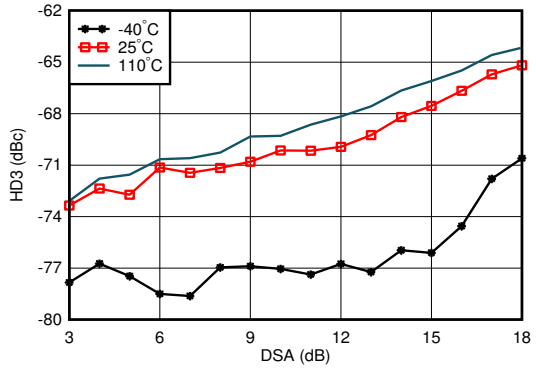


With 4.9 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-430. RX HD3 vs DSA Setting and Channel at 4.9 GHz

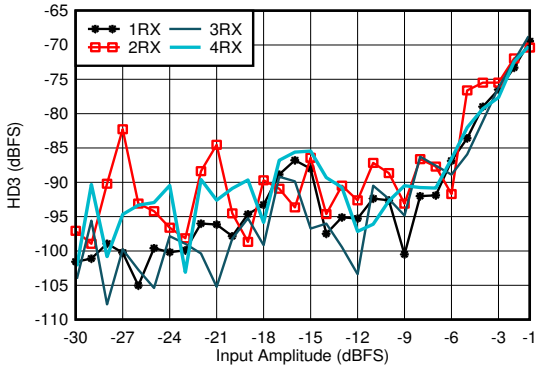
6.12.12 RX Typical Characteristics at 4.9 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.



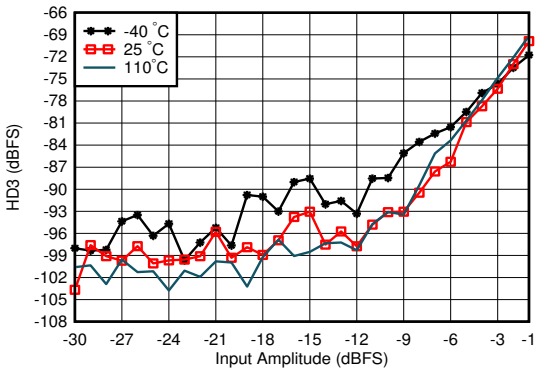
With 4.9 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-431. RX HD3 vs DSA Setting and Temperature at 4.9 GHz



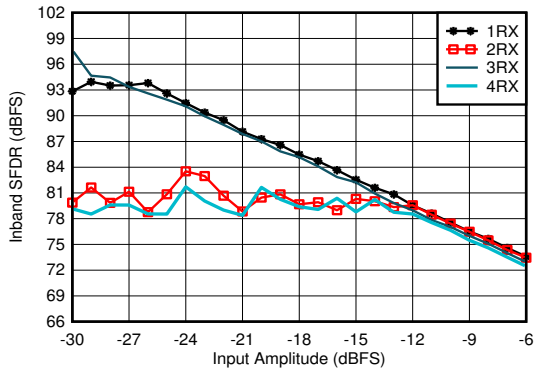
With 4.9 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-432. RX HD3 vs Input Level and Channel at 4.9 GHz



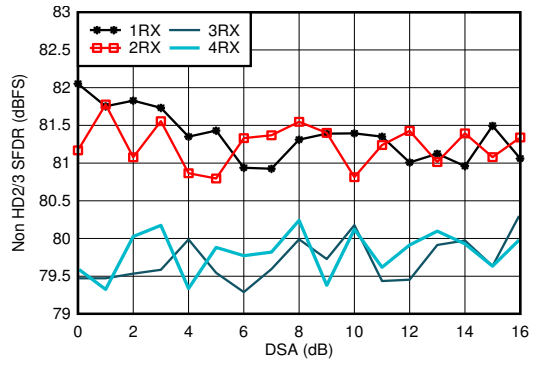
With 4.9 GHz matching, DDC bypass mode (TI only mode for characterization)

図 6-433. RX HD3 vs Input Level and Temperature at 4.9 GHz



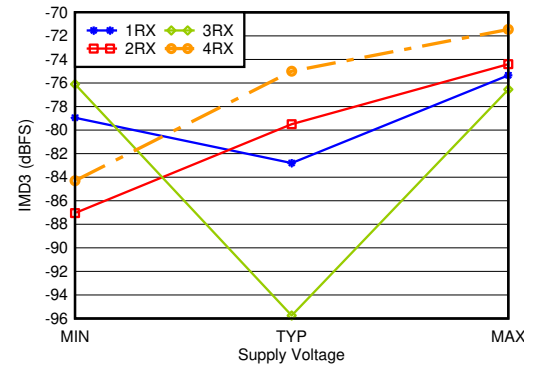
With 4.9 GHz matching, decimate by 3

図 6-434. RX In-Band SFDR (±400 MHz) vs Input Amplitude and Channel at 4.9 GHz



With 4.9 GHz matching

図 6-435. RX Non-HD2/3 vs DSA Setting at 4.9 GHz

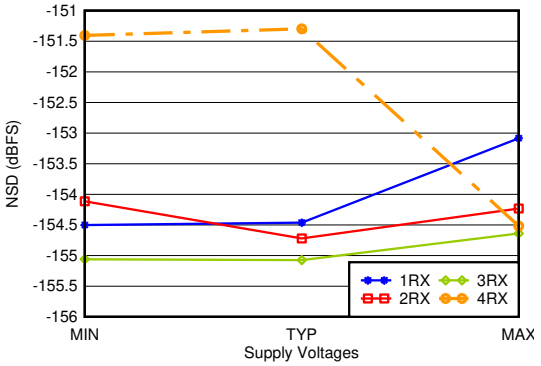


With 4.9 GHz matching, –7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-436. RX IMD3 vs Supply and Channel at 4.9 GHz

6.12.12 RX Typical Characteristics at 4.9 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52MSPS (decimate by 6), PLL clock mode with f_{REF} = 491.52 MHz, A_{IN} = –3 dBFS, DSA setting = 4 dB.

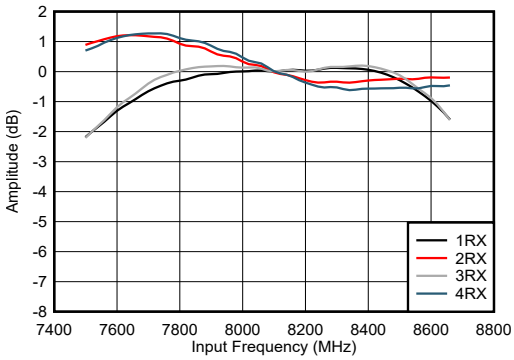


With 4.9 GHz matching, 12.5-MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

図 6-437. RX Noise Spectral Density vs Supply and Channel at 4.9 GHz

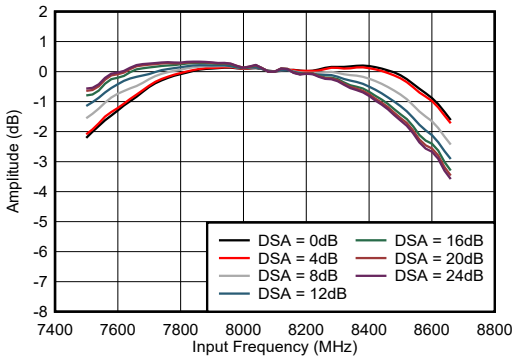
6.12.13 RX Typical Characteristics at 8.1GHz

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2) , External clock mode with f_{CLK} = 11796.48MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 8.1GHz matching.



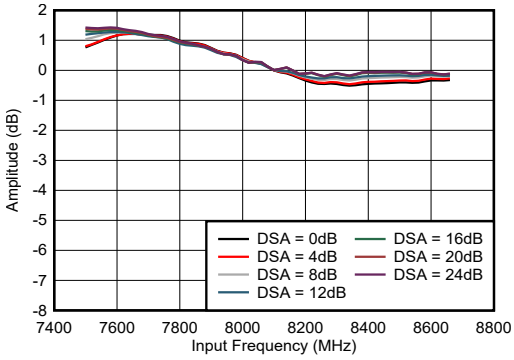
Normalized to 8.11GHz

図 6-438. RX Amplitude vs Frequency and Channel



1RX and 3RX, Normalized to 8.11GHz

図 6-439. RX Amplitude vs Frequency and DSA Setting



2RX and 4RX, Normalized to 8.11GHz

図 6-440. RX Amplitude vs Frequency and DSA Setting

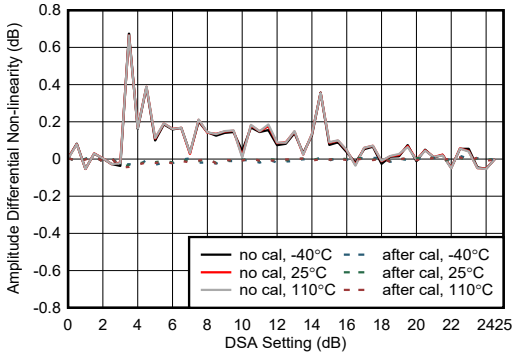


図 6-441. RX Amplitude Differential Nonlinearity at 8.11GHz

6.12.13 RX Typical Characteristics at 8.1GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2) , External clock mode with f_{CLK} = 11796.48MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 8.1GHz matching.

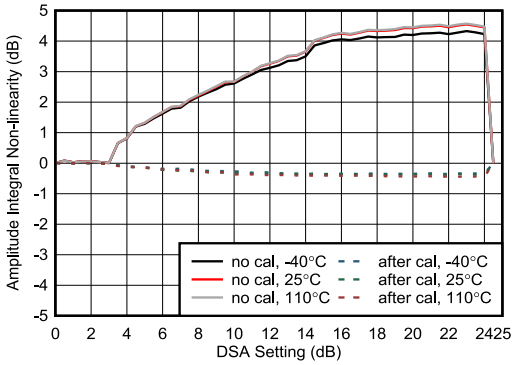


図 6-442. RX Amplitude Integrated Nonlinearity at 8.11GHz

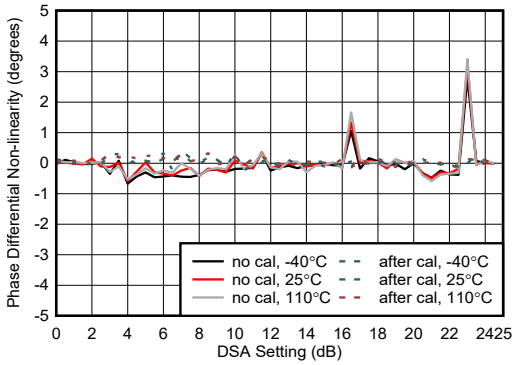


図 6-443. RX Phase Differential Nonlinearity at 8.11GHz

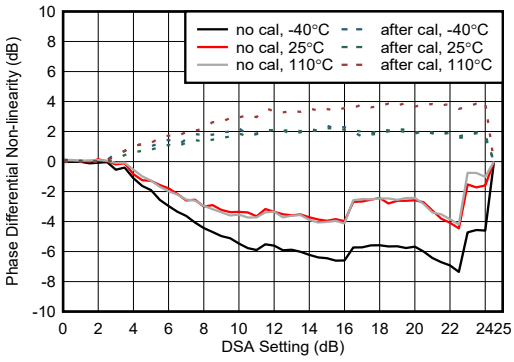
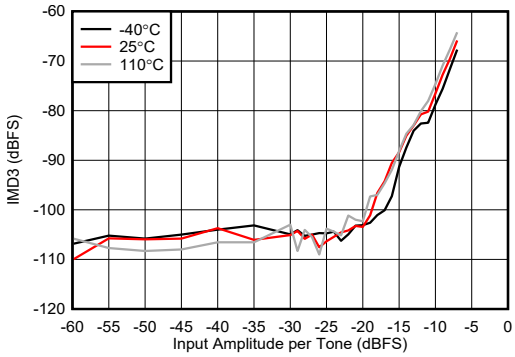
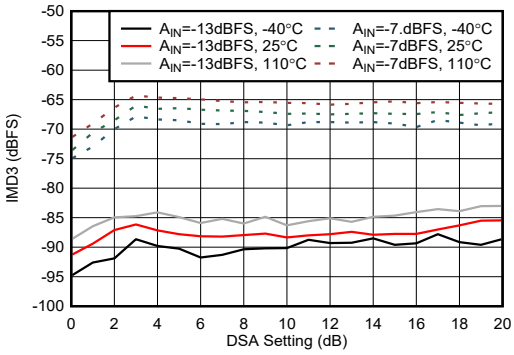


図 6-444. RX Phase Differential Nonlinearity at 8.11GHz



50MHz tone spacing

図 6-445. RX IMD3 vs Input Amplitude at 8.11GHz



50MHz tone spacing

図 6-446. RX IMD3 vs DSA Setting at 8.11GHz

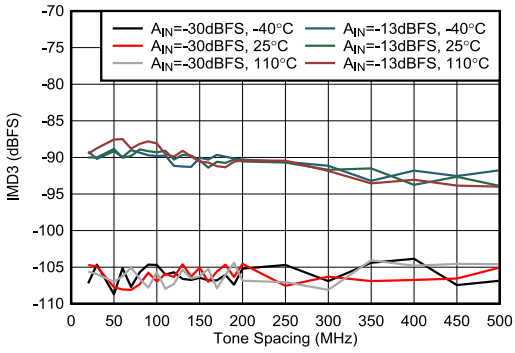


図 6-447. RX IMD3 vs Tone Spacing at 8.11GHz

6.12.13 RX Typical Characteristics at 8.1GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2) , External clock mode with f_{CLK} = 11796.48MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 8.1GHz matching.

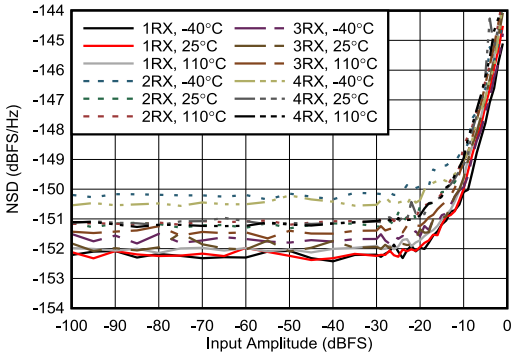


図 6-448. RX NSD vs Digital Amplitude at 8.11GHz

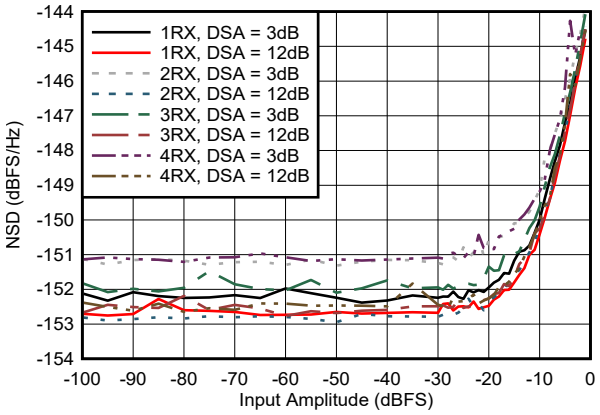


図 6-449. RX NSD vs Digital Amplitude at 8.11GHz

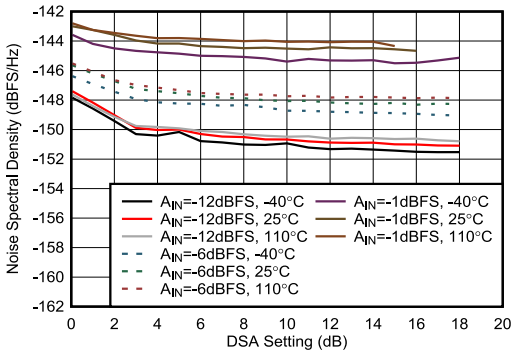
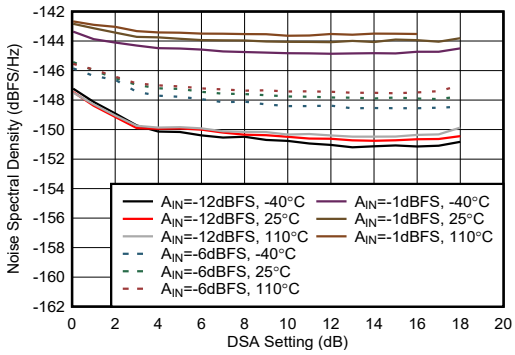


図 6-450. RX NSD vs DSA Setting at 8.11GHz



External clock mode

図 6-451. RX NSD vs DSA Setting at 8.11GHz

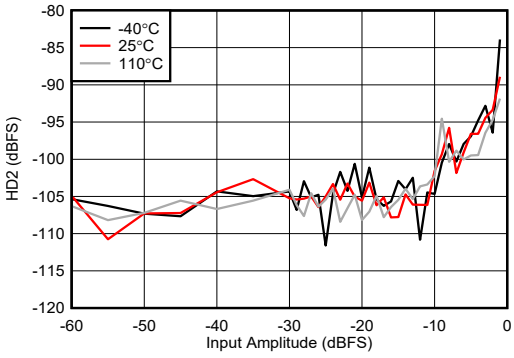


図 6-452. RX HD2 vs Digital Amplitude at 8.11GHz

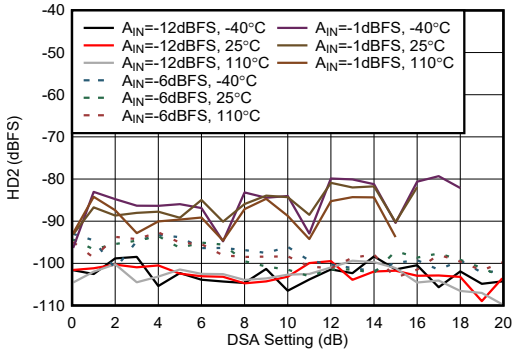


図 6-453. RX HD2 vs DSA Setting at 8.11GHz

6.12.13 RX Typical Characteristics at 8.1GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2) , External clock mode with f_{CLK} = 11796.48MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 8.1GHz matching.

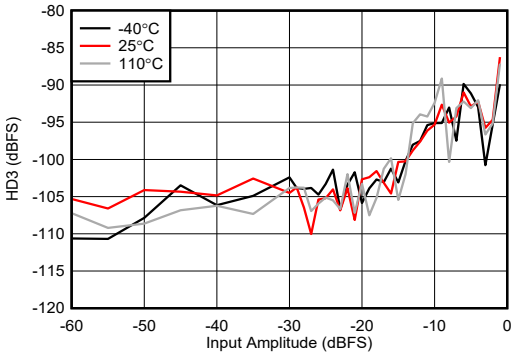


図 6-454. RX HD3 vs Digital Amplitude at 8.11GHz

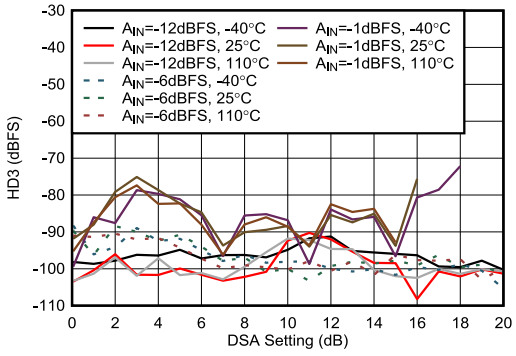
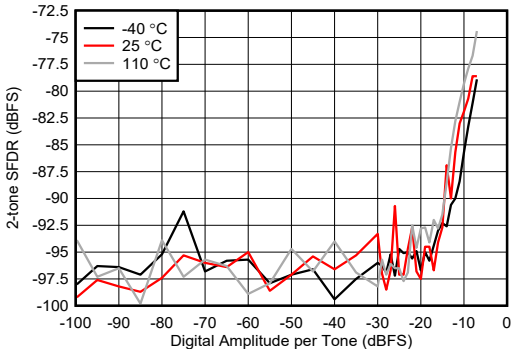
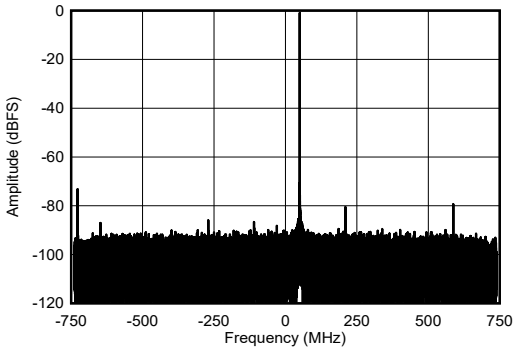


図 6-455. RX HD3 vs DSA Setting at 8.11GHz



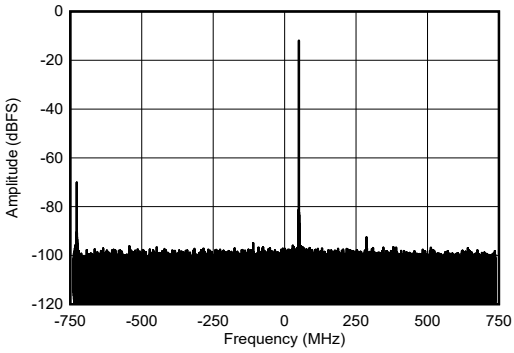
50MHz Tone Spacing

図 6-456. RX 2-tone SFDR vs Digital Amplitude at 8.11GHz



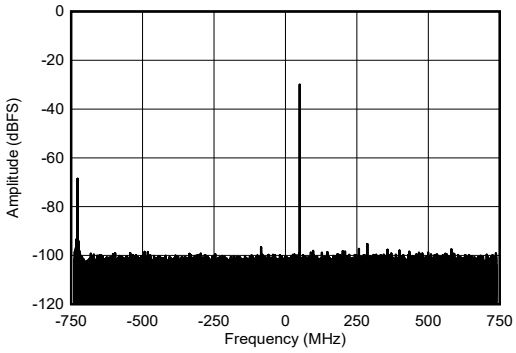
External clock mode

図 6-457. RX Single Tone Output FFT at 8.11GHz, -1dBFS



External clock mode

図 6-458. RX Single Tone Output FFT at 8.11GHz, -12dBFS

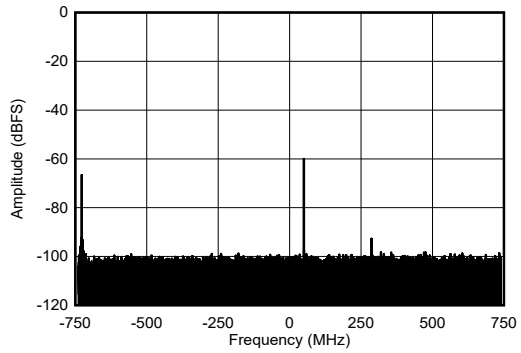


External clock mode

図 6-459. RX Single Tone Output FFT at 8.11GHz, -30dBFS

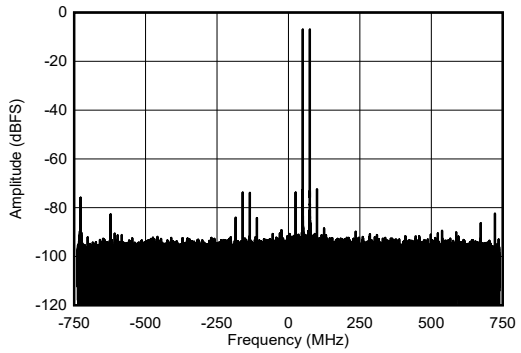
6.12.13 RX Typical Characteristics at 8.1GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2) , External clock mode with f_{CLK} = 11796.48MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 8.1GHz matching.



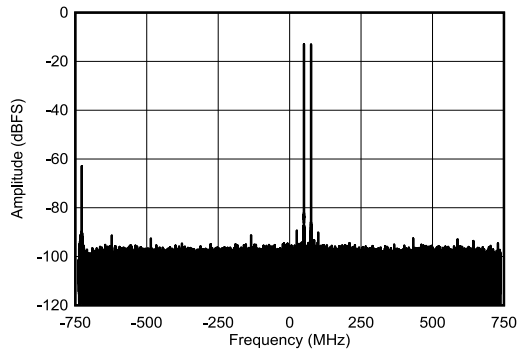
External clock mode

図 6-460. RX Single Tone Output FFT at 8.11GHz, -60dBFS



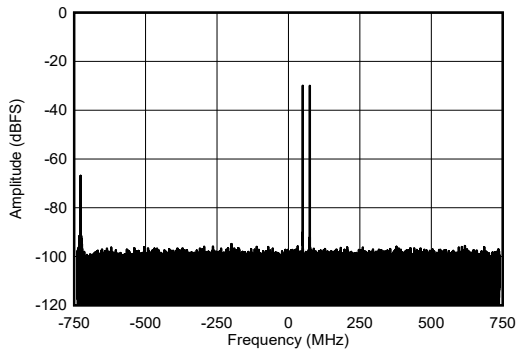
External clock mode, -7dBFS each tone

図 6-461. RX Dual Tone Output FFT at 8.11GHz



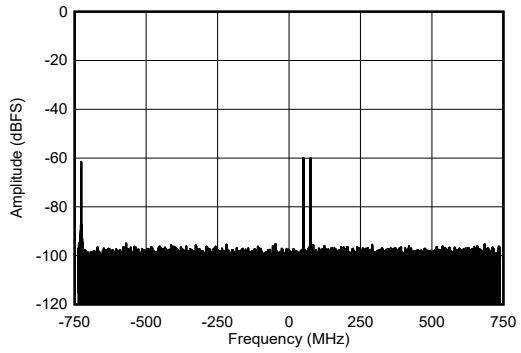
External clock mode, -13dBFS each tone

図 6-462. RX Dual Tone Output FFT at 8.11GHz



External clock mode, -30dBFS each tone

図 6-463. RX Dual Tone Output FFT at 8.11GHz

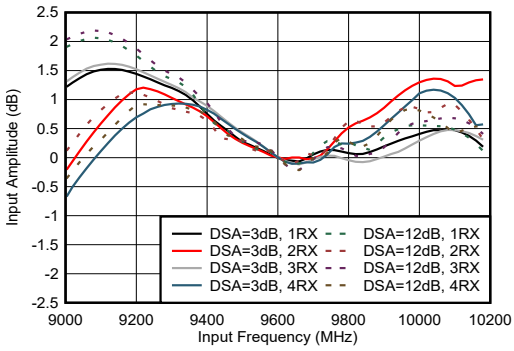


External clock mode, -60dBFS each tone

図 6-464. RX Dual Tone Output FFT at 8.11GHz

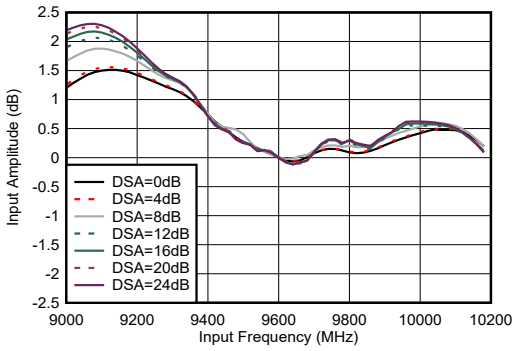
6.12.14 RX Typical Characteristics at 9.6 GHz

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with f_{CLK} = 11796.48 MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 9.6 GHz matching.



Normalized to 9.6 GHz

図 6-465. RX Input Amplitude vs Frequency



Normalized to 9.6 GHz

図 6-466. RX Input Amplitude vs Frequency at 9.6 GHz

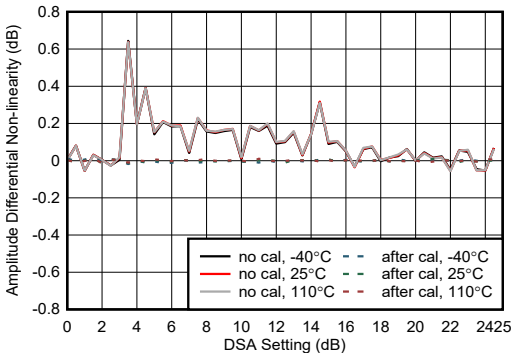


図 6-467. RX Amplitude Differential Non-Linearity at 9.6 GHz

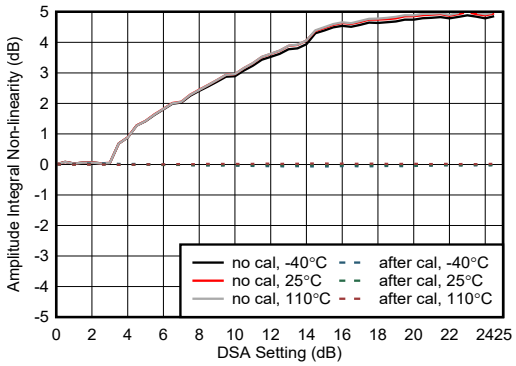


図 6-468. RX Amplitude Integrated Non-linearity at 9.6 GHz

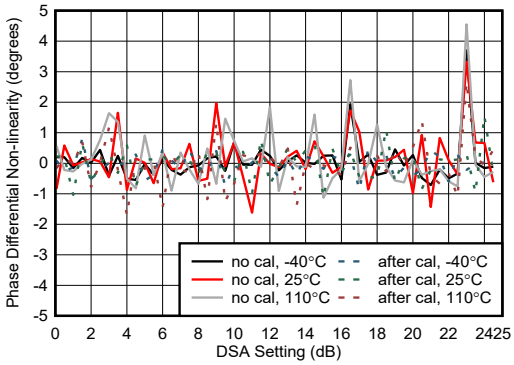


図 6-469. RX Phase Differential Non-linearity at 9.6 GHz

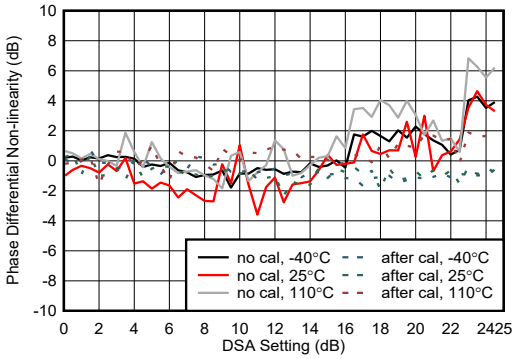


図 6-470. RX Phase Integrated Non-linearity at 9.6 GHz

6.12.14 RX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with f_{CLK} = 11796.48 MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 9.6 GHz matching.

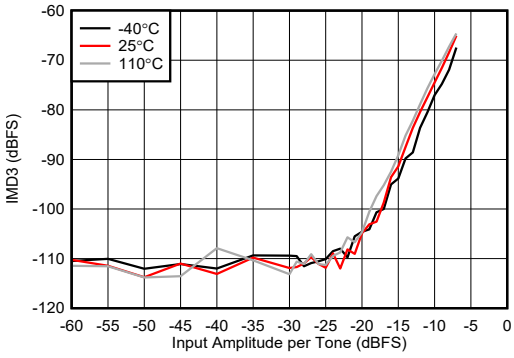
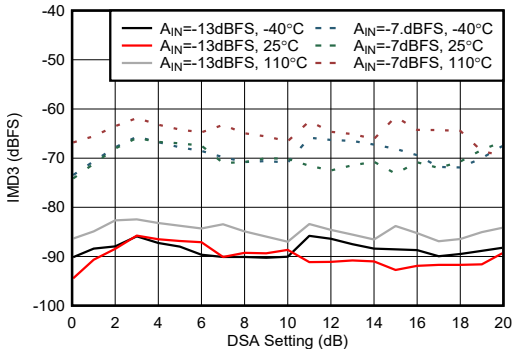
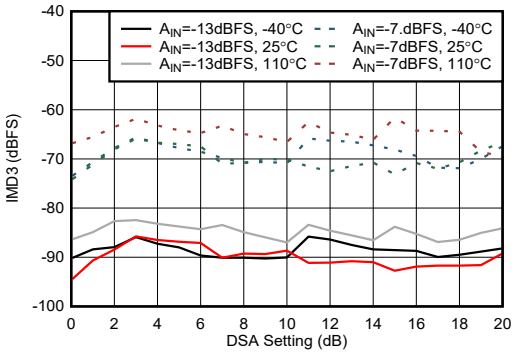


図 6-471. RX IMD3 vs Digital Amplitude at 9.6 GHz



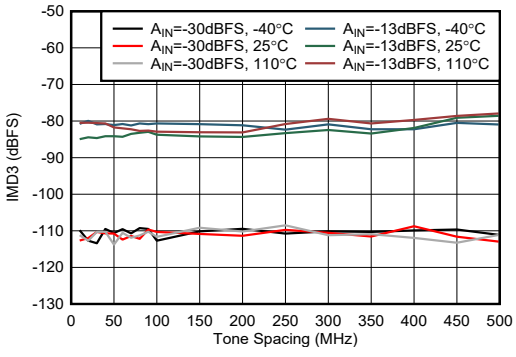
50MHz tone spacing

図 6-472. RX IMD3 vs DSA Setting at 9.6 GHz



50MHz tone spacing

図 6-473. RX IMD3 vs DSA Setting at 9.6 GHz



50MHz tone spacing

図 6-474. RX IMD3 vs Tone Spacing at 9.6 GHz

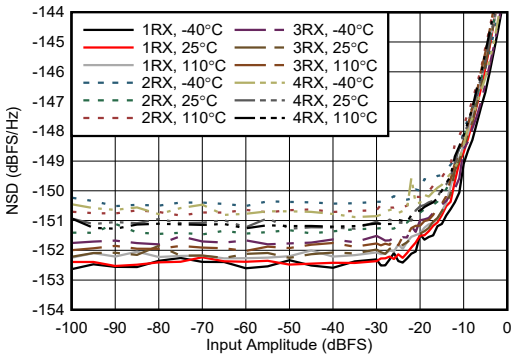


図 6-475. RX NSD vs Digital Amplitude at 9.6 GHz

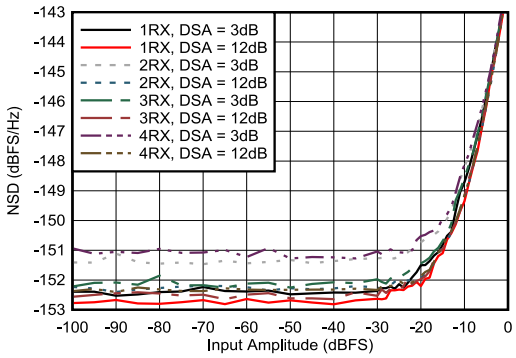


図 6-476. RX NSD vs Digital Amplitude at 9.6 GHz

6.12.14 RX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with f_{CLK} = 11796.48 MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 9.6 GHz matching.

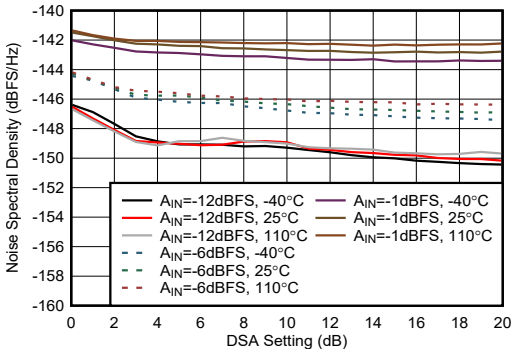


図 6-477. RX NSD vs DSA Setting at 9.6 GHz

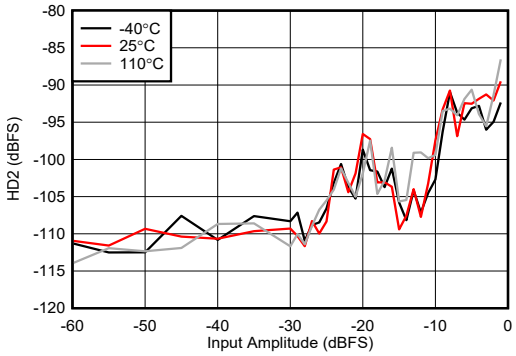


図 6-478. RX HD2 vs Digital Level at 9.6 GHz

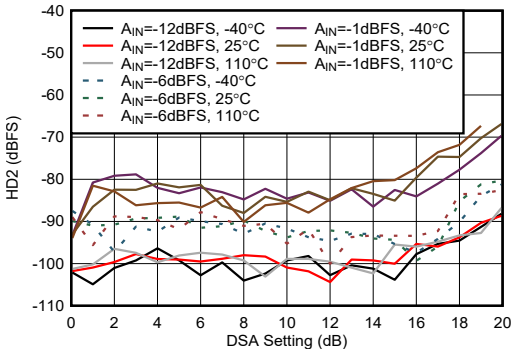


図 6-479. RX HD2 vs DSA Setting at 9.6 GHz

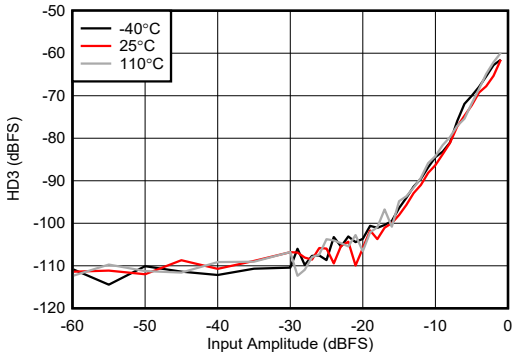


図 6-480. RX HD3 vs Digital Level at 9.6 GHz

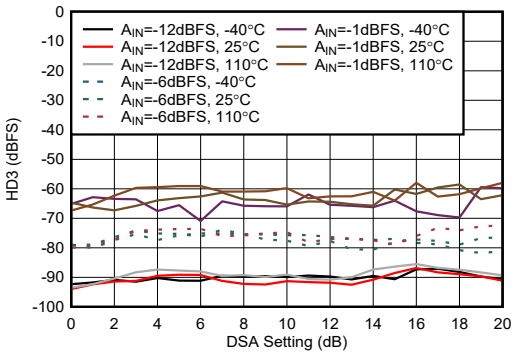
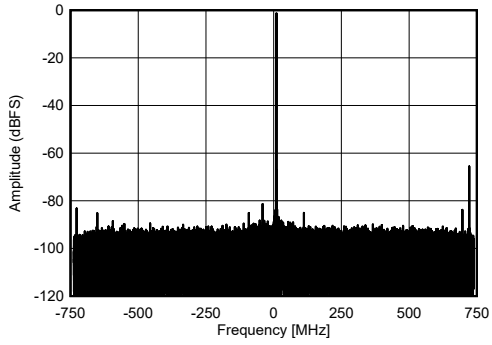


図 6-481. RX HD3 vs DSA Setting at 9.6 GHz

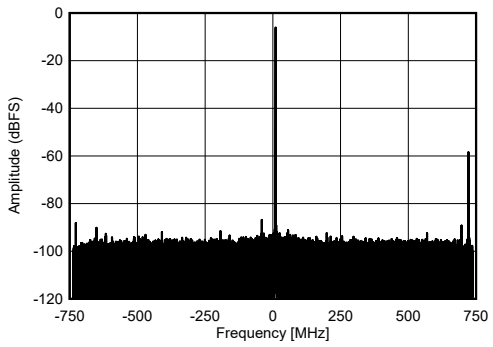


–1 dBFS

図 6-482. RX Single Tone Output FFT at 9.61 GHz

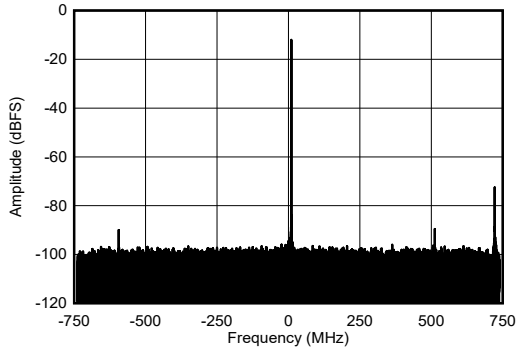
6.12.14 RX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with f_{CLK} = 11796.48 MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 9.6 GHz matching.



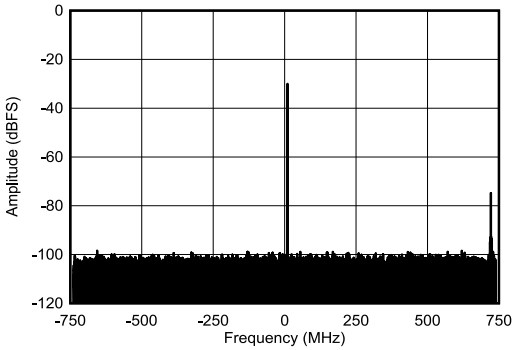
–6 dBFS

図 6-483. RX Single Tone Output FFT at 9.61 GHz



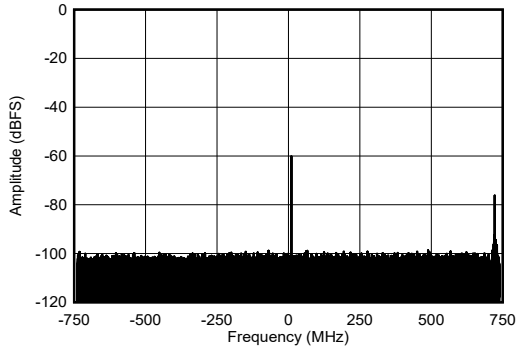
–12 dBFS.

図 6-484. RX Single Tone Output FFT at 9.61 GHz



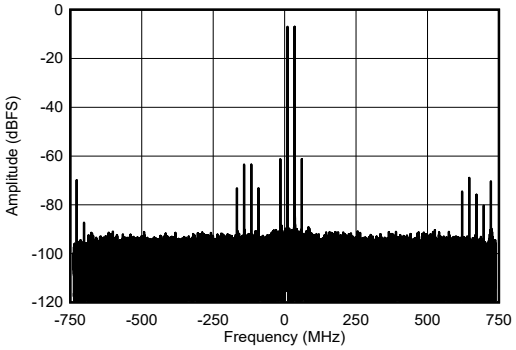
–30 dBFS

図 6-485. RX Single Tone Output FFT at 9.61 GHz



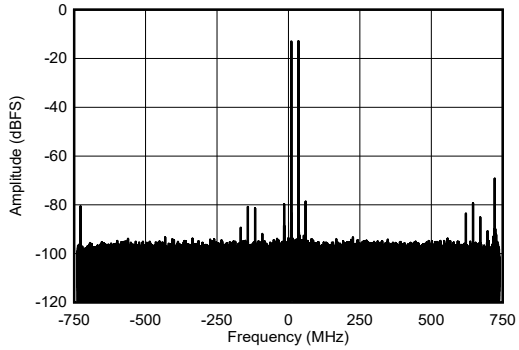
–60 dBFS

図 6-486. RX Single Tone Output FFT at 9.61 GHz



9.61 GHz and 9.635 GHz, –7 dBFS each tone

図 6-487. RX Two Tone Output FFT at 9.61 GHz

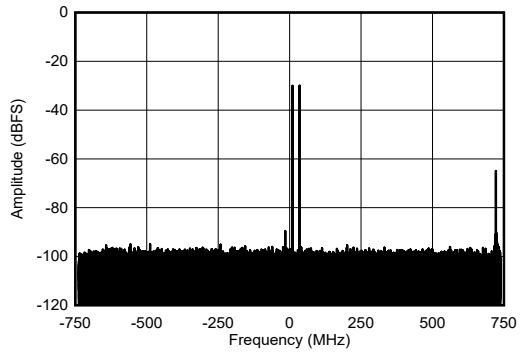


9.61 GHz and 9.635 GHz, –13 dBFS each tone

図 6-488. RX Two Tone Output FFT at 9.61 GHz

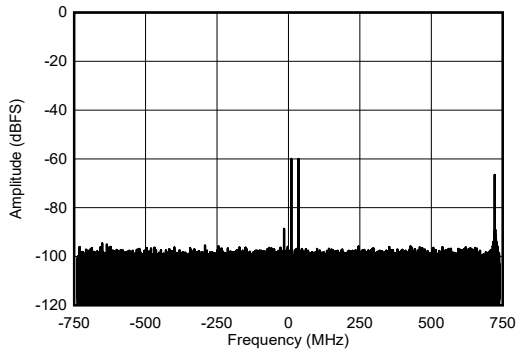
6.12.14 RX Typical Characteristics at 9.6 GHz (continued)

Typical values at T_A = +25°C, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 1474.56MSPS (decimate by 2), External clock mode with f_{CLK} = 11796.48 MHz, A_{IN} = –3 dBFS, DSA setting = 3 dB, 9.6 GHz matching.



9.61 GHz and 9.635 GHz, –30 dBFS each tone

図 6-489. RX Two Tone Output FFT at 9.61 GHz

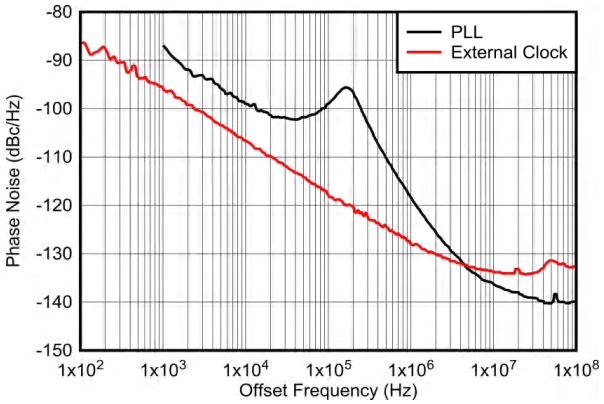


9.61 GHz and 9.635 GHz, –60 dBFS each tone

図 6-490. RX Two Tone Output FFT at 9.61 GHz

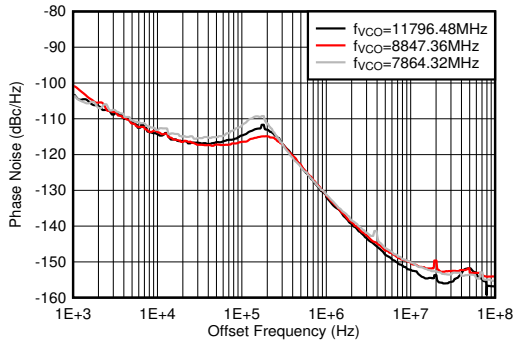
6.12.15 PLL and Clock Typical Characteristics

Typical values at T_A = +25°C with nominal supplies. Unless otherwise noted, f_{REF} = 491.52 MHz, Phase noise measured at TX output



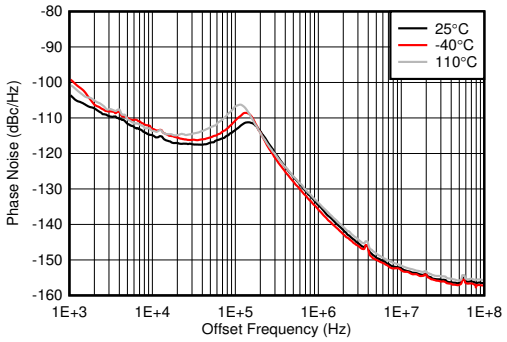
measured at TX output, normalized to 12GHz by 20*log10(12GHz/F_{OUT})

図 6-491. Phase Noise vs Offset Frequency for PLL and External Clock at 12GHz



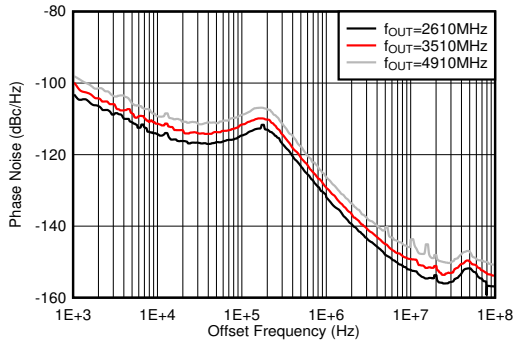
PLL enabled, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-492. Phase Noise vs Offset Frequency and f_{VCO} at f_{OUT} = 2610 MHz



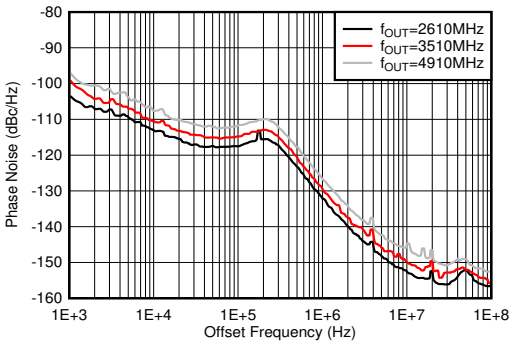
PLL enabled, f_{VCO} = 11796.48 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-493. Phase Noise for 12-GHz VCO vs Offset Frequency and Temperature at f_{OUT} = 1910 MHz



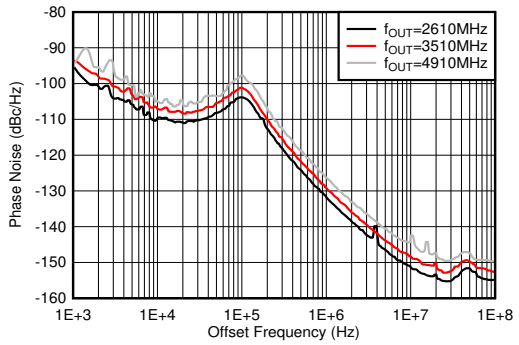
PLL enabled, f_{VCO} = 11796.48 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-494. Phase Noise for 12-GHz VCO vs Offset Frequency and f_{OUT} at 25°C



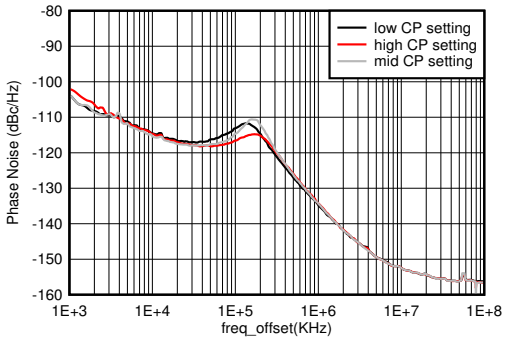
PLL enabled, f_{VCO} = 11796.48 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-495. Phase Noise for 12-GHz VCO vs Offset Frequency and f_{OUT} at –40°C



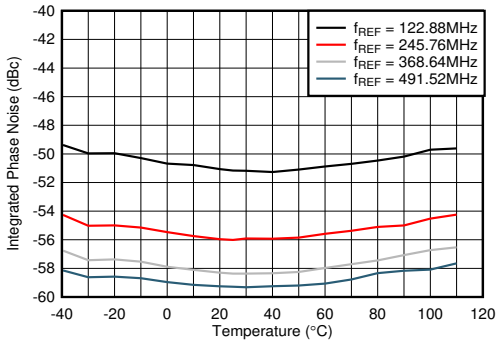
PLL enabled, f_{VCO} = 11796.48 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-496. Phase Noise for 12-GHz VCO vs Offset Frequency and f_{OUT} at 110°C



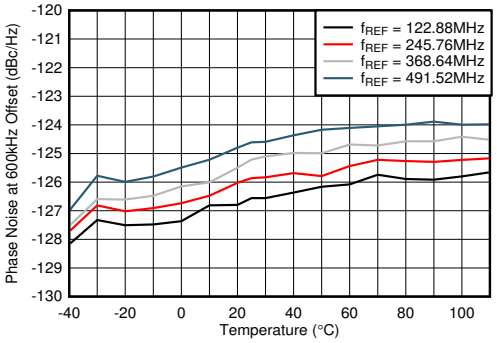
PLL enabled, f_{VCO} = 11796.48 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-497. Phase Noise for 12-GHz VCO vs Offset Frequency and CP Setting at f_{OUT} = 2.6 GHz



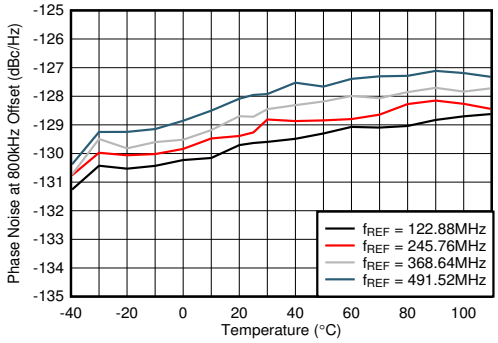
PLL enabled, f_{VCO} = 11796.48 MHz, 1-kHz to 100-MHz, single-sided integration bandwidth, measured at 2TXOUT

図 6-498. Integrated Phase Noise for 12-GHz VCO vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



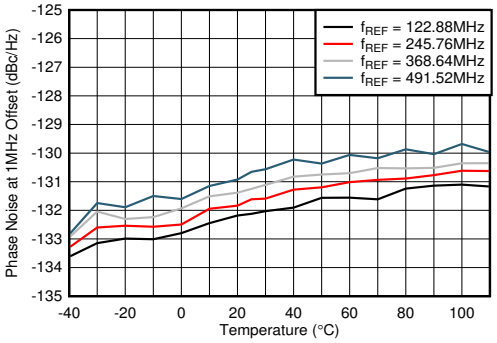
PLL enabled, f_{VCO} = 11796.48 MHz, measured at 2TXOUT

図 6-499. Phase Noise for 12-GHz VCO at 600kHz Offset vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



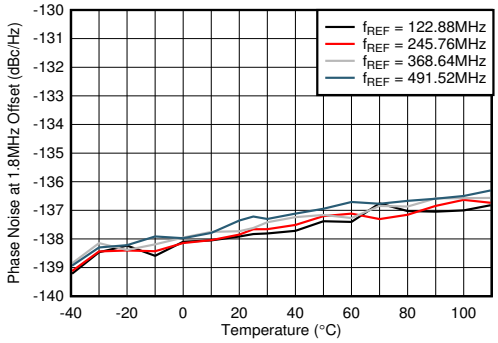
A. PLL enabled, f_{VCO} = 11796.48 MHz, measured at 2TXOUT

図 6-500. Phase Noise for 12-GHz VCO at 800-kHz Offset vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



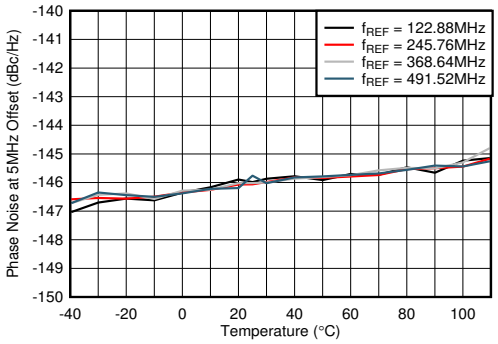
PLL enabled, f_{VCO} = 11796.48 MHz, measured at 2TXOUT

図 6-501. Phase Noise for 12-GHz VCO at 1-MHz Offset vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



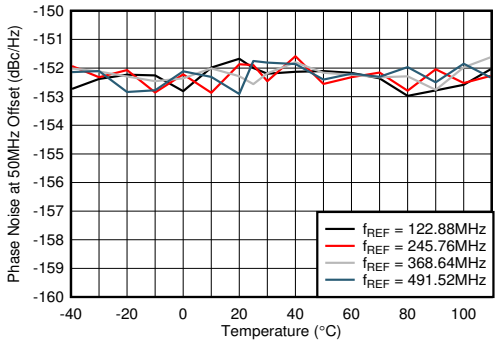
PLL enabled, f_{VCO} = 11796.48 MHz, measured at 2TXOUT

図 6-502. Phase Noise for 12-GHz VCO at 1.8-MHz Offset vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



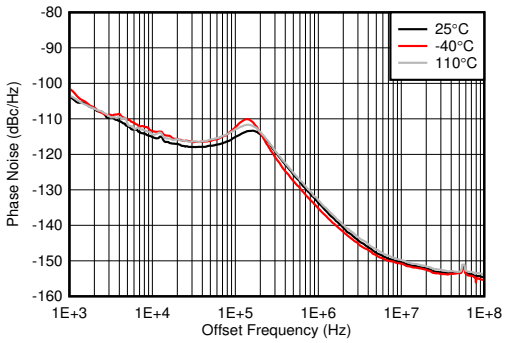
PLL enabled, f_{VCO} = 11796.48 MHz, measured at 2TXOUT

図 6-503. Phase Noise for 12-GHz VCO at 5-MHz Offset vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



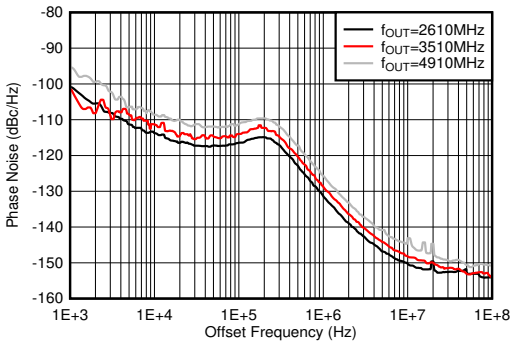
PLL enabled, f_{VCO} = 11796.48 MHz, measured at 2TXOUT

図 6-504. Phase Noise for 12-GHz VCO at 50-MHz Offset vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



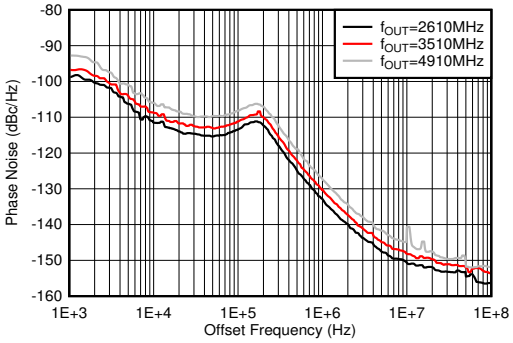
PLL enabled, f_{VCO} = 9830.4 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-505. Phase Noise for 10-GHz VCO vs Offset Frequency and Temperature at f_{OUT} = 1910 MHz



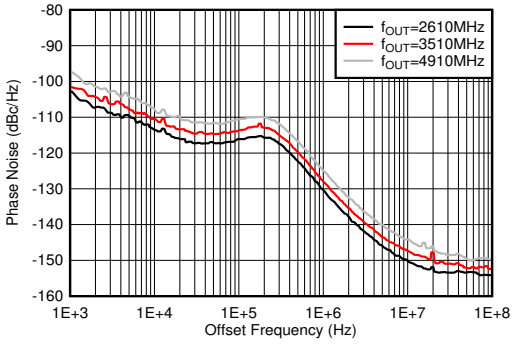
PLL enabled, f_{VCO} = 9830.4 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-506. Phase Noise for 10-GHz VCO vs Offset Frequency and f_{OUT} at 25°C



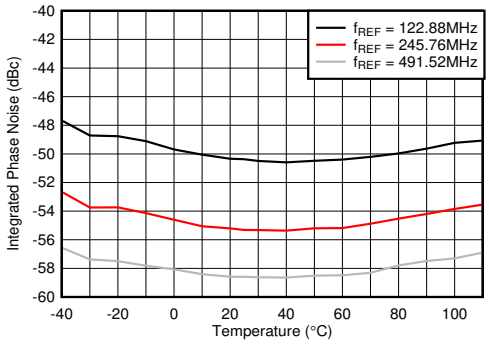
PLL enabled, f_{VCO} = 9830.4 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-507. Phase Noise for 10-GHz VCO vs Offset Frequency and f_{OUT} at –40°C



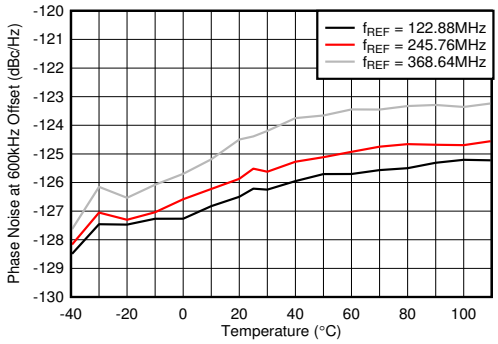
PLL enabled, f_{VCO} = 9830.4 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-508. Phase Noise for 10-GHz VCO vs Offset Frequency and f_{OUT} at 110°C



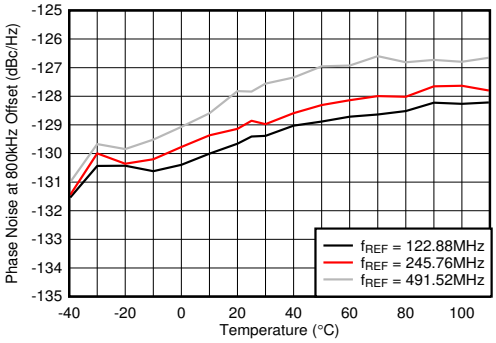
PLL enabled, f_{VCO} = 9830.4 MHz, 1-kHz to 100-MHz, single-sided integration bandwidth, measured at 2TXOUT

図 6-509. Integrated Phase Noise for 10-GHz VCO vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



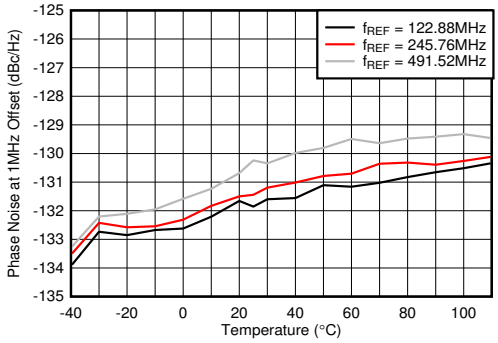
PLL enabled, f_{VCO} = 9830.4 MHz, measured at 2TXOUT

図 6-510. Phase Noise for 10-GHz VCO at 600 kHz vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



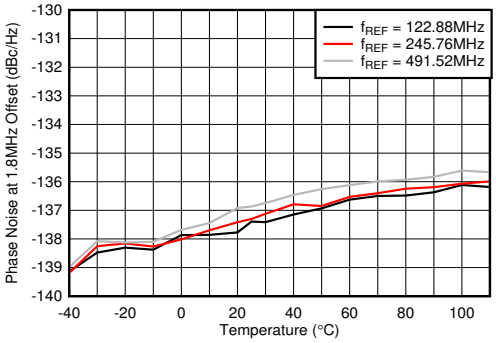
PLL enabled, f_{VCO} = 9830.4 MHz, measured at 2TXOUT

図 6-511. Phase Noise for 10-GHz VCO at 800 kHz vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



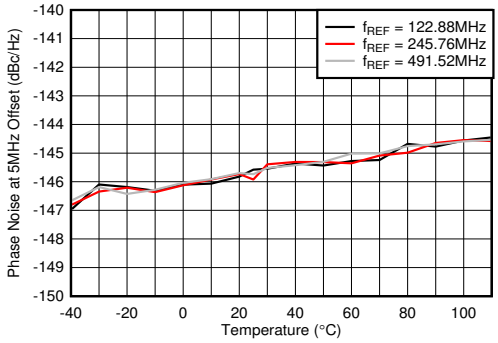
PLL enabled, f_{VCO} = 9830.4 MHz, measured at 2TXOUT

図 6-512. Phase Noise for 10-GHz VCO at 1 MHz vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



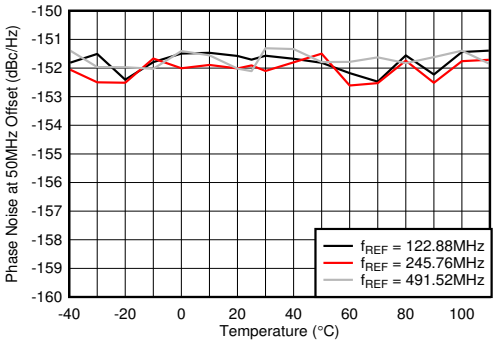
PLL enabled, f_{VCO} = 9830.4 MHz, measured at 2TXOUT

図 6-513. Phase Noise for 10-GHz VCO at 1.8 MHz vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



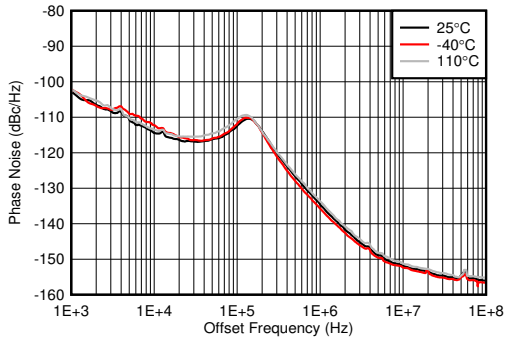
PLL enabled, f_{VCO} = 9830.4 MHz, measured at 2TXOUT

図 6-514. Phase Noise for 10-GHz VCO at 5 MHz vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



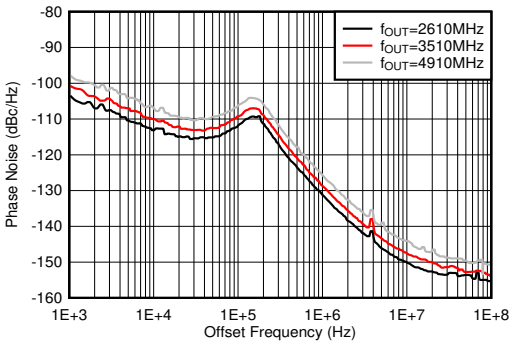
PLL enabled, f_{VCO} = 9830.4 MHz, measured at 2TXOUT

図 6-515. Phase Noise for 10-GHz VCO at 50 MHz vs Temperature and f_{REF} at f_{OUT} = 2.6 GHz



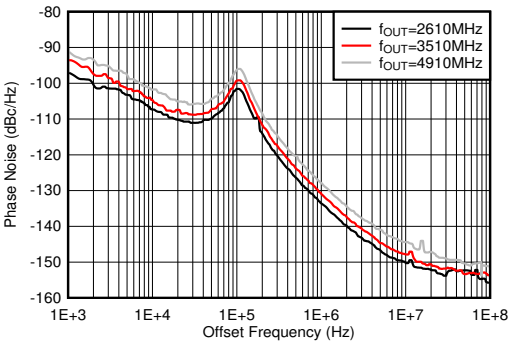
PLL enabled, f_{VCO} = 8847.36 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-516. Phase Noise for 9-GHz VCO vs Offset Frequency and Temperature at f_{OUT} = 1910 MHz



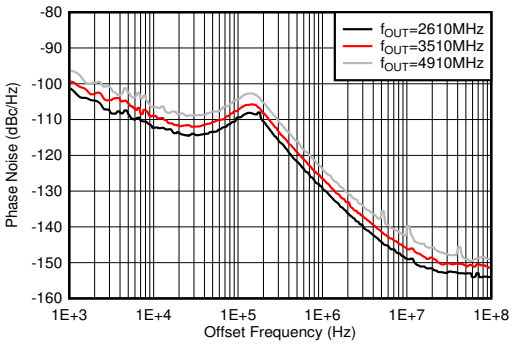
PLL enabled, f_{VCO} = 8847.36 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-517. Phase Noise for 9-GHz VCO vs Offset Frequency and f_{OUT} at 25°C



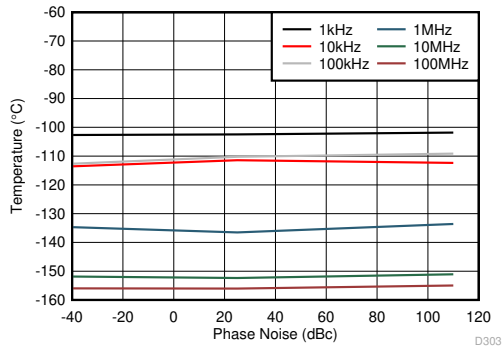
PLL enabled, f_{VCO} = 8847.36 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-518. Phase Noise for 9-GHz VCO vs Offset Frequency and f_{OUT} at –40°C



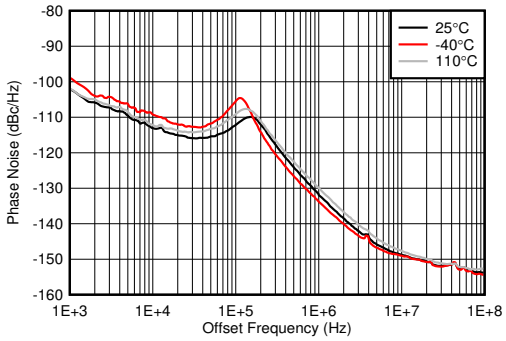
PLL enabled, f_{VCO} = 8847.36 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-519. Phase Noise for 9-GHz VCO vs Offset Frequency and f_{OUT} at 110°C



PLL enabled, f_{VCO} = 8847.36 MHz, f_{REF} = 491.52MSPS, minimum LPF BW, measured at 2TXOUT

図 6-520. Phase Noise for 9-GHz VCO vs Temperature Over Offset Frequency at f_{OUT} = 2.6 GHz



PLL enabled, f_{VCO} = 7864.32 MHz, f_{REF} = 491.52MSPS, measured at 2TXOUT

図 6-521. Phase Noise for 8-GHz VCO vs Offset Frequency and Temperature at f_{OUT} = 1910 MHz

7 Device and Documentation Support

7.1 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、ti.com のデバイス製品フォルダを開いてください。「更新の通知を受け取る」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

7.2 サポート・リソース

TI E2E™ サポート・フォーラムは、エンジニアが検証済みの回答と設計に関するヒントをエキスパートから迅速かつ直接得ることができる場所です。既存の回答を検索したり、独自の質問をしたりすることで、設計で必要な支援を迅速に得ることができます。

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7.3 商標

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7.4 静電気放電に関する注意事項

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ESD による破損は、わずかな性能低下からデバイスの完全な故障まで多岐にわたります。精密な IC の場合、パラメータがわずかに変化するだけで公表されている仕様から外れる可能性があるため、破損が発生しやすくなっています。

7.5 用語集

テキサス・インスツルメンツ用語集　　この用語集には、用語や略語の一覧および定義が記載されています。

8 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
AFE7950IABJ	ACTIVE	FCBGA	ABJ	400	90	RoHS & Green	SNAGCU	Level-3-260C-168 HR	-40 to 85	AFE7950I	Samples
AFE7950IALK	ACTIVE	FCBGA	ALK	400	90	Non-RoHS & Green	Call TI	Level-3-220C-168 HR	-40 to 85	AFE7950 SNPB	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

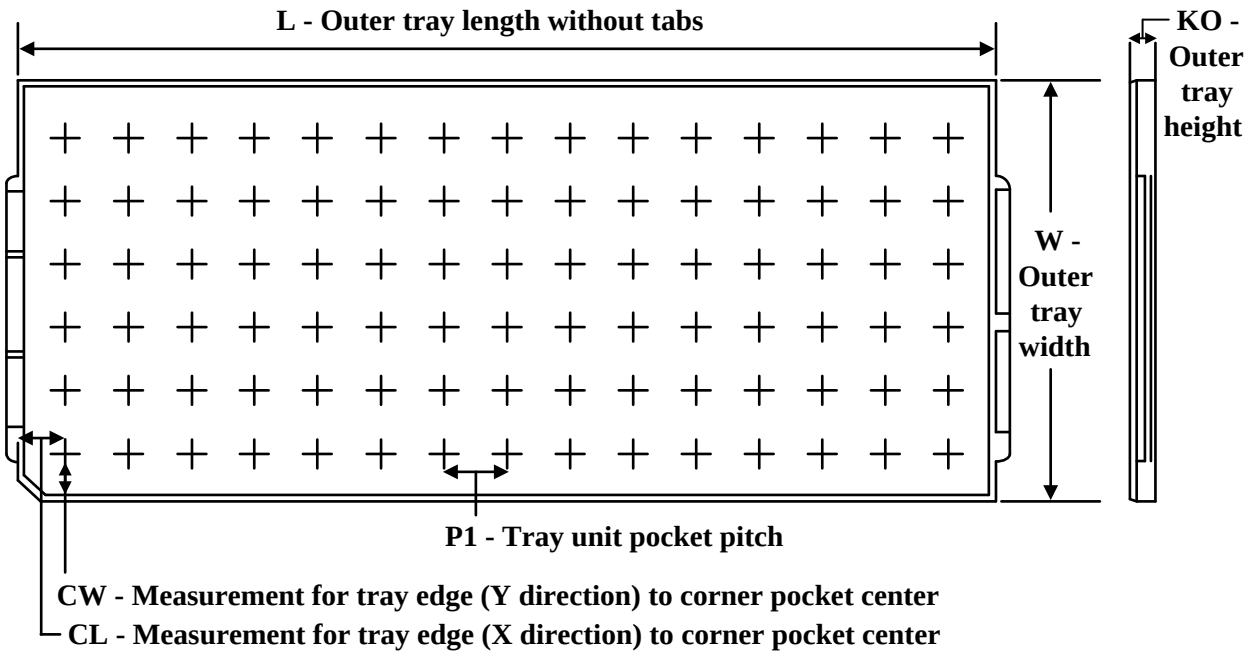
(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

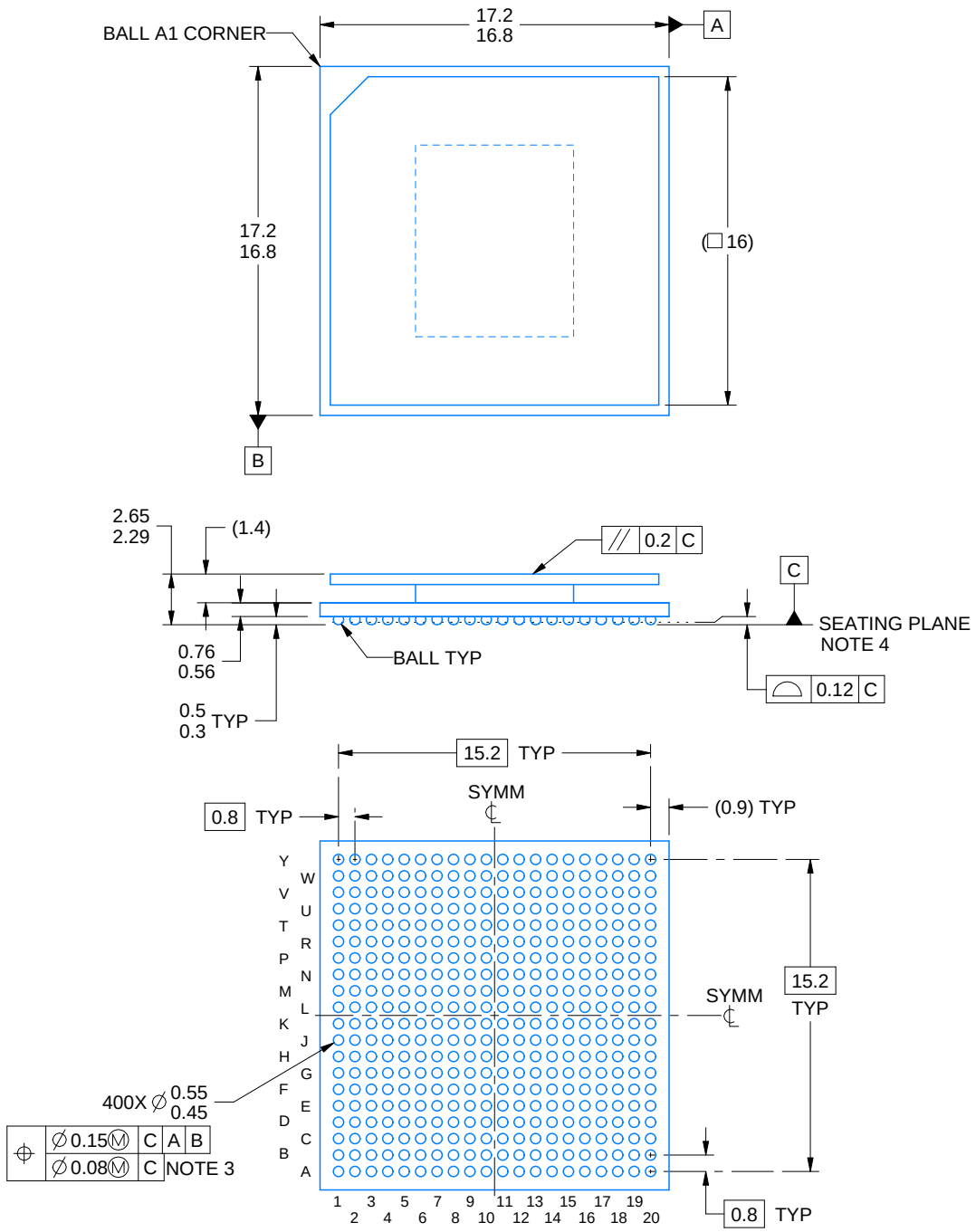
Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW (mm)
AFE7950IABJ	ABJ	FCBGA	400	90	6 x 15	150	315	135.9	7620	19.5	21	19.2
AFE7950IABJ	ABJ	FCBGA	400	90	6 x 15	150	315	135.9	7620	19.5	21	19.2
AFE7950IALK	ALK	FCBGA	400	90	6 x 15	150	315	135.9	7620	19.5	21	19.2

PACKAGE OUTLINE

ABJ0400A

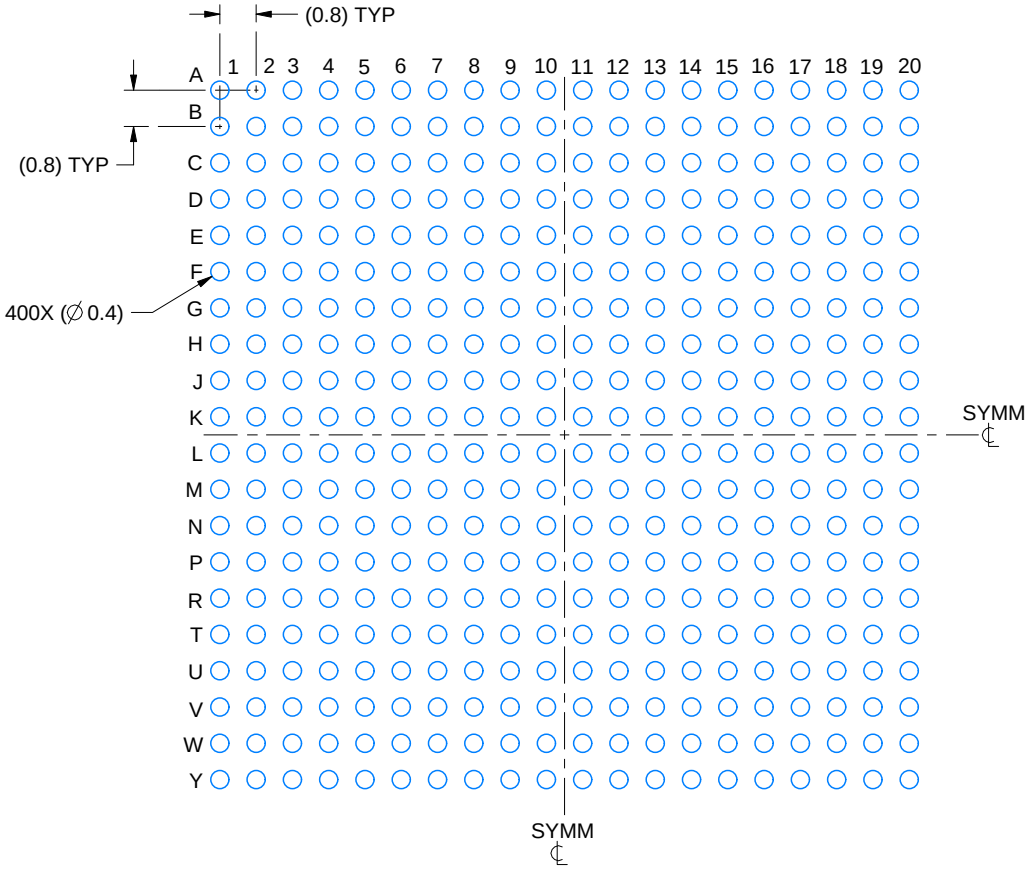
FCBGA - 2.65 mm max height

BALL GRID ARRAY

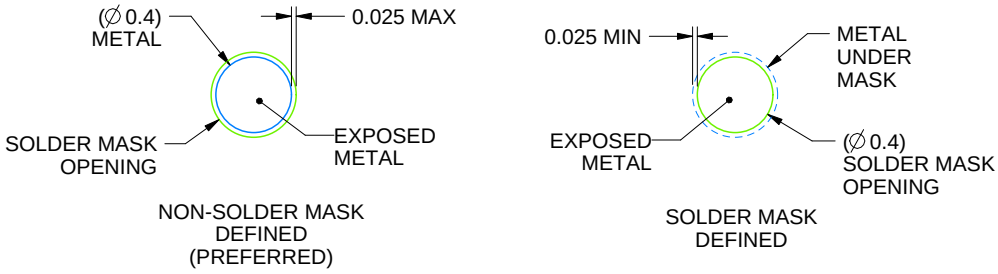


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Dimension is measured at the maximum solder ball diameter, parallel to primary datum C.
4. Primary datum C and seating plane are defined by the spherical crowns of the solder balls.
5. The lids are electrically floating (e.g. not tied to GND).



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X

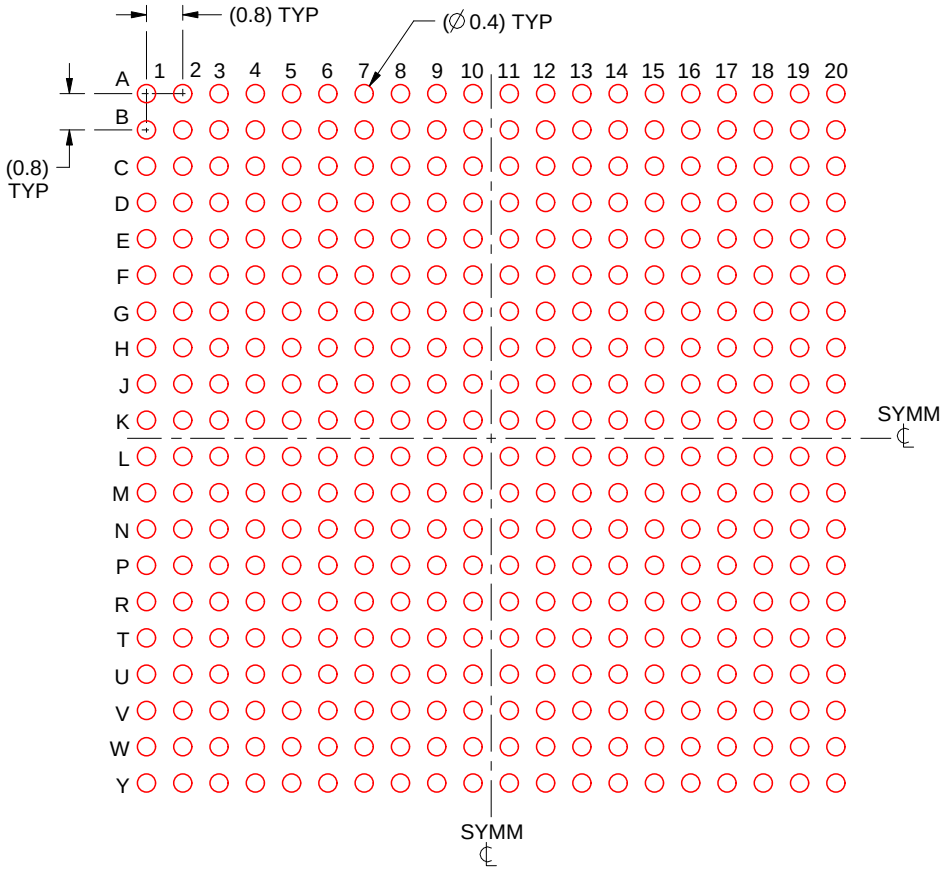


SOLDER MASK DETAILS
NOT TO SCALE

4221311/D 03/2023

NOTES: (continued)

6. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SPRU811 (www.ti.com/lit/spru811).



SOLDER PASTE EXAMPLE
BASED ON 0.15 mm THICK STENCIL
SCALE:6X

4221311/D 03/2023

NOTES: (continued)

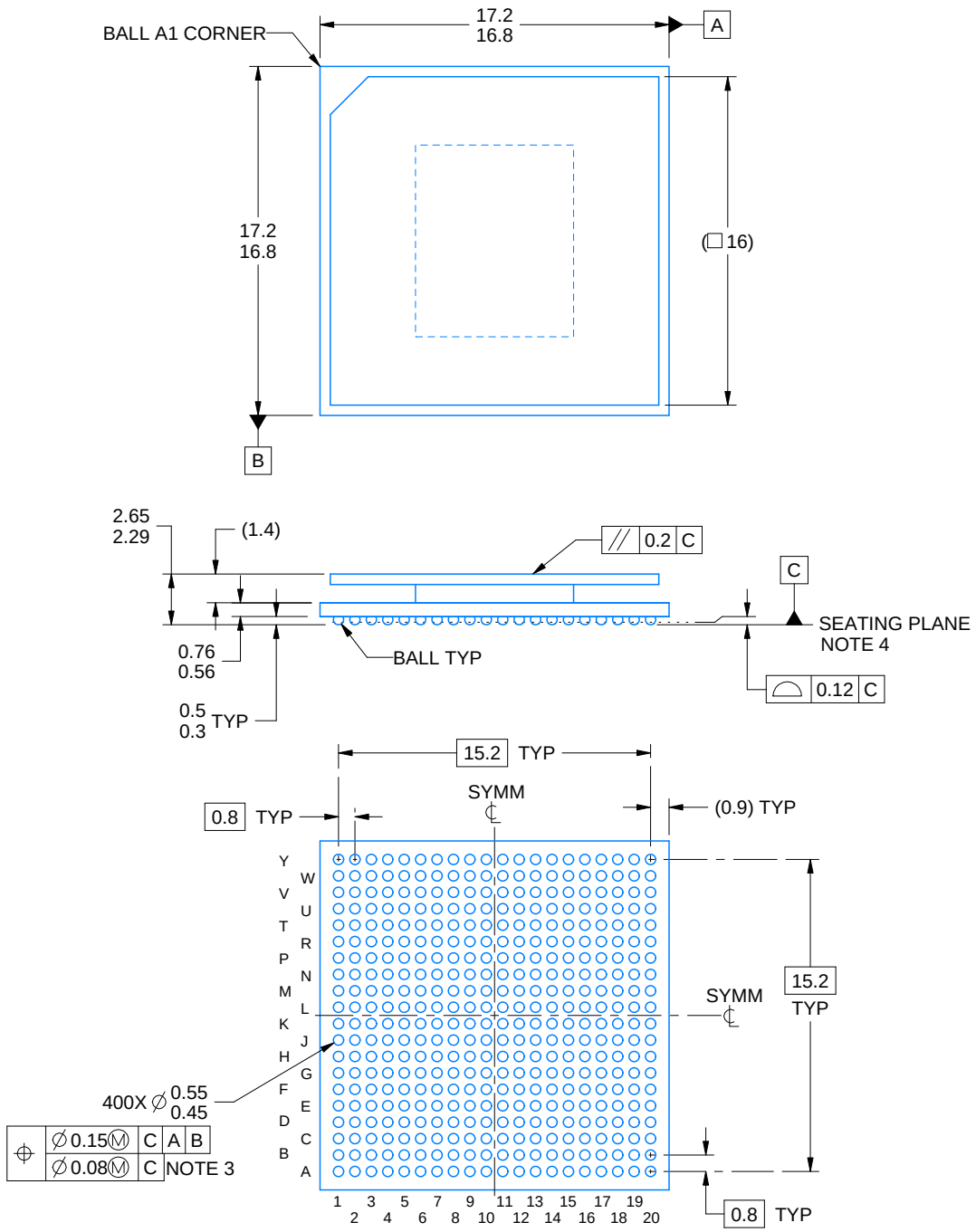
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

ALK0400A

PACKAGE OUTLINE

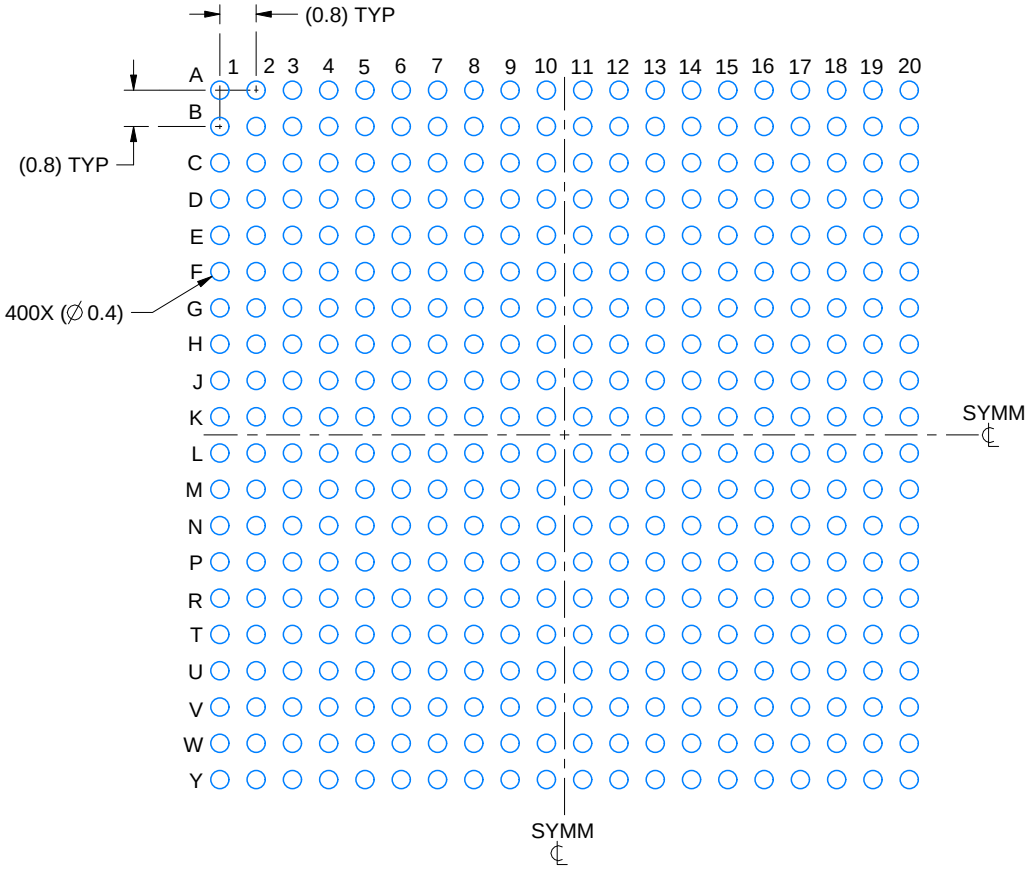
FCBGA - 2.65 mm max height

BALL GRID ARRAY

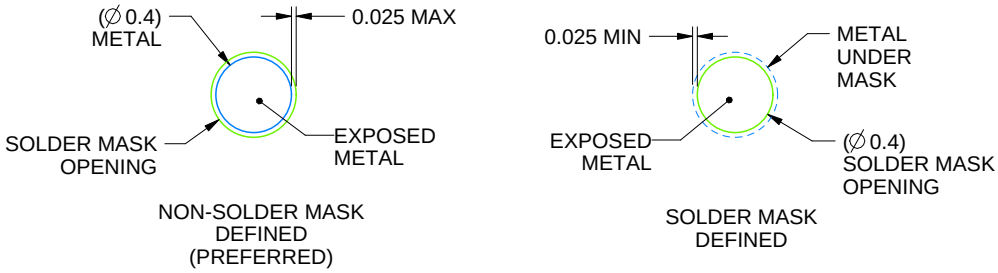


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Dimension is measured at the maximum solder ball diameter, parallel to primary datum C.
4. Primary datum C and seating plane are defined by the spherical crowns of the solder balls.
5. Pb-Free die bump and SnPb solder ball.
6. The lids are electrically floating (e.g. not tied to GND).



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X

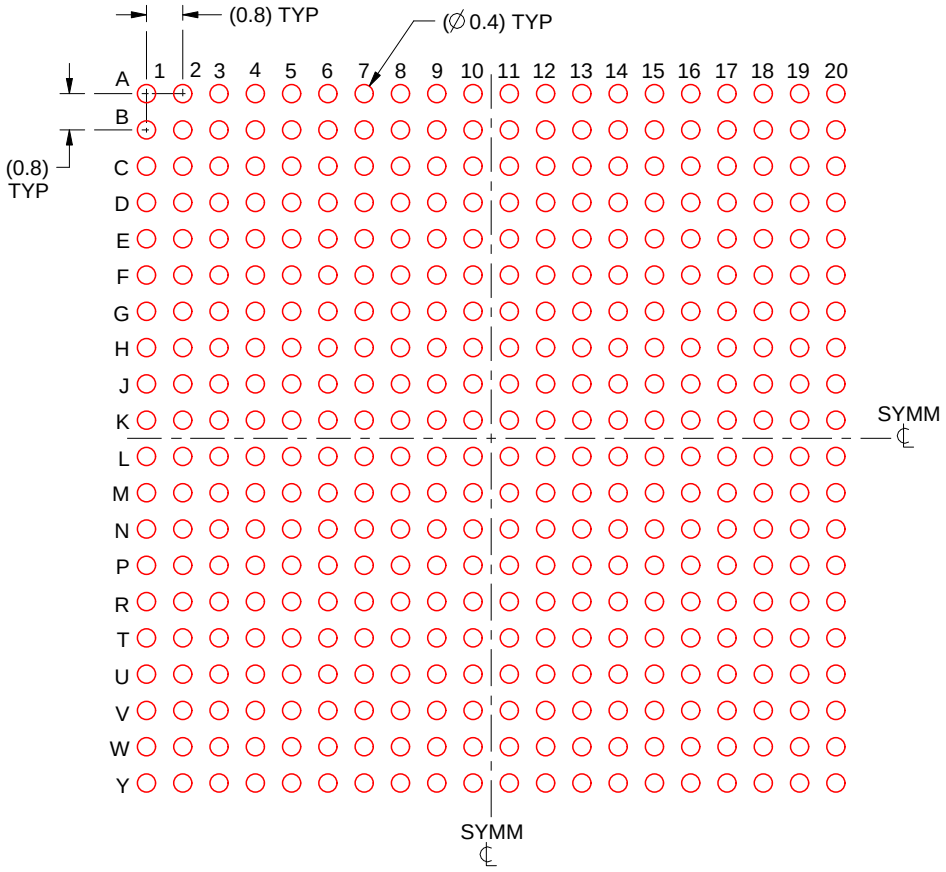


SOLDER MASK DETAILS
NOT TO SCALE

4225930/C 03/2023

NOTES: (continued)

7. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SPRU811 (www.ti.com/lit/spru811).



SOLDER PASTE EXAMPLE
BASED ON 0.15 mm THICK STENCIL
SCALE:6X

4225930/C 03/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

重要なお知らせと免責事項

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